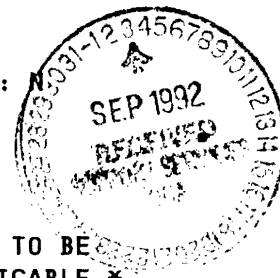


08/27/92



GEORGIA INSTITUTE OF TECHNOLOGY
OFFICE OF CONTRACT ADMINISTRATION

NOTICE OF PROJECT CLOSEOUT

Closeout Notice Date 11/03/92

Project No. E-18-617_____ Center No. 10/24-6-R7581-0A0_
Project Director CARTER W B_____ School/Lab MSE_____
Sponsor NASA/MARSHALL SPACE FLT CTR, AL_____
Contract/Grant No. H-13010D_____ Contract Entity GTRC
Prime Contract No. _____
Title ELECTRON SPECTROSCOPY FOR CHEMICAL ANALYSIS - SAMPLE ANALYSIS_____
Effective Completion Date 920930 (Performance) 920930 (Reports)

Closeout Actions Required:	Y/N	Date Submitted
Final Invoice or Copy of Final Invoice	Y	_____
Final Report of Inventions and/or Subcontracts	Y	_____
Government Property Inventory & Related Certificate	Y	_____
Classified Material Certificate	N	_____
Release and Assignment	Y	_____
Other _____	N	_____

CommentsEFFECTIVE DATE 7-31-92. CONTRACT VALUE \$19,844_____

Subproject Under Main Project No. _____

Continues Project No. _____

Distribution Required:

Project Director	Y
Administrative Network Representative	Y
GTRI Accounting/Grants and Contracts	Y
Procurement/Supply Services	Y
Research Property Management	Y
Research Security Services	N
Reports Coordinator (OCA)	Y
GTRC	Y
Project File	Y
Other HARRY VANN FMD_____	Y
FRED CAIN OOD_____	Y

NOTE: Final Patent Questionnaire sent to PDPI.

4 18-611

ELECTRON SPECTROSCOPY FOR CHEMICAL ANALYSIS -- SAMPLE ANALYSIS

REPORT # LDEF-01

Prepared by:

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for:

NASA/MSFC
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under:

PO # H-13010D

11 September 1992

This document reports the results of ESCA analyses performed on the following samples:

IV-1, IV-4, IV-5, IV-8, IV-11, IV-68, IV-73

A description of the ESCA data precedes reports of the analyses.

Description of ESCA Data

Two types of ESCA spectra were collected 1) general surveys and 2) high resolution spectra. The ESCA spectrometer is calibrated such that the Au $4f_{7/2}$ photoemission peak appears at a B.E. of 84.0 eV.

General surveys were first taken of all samples over a binding energy (B.E.) range of -10 eV to 1090 eV. A single count, plotted on the vertical axes, corresponds to one detected photoelectron. An analyzer pass energy of 200 eV and an x-ray spot about 1 mm in diameter were used for the collection of general surveys. Semiquantitative analyses of the elemental compositions of the sample surfaces were performed from the general survey data. These analyses are based on the photoemission peak areas of the various elements represented in the spectra, their photoemission cross sections and the energy response of the analyses. Not included in these analyses are the effects of variable electron inelastic mean free paths in the samples or the influences of sample inhomogeneities.

High resolution spectra were taken over B.E. ranges corresponding to photoemission peaks of interest identified in the general surveys. High resolution spectra were collected using an analyzer pass energy of 50 eV and an x-ray spot of about 300 μm in diameter. Most high resolution spectra have been peak fitted with one or more Gaussian components. The energy, FWHM and area (total counts in Gaussian component) corresponding to each fitted component are displayed on the spectra.

At least two spots on each sample were examined as discussed in the reports below.

Reports on ESCA Analyses

Samples IV-1, IV-4, IV-5 and IV-11 produced similar spectra with the exception that IV-1 has a small amount of Ag present. Varying amounts of C were observed on these samples ranging from about 9 atomic percent near the center of IV-5 to about 20 atomic percent at one spot on IV-4. The semiquantitative O to Si ratios range from about 1.6 to 2.1. It must be stressed that these ratios are for the surfaces of the samples, which almost certainly are covered to some extent with water, adventitious carbon, O_2 , etc.

Samples IV-8, IV-68 and IV-73 were each unique among the IV designated samples. Each sample analysis is presented below.

IV-1: Exposed passivated Ti reflector

A spot near the center and a spot about midway between the center and the perimeter (off center region) of this sample were examined.

The surface of this specimen is composed primarily of O, Si and C with a small amount of Ag (~1 atomic %). Semiquantitatively, the ratio of O to Si is about 2:1.

The general surveys from each spot were similar and indicated the presence of O, Si, Ag and C. See figure 1 (center region) and figure 4 (off center region). Figure 4 indicates the possible presence of I. Semiquantitative analyses of the relative sizes of the photoemission peaks from the four elements common to both spectra yield the following:

Table 1: Semiquantitative Composition of
Center Region of Sample IV-1
from Figure 1

Element	Approximate Atomic Percent
O	58
Si	30
C	11
Ag	1

Table 2: Semiquantitative Composition of
Off Center Region of Sample IV-1
from Figure 5

Element	Approximate Atomic Percent
O	60
Si	28
C	11
Ag	1

Figures 2 and 3 are high resolution spectra of the Si 2s and O 1s photoemission peaks, respectively, obtained from the center region. Each has been peak fitted with a single Gaussian peak. Figures 5 and 6 are similar high resolution spectra obtained from

the off center region. Both Si 2s spectra and both O 1s spectra are similar.

Figure 7 is a high resolution spectrum of the Ag 3d photoemission peaks ($3d_{5/2}$ and $3d_{3/2}$) obtained from the off center region of the sample. It has been fitted with two Gaussian components.

IV-4: Exposed Ti with protective overcoat

A spot near the center and a spot about midway between the center and the perimeter (off center region) of this sample were examined.

The surface of this specimen is composed primarily of O, Si and C. Figures 8 - 13 display the spectra taken on this sample. Tables 3 and 4 present the semiquantitative analyses obtained from the two general surveys taken on this sample.

Table 3: Semiquantitative Composition of
Center Region of Sample IV-4
from Figure 8

Element	Approximate Atomic Percent
O	54
Si	30
C	16

Table 4: Semiquantitative Composition of
Off Center Region of Sample IV-4
from Figure 11

Element	Approximate Atomic Percent
O	50
Si	31
C	19

IV-5: Exposed Ti, passivated

A spot near the center and a spot about midway between the center and the perimeter (off center region) of this sample were examined.

The surface of this specimen is composed primarily of O, Si and C. Figures 14 - 19 display the spectra taken on this sample. Tables 5 and 6 present the semiquantitative analyses obtained from the two general surveys taken on this sample.

Table 5: Semiquantitative Composition of
Center Region of Sample IV-5
from Figure 14

Element	Approximate Atomic Percent
O	57
Si	34
C	9

Table 6: Semiquantitative Composition of
Off Center Region of Sample IV-5
from Figure 17

Element	Approximate Atomic Percent
O	54
Si	33
C	13

IV-8: Exposed Al, SiO₂

The surface of this specimen is about half covered with a dark material that appears "corroded". The region not appearing "corroded" appears "shiny". Two spots were examined - one located on a shiny region of the sample and one located on the "corroded" region. There are fingerprints on the side of the sample that was not examined.

Both spots examined indicate the presence of O, C and Ag. The "shiny" region also displays Si and a small amount of Na (~2 atomic %). The "corroded" region does not display Si or Na. The relative amounts of C and Ag differ substantially between the two regions. The "shiny" region displays about 18 atomic percent C

and about 2 atomic percent Ag while the "corroded" region displays about 57 atomic percent C and about 21 atomic percent Ag.

The O 1s spectrum from the "shiny" region is composed of at least two components. The larger of these is probably associated with silicon oxides and the smaller with metallic oxides. The O 1s spectrum from the "corroded" region displays a single Gaussian component, which is consistent with presence of a single oxide of Ag. The "corroded" region appears to be covered with primarily carbonaceous material and an oxide of silver.

Figures 20 - 27 display the spectra taken on this sample. Tables 7 and 8 present the semiquantitative analyses obtained from the two general surveys taken on this sample.

Table 7: Semiquantitative Composition of
"Shiny" Region of Sample IV-8
from Figure 20

Element	Approximate Atomic Percent
O	55
Si	23
C	18
Ag	2
Na	2

Table 8: Semiquantitative Composition of
"Corroded" Region of Sample IV-8
from Figure 24

Element	Approximate Atomic Percent
O	22
C	57
Ag	21

IV-11: Exposed Al, SiO₂

A spot near the center and a spot about midway between the center and the perimeter (off center region) of this sample were examined.

The surface of this specimen is composed primarily of O, Si and C. Figures 28 - 33 display the spectra taken on this sample. Tables 9 and 10 present the semiquantitative analyses obtained from the two general surveys taken on this sample.

Table 9: Semiquantitative Composition of
Center Region of Sample IV-11
from Figure 28

Element	Approximate Atomic Percent
O	53
Si	30
C	17

Table 10: Semiquantitative Composition of
Off Center Region of Sample IV-11
from Figure 31

Element	Approximate Atomic Percent
O	54
Si	32
C	14

IV-68: Exposed tungsten

About half of one side of this sample was exposed during the LDEF flight. Two spots in the exposed area were examined - one spot near the center (center region) and one spot about midway between the center and the perimeter (off center region).

Both spots display O, C, Si and W. The center region displays substantially more C than the off center region.

The two high resolution scans of the W 4f_{7/2} photoemission peak indicate that its B.E. is about 35.5 eV. This B.E. is indicative of WO₃.^{1,2} WO₂ displays values for this B.E. 2 to 3 eV lower. The W4f_{7/2} B.E. from tungsten oxy-carbides are 1 to 2 eV higher.

It can thus be surmised that most of the W at or near the surface of this sample is in the form of WO_3 .

The O 1s spectra are composed of at least two components. The larger of these is probably associated with silicon oxides and the smaller with WO_3 .

Tables 11 and 12 present the results of the semiquantitative analyses obtained from the two general surveys taken from this sample. Figures 34 - 41 contain the spectra taken from this sample.

Table 11: Semiquantitative Composition of
Center Region of Sample IV-68
from Figure 34

Element	Approximate Atomic Percent
O	49
Si	22
C	26
W	3

Table 12: Semiquantitative Composition of
Off Center Region of Sample IV-68
from Figure 38

Element	Approximate Atomic Percent
O	59
Si	26
C	11
W	4

IV-73: Exposed tantalum

About half of one side of this sample was exposed during the LDEF flight. Two spots in the exposed area were examined - one spot near the center (center region) and one spot about midway between the center and the perimeter (off center region).

Both spots display O, C, Si and Ta. Substantial amounts of C exist on both spots. The two high resolution scans of the Ta $4f_{7/2}$ photoemission peak indicate that its B.E. is about 26.5 eV. This B.E. is indicative of Ta_2O_5 .¹ The O 1s spectra are composed

of at least two components. The larger of these is probably associated with silicon oxides and the smaller with Ta₂O₅.

Tables 13 and 14 present the results of the semiquantitative analyses obtained from the two general surveys taken from this sample. Figures 42 - 50 contain the spectra taken from this sample.

Table 13: Semiquantitative Composition of
Center Region of Sample IV-73
from Figure 42

Element	Approximate Atomic Percent
O	46
Si	15
C	34
Ta	5

Table 14: Semiquantitative Composition of
Off Center Region of Sample IV-73
from Figure 47

Element	Approximate Atomic Percent
O	47
Si	20
C	29
Ta	4

References:

- 1.D.D. Sarma and C.N.R. Rao, J. Electron Spectrosc. Relat. Phenom. 20, 25(1980).
- 2.L. Salvati, L.E. Makovsky, J.M. Stencel, F.R. Brown and D.M. Hercules, J. Phys. Chem. 85, 3700 (1981).

File: LDEF002	Date: 8/24/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 1	Resolution: 4
Description: IV-1 EXPOSED PASSIVATED Ti REFLECTOR CENTER REGION			Operator: WBC

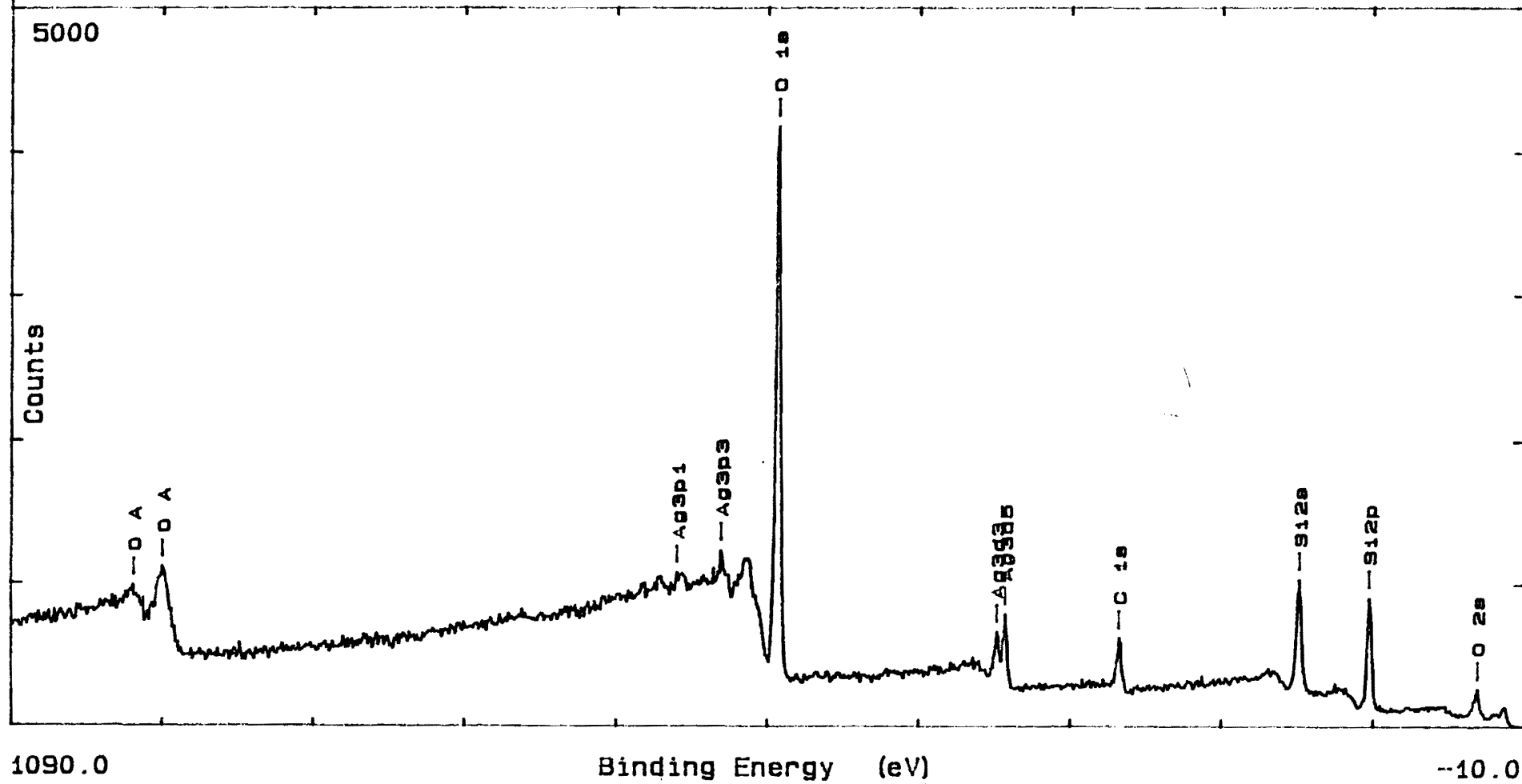


Figure 1

File: LDEF002	Date: 8/24/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description:	IV-1 EXPOSED PASSIVATED T1 REFLECTOR CENTER REGION, Si 2s SPECTRUM		Operator: WBC

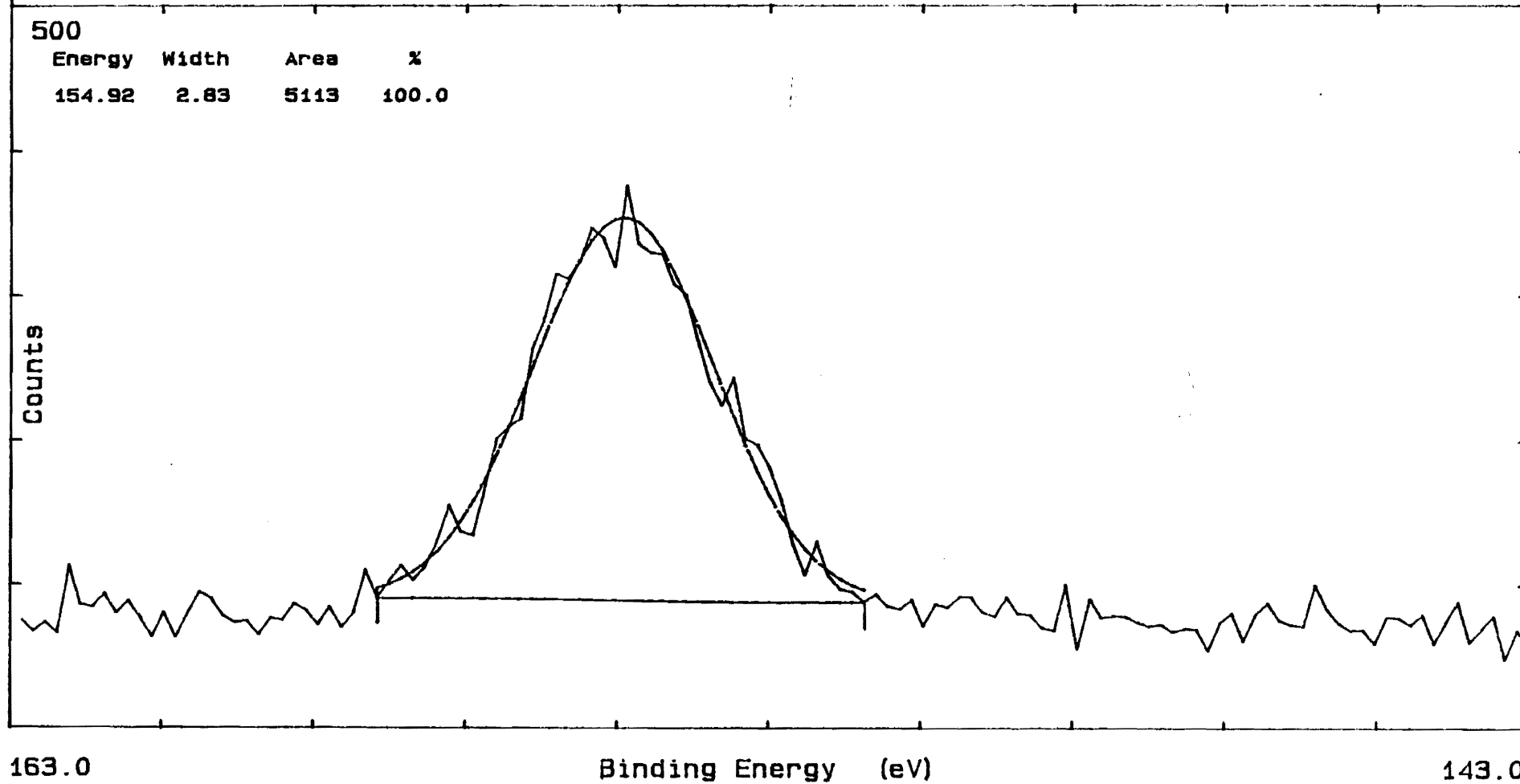


Figure 2

File: LDEF002	Date: 8/24/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2

Description: IV-1 EXPOSED PASSIVATED T1 REFLECTOR
CENTER REGION, 0 1s SPECTRUM

Operator: WBC

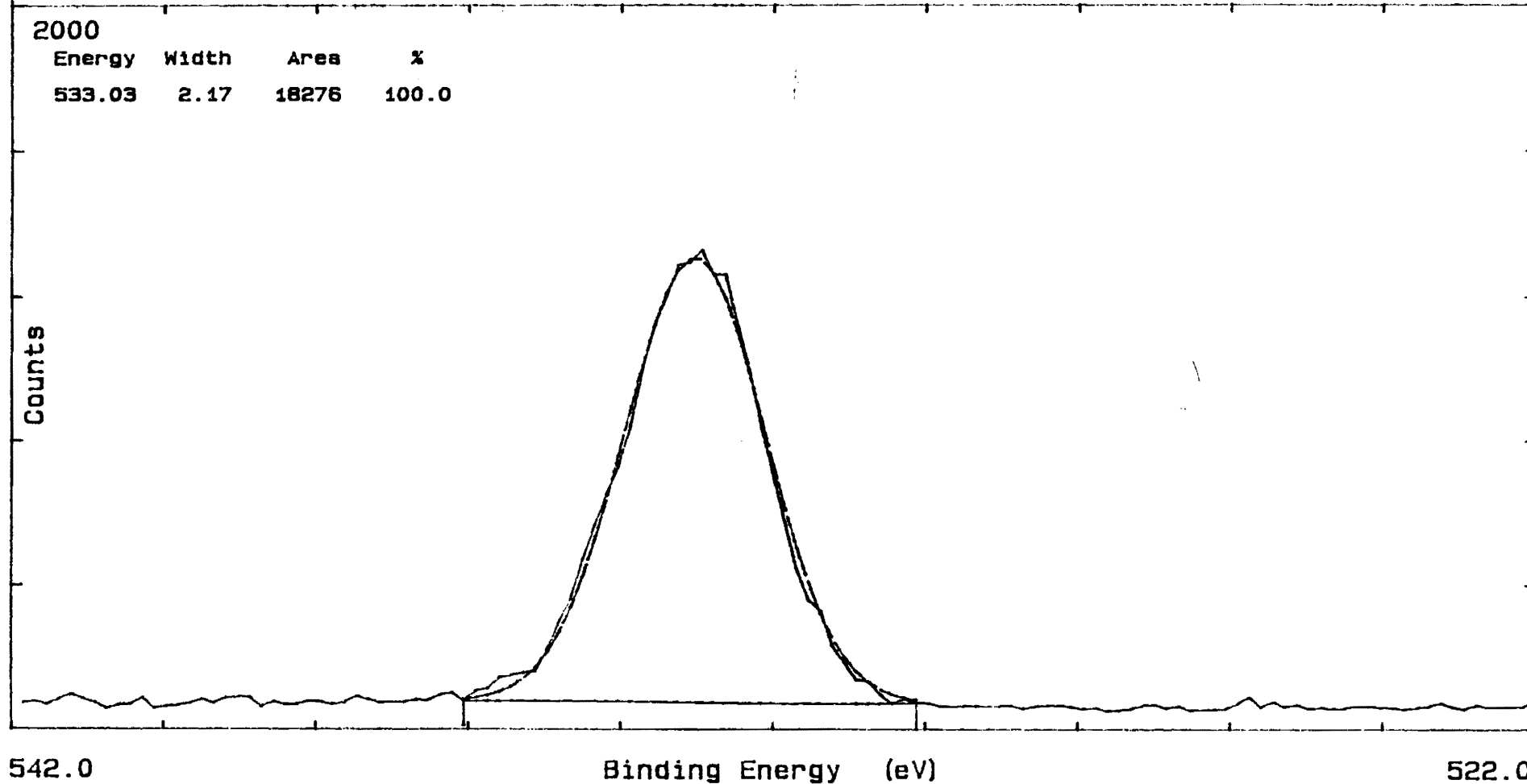


Figure 3

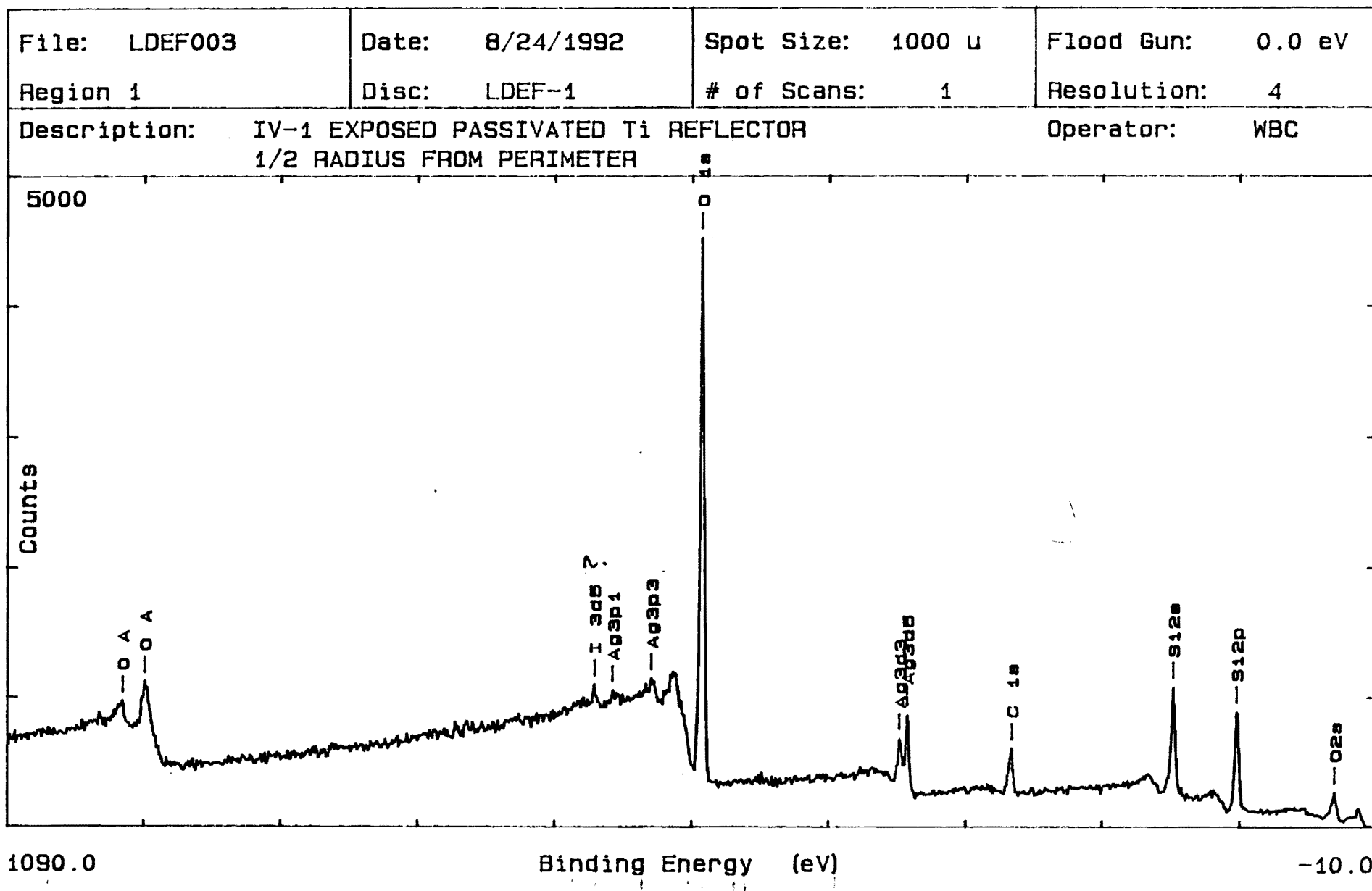


Figure 4

File: LDEF003	Date: 8/24/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 5	Resolution: 2

Description: IV-1 EXPOSED PASSIVATED Ti REFLECTOR
1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM

Operator: WBC

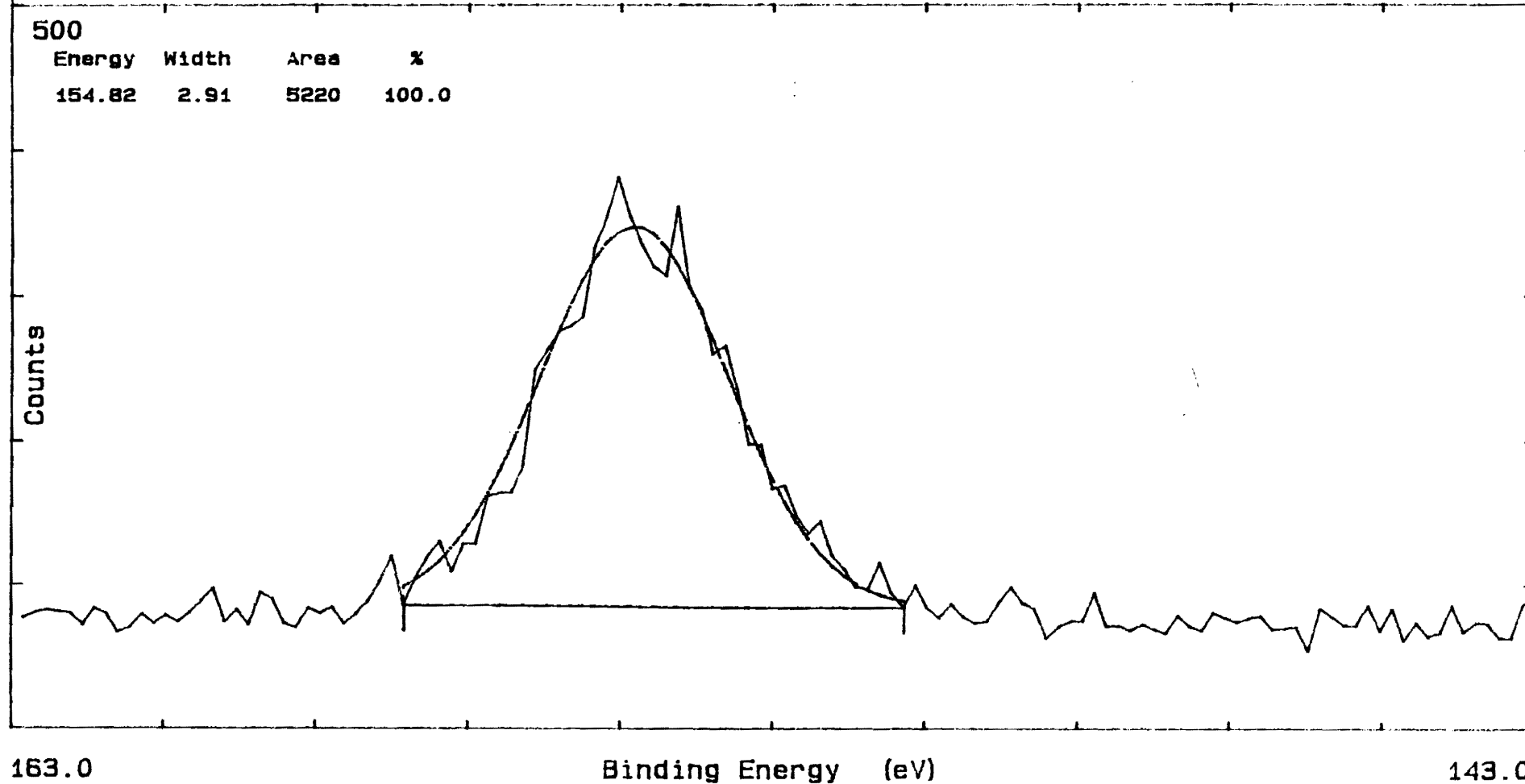


Figure 5

File: LDEF003	Date: 8/24/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-1 EXPOSED PASSIVATED Ti REFLECTOR 1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM			Operator: WBC

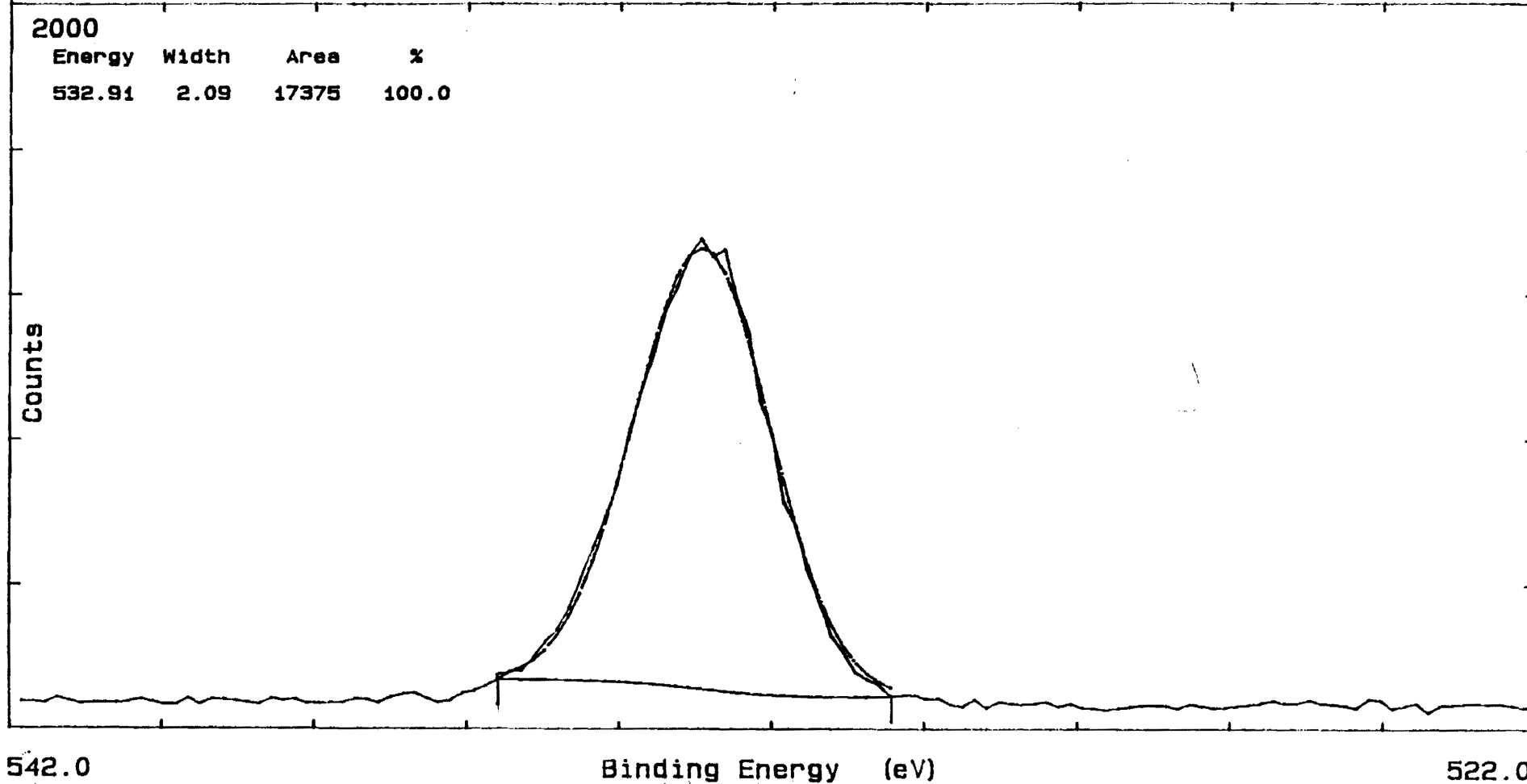


Figure 6

File: LDEF004	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-1	# of Scans: 7	Resolution: 2

Description: IV-1 EXPOSED PASSIVATED Ti REFLECTOR
1/2 RADIUS FROM PERIMETER, Ag 3d SPECTRUM

Operator: TAP

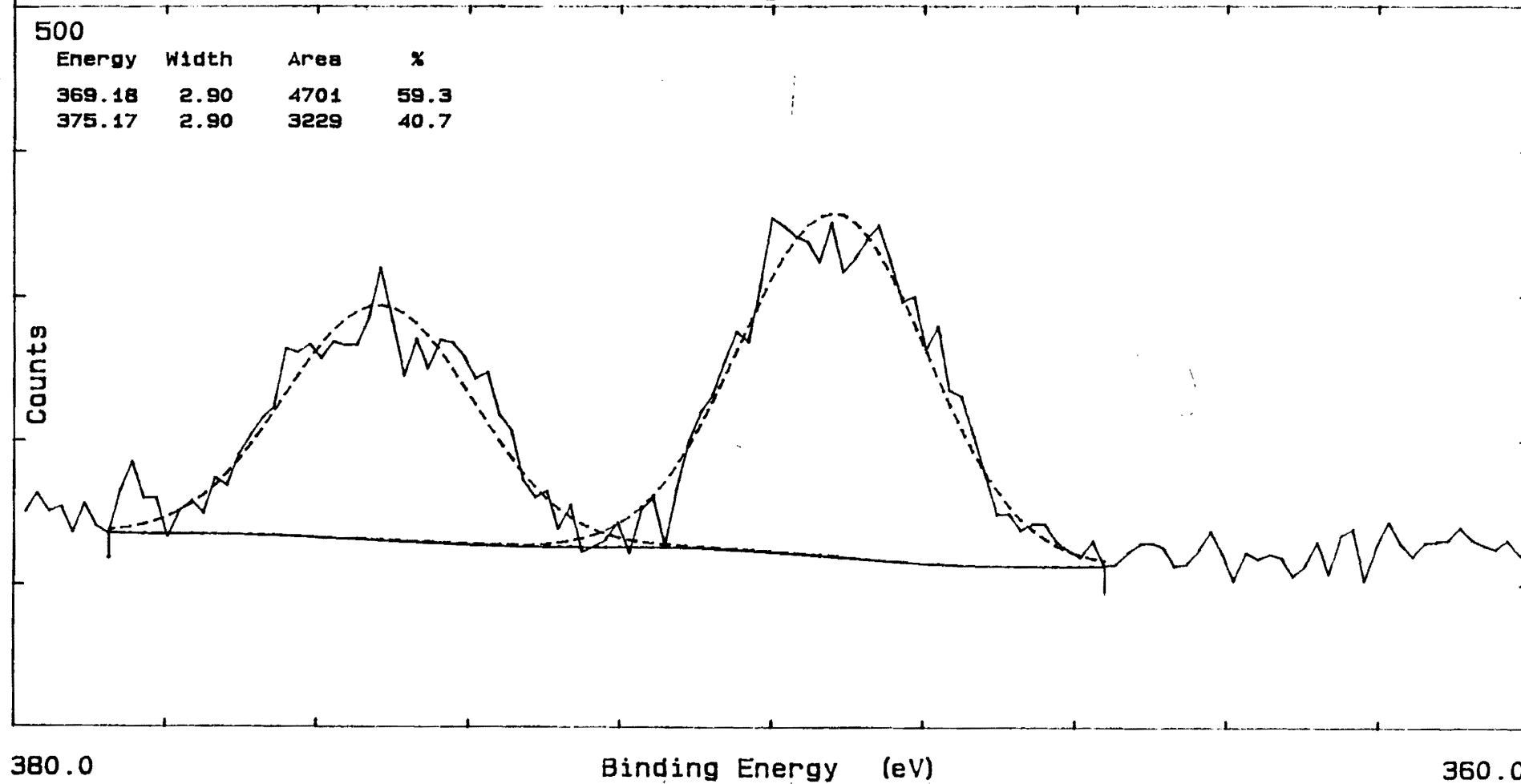


Figure 7

File: LDEF005	Date: 8/25/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
	Disc: LDEF-1	# of Scans: 1	Resolution: 4
Description: IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT CENTER REGION	Operator: TAP		

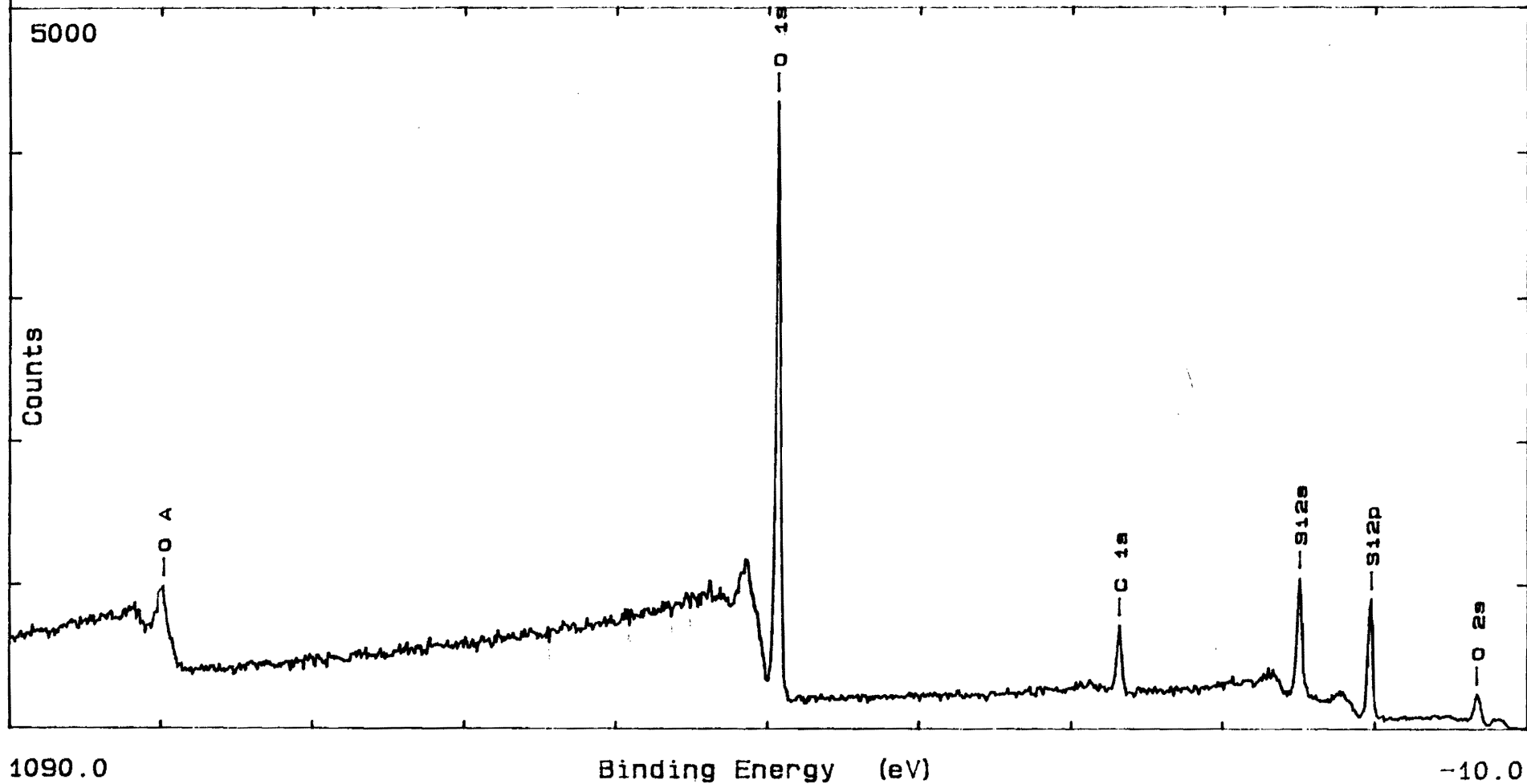


Figure 8

File: LDEF006	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description:	IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT CENTER REGION, Si 2s SPECTRUM		Operator: TAP

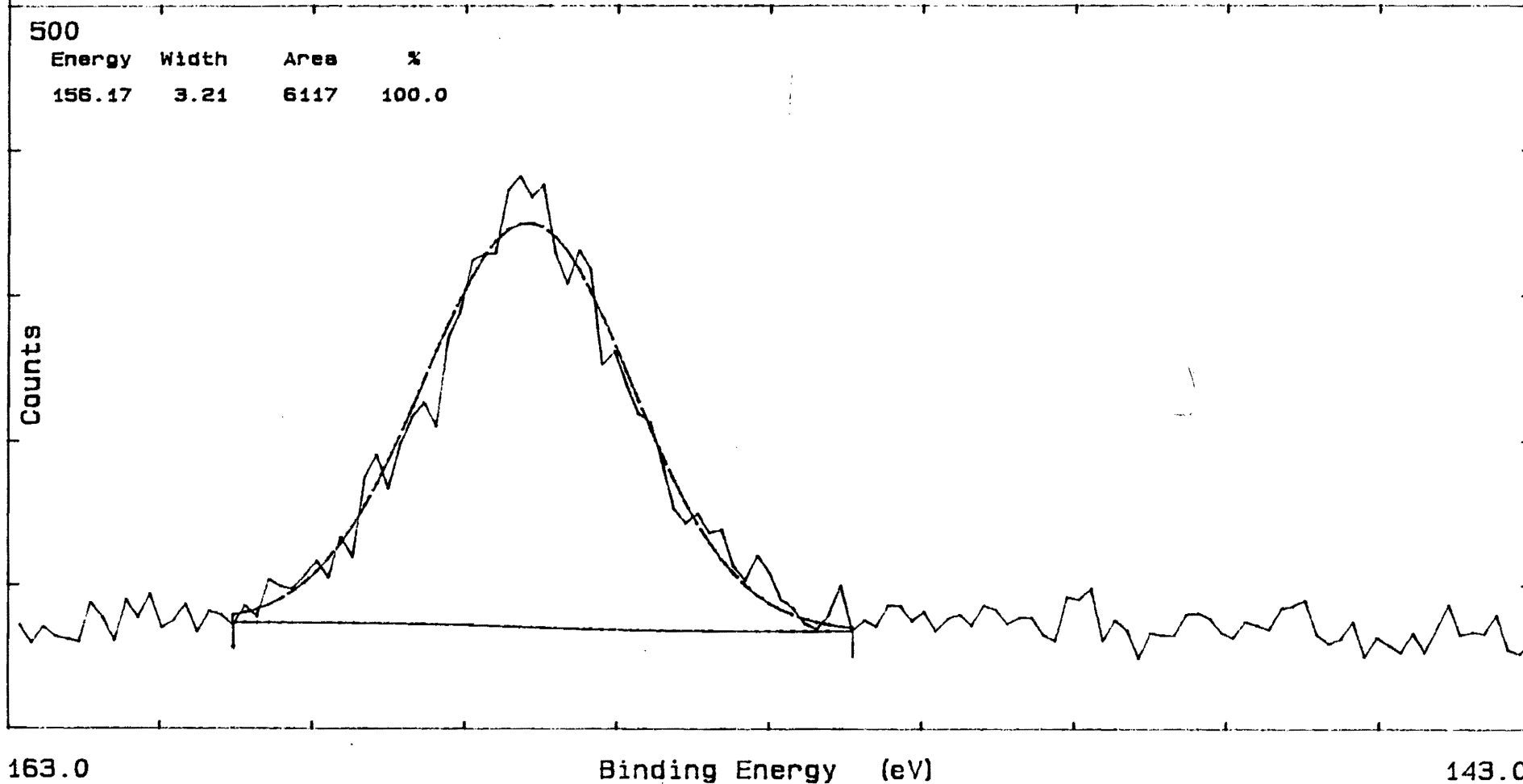


Figure 9

File: LDEF006	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT CENTER REGION, 0 1s SPECTRUM			Operator: TAP

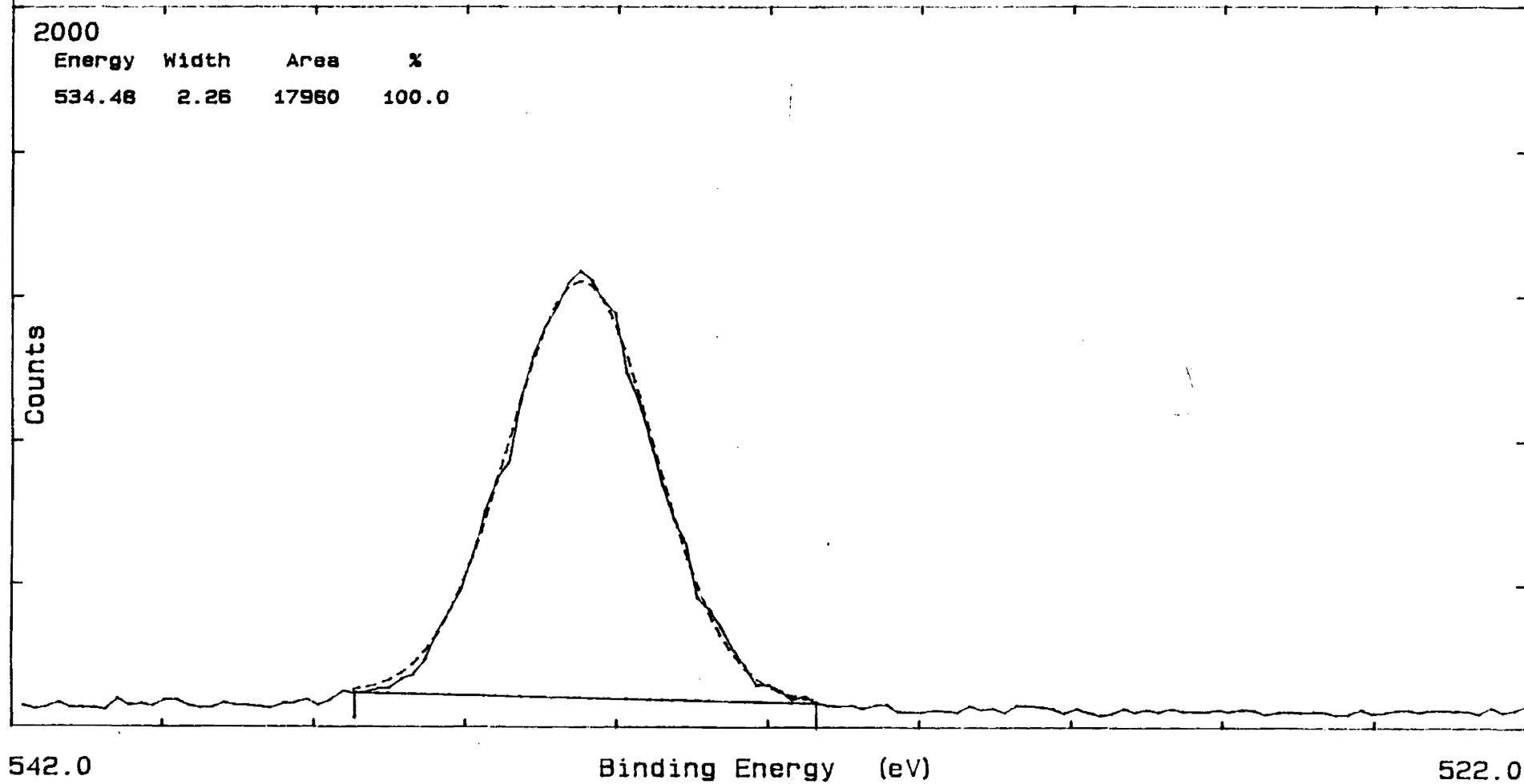


Figure 10

File: LDEF007	Date: 8/25/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 1	Resolution: 4
Description: IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT 1/2 RADIUS FROM PERIMETER			Operator: TAP

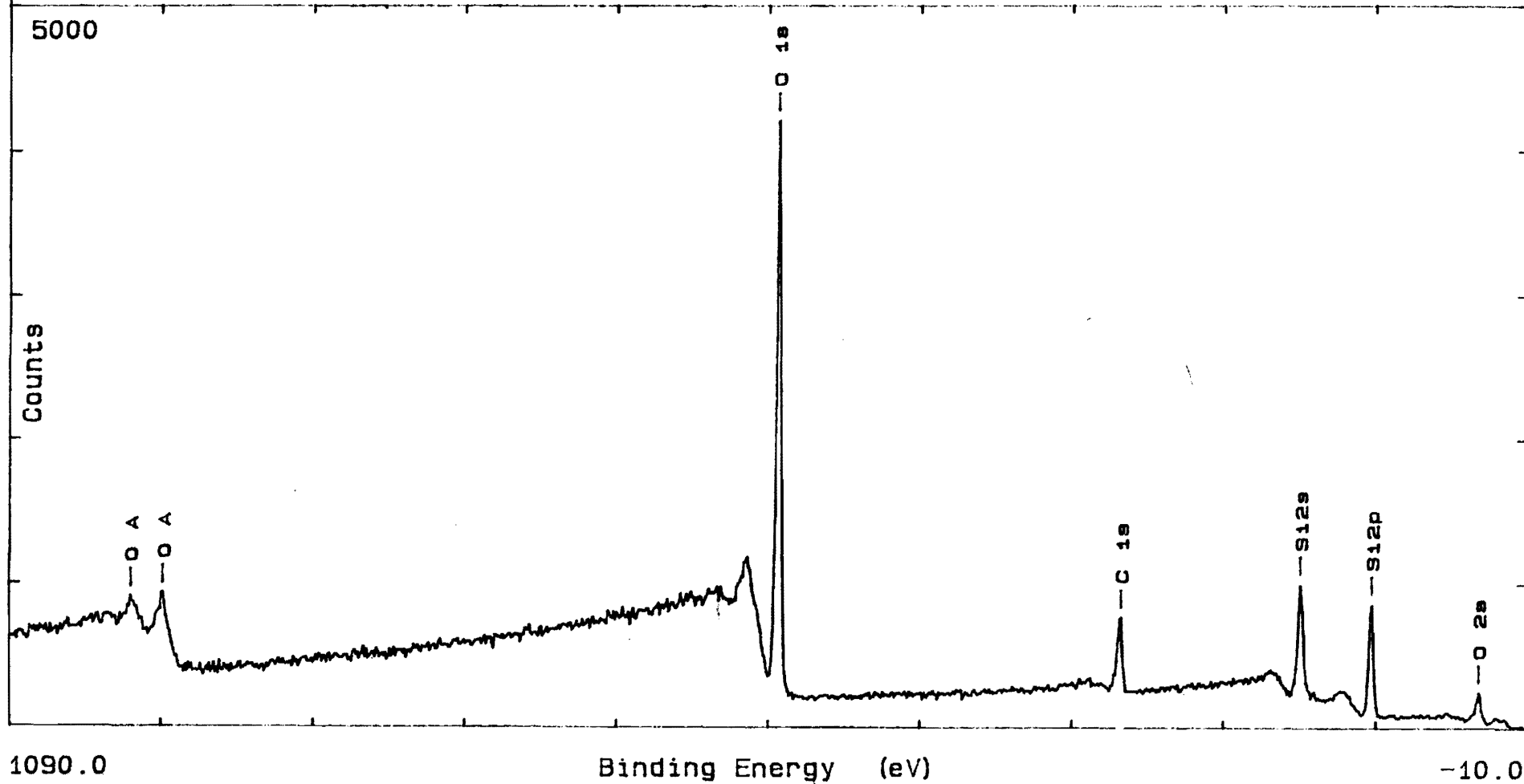


Figure 11

File: LDEF007	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description:	IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT 1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM		Operator: TAP

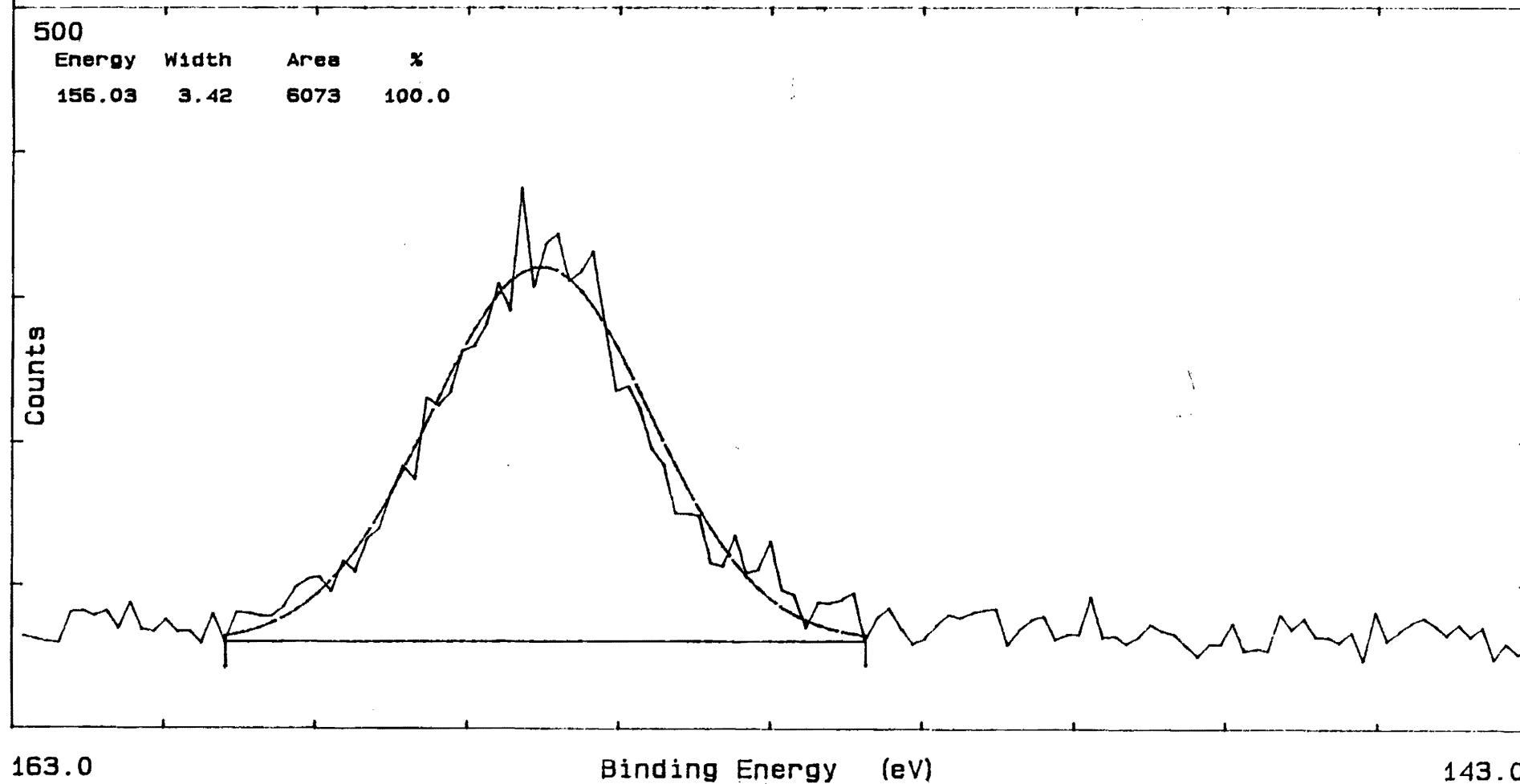


Figure 12

File: LDEF007	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-4 EXPOSED Ti WITH PROTECTIVE OVERCOAT 1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM			Operator: TAP

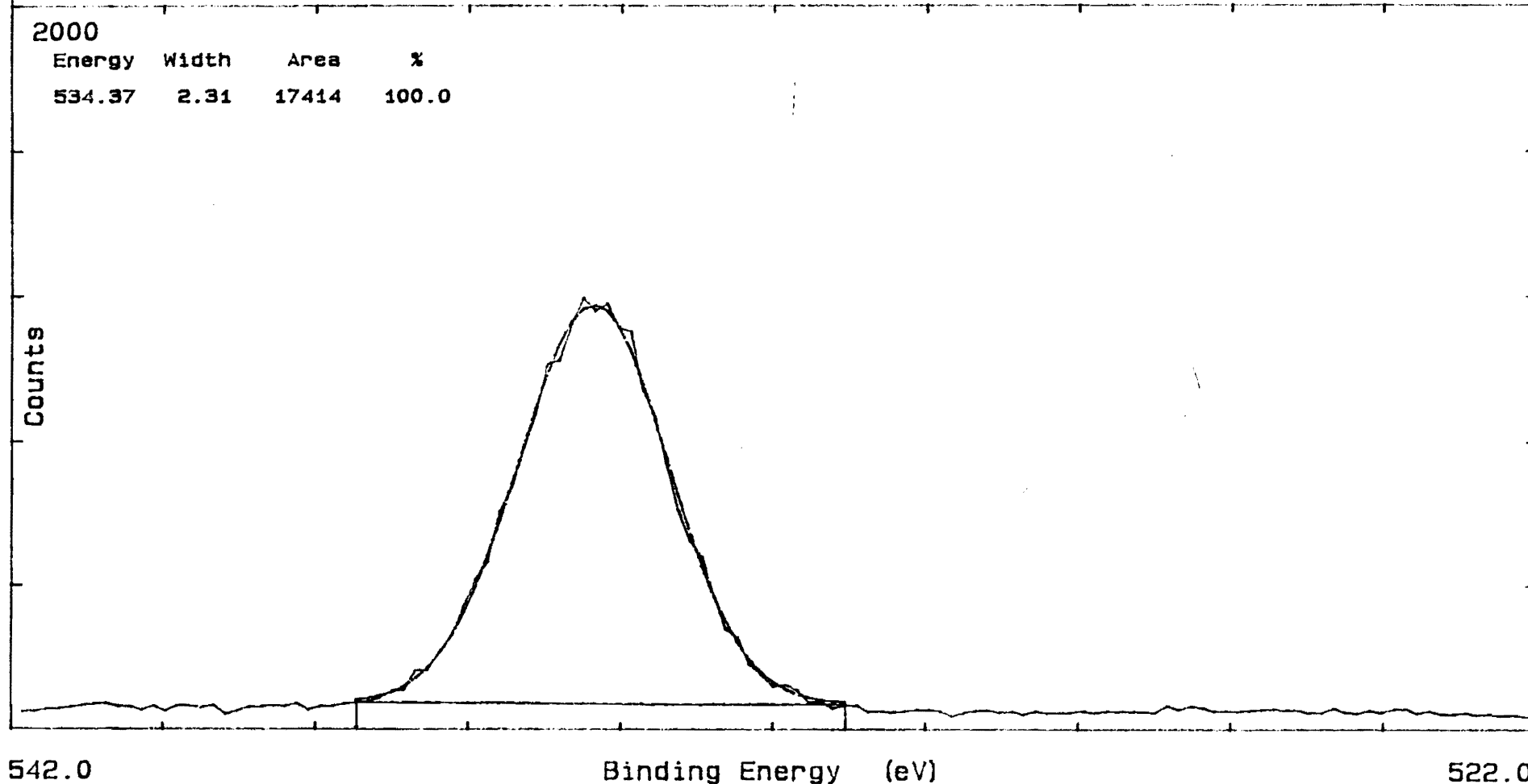


Figure 13

File: LDEF008	Date: 8/25/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
	Disc: LDEF-1	# of Scans: 1	Resolution: 4

Description: IV-5 EXPOSED Ti. PASSIVATED
CENTER REGION

Operator: WBC

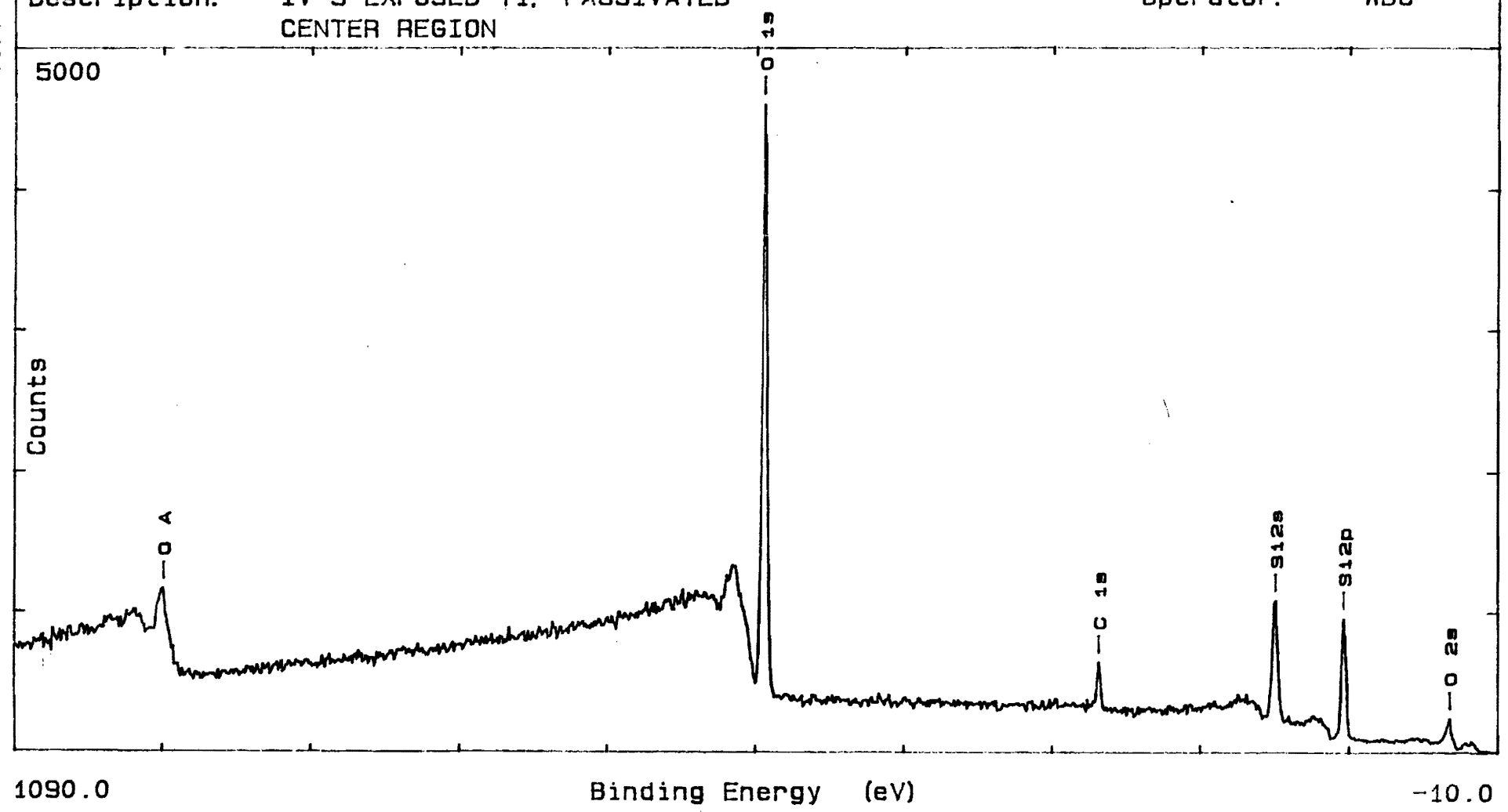


Figure 14

File: LDEF009	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-5 EXPOSED Ti, PASSIVATED CENTER REGION, Si 2s SPECTRUM			Operator: TAP

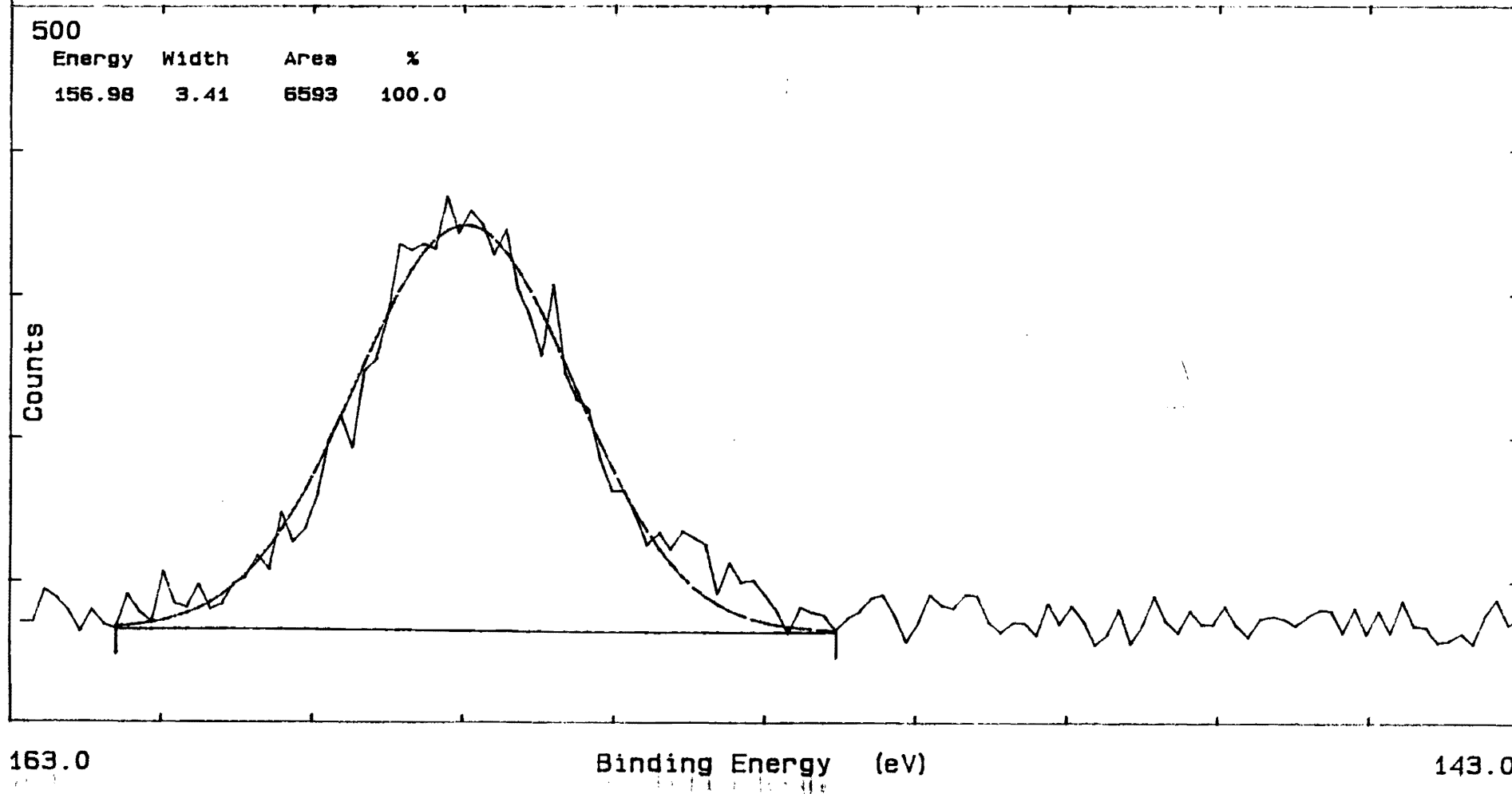


Figure 15

File: LDEF009	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-5 EXPOSED Ti, PASSIVATED CENTER REGION, O 1s SPECTRUM			Operator: TAP

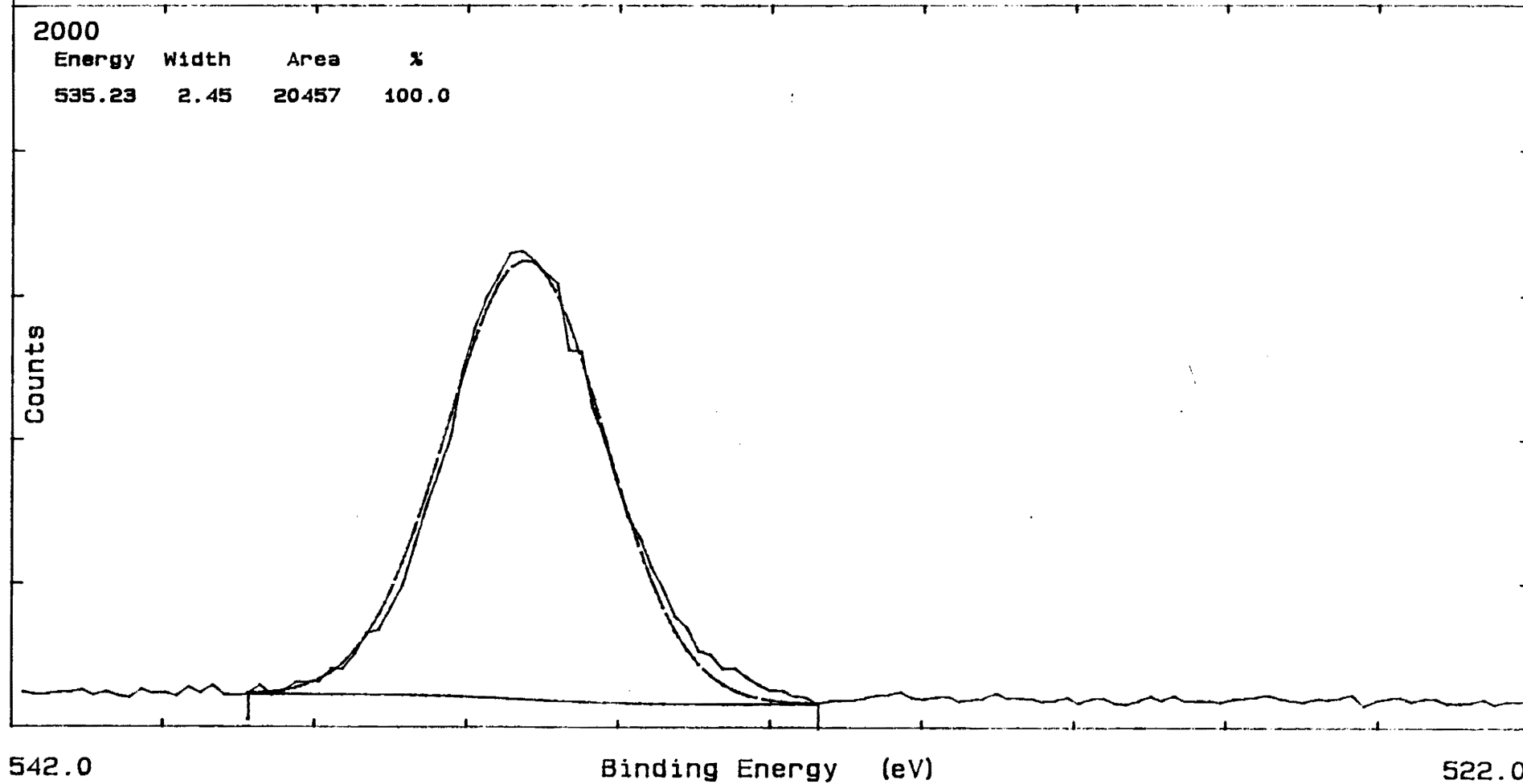


Figure 16

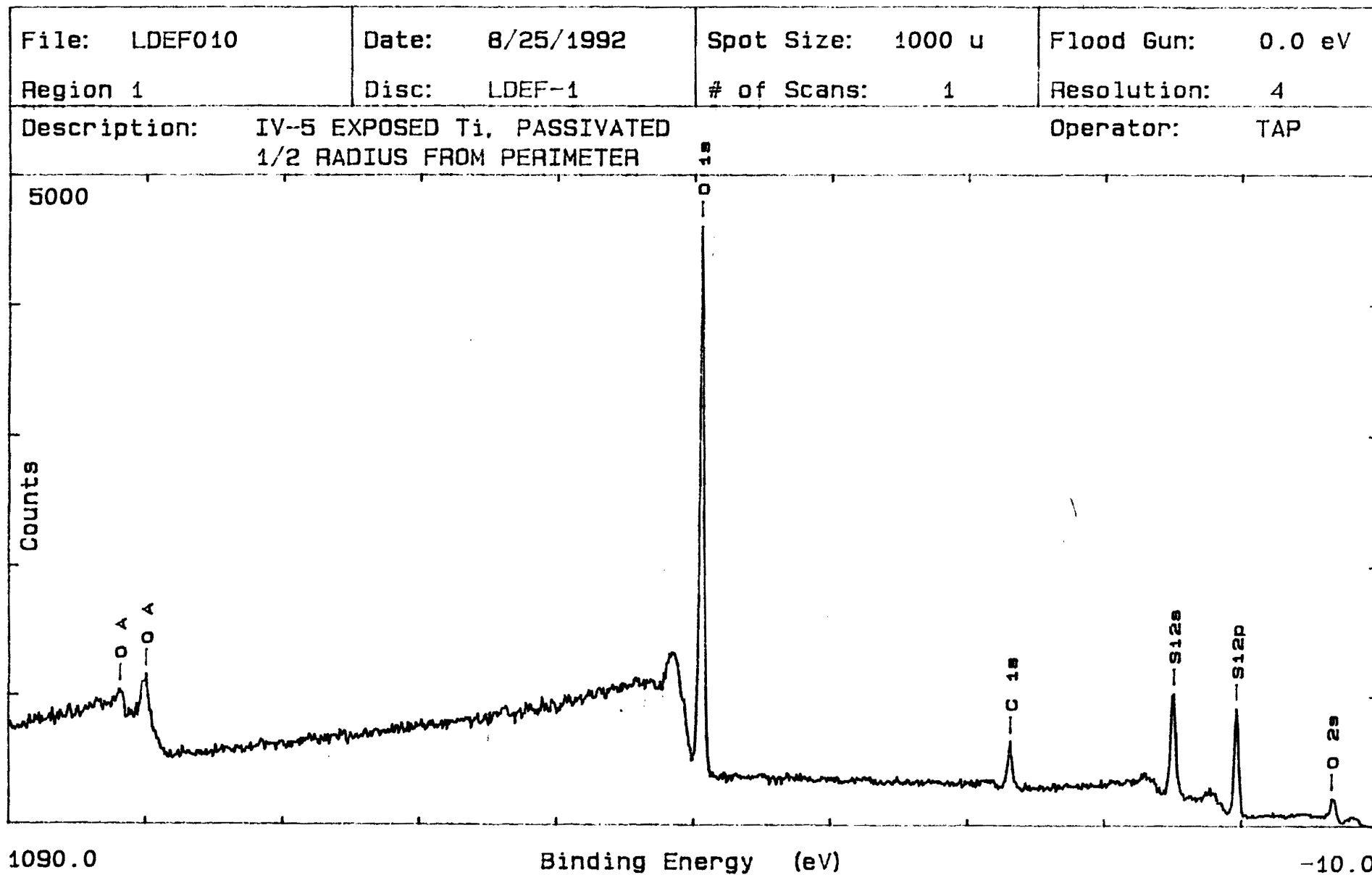


Figure 17

File: LDEF010	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description:	IV-5 EXPOSED Ti, PASSIVATED 1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM		Operator: TAP

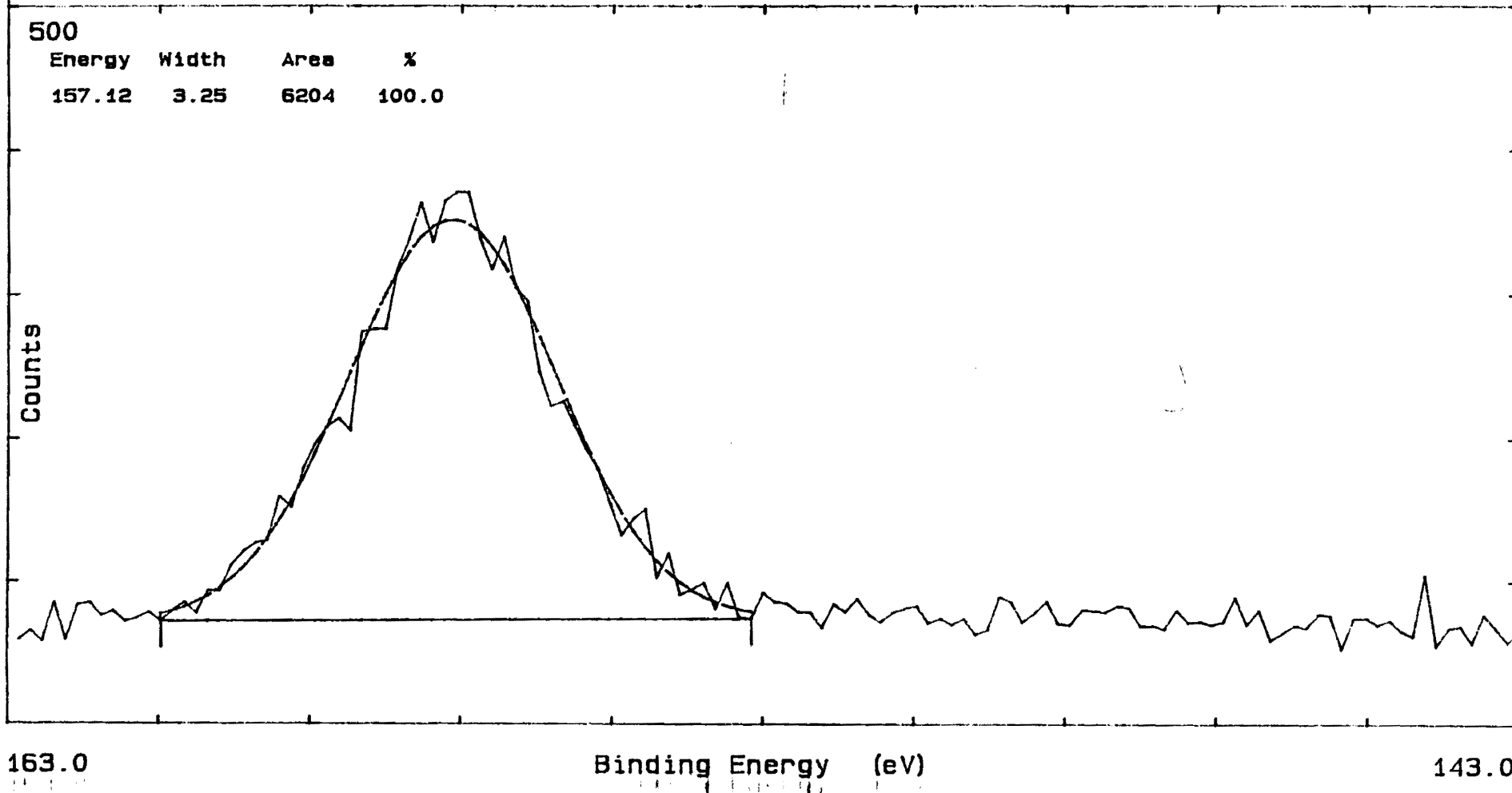


Figure 18

File: LDEF010	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-5 EXPOSED Ti. PASSIVATED 1/2 RADIUS FROM PERIMETER. 0 1s SPECTRUM			Operator: TAP

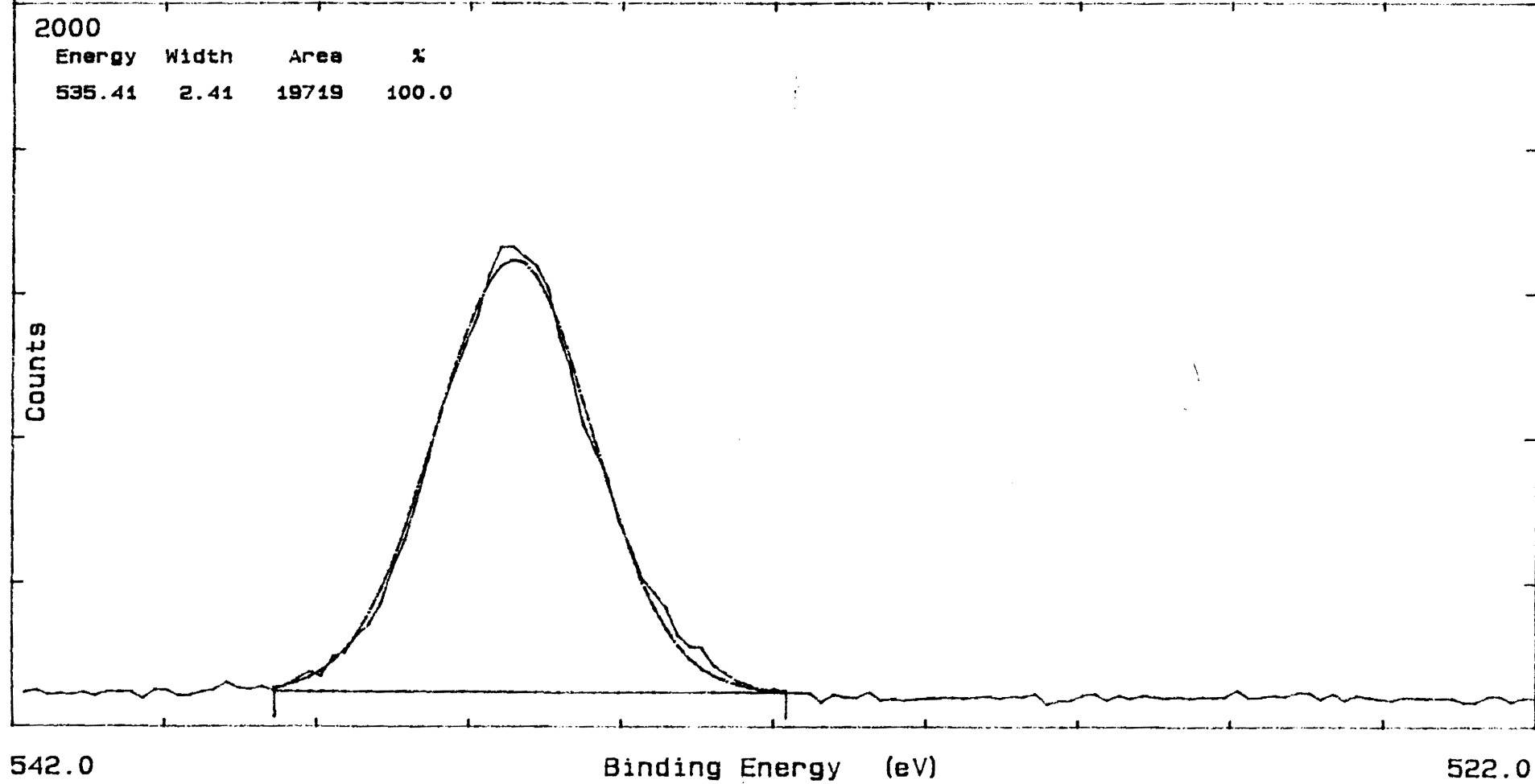


Figure 19

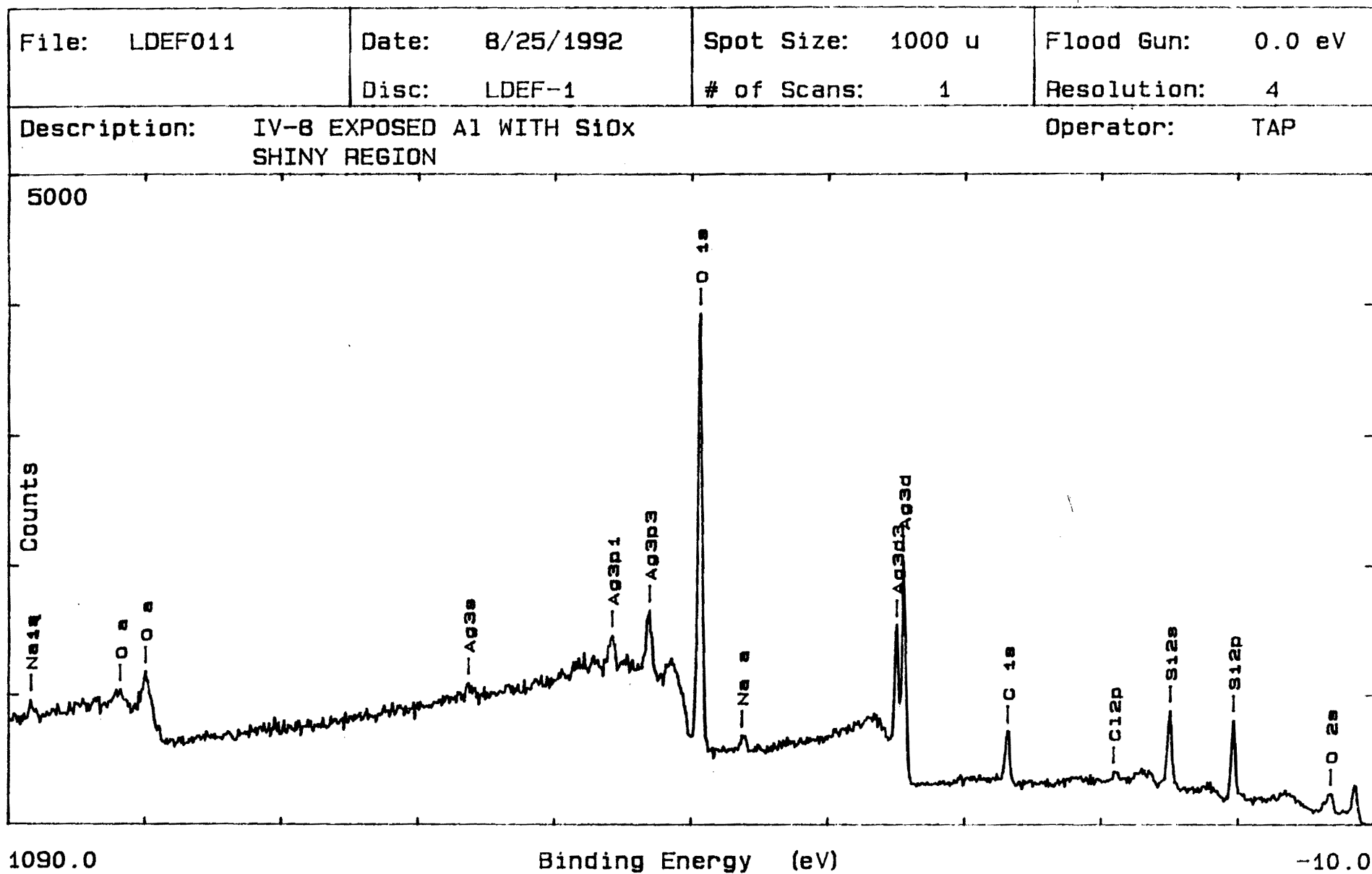


Figure 20

File: LDEF012	Date: 8/25/1992	Spot Size: 300 μ	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-8 EXPOSED Al, SiO _x SHINY REGION, Si 2s SPECTRUM			Operator: TAP

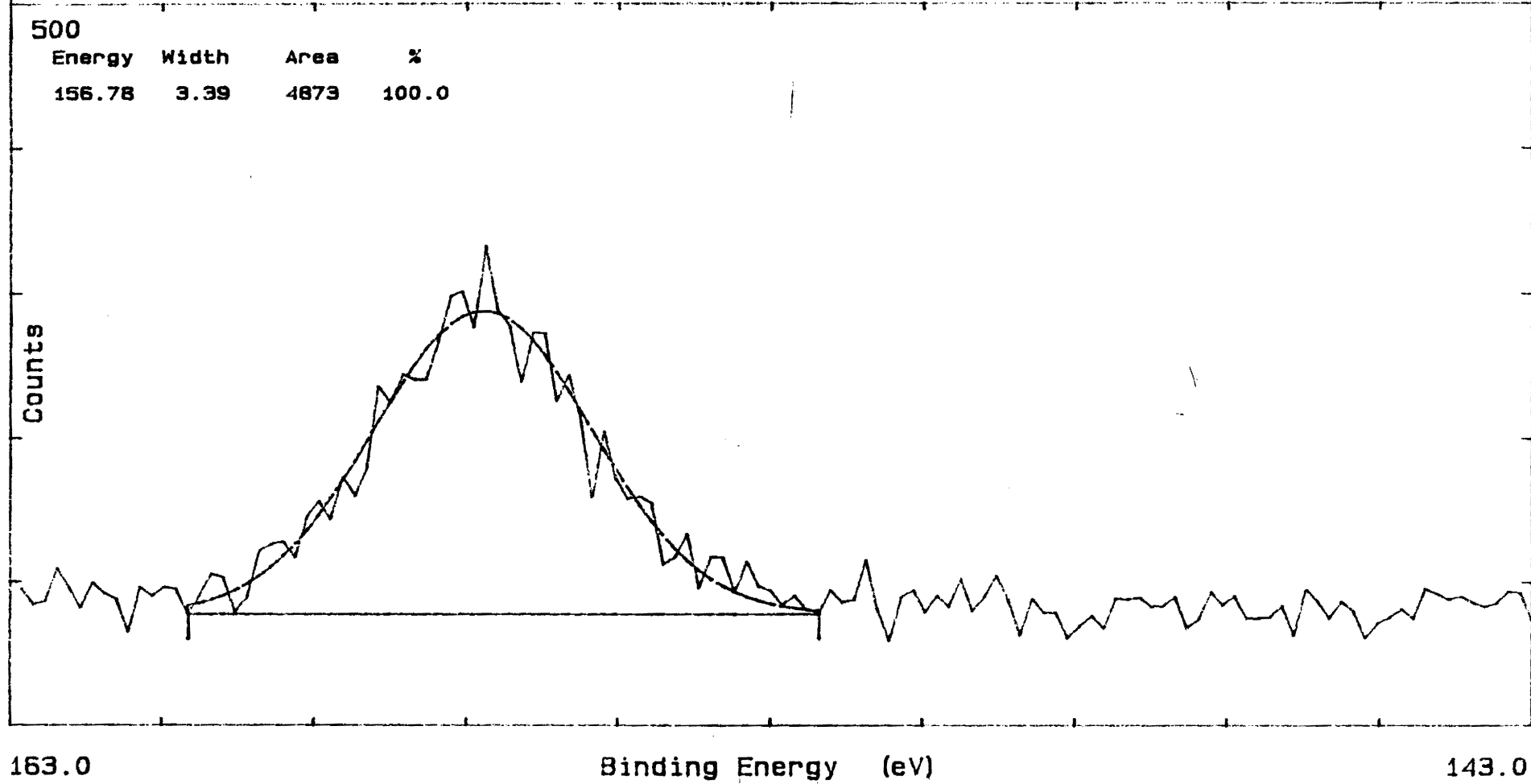


Figure 21

File: LDEF012	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-8 EXPOSED Al. SiO _x SHINY REGION, O 1s SPECTRUM			Operator: TAP

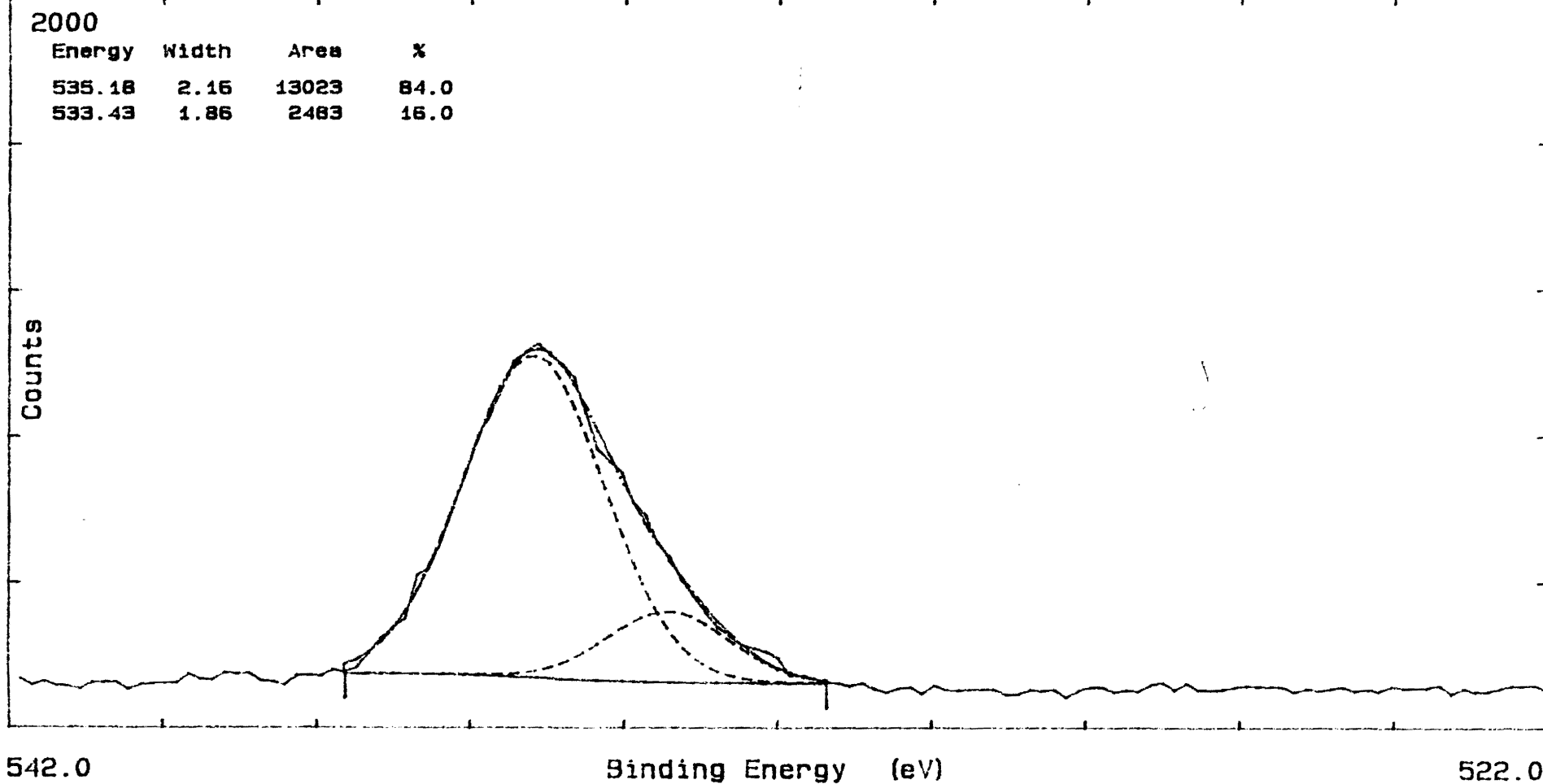


Figure 22

File: LDEF012

Date: 8/25/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 3

Disc: LDEF-1

of Scans: 4

Resolution: 2

Description: IV-8 EXPOSED Al, SiO_x
SHINY REGION, Ag 3d SPECTRUM

Operator: TAP

1000

Energy	Width	Area	%
370.99	2.29	7774	58.7
376.98	2.23	5462	41.3

Counts

Binding Energy (eV)

380.0

360.0

Figure 23

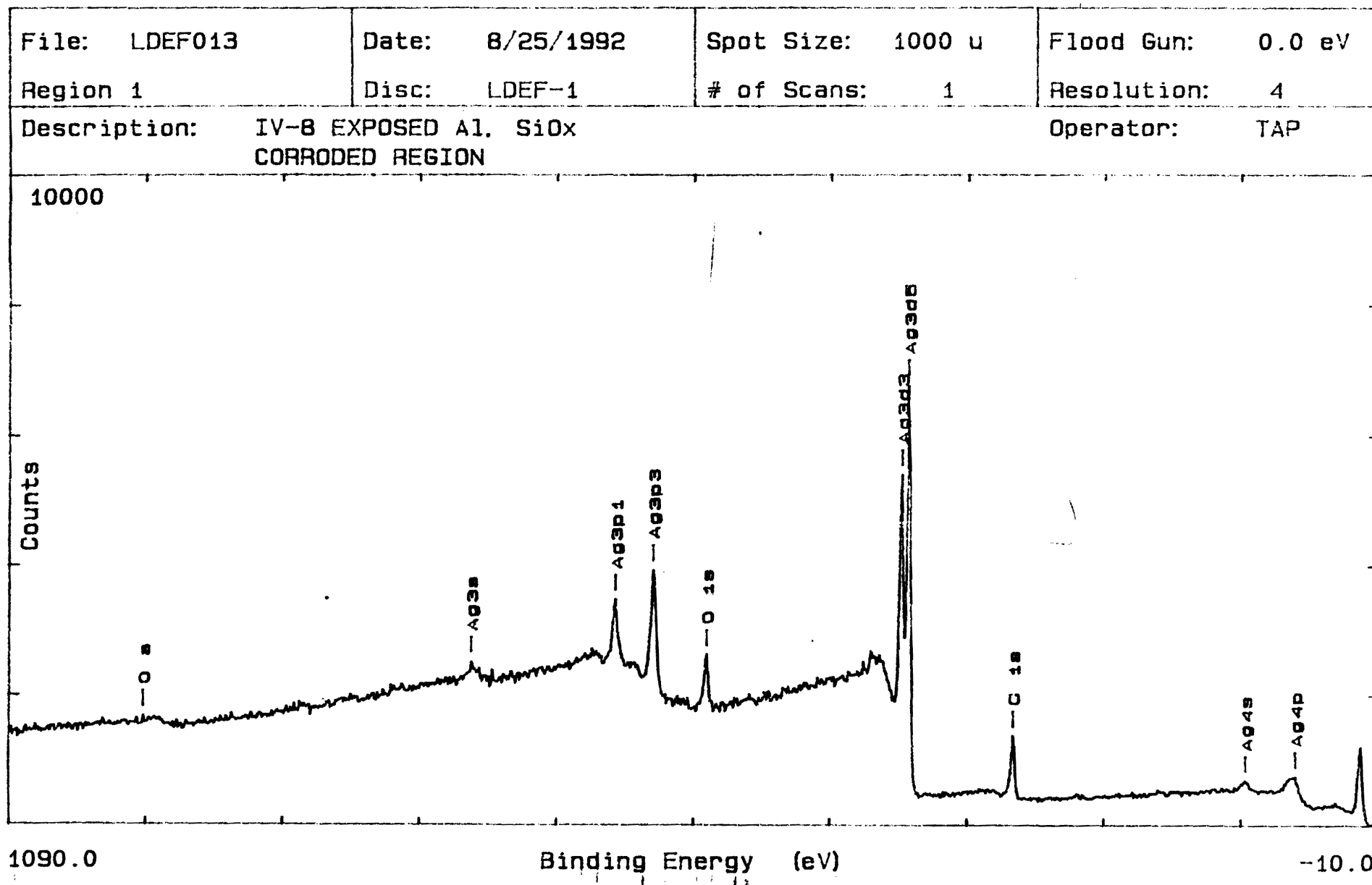


Figure 24

File: LDEF013	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-8 EXPOSED Al, SiO _x CORRODED REGION, 0 1s SPECTRUM	Operator: TAP		

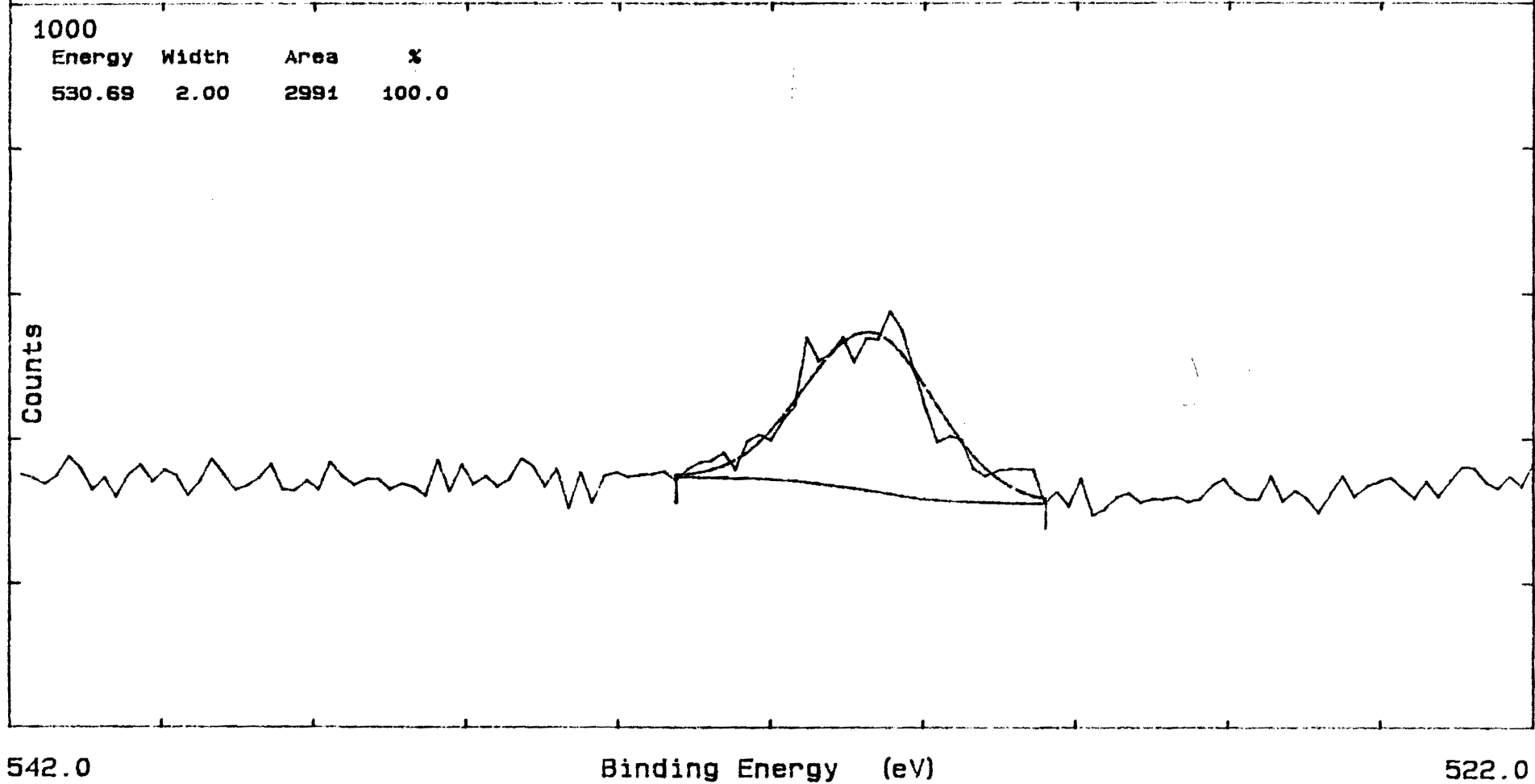


Figure 25

File: LDEF013	Date: 8/25/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 4	Disc: LDEF-1	# of Scans: 4	Resolution: 2
Description: IV-8 EXPOSED Al, SiOx CORRODED REGION, Ag 3d SPECTRUM			Operator: TAP

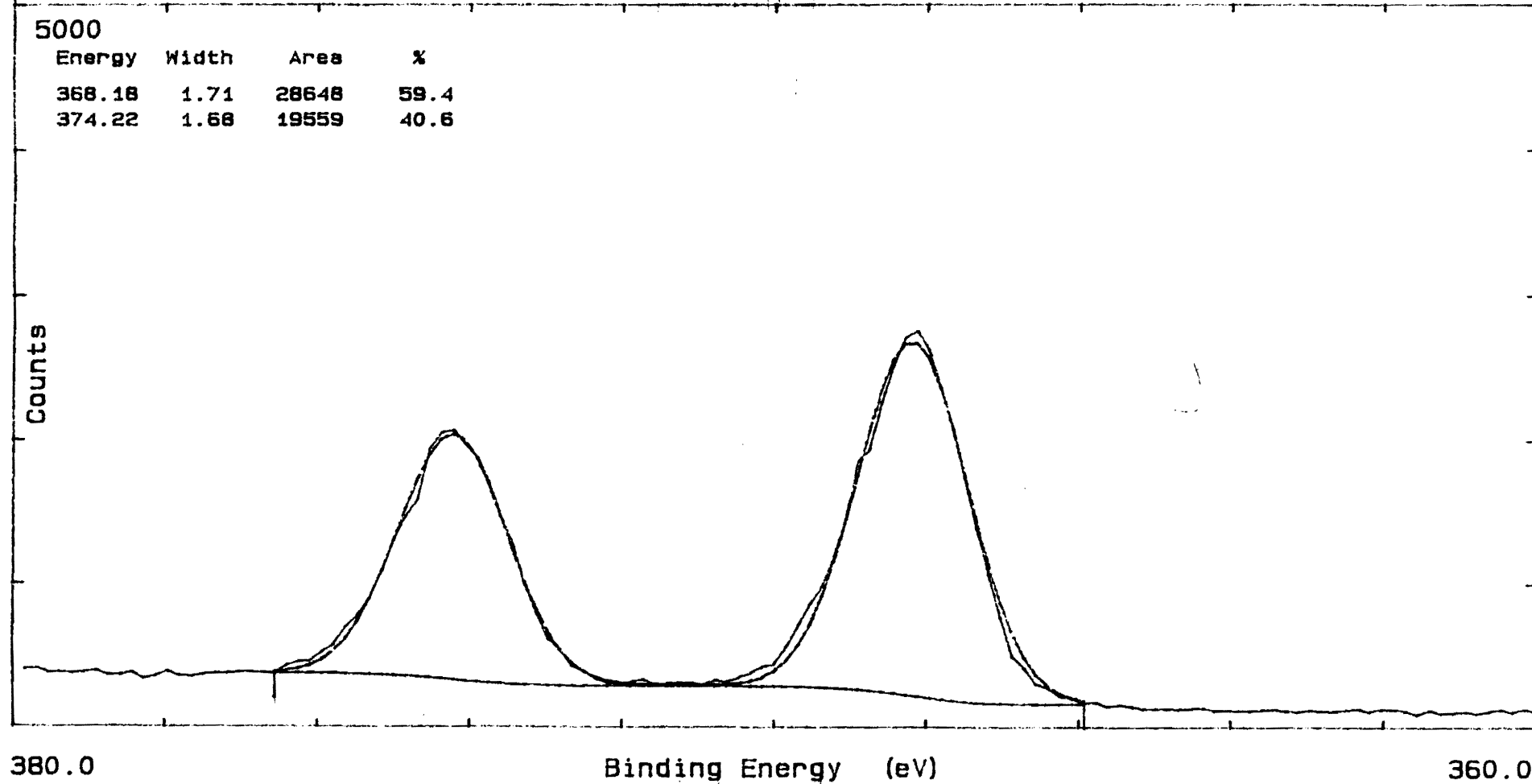


Figure 26

File: LDEF021	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-1	# of Scans: 10	Resolution: 2

Description: IV-8 EXPOSED Al, SiO_x
2nd CORRODED REGION, C 1s SPECTRUM

Operator: TAP

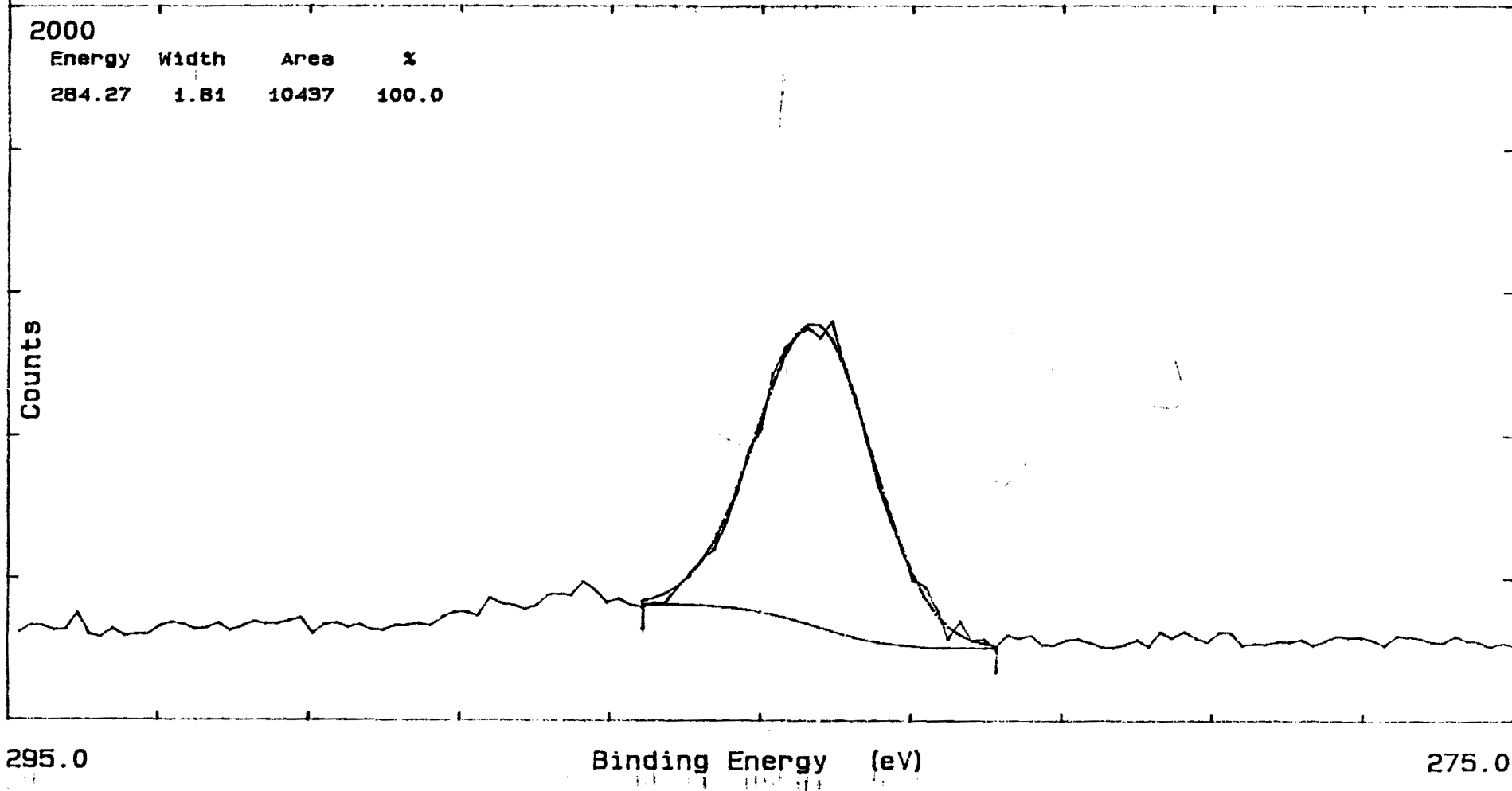


Figure 27

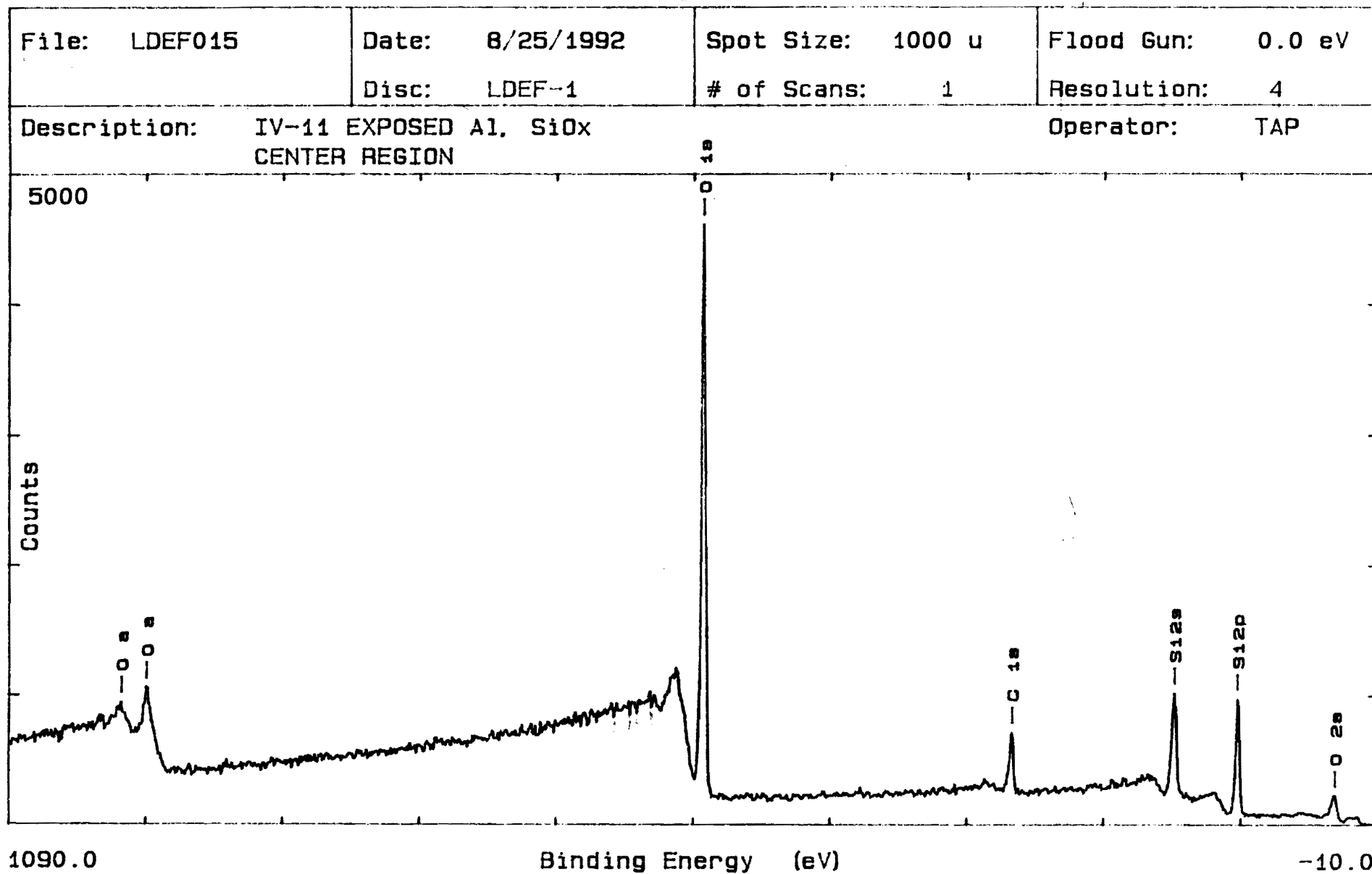


Figure 28

File: LDEF016	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-11 EXPOSED Al, SiO _x CENTER REGION, Si 2s SPECTRUM			Operator: TAP

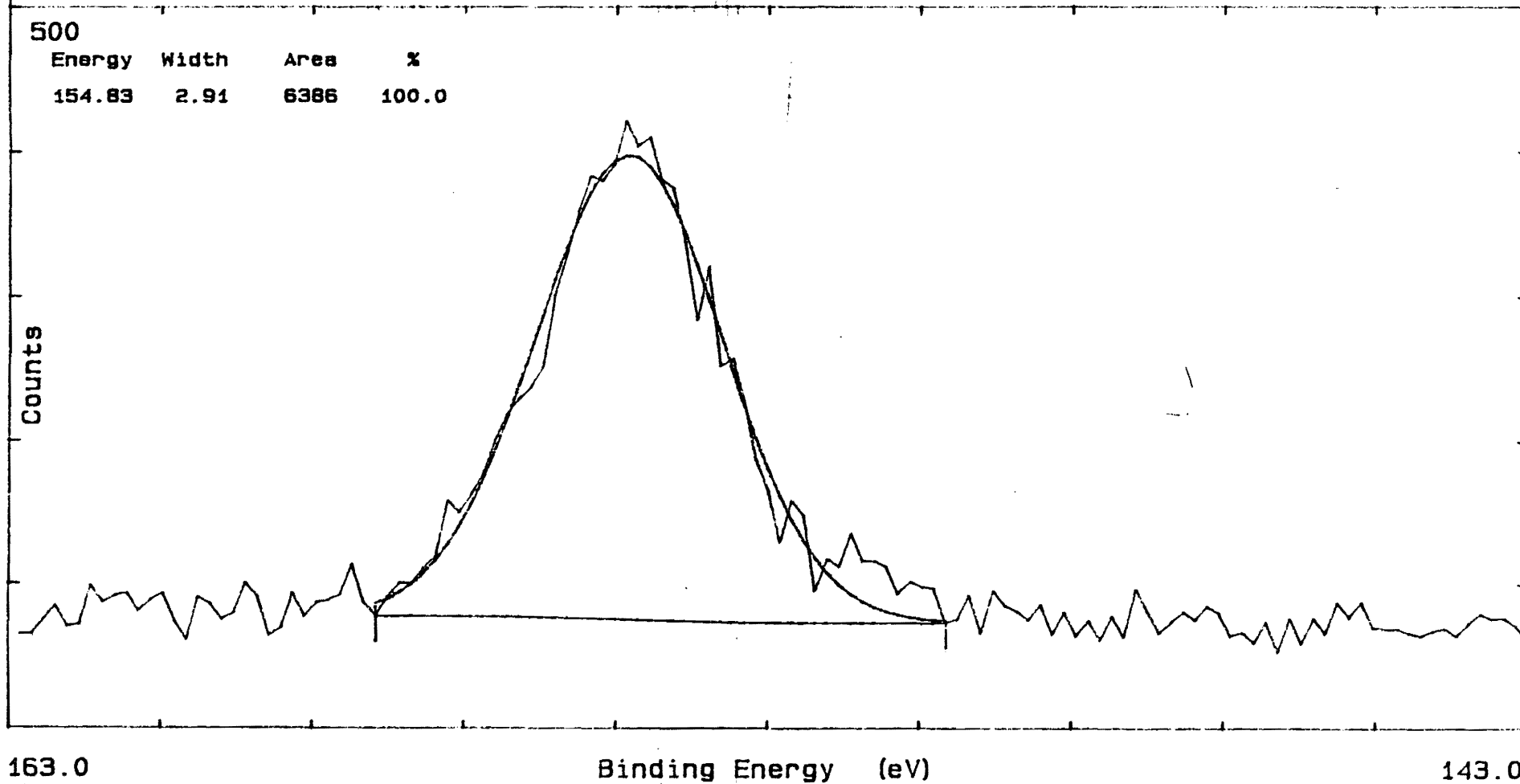


Figure 29

File: LDEF016	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-11 EXPOSED Al, SiO _x CENTER REGION, O 1s SPECTRUM			Operator: TAP

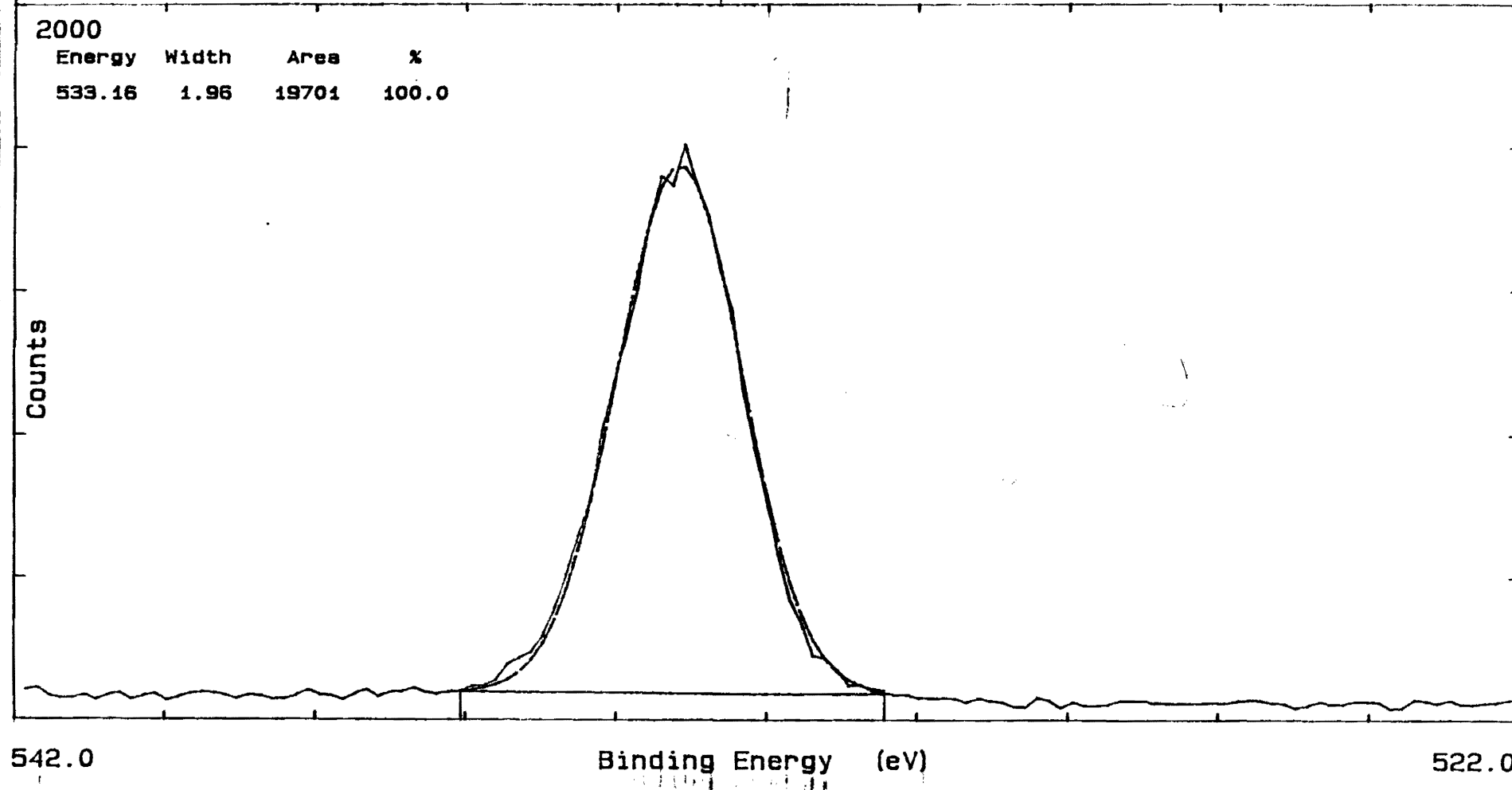


Figure 30

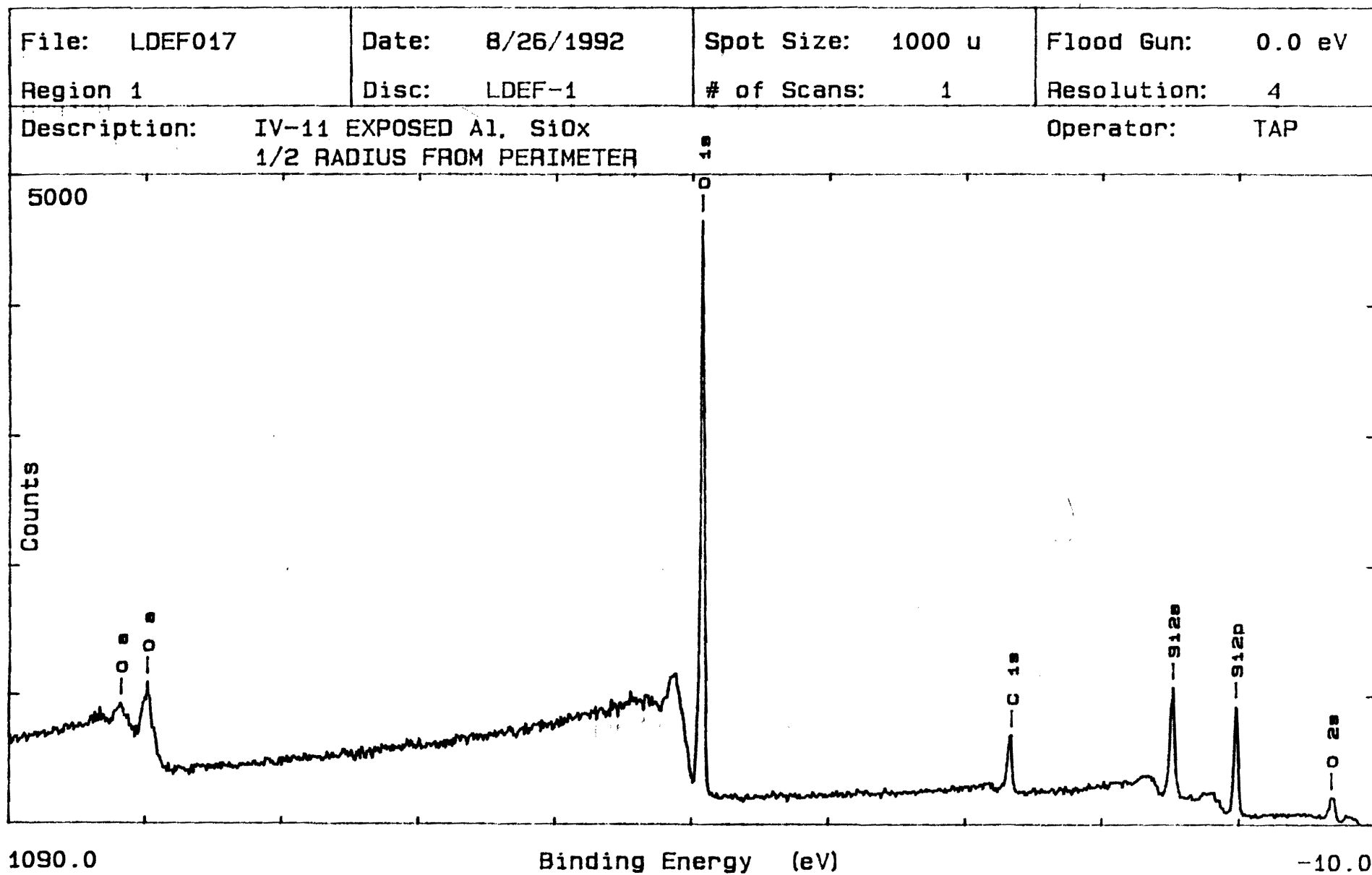


Figure 31

File: LDEF017	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 5	Resolution: 2

Description: IV-11 EXPOSED Al, SiO_x
1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM

Operator: TAP

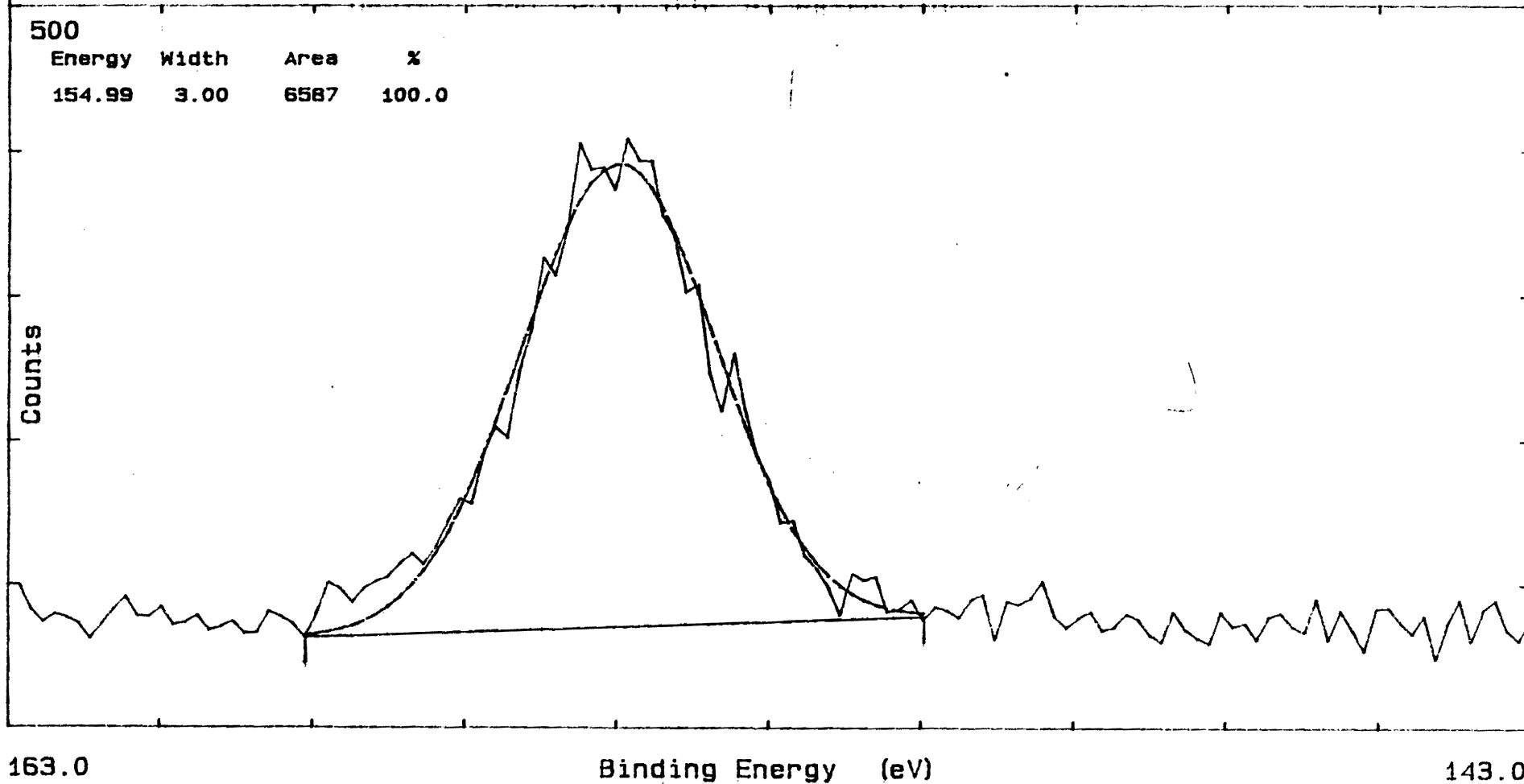


Figure 32

File: LDEF017	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-11 EXPOSED Al. SiO _x 1/2 RADIUS FROM PERIMETER, O 1s SPECTRUM			Operator: TAP

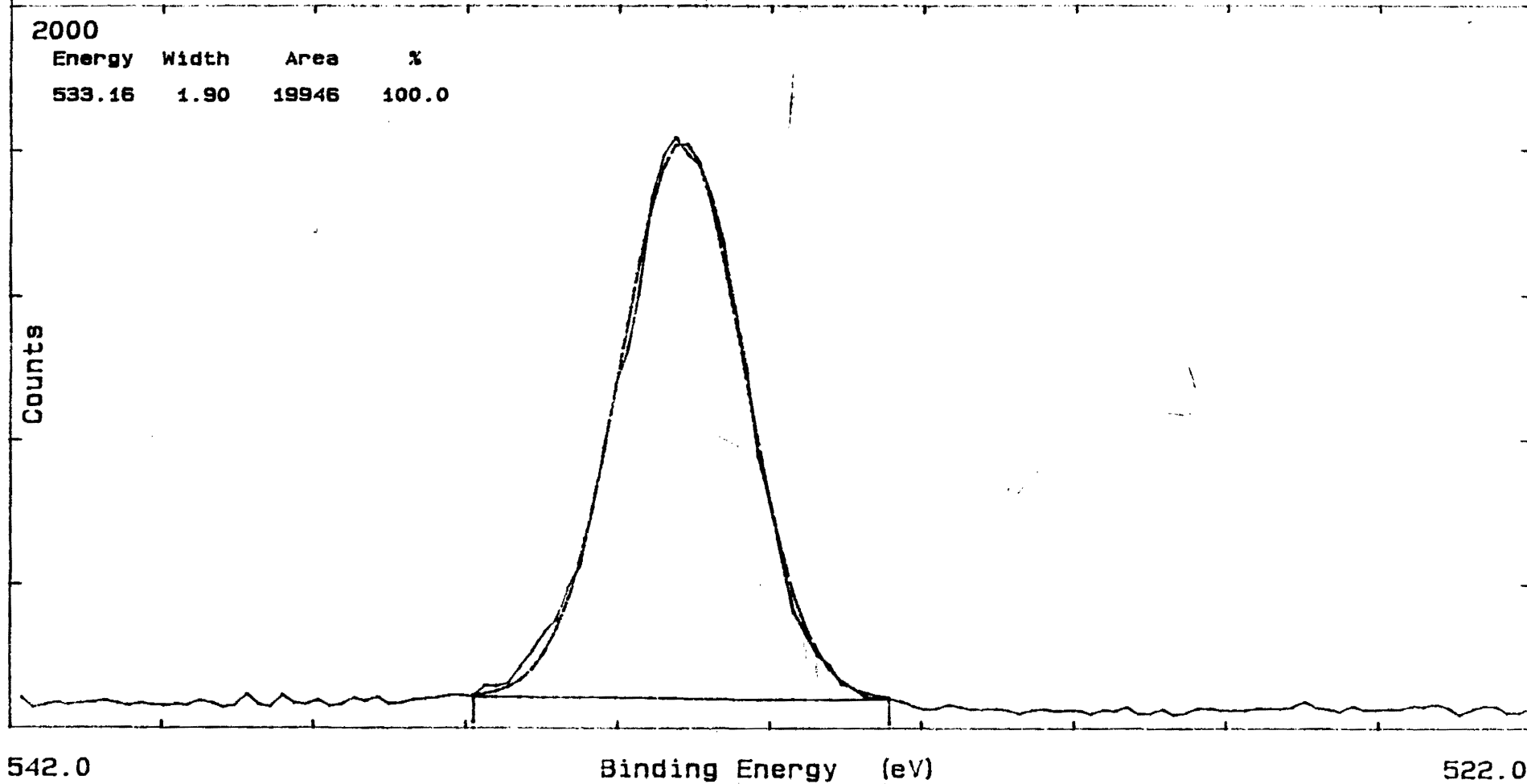


Figure 33

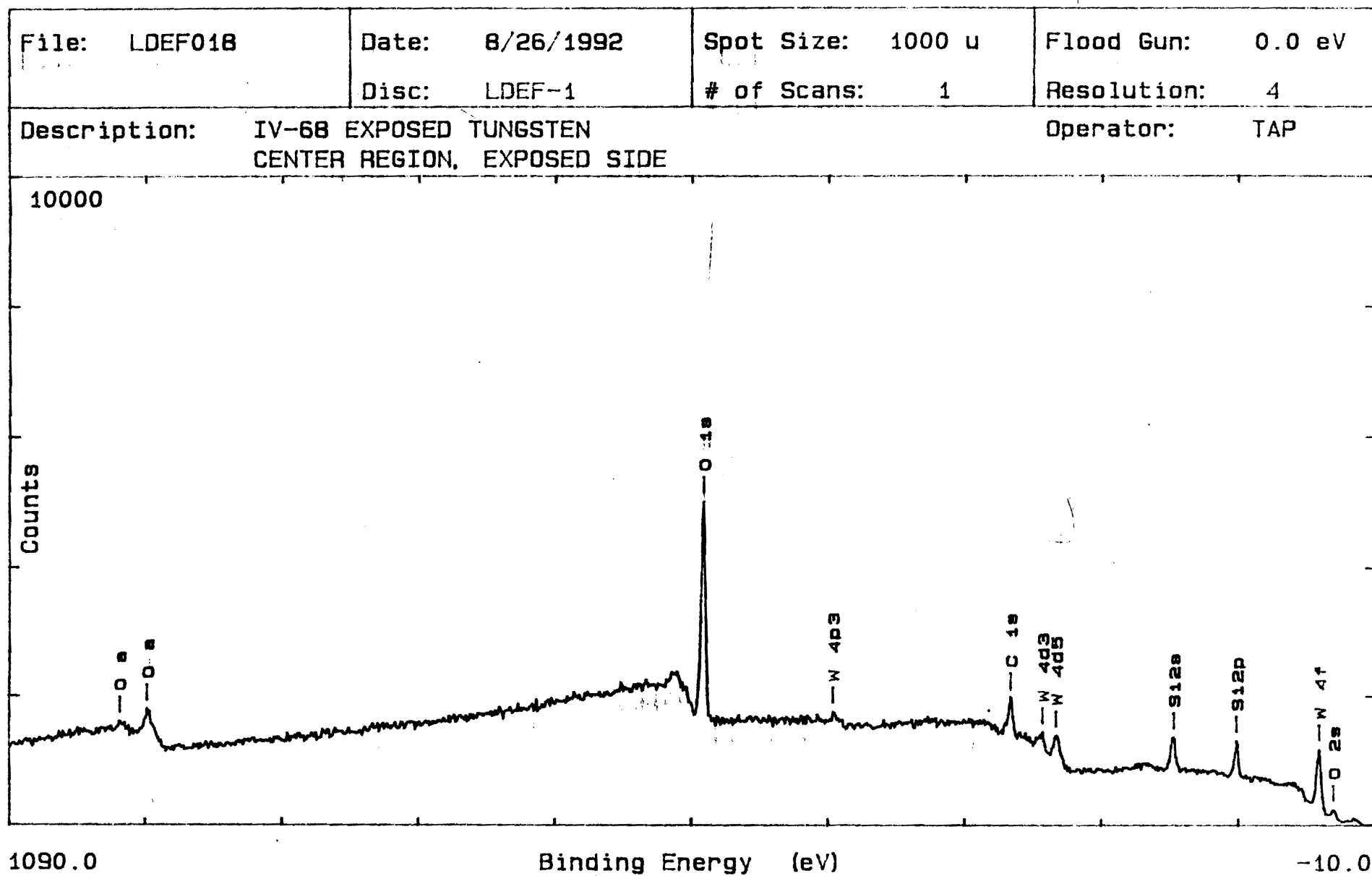


Figure 34

File: LDEF019	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-68 EXPOSED TUNGSTEN CENTER REGION, Si 2s SPECTRUM			Operator: TAP

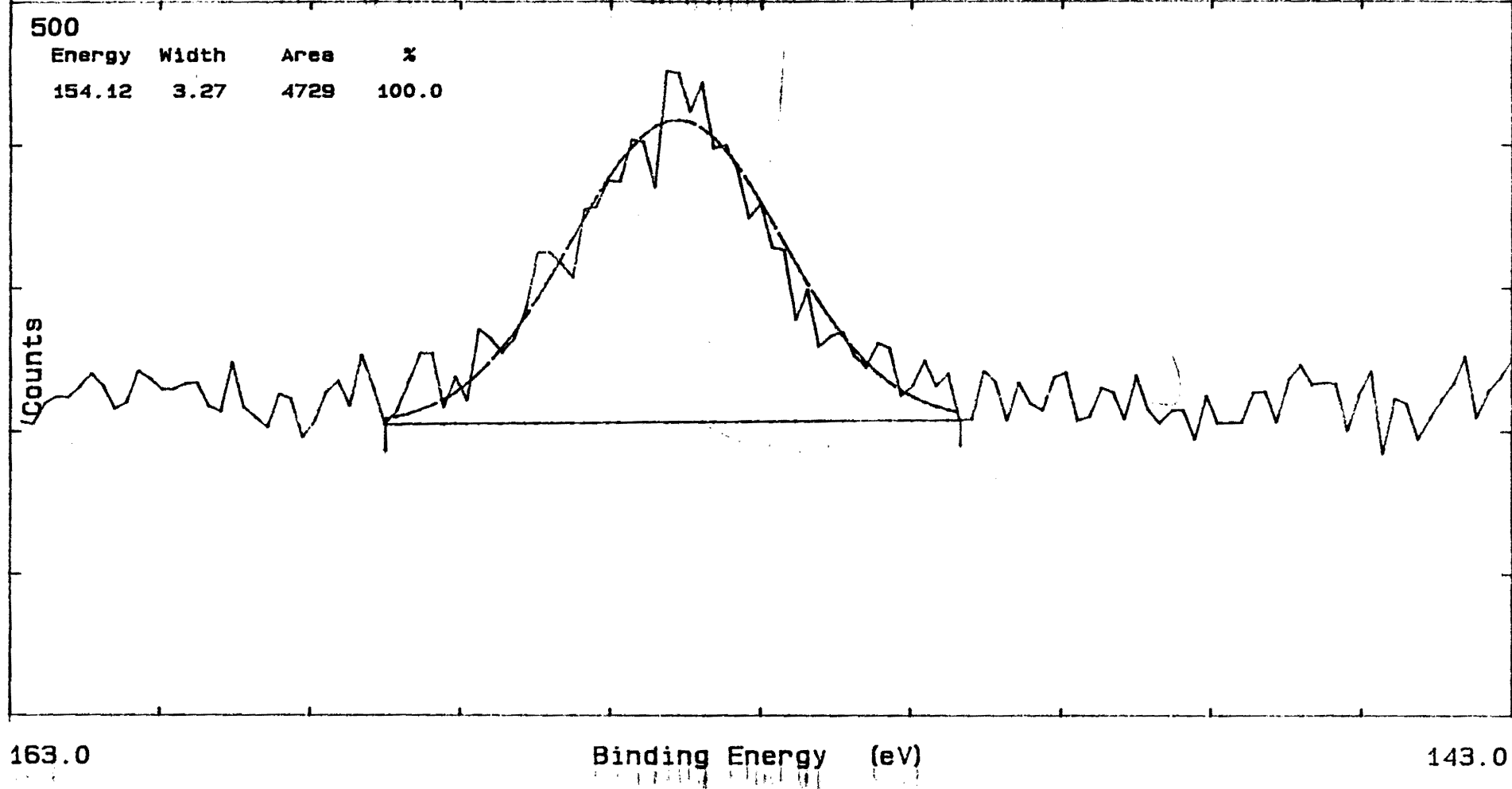


Figure 35

File: LDEF019	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-68 EXPOSED TUNGSTEN CENTER REGION, O 1s SPECTRUM			Operator: TAP

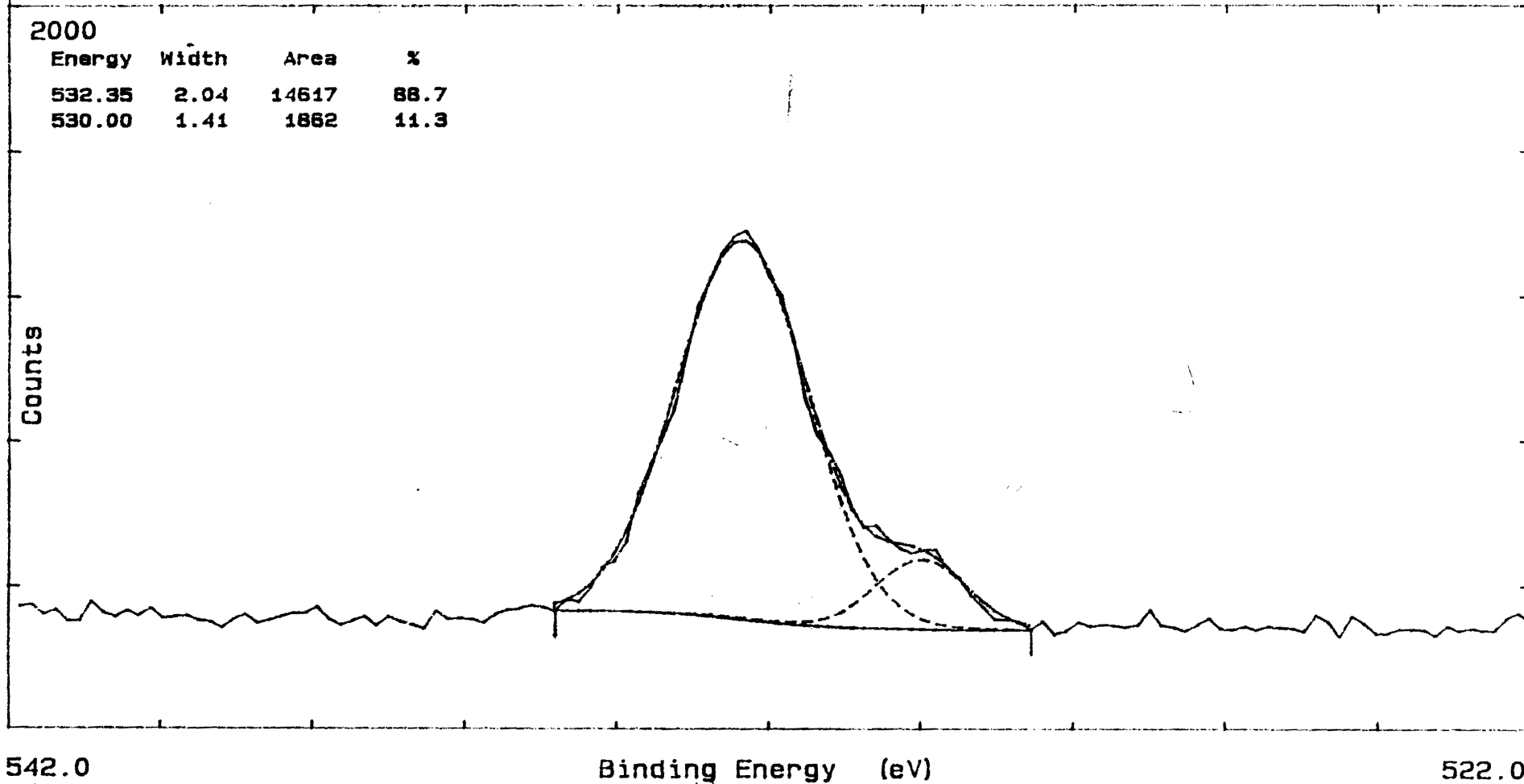


Figure 36

File: LDEF019	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-68 EXPOSED TUNGSTEN CENTER REGION, W 4f SPECTRUM			Operator: TAP

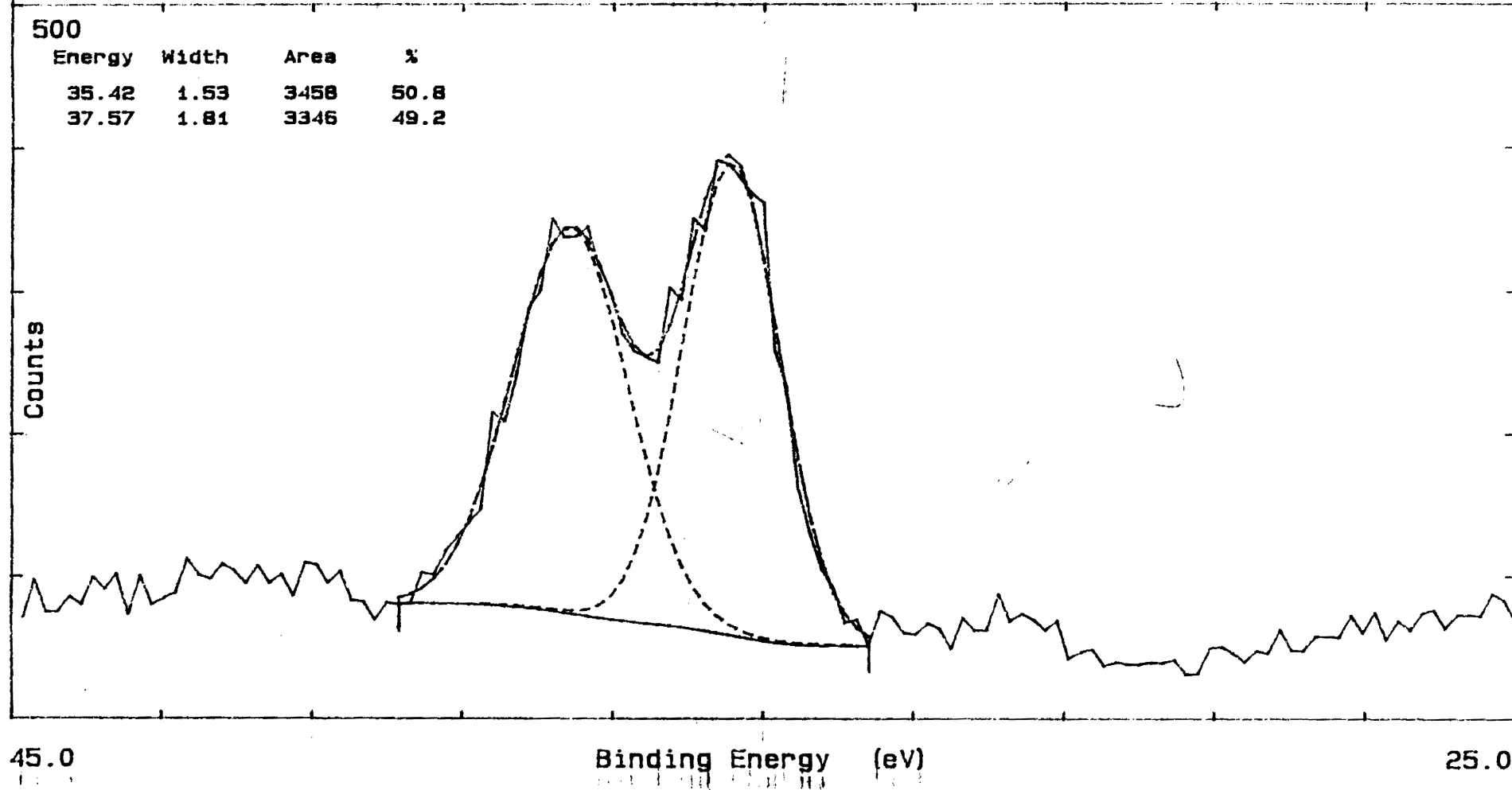


Figure 37

File: LDEF020	Date: 8/26/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 1	Resolution: 4

Description: IV-68 EXPOSED TUNGSTEN
1/2 RADIUS FROM PERIMETER, EXPOSED SIDE

Operator: TAP

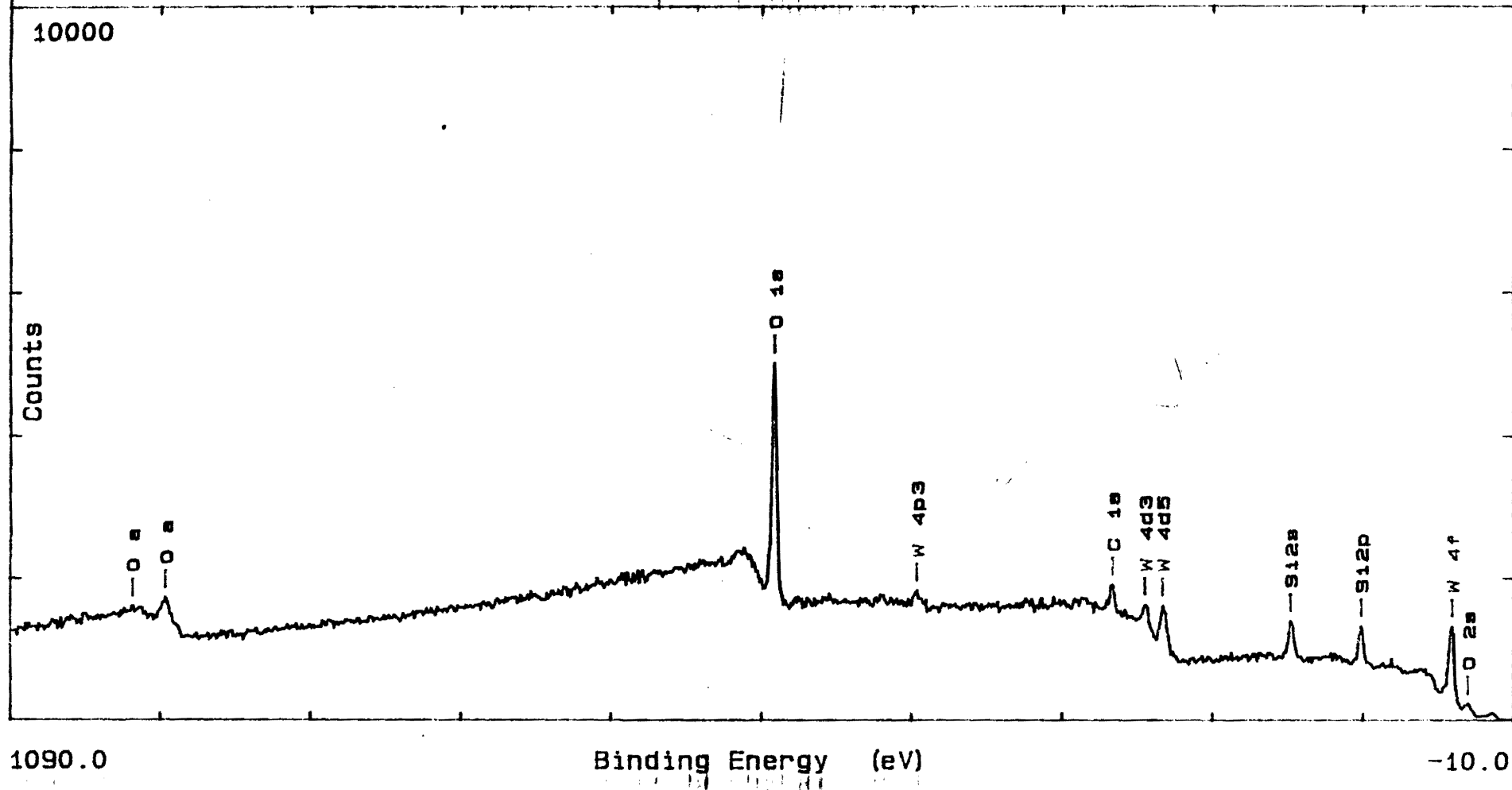


Figure 38

File: LDEF020	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-68 EXPOSED TUNGSTEN 1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM	Operator: TAP		

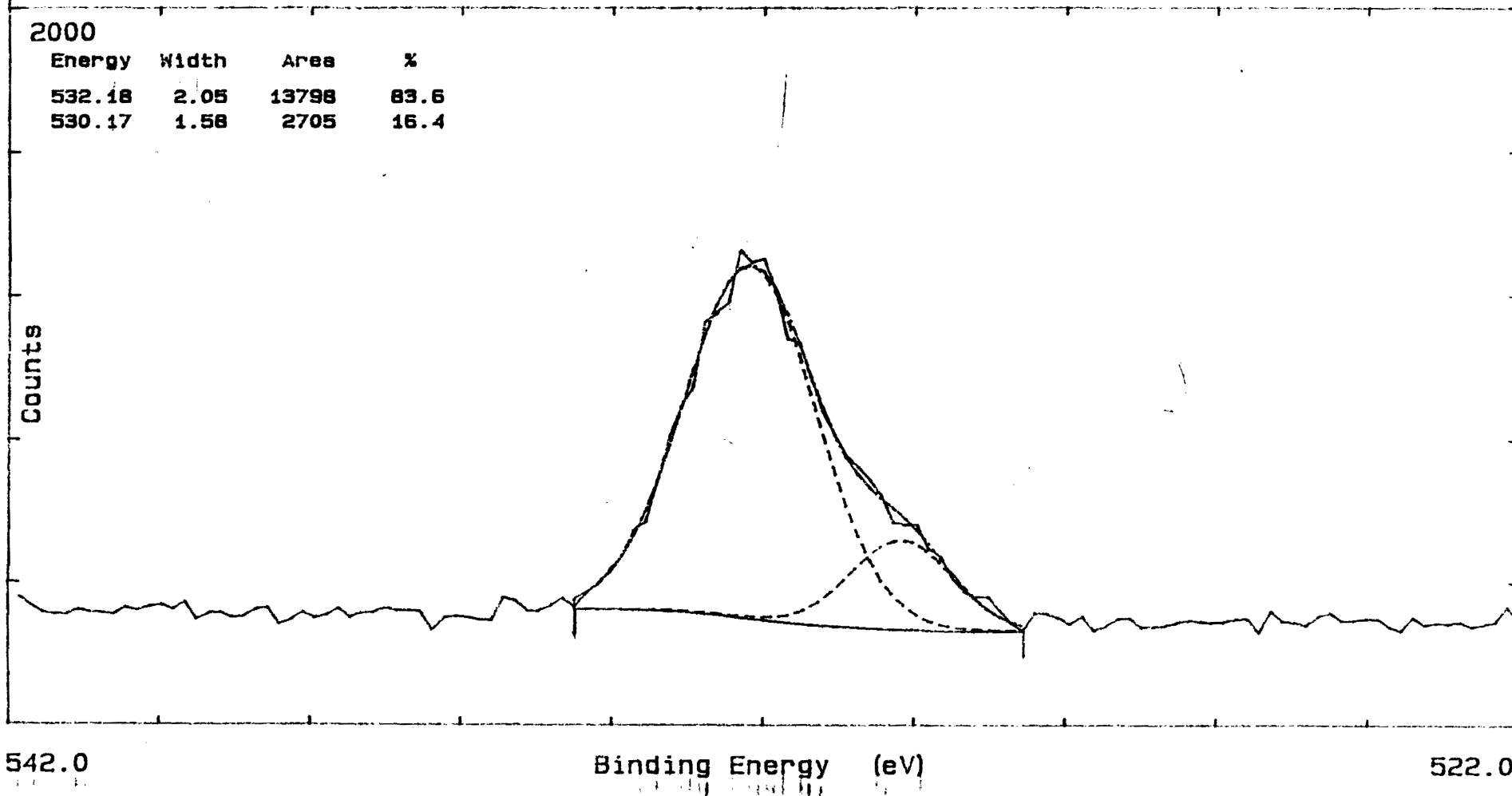


Figure 39

File: LDEF020	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: IV-68 EXPOSED TUNGSTEN 1/2 RADIUS FROM PERIMETER. W 4f SPECTRUM			Operator: TAP

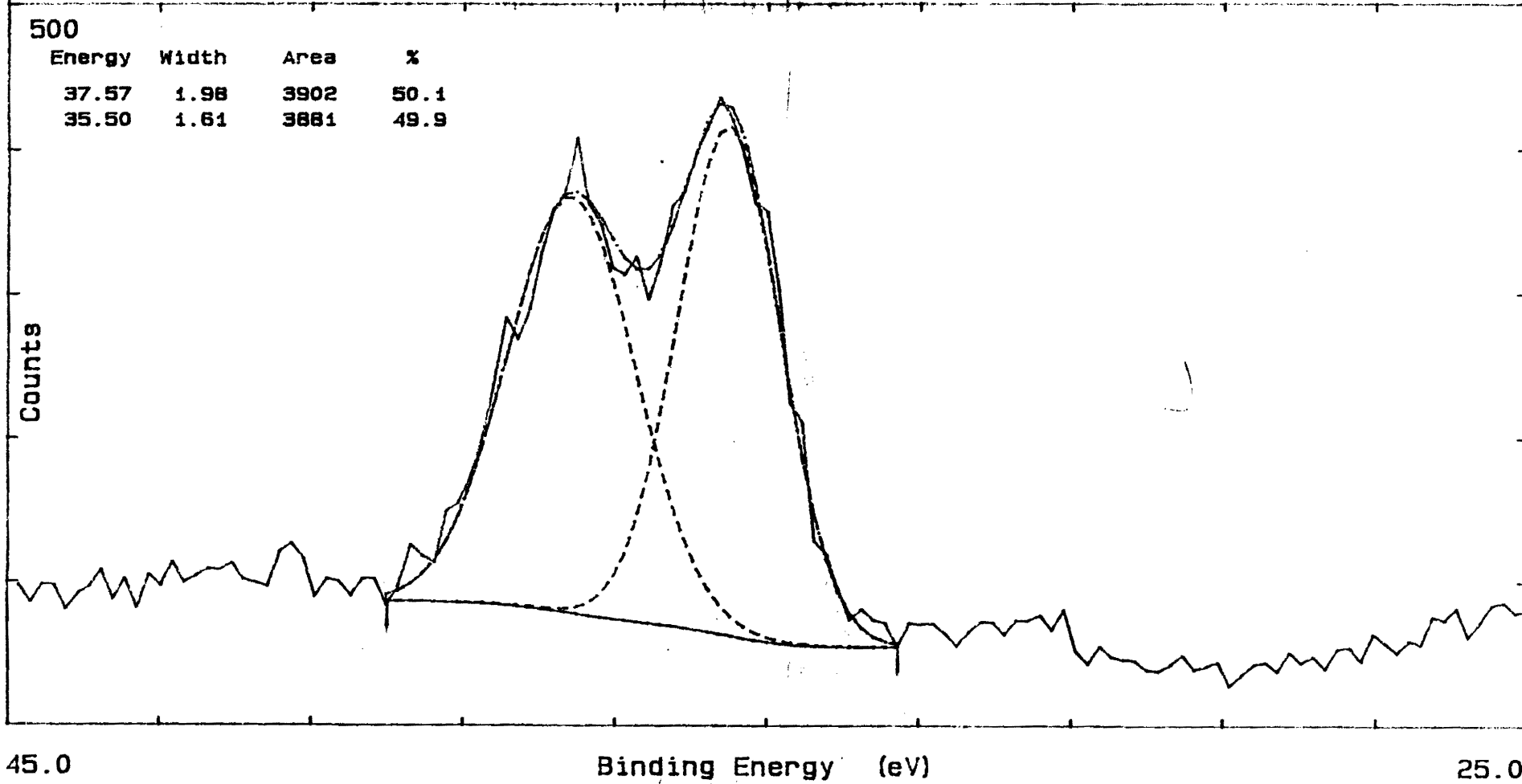


Figure 40

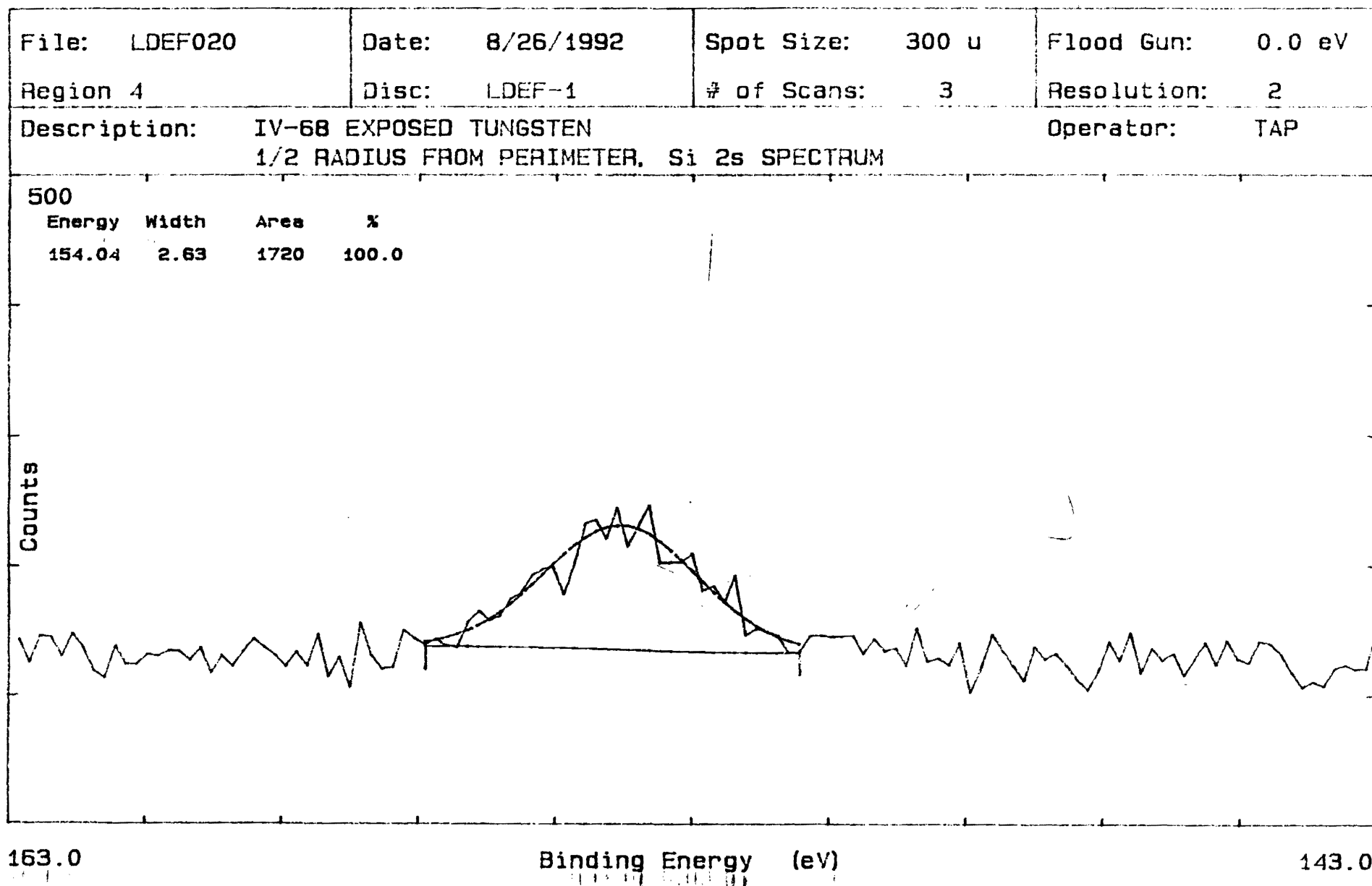


Figure 41

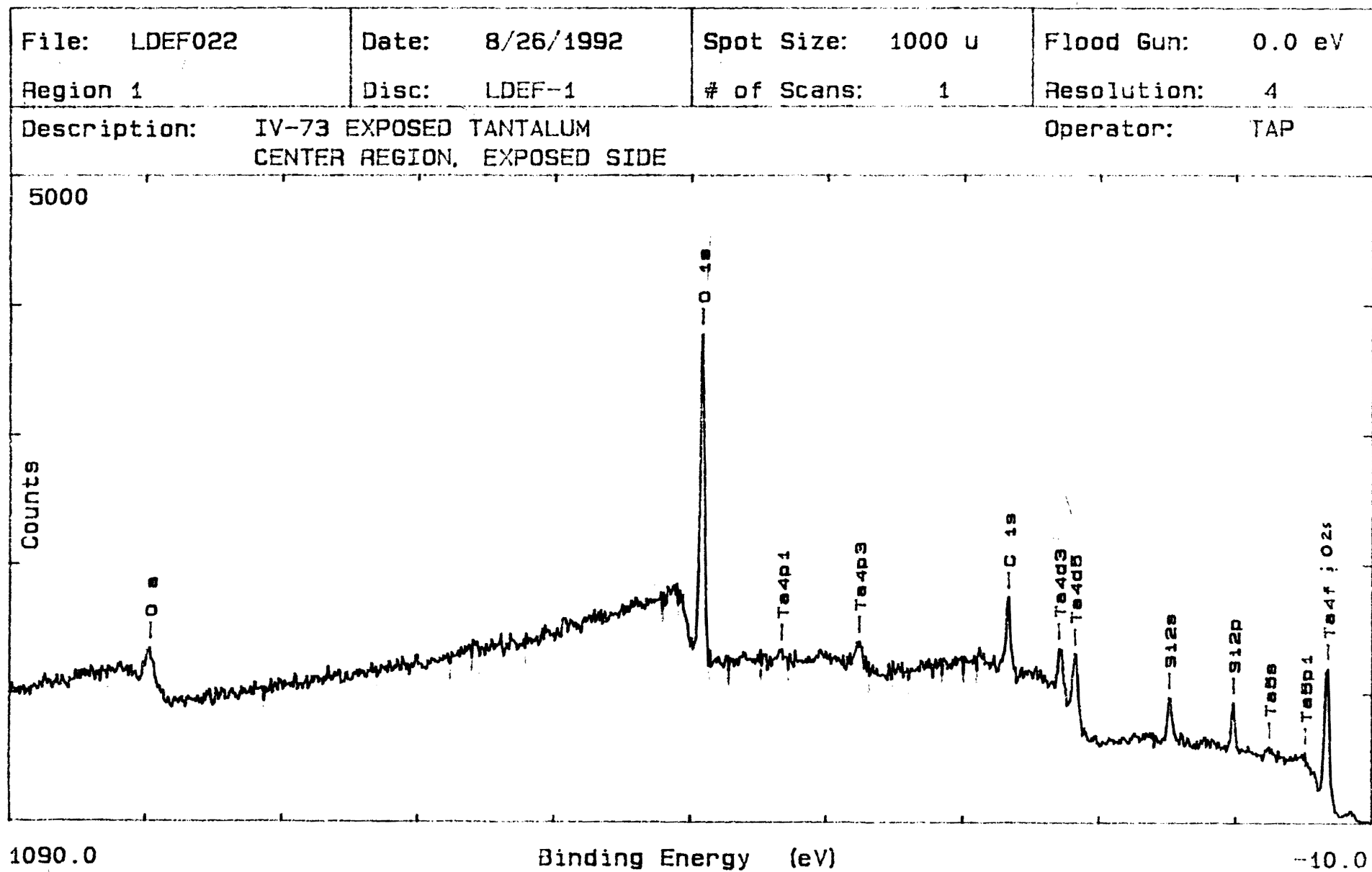


Figure 42

File: LDEF022	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF--1	# of Scans: 5	Resolution: 2
Description: IV-73 EXPOSED TANTALUM CENTER REGION, C 1s SPECTRUM			Operator: TAP

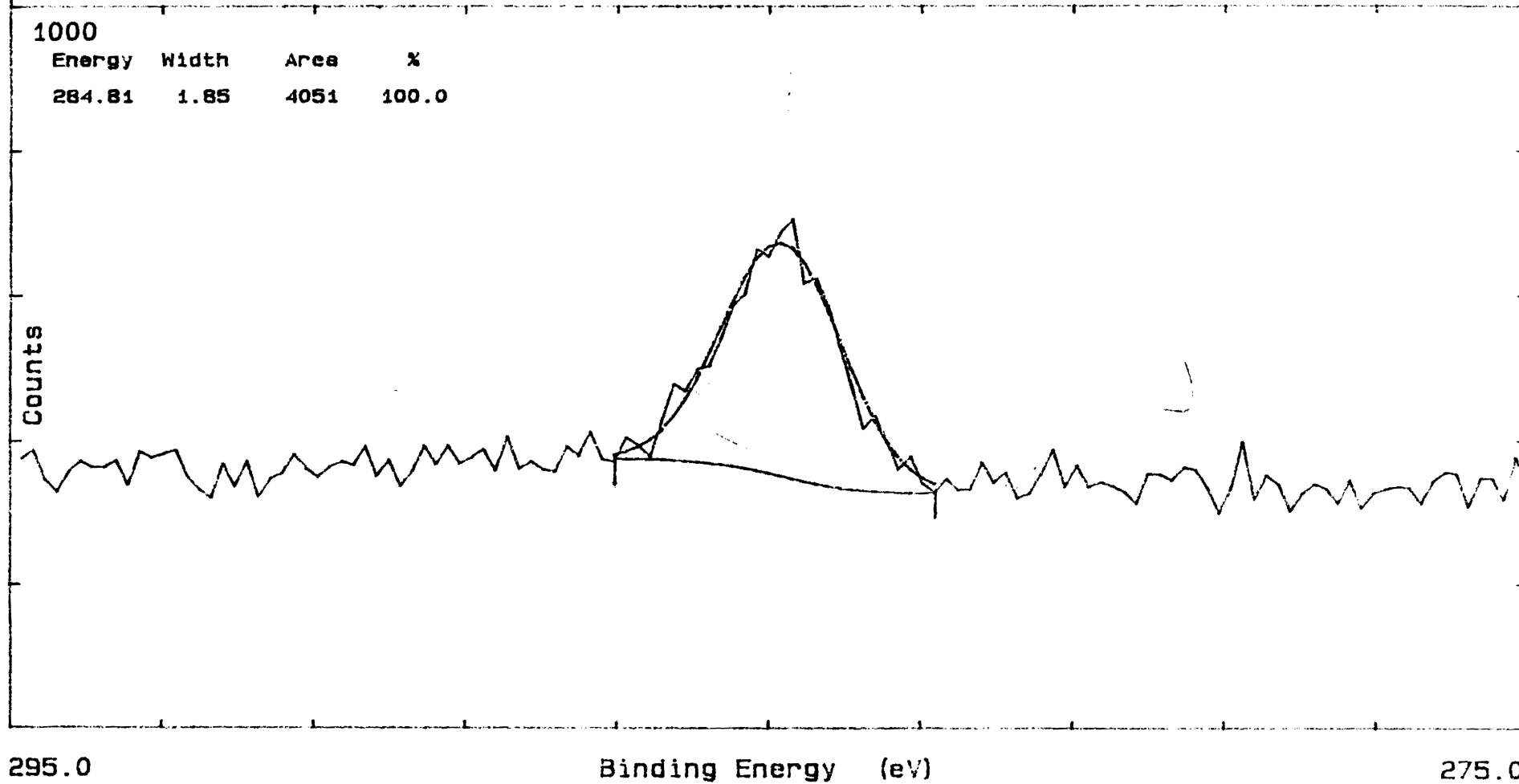


Figure 43

File: LDEF022	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-73 EXPOSED TANTALUM CENTER REGION, 0 1s SPECTRUM			Operator: TAP

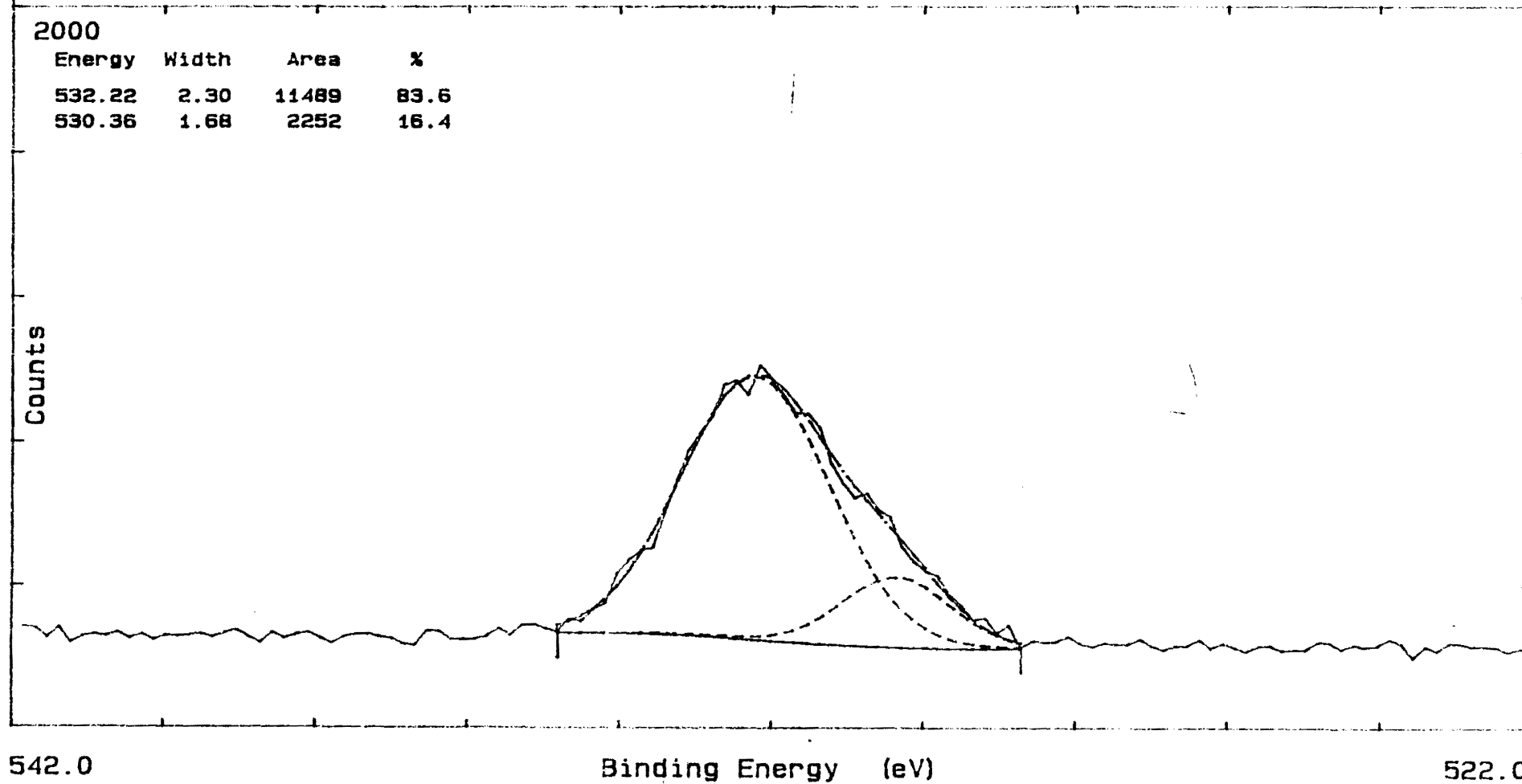


Figure 44

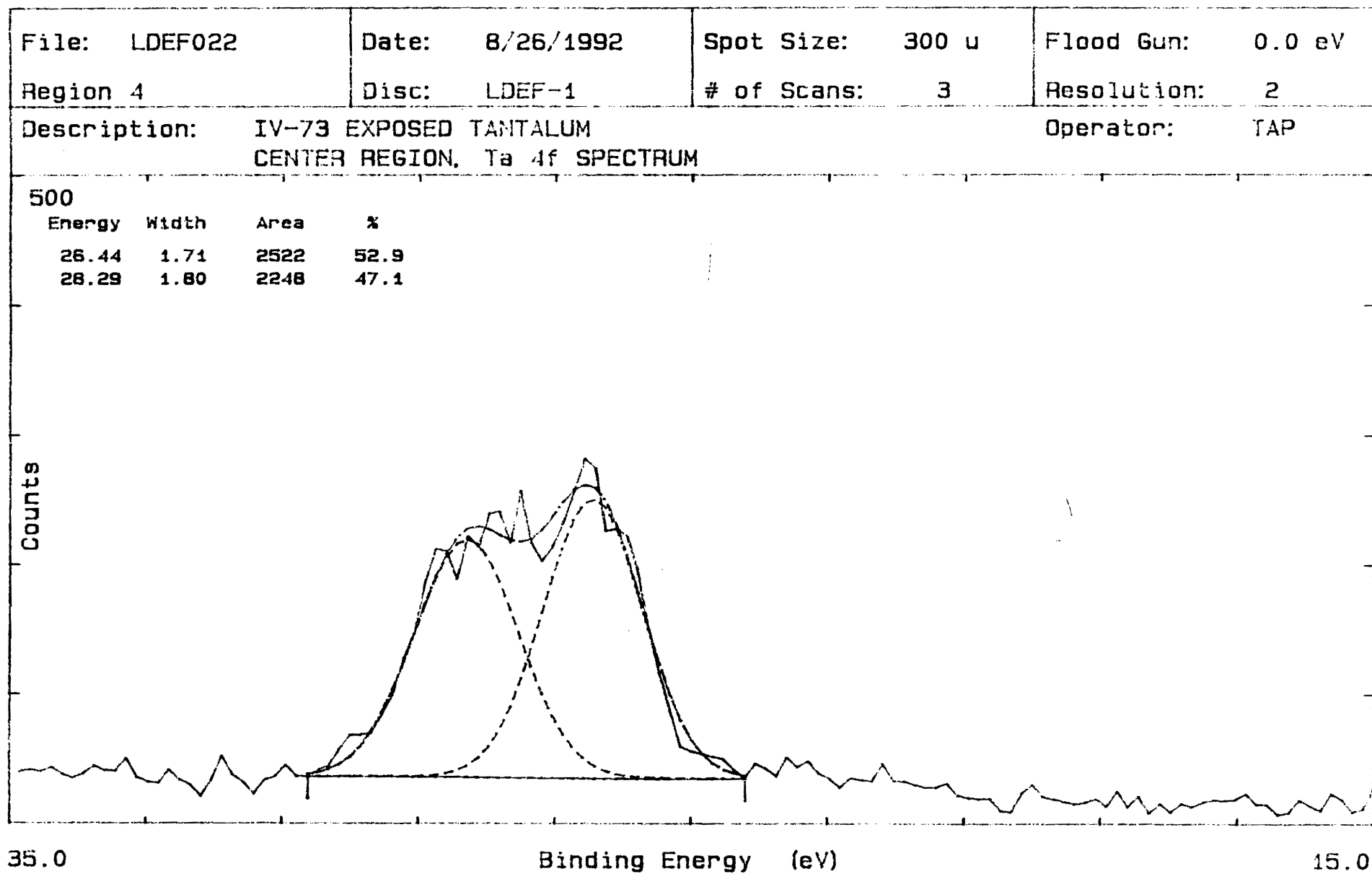


Figure 45

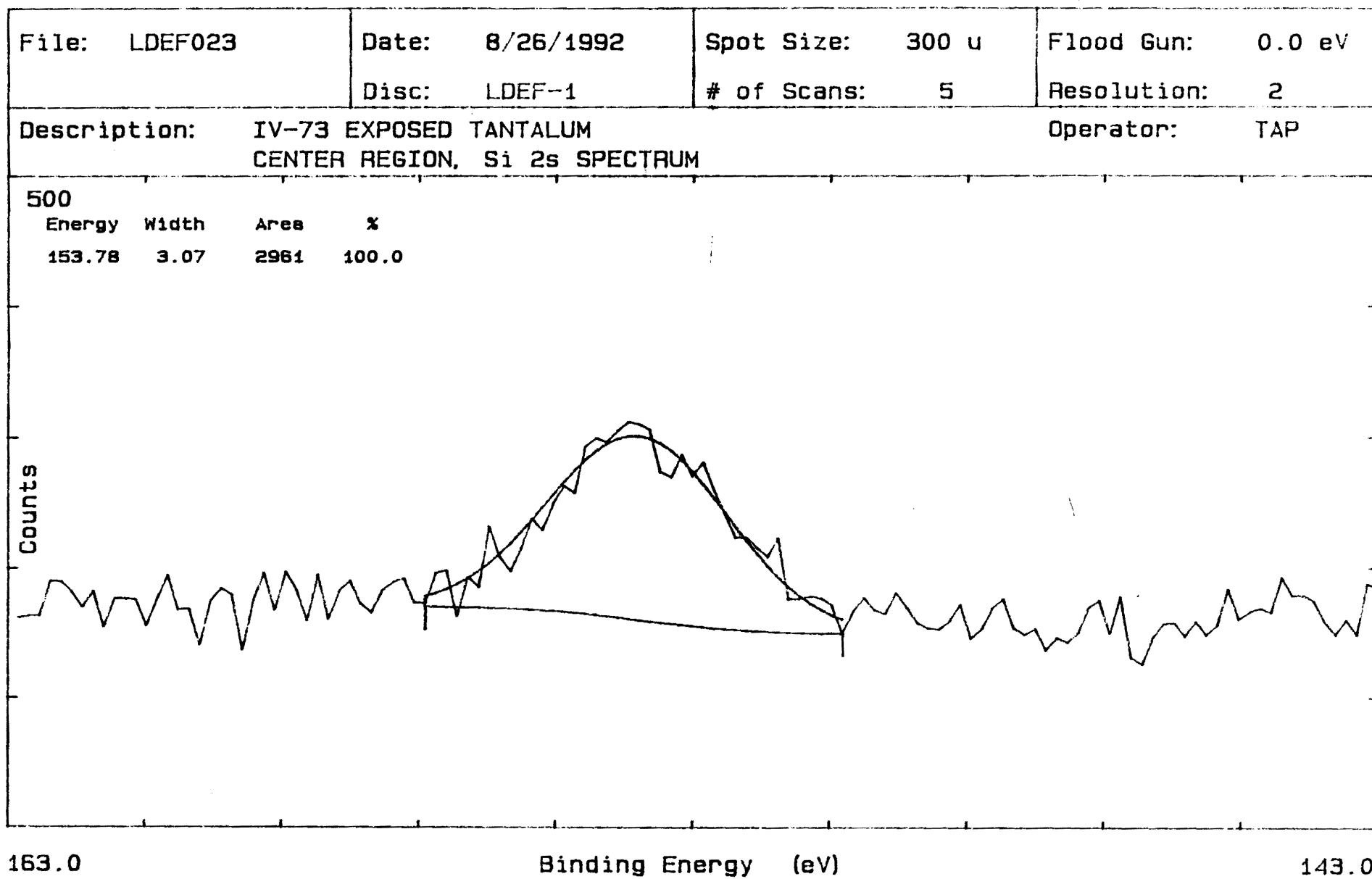


Figure 46

File: LDEF024	Date: 8/26/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-1	# of Scans: 1	Resolution: 4
Description: IV-73 EXPOSED TANTALUM 1/2 RADIUS FROM PERIMETER			Operator: TAP

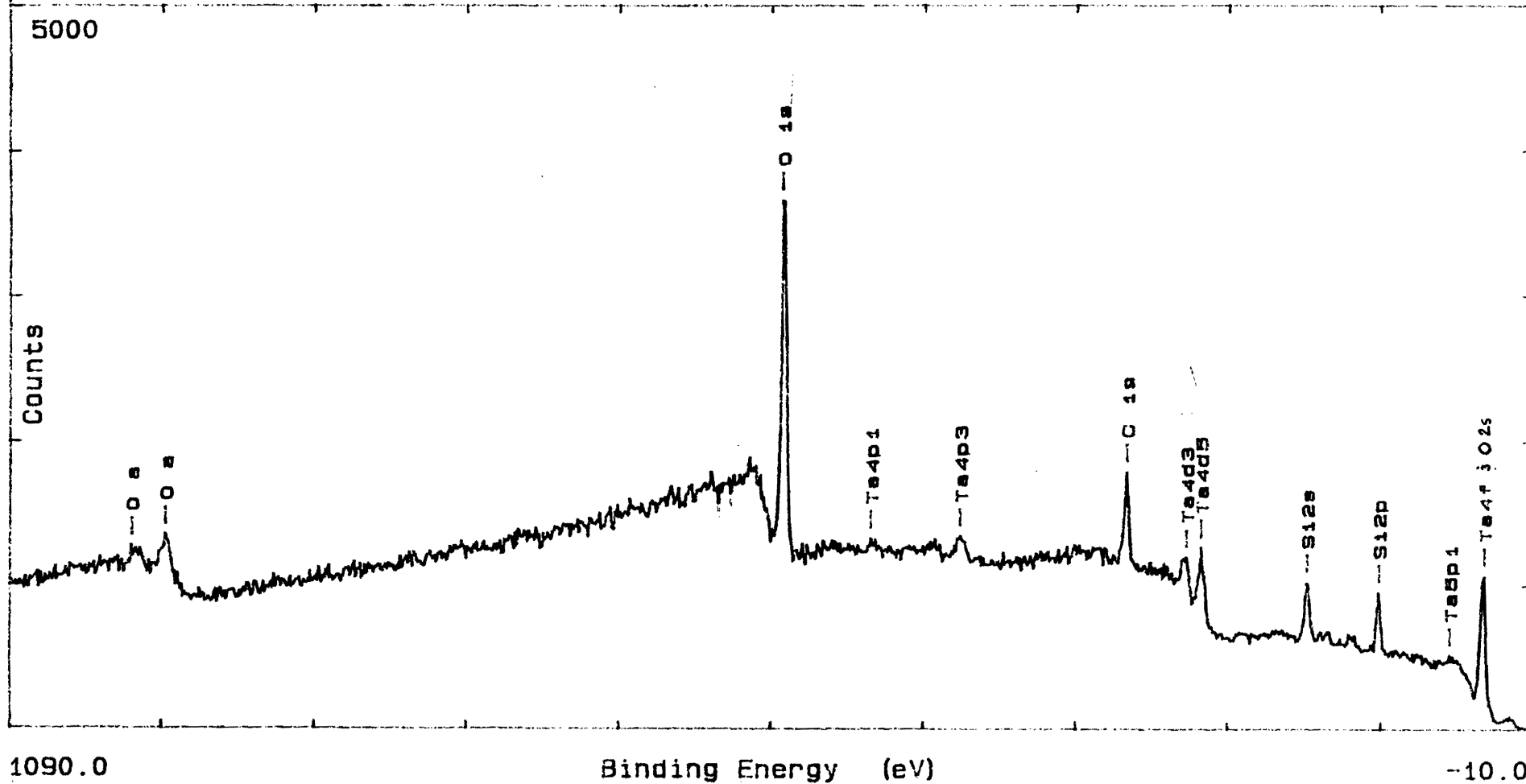


Figure 47

File: LDEF024	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-73 EXPOSED TANTALUM 1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM			Operator: TAP

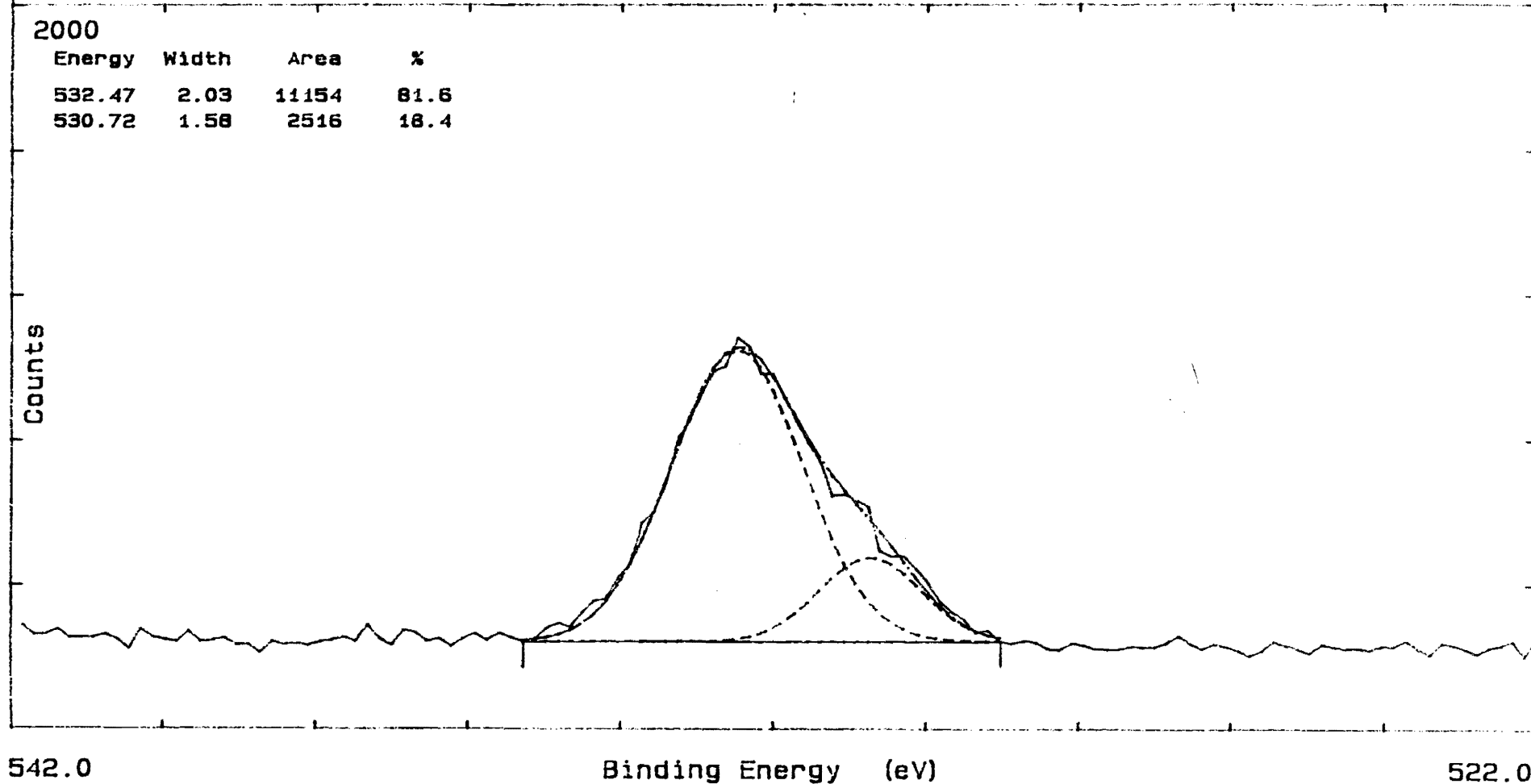


Figure 48

File: LDEF024	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 5	Resolution: 2

Description: IV-73 EXPOSED TANTALUM
1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM

Operator: TAP

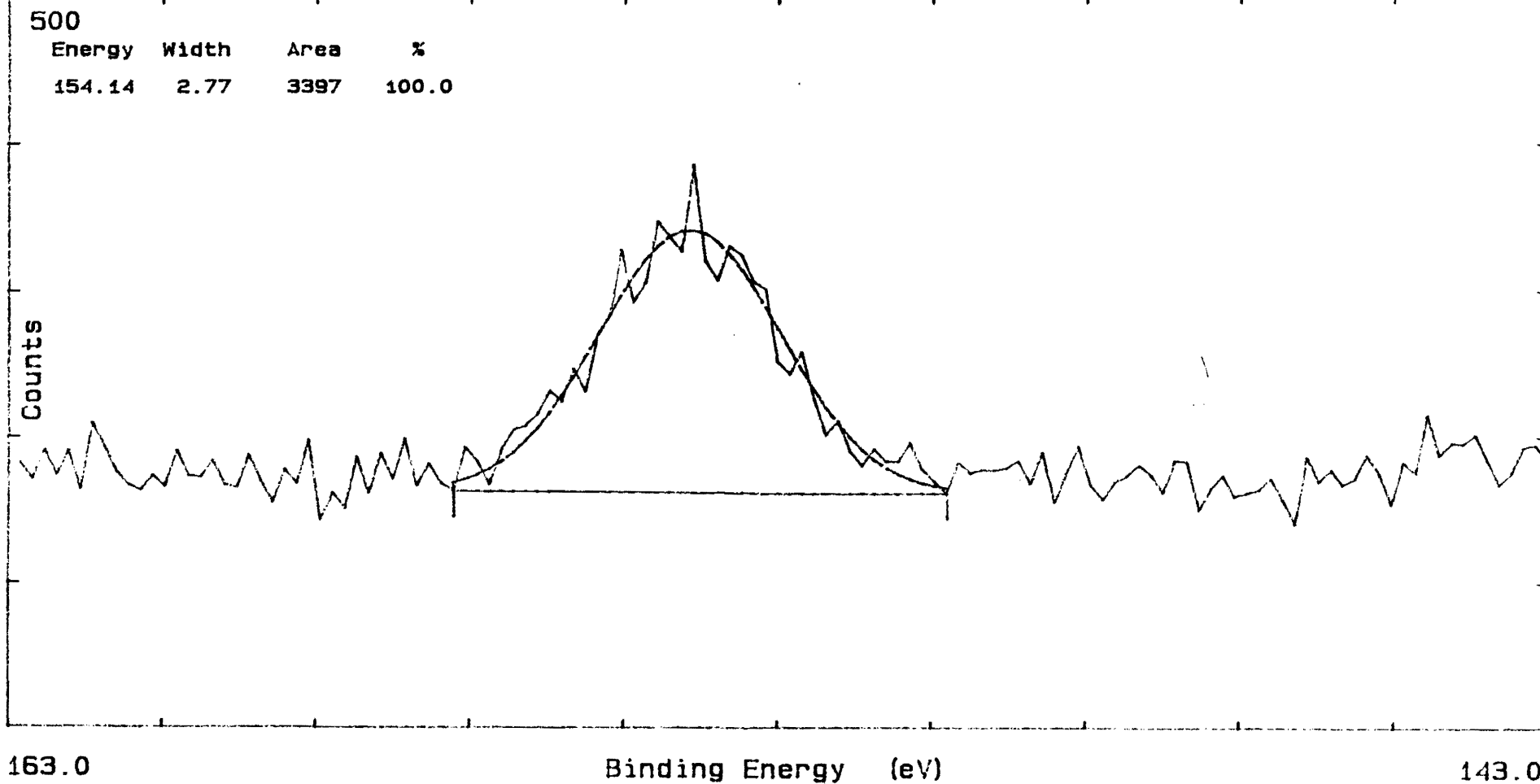


Figure 49

File: LDEF024	Date: 8/26/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 4	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: IV-73 EXPOSED TANTALUM 1/2 RADIUS FROM PERIMETER, Ta 4f SPECTRUM	Operator: TAP		

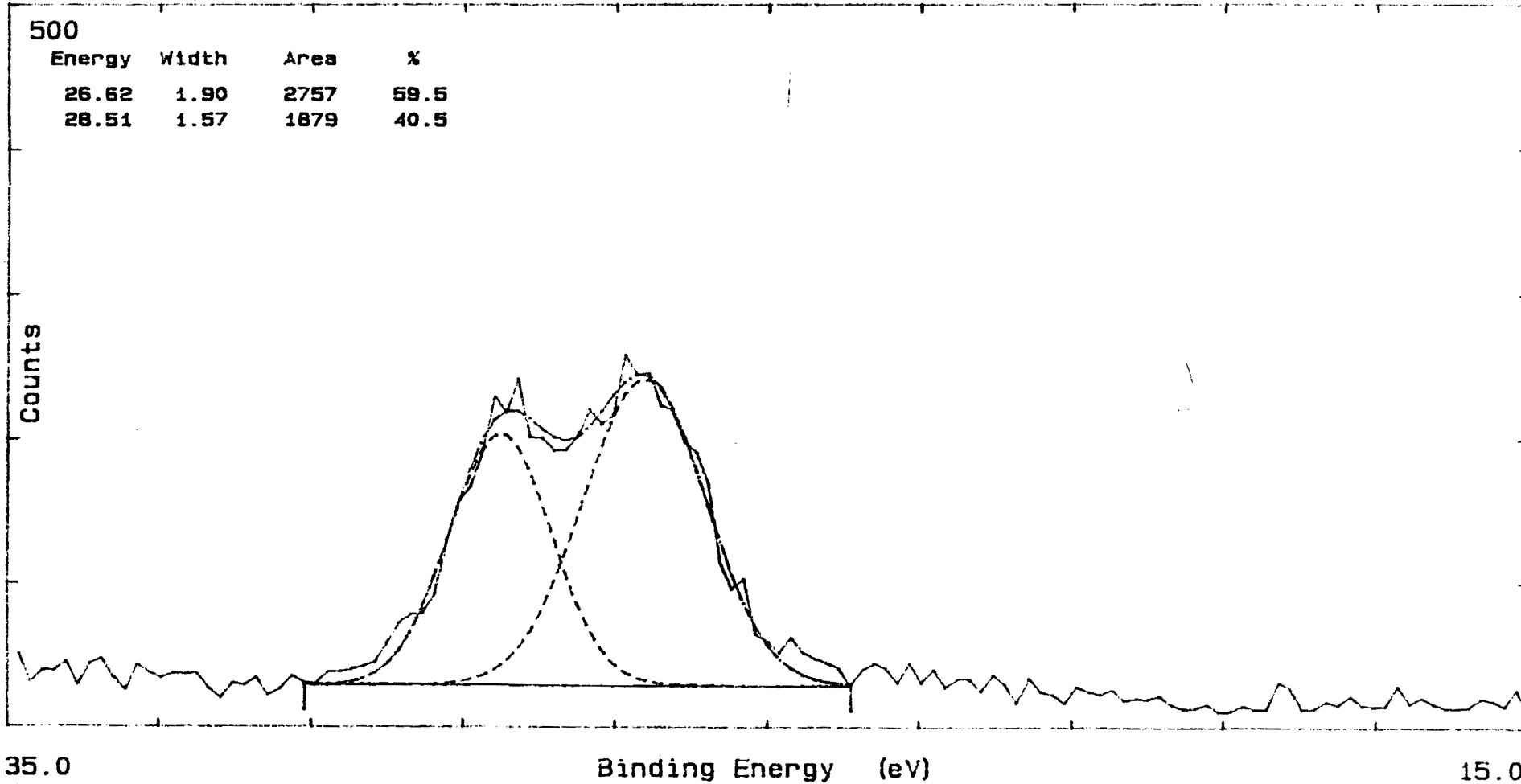


Figure 50

E 13-6-7

ELECTRON SPECTROSCOPY FOR CHEMICAL ANALYSIS -- SAMPLE ANALYSIS

REPORT # LDEF-02

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PO # H-13010D

September 14, 1992

This document reports the results of ESCA analyses performed on the following samples:

CM01-15, CM01-24, CM01-31, CM01-45, CM02-15

A general description of the ESCA data is contained in previous report # LDEF-01. A spot near the center and a spot about midway between the center and the perimeter (off center region) of each sample were examined. After collecting data from two spots on each sample, a spot near the center of each was examined, sputtered for 2 minutes with 4 keV Ar⁺ ions and reexamined. Reports of the sample analyses follow.

Reports on ESCA Analyses

Prior to sputtering, all samples produced similar spectra comprised primarily of C, O and Si. The single exception being that the center region of sample CM01-24 displayed a small amount of Mg. Mg was not observed on the off center region of this sample nor was Mg observed near its center after sputtering. Varying amounts of C were observed on these samples prior to sputtering ranging from about 17 atomic percent on CM01-45 to about 38 atomic percent on CM01-15.

Sputtering affected the surface composition of each sample generally by reducing the atomic percent C present and by decreasing the O/Si ratio. The single exception to this is sample CM01-31 on which the O/Si ratio increased after sputtering. The C on sample CM01-45 was reduced below detectability by 2 minutes of sputtering.

Prior to sputtering, the samples did not charge under the x-ray beam. They did charge after sputtering. This indicates that the sample surfaces were initially covered with electrically conductive layers that were removed by sputtering.

CM01-15: Control mirror, SiO₂ on aluminum

Figures 1 - 8 are the spectra taken from the two spots prior to sputtering. Figure 9 is a spectrum taken of the center region which was then sputtered for two minutes prior to collecting the spectrum shown in figure 10.

Table 1: Semiquantitative Composition of
Center Region of Sample CM01-15
from Figure 1 Prior to Sputtering

Element	Approximate Atomic Percent
O	39
Si	22
C	39

Table 2: Semiquantitative Composition of
Off Center Region of Sample CM01-15
from Figure 5 Prior to Sputtering

Element	Approximate Atomic Percent
O	42
Si	20
C	38

Table 3: Semiquantitative Composition of
Center Region of Sample CM01-15
from Figure 10 After Sputtering

Element	Approximate Atomic Percent
O	34
Si	32
C	34

CM01-24: Exposed mirror, SiO₂ on aluminum

Figures 11 - 18 are the spectra taken from the two spots prior to sputtering. Figure 19 is a spectrum taken of the center region which was then sputtered for two minutes prior to collecting the spectrum shown in figure 20.

The presence of Mg near the center of this sample is indicated by the Mg Auger peak seen in the general survey of this area. It was not possible to quantify the amount of Mg present because of the unavailability of sensitivity data for Auger peaks appearing in ESCA spectra.

Table 4: Semiquantitative Composition of
Center Region of Sample CM01-24
from Figure 11 Prior to Sputtering

Element	Approximate Atomic Percent
O	48
Si	29
C	23

Table 5: Semiquantitative Composition of
Off Center Region of Sample CM01-24
from Figure 15 Prior to Sputtering

Element	Approximate Atomic Percent
O	51
Si	29
C	20

Table 6: Semiquantitative Composition of
Center Region of Sample CM01-24
from Figure 20 After Sputtering

Element	Approximate Atomic Percent
O	54
Si	41
C	5

CM01-31: Exposed mirror (windowed), SiO_x on aluminum

Figures 21 - 26 are the spectra taken from the two spots prior to sputtering. Figure 27 is a spectrum taken of the center region which was then sputtered for two minutes prior to collecting the spectrum shown in figure 28.

Table 7: Semiquantitative Composition of
Center Region of Sample CM01-31
from Figure 21 Prior to Sputtering

Element	Approximate Atomic Percent
O	51
Si	30
C	19

Table 8: Semiquantitative Composition of
Off Center Region of Sample CM01-31
from Figure 24 Prior to Sputtering

Element	Approximate Atomic Percent
O	51
Si	30
C	19

Table 9: Semiquantitative Composition of
Center Region of Sample CM01-31
from Figure 28 After Sputtering

Element	Approximate Atomic Percent
O	63
Si	27
C	9

CM01-45: Exposed mirror, SiO₂ on aluminum

Figures 29 - 36 are the spectra taken from the two spots prior to sputtering. Figure 37 is a spectrum taken of the center region which was then sputtered for two minutes prior to collecting the spectrum shown in figure 38.

Table 10: Semiquantitative Composition of
Center Region of Sample CM01-45
from Figure 29 Prior to Sputtering

Element	Approximate Atomic Percent
O	51
Si	31
C	18

Table 11: Semiquantitative Composition of
Off Center Region of Sample CM01-45
from Figure 33 Prior to Sputtering

Element	Approximate Atomic Percent
O	52
Si	32
C	16

Table 12: Semiquantitative Composition of
Center Region of Sample CM01-45
from Figure 38 After Sputtering

Element	Approximate Atomic Percent
O	58
Si	42

CM02-15: Exposed mirror, SiO_2 on Al, Trailing Edge

Figures 39 - 44 are the spectra taken from the two spots prior to sputtering. Figure 45 is a spectrum taken of the center region which was then sputtered for two minutes prior to collecting the spectrum shown in figure 46.

Table 13: Semiquantitative Composition of
Center Region of Sample CM02-15
from Figure 39 Prior to Sputtering

Element	Approximate Atomic Percent
O	38
Si	25
C	37

Table 14: Semiquantitative Composition of
Off Center Region of Sample CM02-15
from Figure 42 Prior to Sputtering

Element	Approximate Atomic Percent
O	39
Si	27
C	34

Table 15: Semiquantitative Composition of
Center Region of Sample CM02-15
from Figure 46 After Sputtering

Element	Approximate Atomic Percent
O	51
Si	42
C	7

Silica Standard

In an effort to calibrate the ESCA technique in regard to O/Si ratios on SiO_x covered samples, spectra were collected from a piece of high purity silica (SiO_2). The silica was first rinsed in acetone followed by a rinse in methanol. The silica was mounted on a sample holder under a fine nickel wire mesh screen, placed in the ESCA spectrometer and a general survey collected using the low energy electron flood gun. The nickel screen and flood gun controlled sample charging. The spectrum (figure 47) indicates the presence of O, C, Si and N in the approximate

atomic percentages displayed in table 16. The O/Si ratio from this spectrum is about 2.6.

After collecting this spectrum, the sample was heated in the ESCA system to an unknown temperature below 300°C. (The sample stage in which the sample holder sits was heated to 300°C.) After about three days at the elevated temperature, the spectrum shown in figure 48 was collected while the sample was hot. O, Si, C and N were present on the surface. Table 17 presents the results of the semiquantitative analysis of this spectrum. The O/Si ratio after heating is about 1.4.

The primary effect of heating seems to be to decrease the O/Si ration without affecting the C or N coverage. This is perhaps due to the desorption of water and other contaminants from the surface promoted by heating.

It is not feasible to sputter the silica surface while it is under the nickel screen. Because of the variability of the O/Si ratio, the substantial amounts of C and N present on the silica standard after heating and the inability to sputter clean the standard as it was observed, it is not possible to yet determine what semiquantitative O/Si ratio would be obtained from a clean SiO₂ surface.

Table 16: Semiquantitative Composition of
Silica Standard after Cleaning
from Figure 47

Element	Approximate Atomic Percent
O	42
Si	16
C	34
N	8

Table 17: Semiquantitative Composition of Silica
Standard after About Three Days at an
Elevated Temperature from Figure 48

Element	Approximate Atomic Percent
O	34
Si	24
C	34
N	8

File: LDEF025

Date: 8/27/1992

Spot Size: 1000 μ

Flood Gun: 0.0 eV

Disc: LDEF-1

of Scans: 1

Resolution: 4

Description: CM01-15 CONTROL MIRROR, SiO₂ on Al
CENTER REGION

Operator: TAP

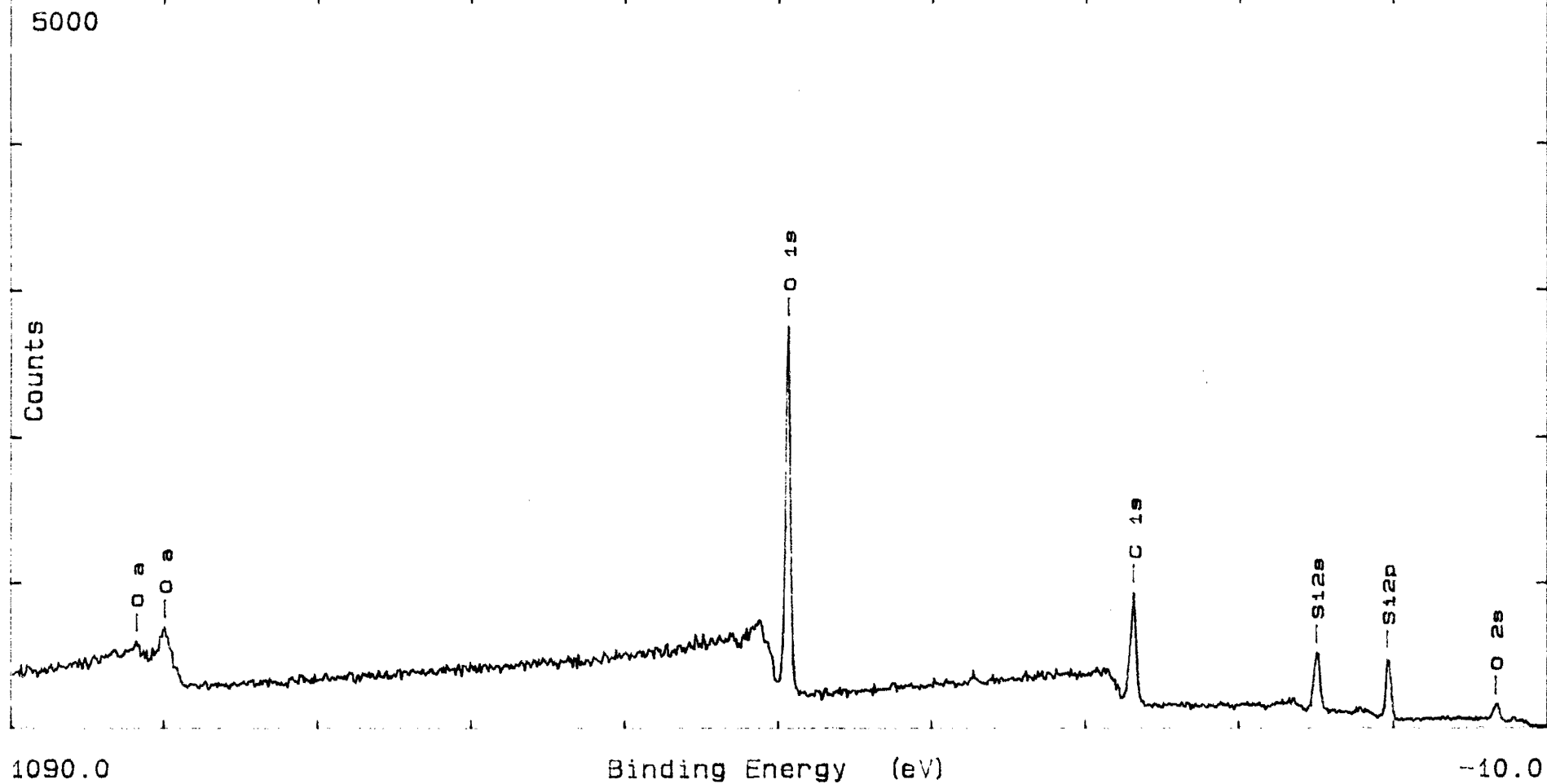


Figure 1

File: LDEF026

Date: 8/27/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 1

Disc: LDEF-1

of Scans: 3

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO_x on Al
CENTER REGION, O 1s SPECTRUM

Operator: TAP

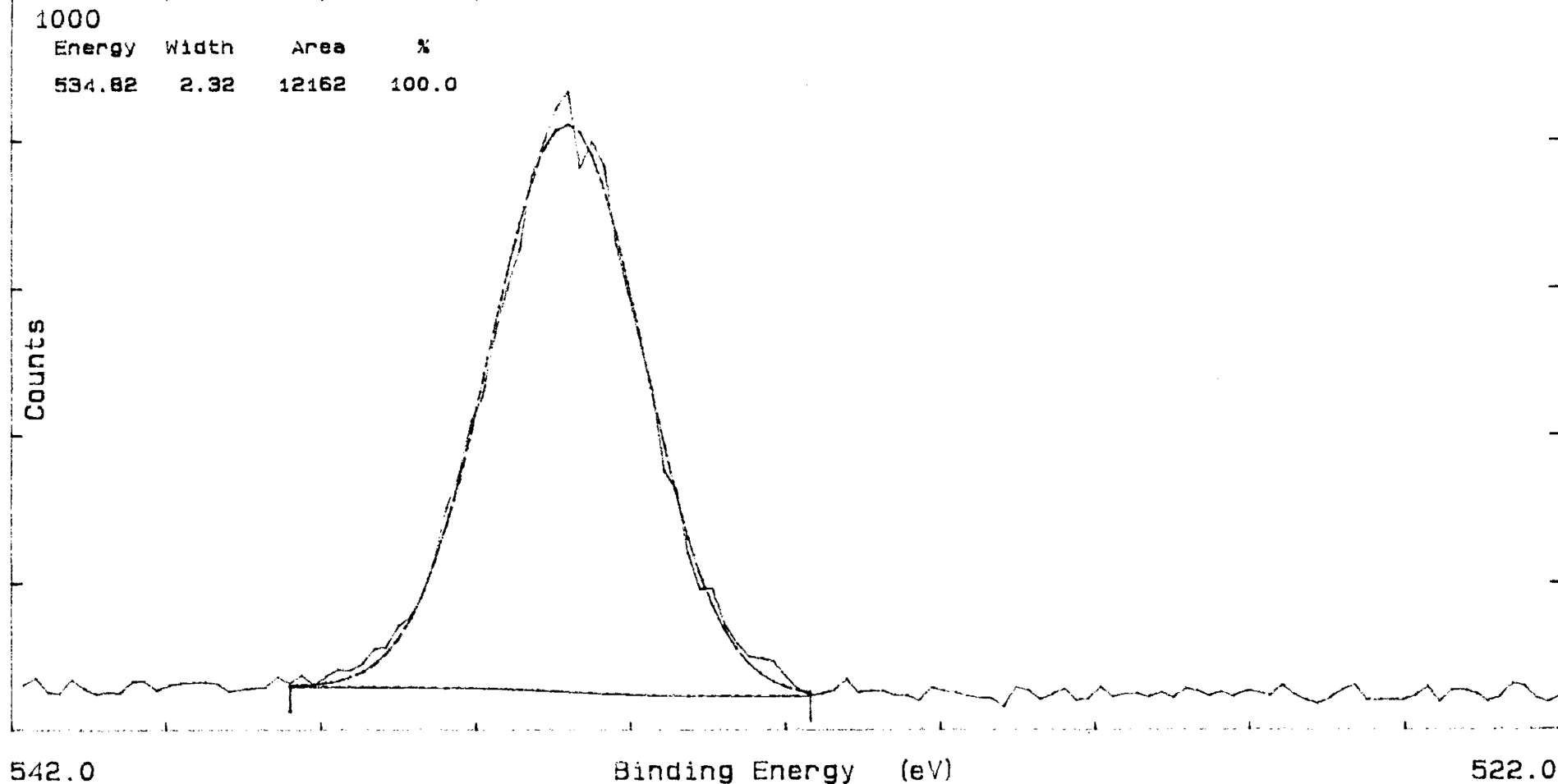


Figure 2

File: LDEF026

Date: 8/27/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-1

of Scans: 5

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO_x on Al
CENTER REGION, Si 2s SPECTRUM

Operator: TAP

500				
Energy	Width	Area	%	
156.55	3.05	2985	100.0	

Counts

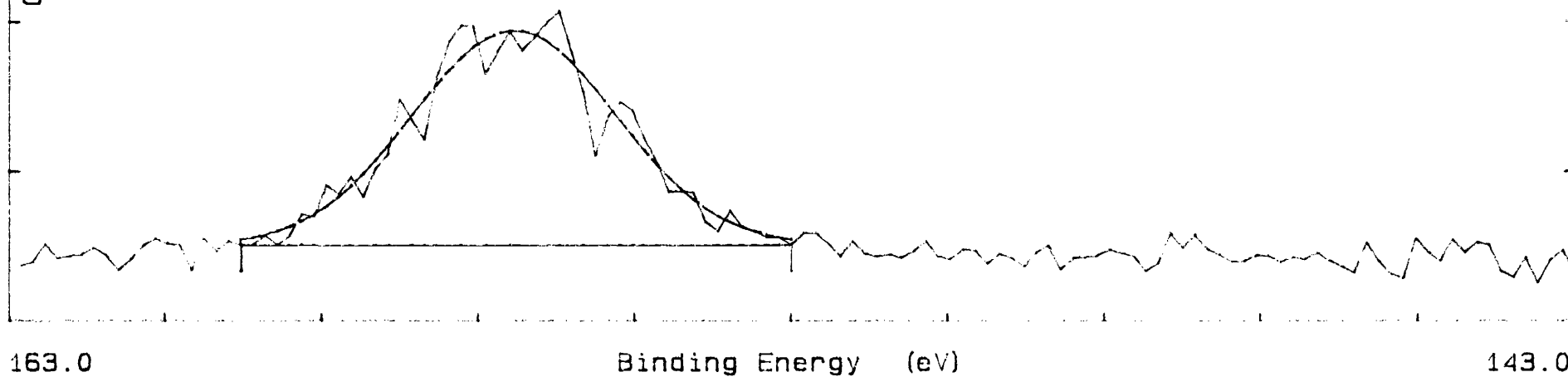


Figure 3

File: LDEF026

Date: 8/27/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 3

Disc: LDEF-1

of Scans: 5

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO_x on Al
CENTER REGION, C 1s SPECTRUM

Operator: TAP

2000

Energy	Width	Area	%
287.47	2.49	4768	92.3
289.80	1.37	396	7.7

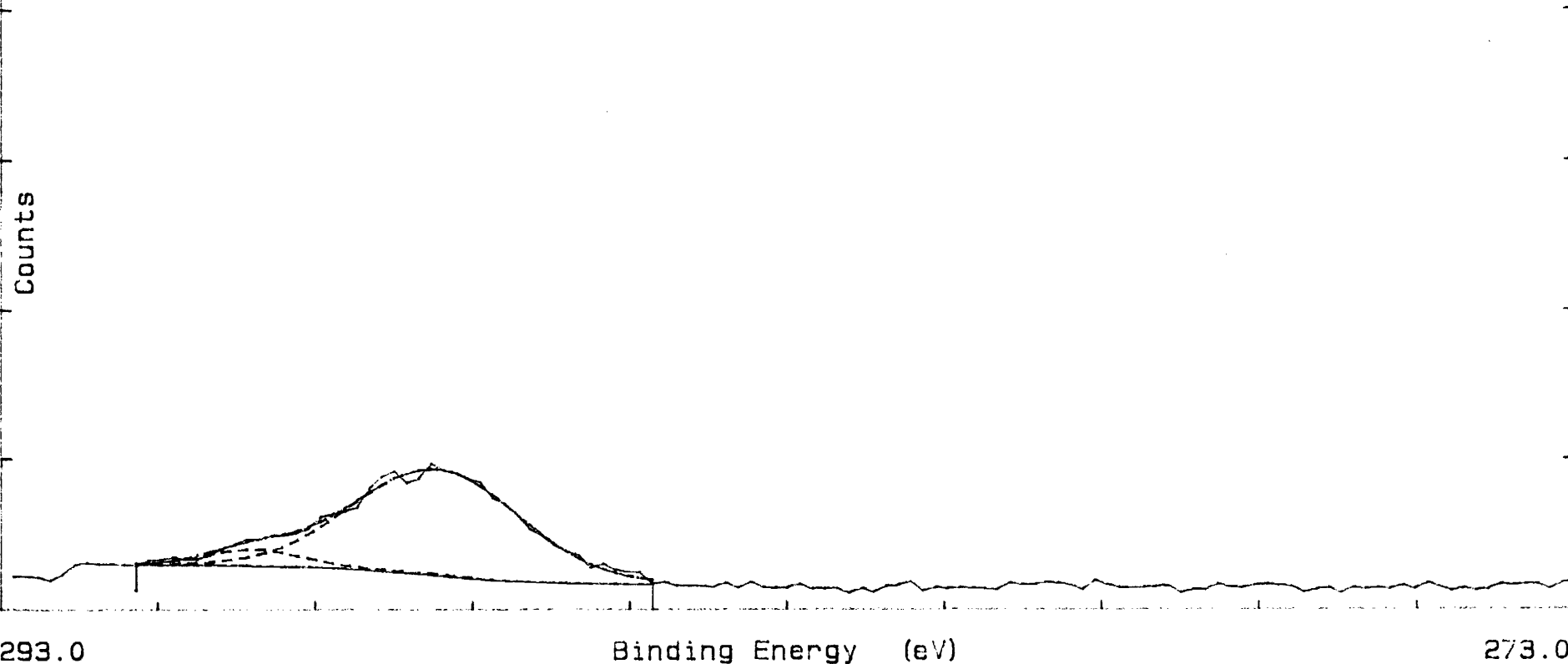


Figure 4

File: LDEF027

Date: 8/27/1992

Spot Size: 1000 μ

Flood Gun: 0.0 eV

Region 1

Disc: LDEF-1

of Scans: 1

Resolution: 4

Description: CM01-15 CONTROL MIRROR, SiO_x on Al
1/2 RADIUS FROM PERIMETER

Operator: TAP

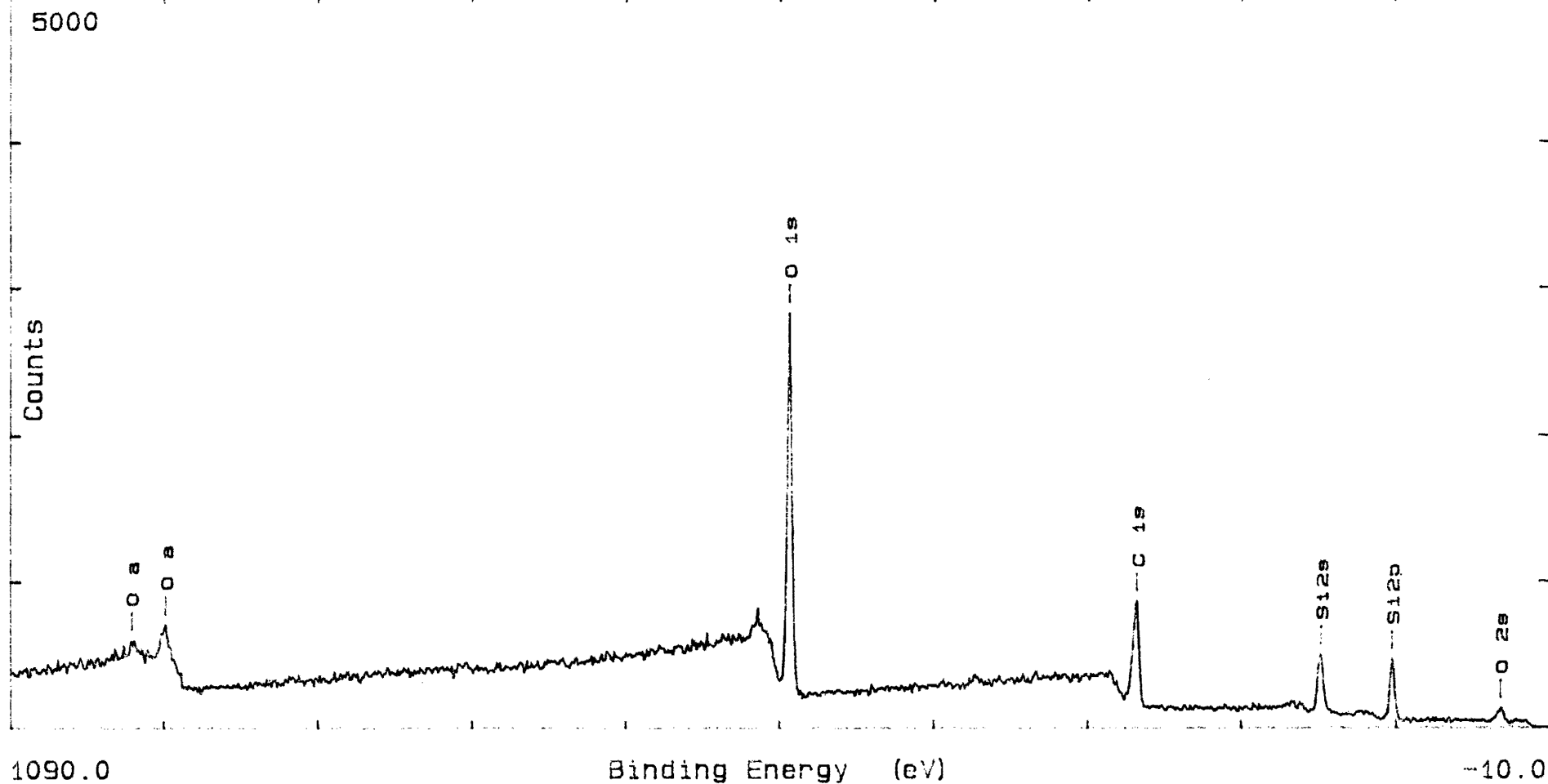


Figure 5

File: LDEF027

Date: 8/27/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-1

of Scans: 3

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO₂ on Al
1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM

Operator: TAP

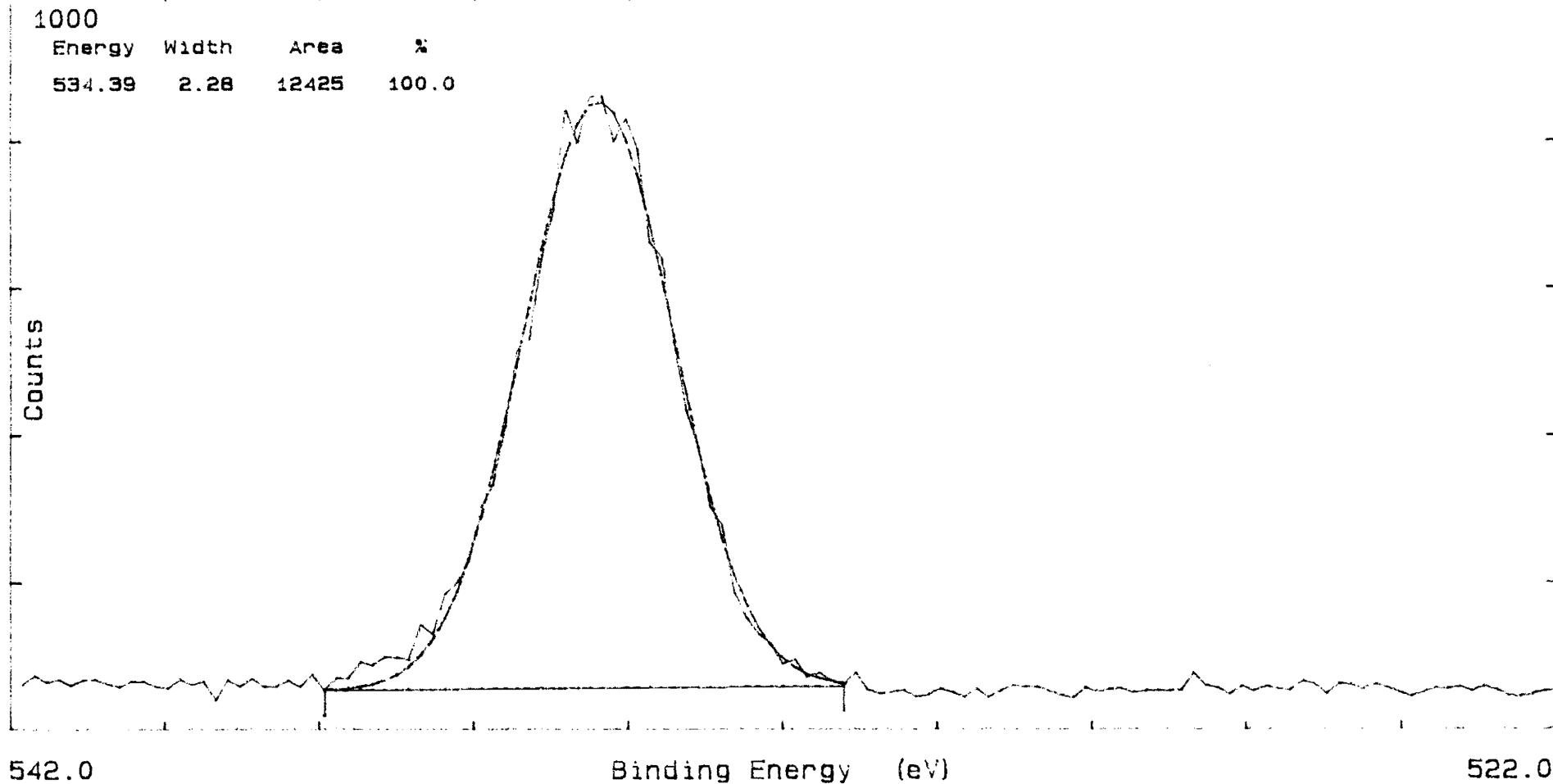


Figure 6

File: LDEF027

Date: 8/27/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 3

Disc: LDEF-1

of Scans: 5

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO_x on Al
1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM

Operator: TAP

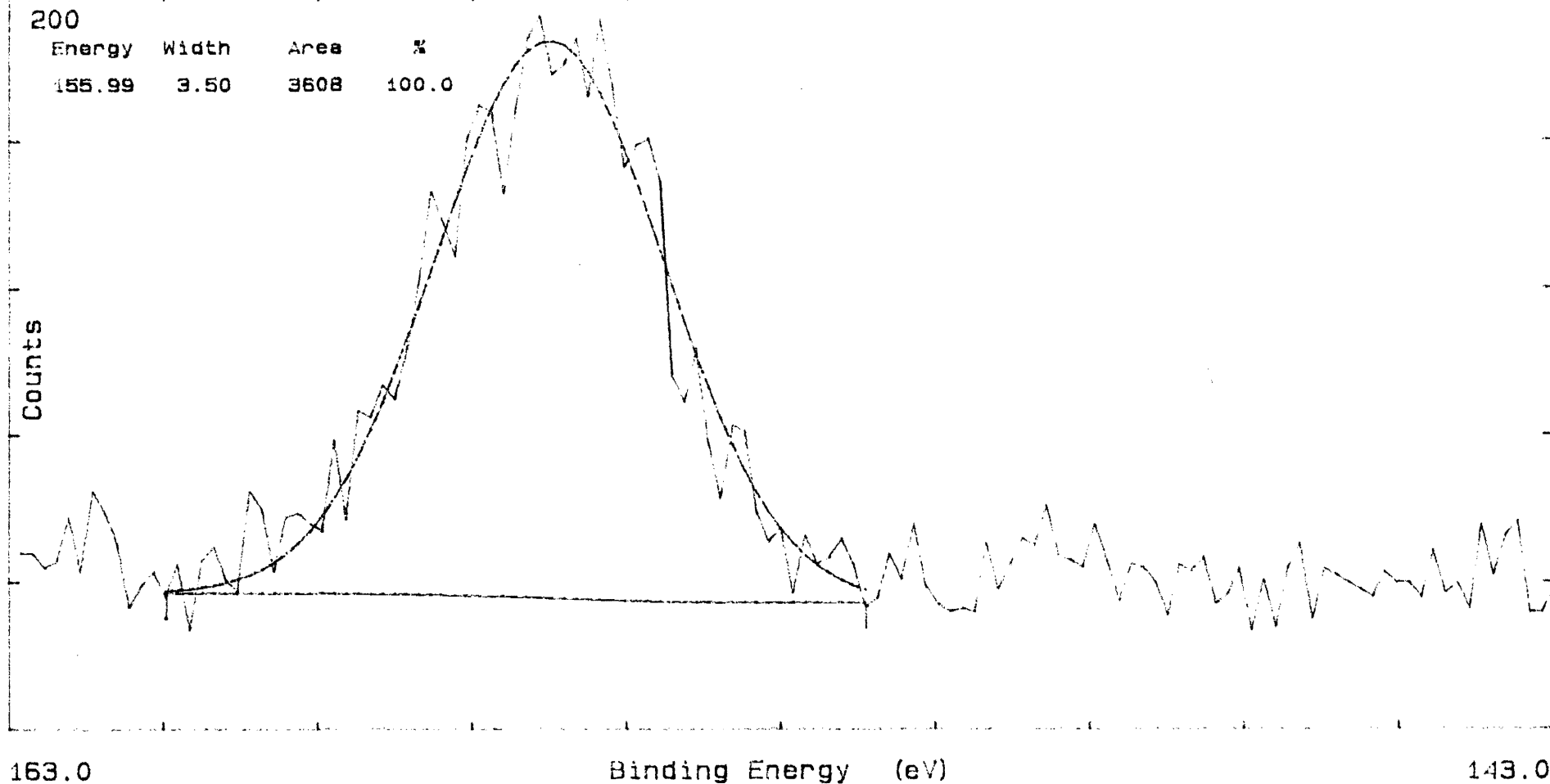


Figure 7

File: LDEF027

Date: 8/27/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 4

Disc: LDEF-1

of Scans: 5

Resolution: 2

Description: CM01-15 CONTROL MIRROR, SiO₂ on Al
1/2 RADIUS FROM PERIMETER, C 1s SPECTRUM

Operator: TAP

500

Energy	Width	Area	%
287.10	2.70	5076	75.1
290.10	3.08	1683	24.9

Counts

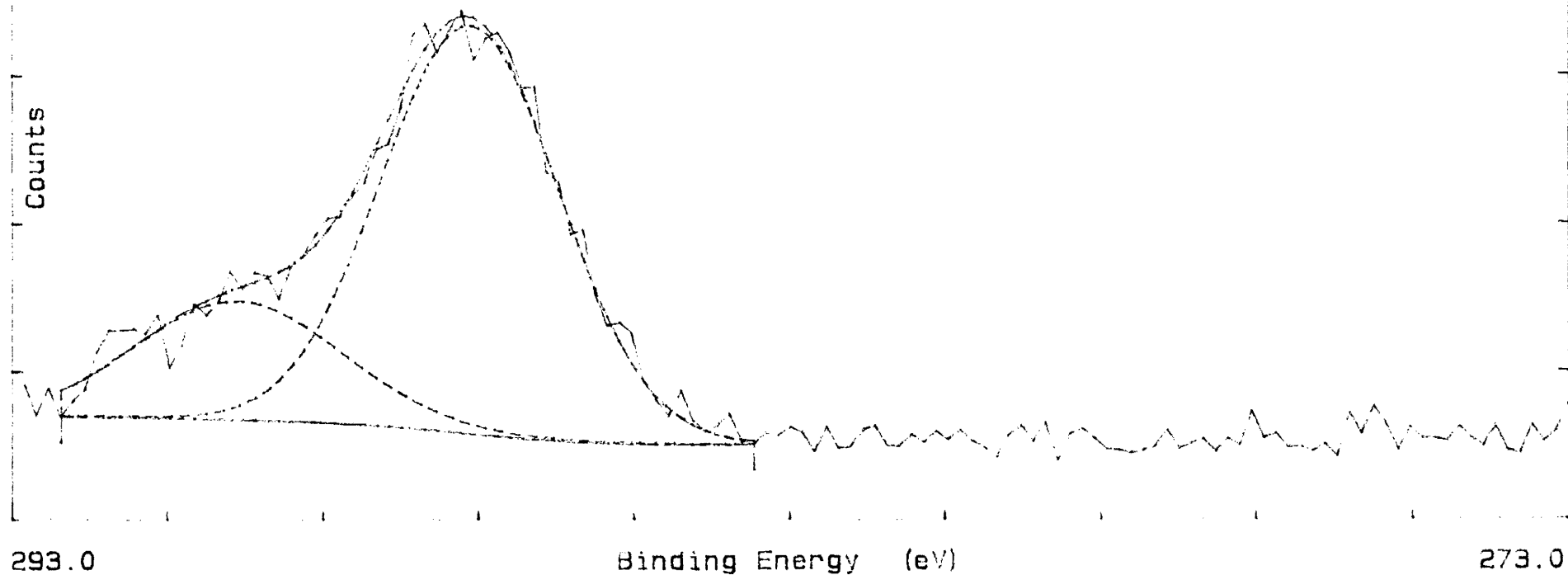


Figure 8

File: LDEF038	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description:	CM01-15 CONTROL MIRROR, SiOx on Al GENERAL SURVEY, BEFORE SPUTTERING		Operator: TAP

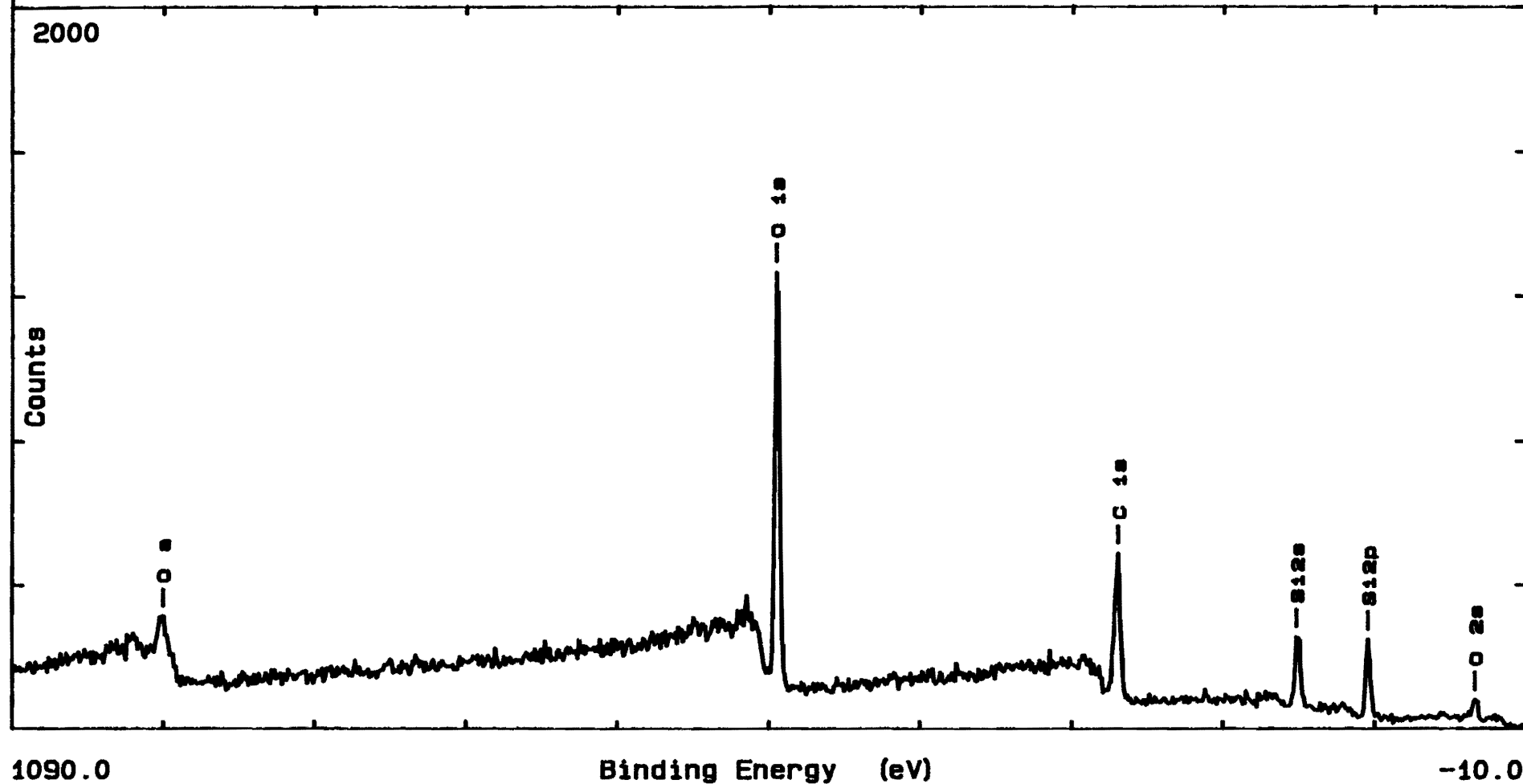


Figure 9

File: LDEF039	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM01-15 CONTROL MIRROR, SiO _x on Al GENERAL SURVEY, AFTER 2 MIN. SPUTTERING			Operator: TAP

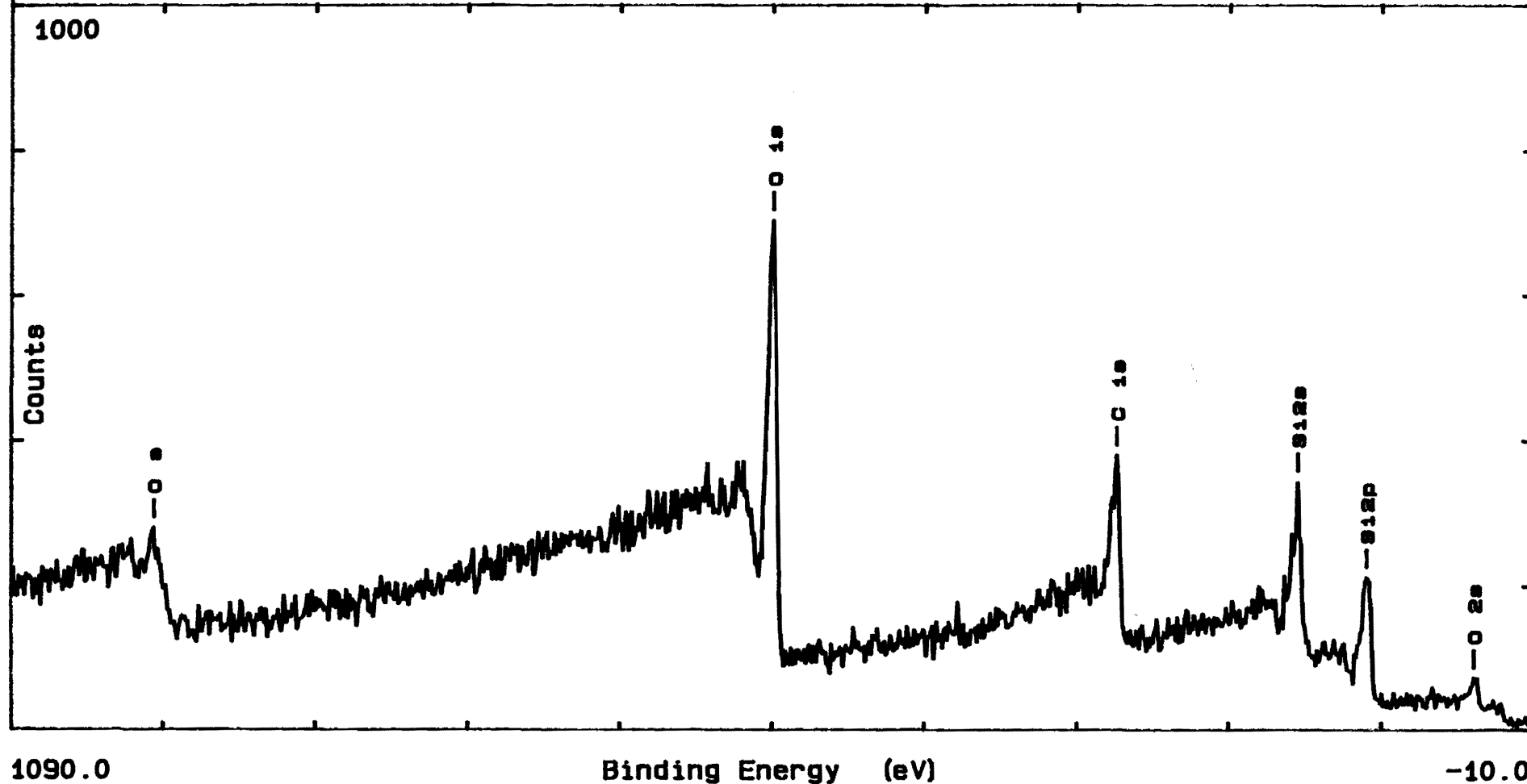


Figure 10

File: LDEF028

Date: 8/27/1992

Spot Size: 1000 μ

Flood Gun: 0.0 eV

Region 1

Disc: LDEF-1

of Scans: 1

Resolution: 1

Description: CM01-24 EXPOSED MIRROR, SiO_x on Al
CENTER REGION

Operator: TAP

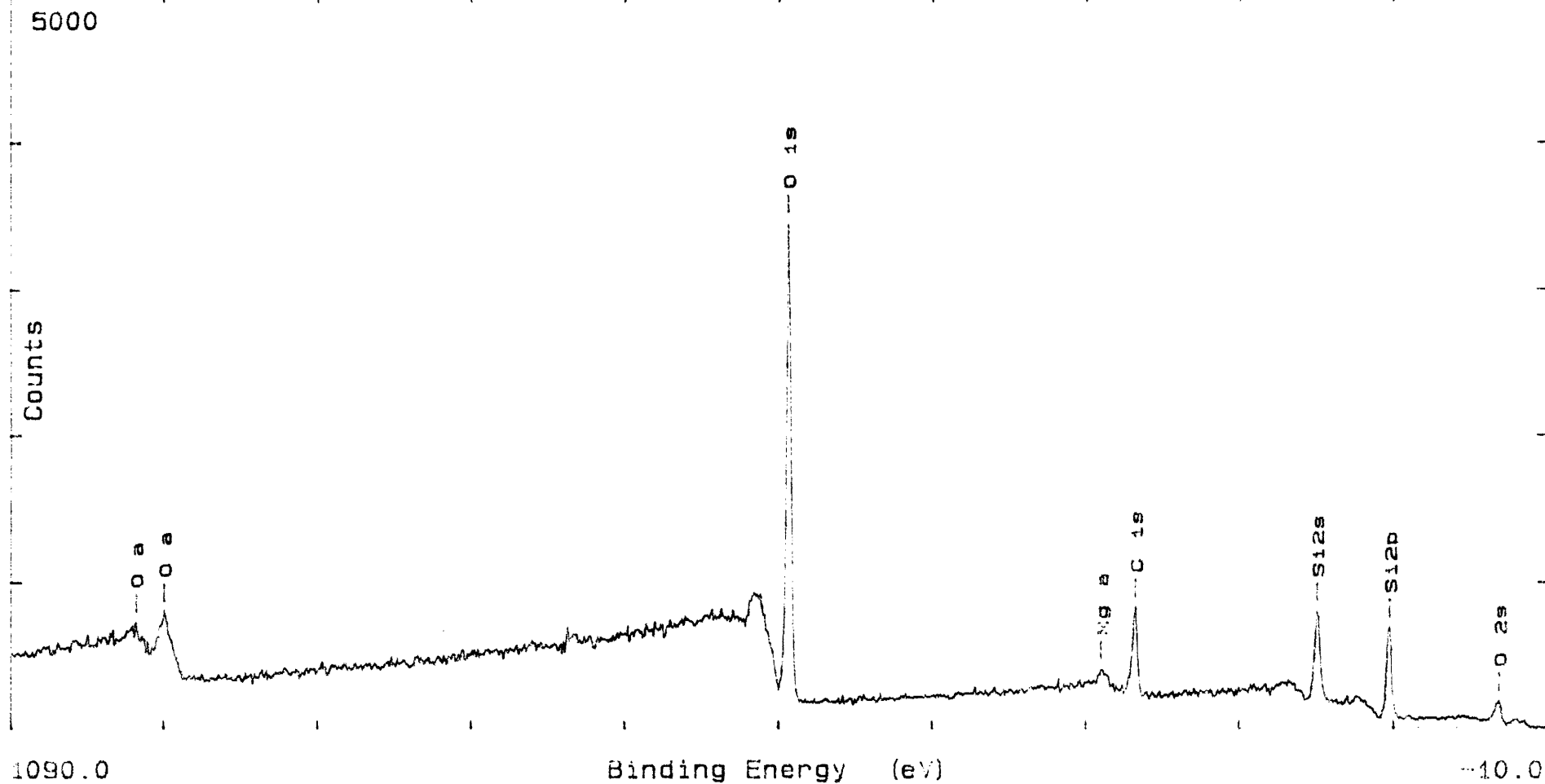


Figure 11

File: LDEF028	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-1	# of Scans: 3	Resolution: 2
Description: CM01-24 EXPOSED MIRROR, SiO ₂ on Al CENTER REGION, 0 1s SPECTRUM			Operator: TAP

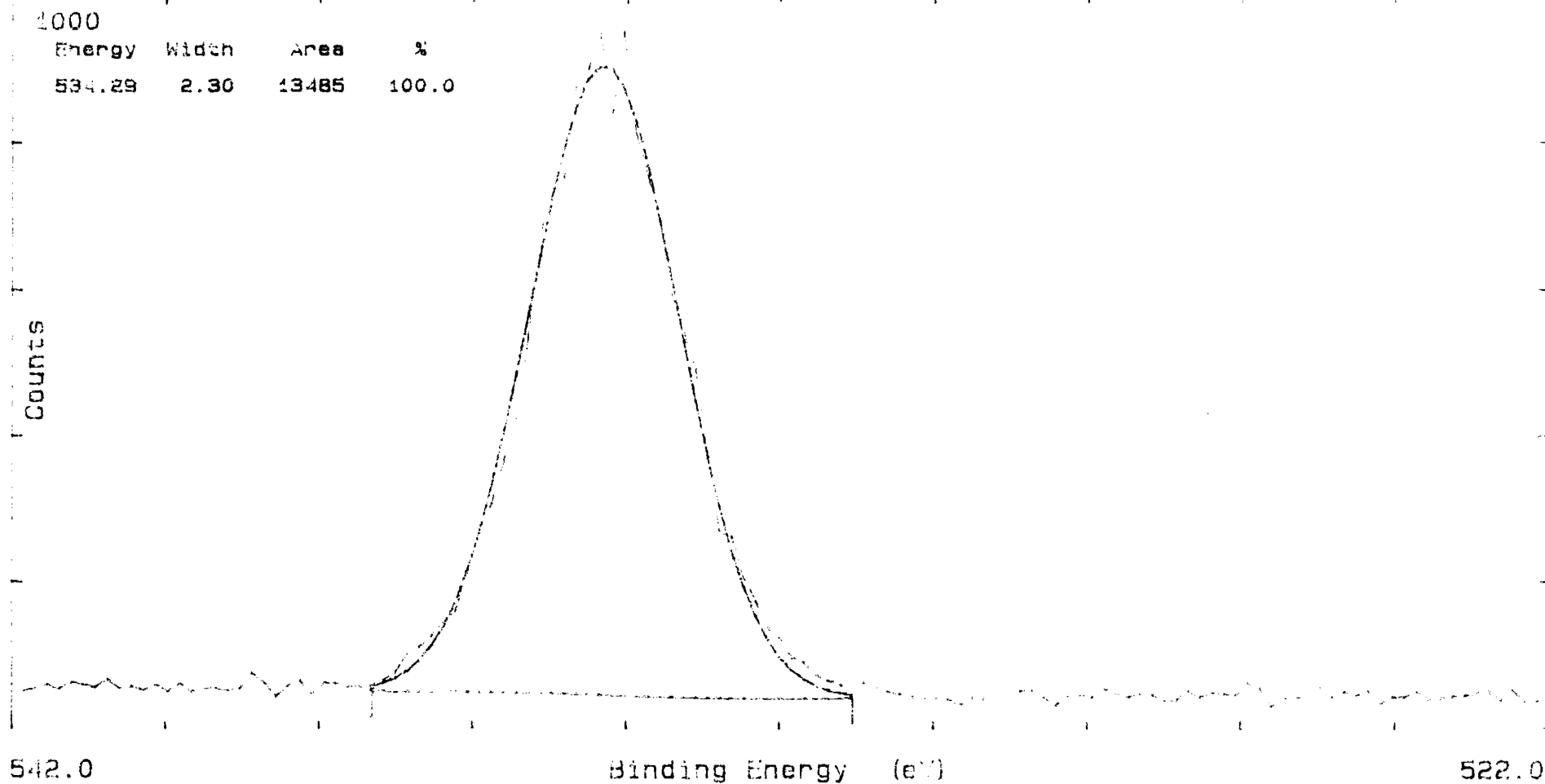


Figure 12

File: LDEF-028	Date: 8/27/1992	Spot Size: 300 μ	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: CM01-24 EXPOSED MIRROR, SiOX on Al			Operator: TAP
CENTER REGION, Si 2s SPECTRUM			

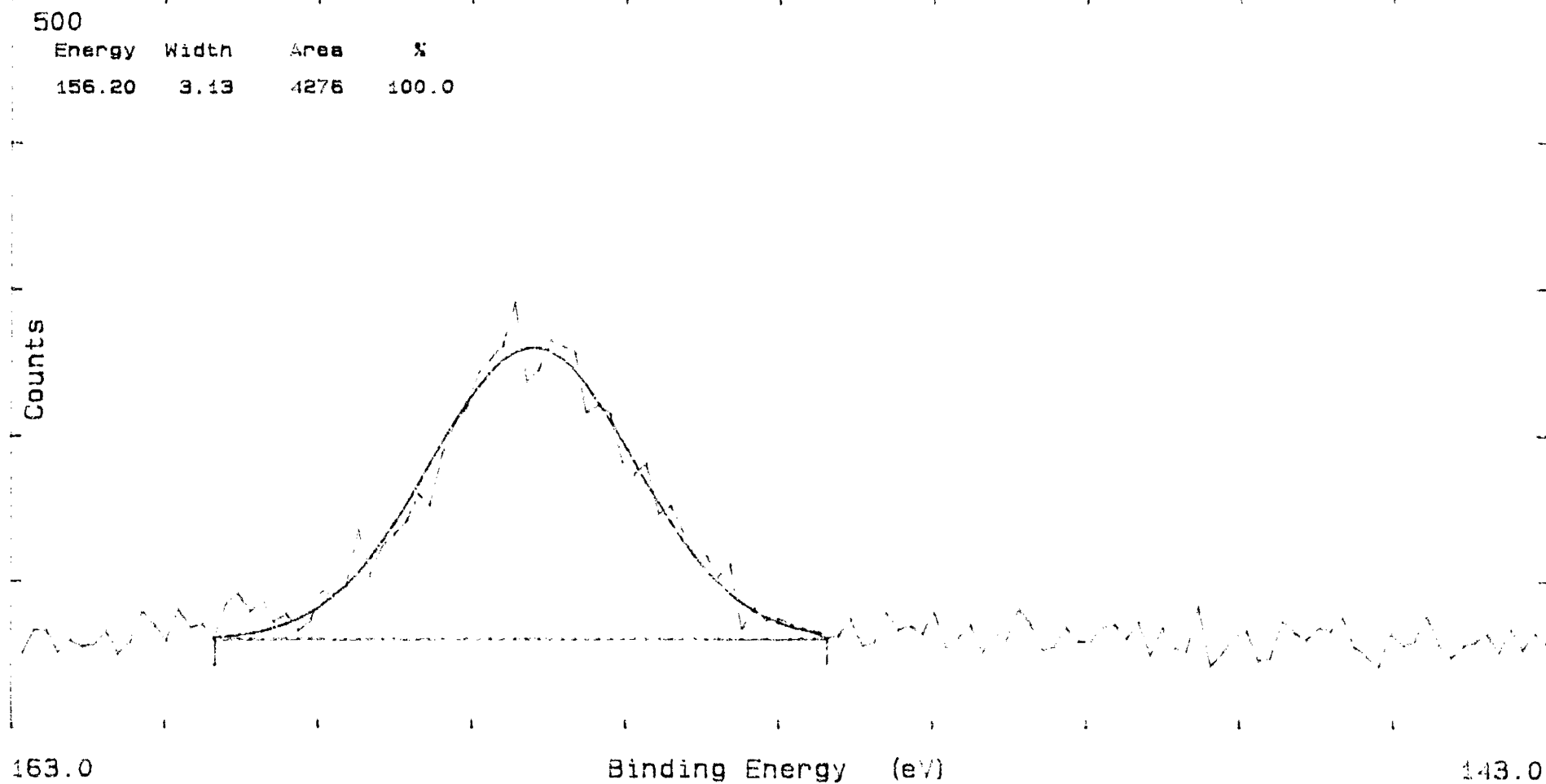


Figure 13

File: LDEF028

Date: 8/27/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 4

Disc: LDEF-1

of Scans: 5

Resolution: 2

Description: CM01-24 EXPOSED MIRROR, SiO₂ on Al
CENTER REGION, C 1s SPECTRUM

Operator: TAP

500

Energy	Width	Area	%
286.82	2.12	3947	100.0

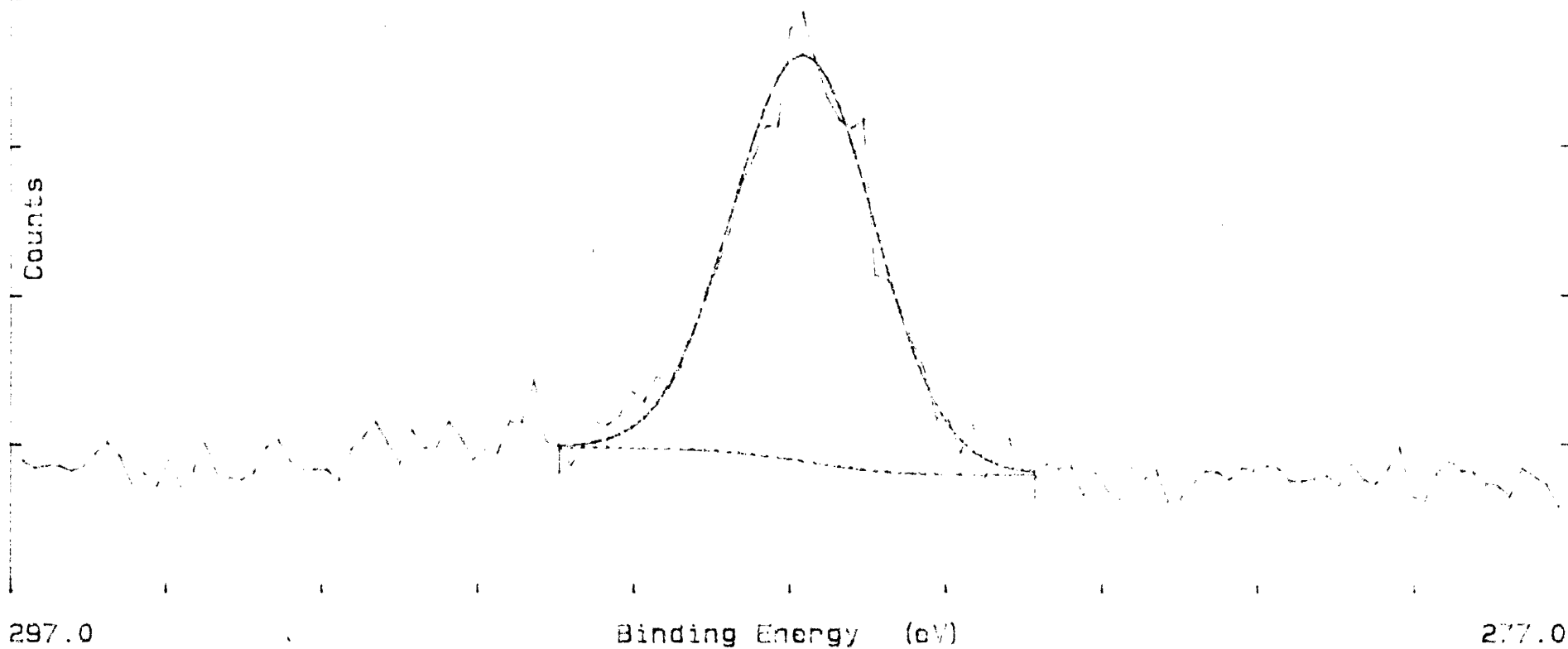


Figure 14

File: LDEF029

Date: 8/27/1992

Spot Size: 1000 μ

Flood Gun: 0.0 eV

Region 1

Disc: LDEF-1

of Scans: 1

Resolution: 4

Description: CM01-24 EXPOSED MIRROR, SiO₂ on Al
1/2 RADIUS FROM PERIMETER

Operator: TAP

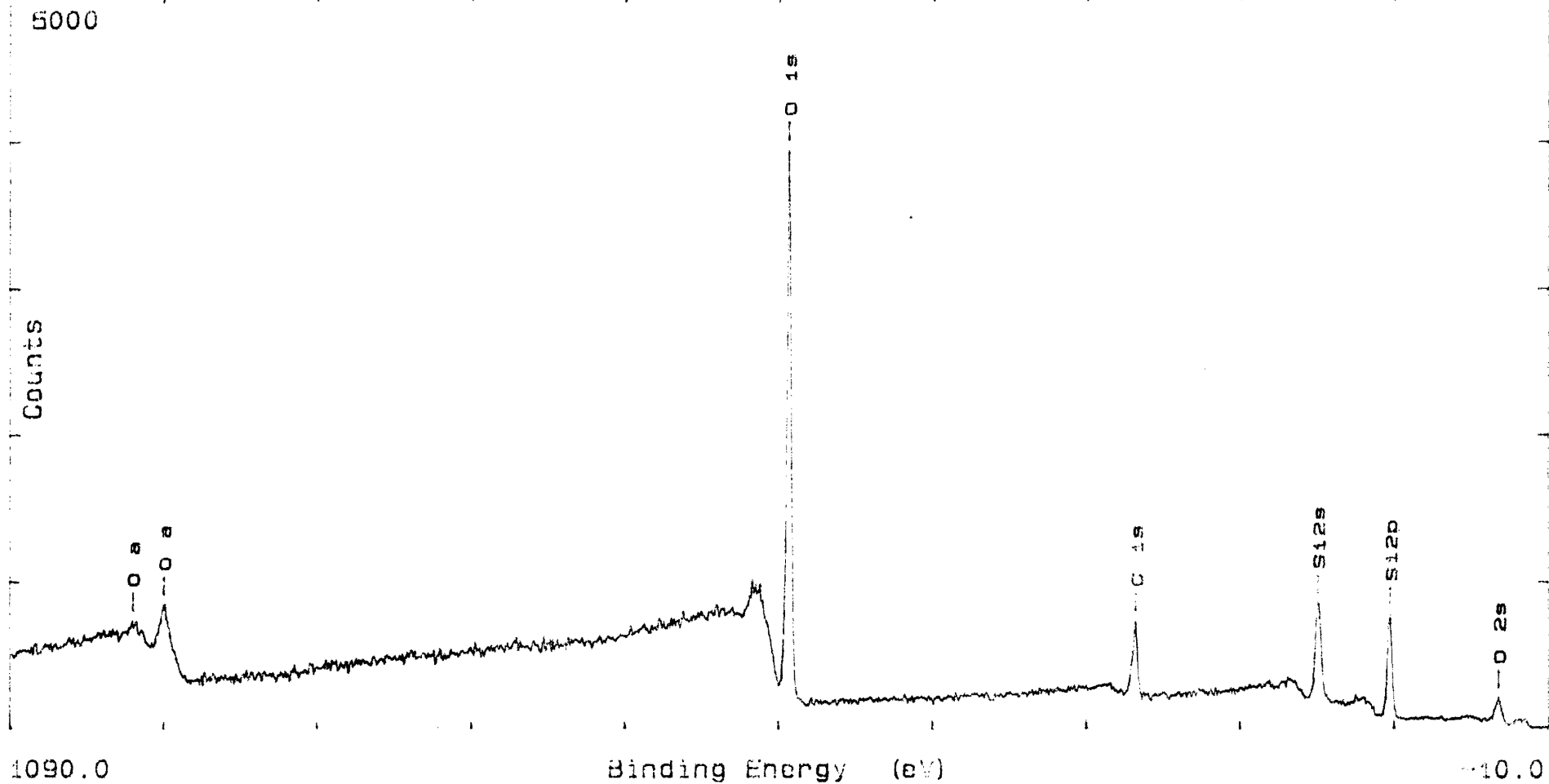


Figure 15

File: LDRF029	Date: 8/21/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDRF-1	# of Scans: 3	Resolution: 2
Description: CM01-21 EXPOSED MIRROR, SiO ₂ on Al			Operator: JAP
1/2 RADIUS FROM PERIMETER, 0 is SPECTRUM			

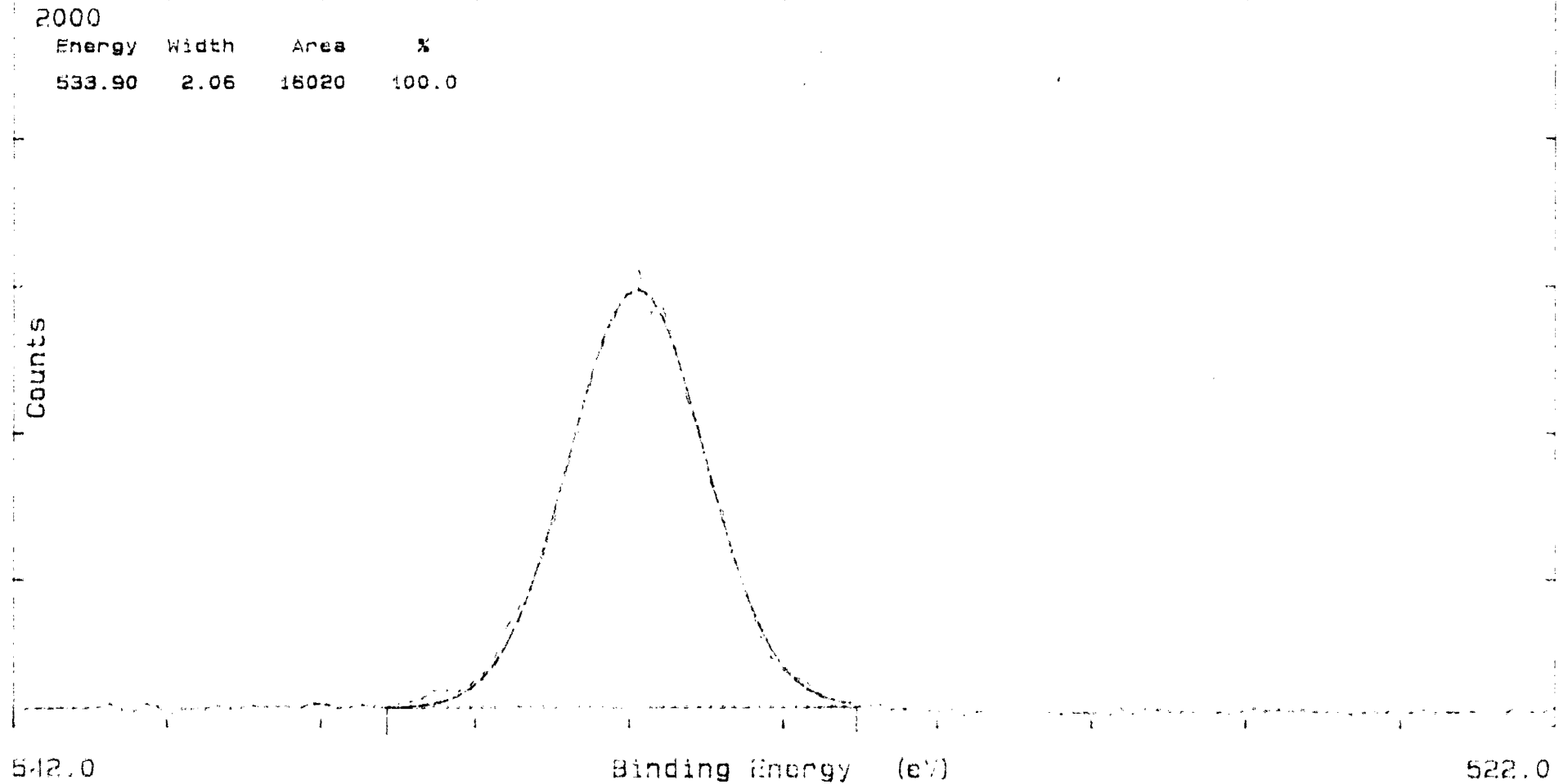


Figure 16

File: LDMF029 Date: 8/27/1992 Spot Size: 300 μ Flood Gun: 0.0 e
 Region 3 Disc: 10-1-1 # of Scans: 5 Resolution: 2
 Description: 5201-2-1 POSSED ERROR, SiO₂ on Al
 172 RADUS RADII, PARAMETER, Si 2s SPECTRUM

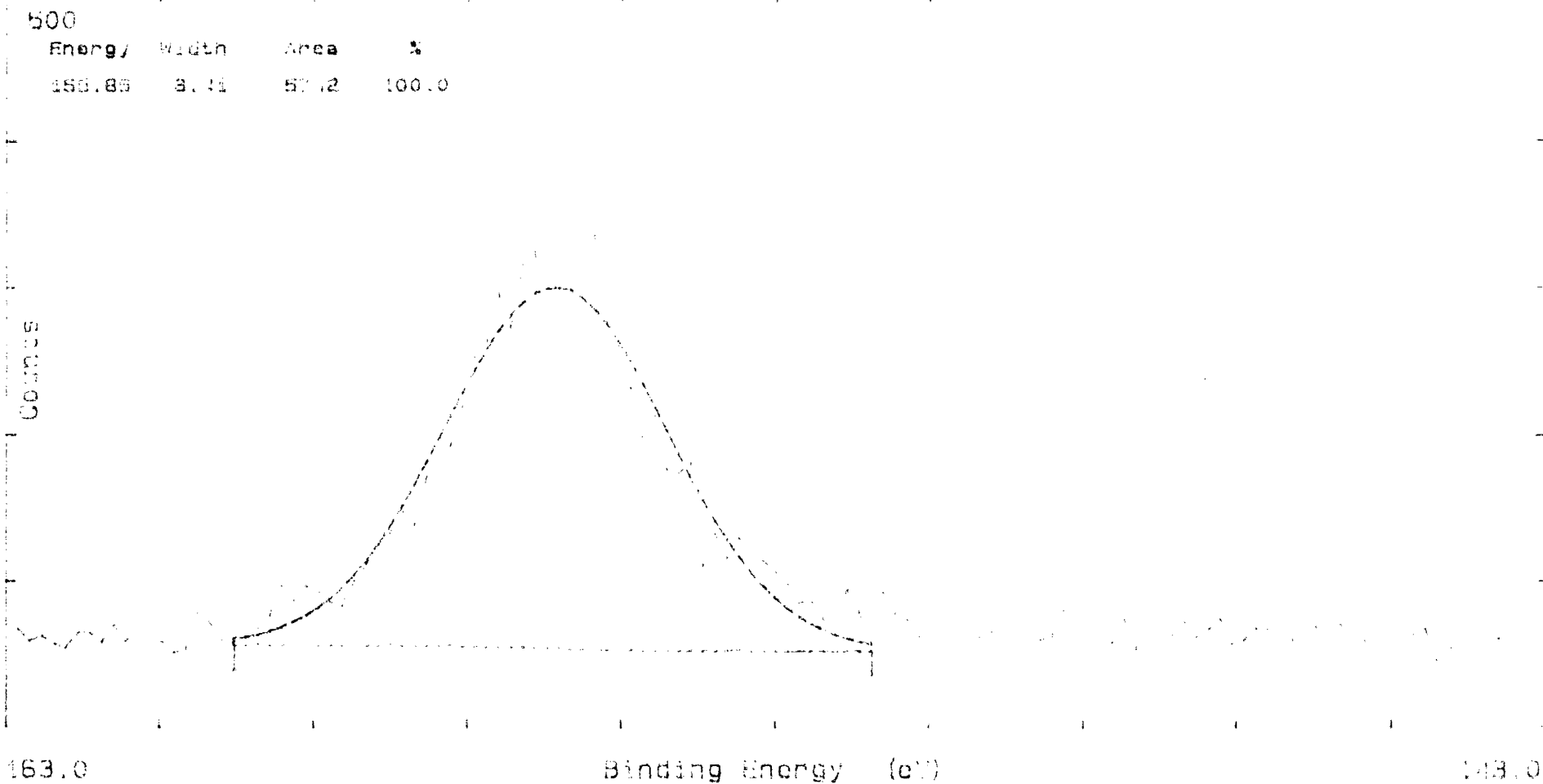


Figure 17

File: LDEF029	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region: 1	Disc: LDEF-1	# of Scans: 5	Resolution: 2
Description: CN01-24 EXPOSED MIRROR, SiO ₂ on Al 1/2 RADIUS FROM PERIMETER, C 1s SPECTRUM			Operator: TAP

Energy	Width	Area	%
286.50	2.50	3821	100.0

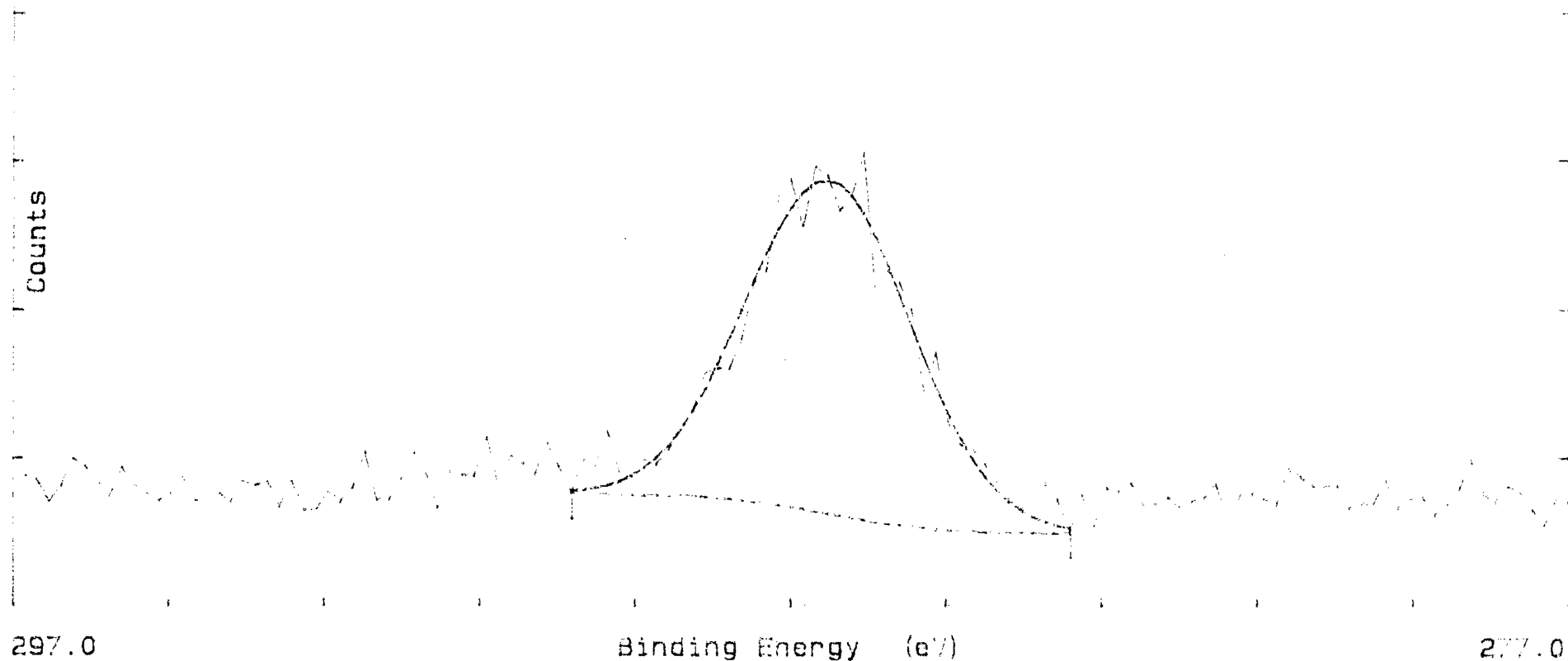


Figure 18

File: LDEF040	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM01-24 EXPOSED MIRROR, SiO _x on Al GENERAL SURVEY, BEFORE SPUTTERING			Operator: TAP

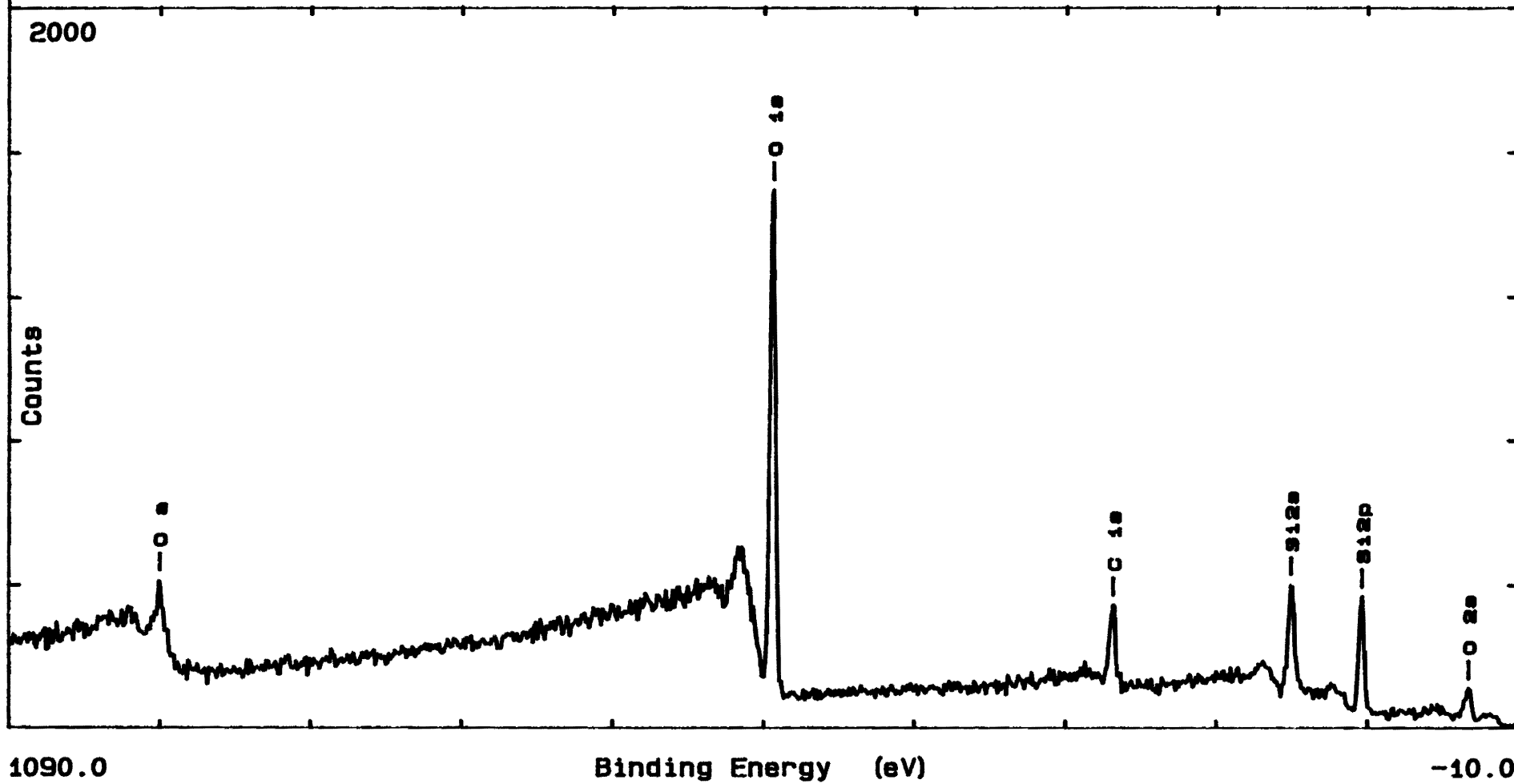


Figure 19

File: LDEF041

Date: 9/3/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Disc: LDEF-2

of Scans: 2

Resolution: 4

Description: CM01-24 EXPOSED MIRROR, SiO_x on Al
GENERAL SURVEY, 2 MIN. SPUTTERING

Operator: TAP

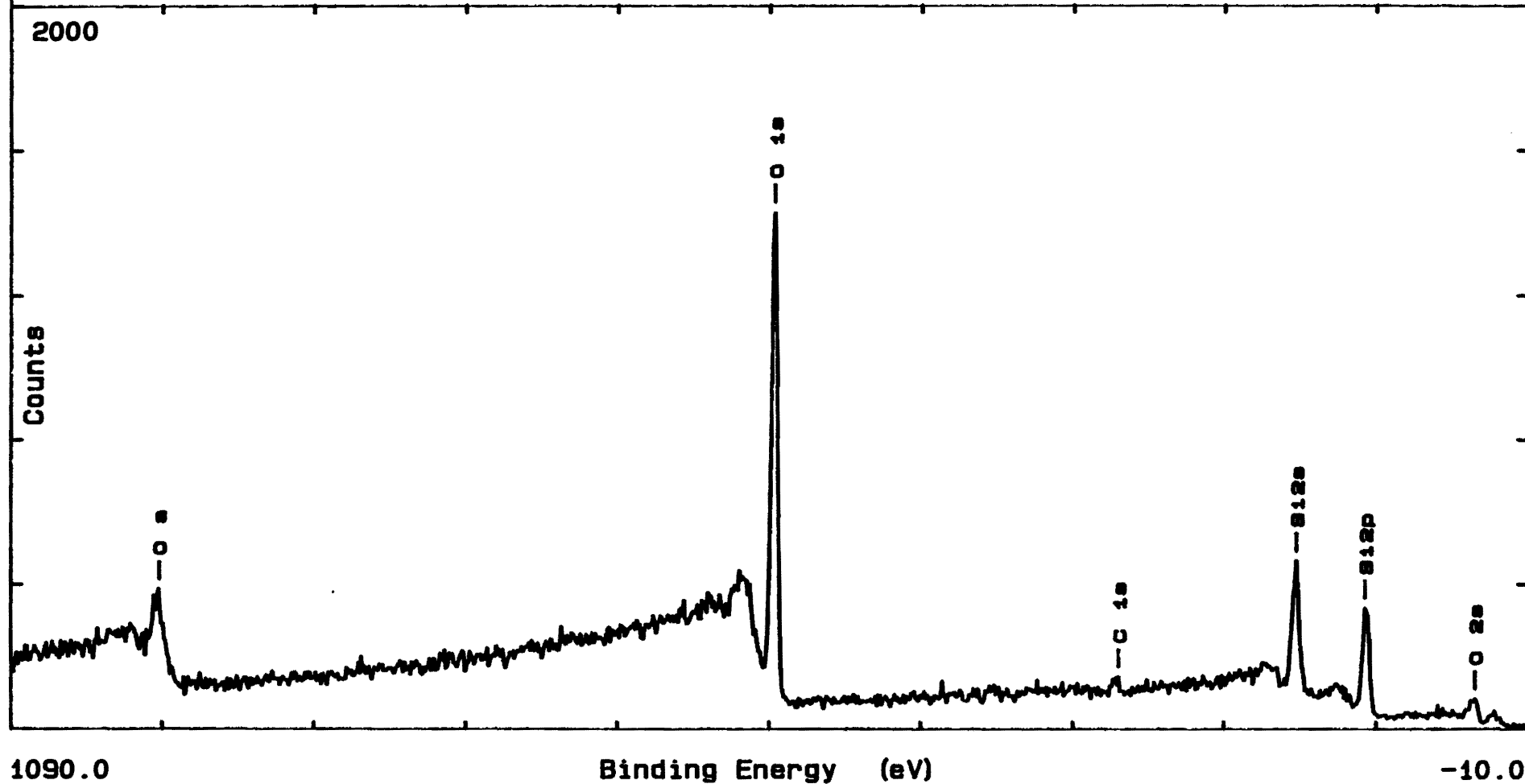


Figure 20

File: LDEF033	Date: 8/28/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: CM01-31 EXPOSED MIRROR (WINDOWED), SiO _x on Al CENTER REGION			Operator: TAP

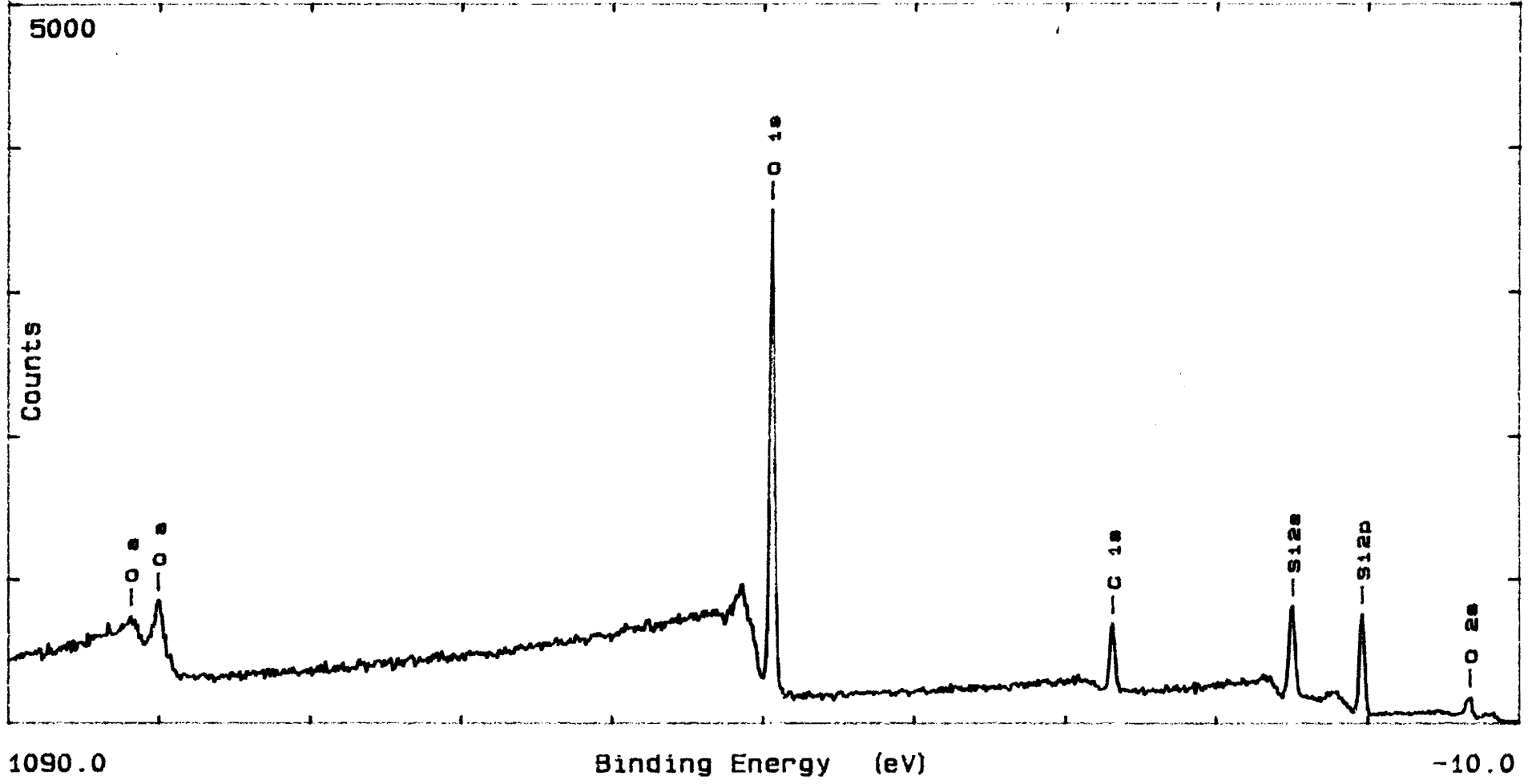


Figure 21

File: LDEF034

Date: 8/28/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Disc: LDEF-2

of Scans: 5

Resolution: 2

Description: CM01-31 EXPOSED MIRROR (WINDOWED), SiO_x on Al
CENTER REGION, Si 2s SPECTRUM

Operator: TAP

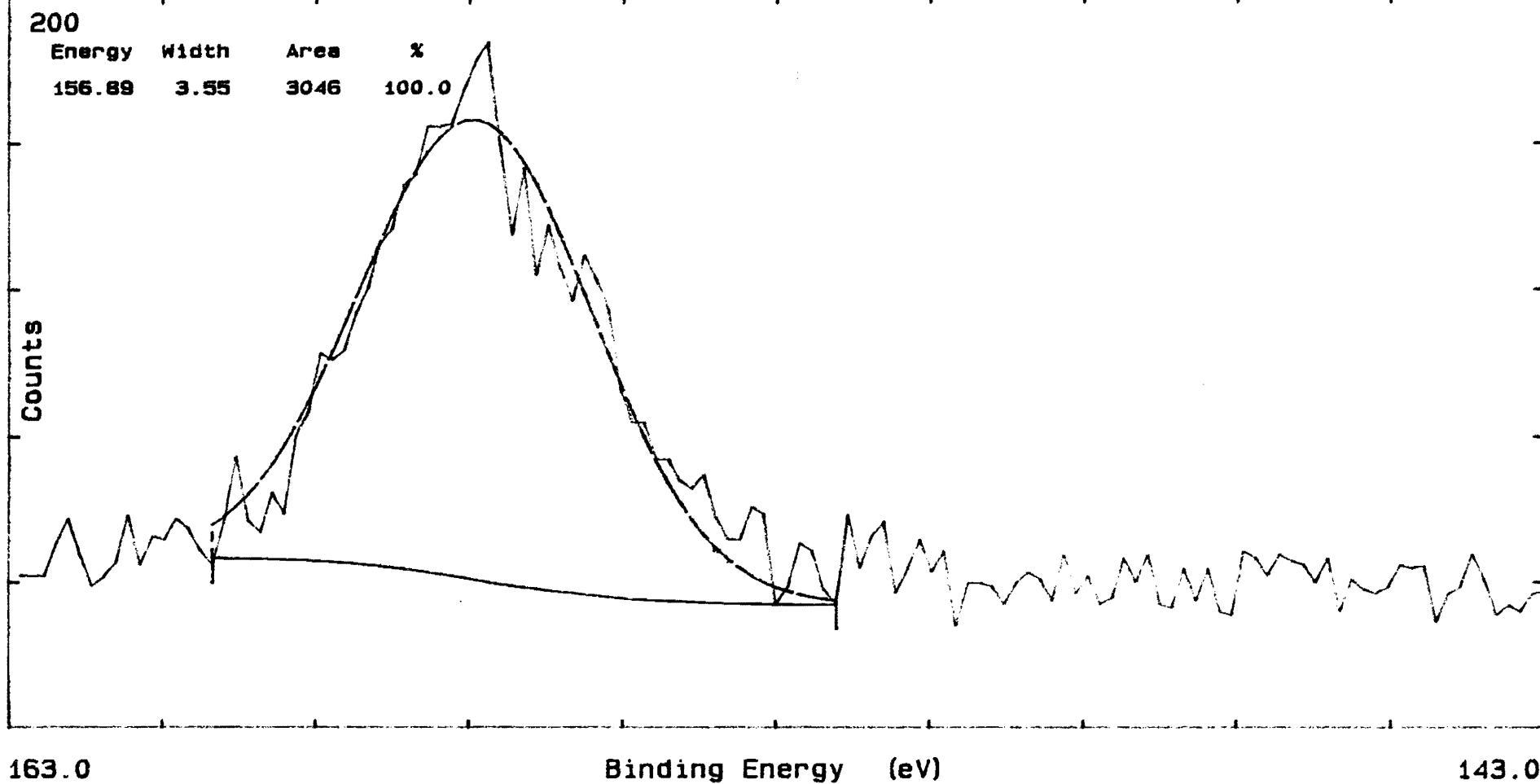


Figure 22

File: LDEF033

Date: 8/28/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-2

of Scans: 3

Resolution: 2

Description: CM01-31 EXPOSED MIRROR (WINDOWED). SiO_x on Al
CENTER REGION, 0 1s SPECTRUM

Operator: TAP

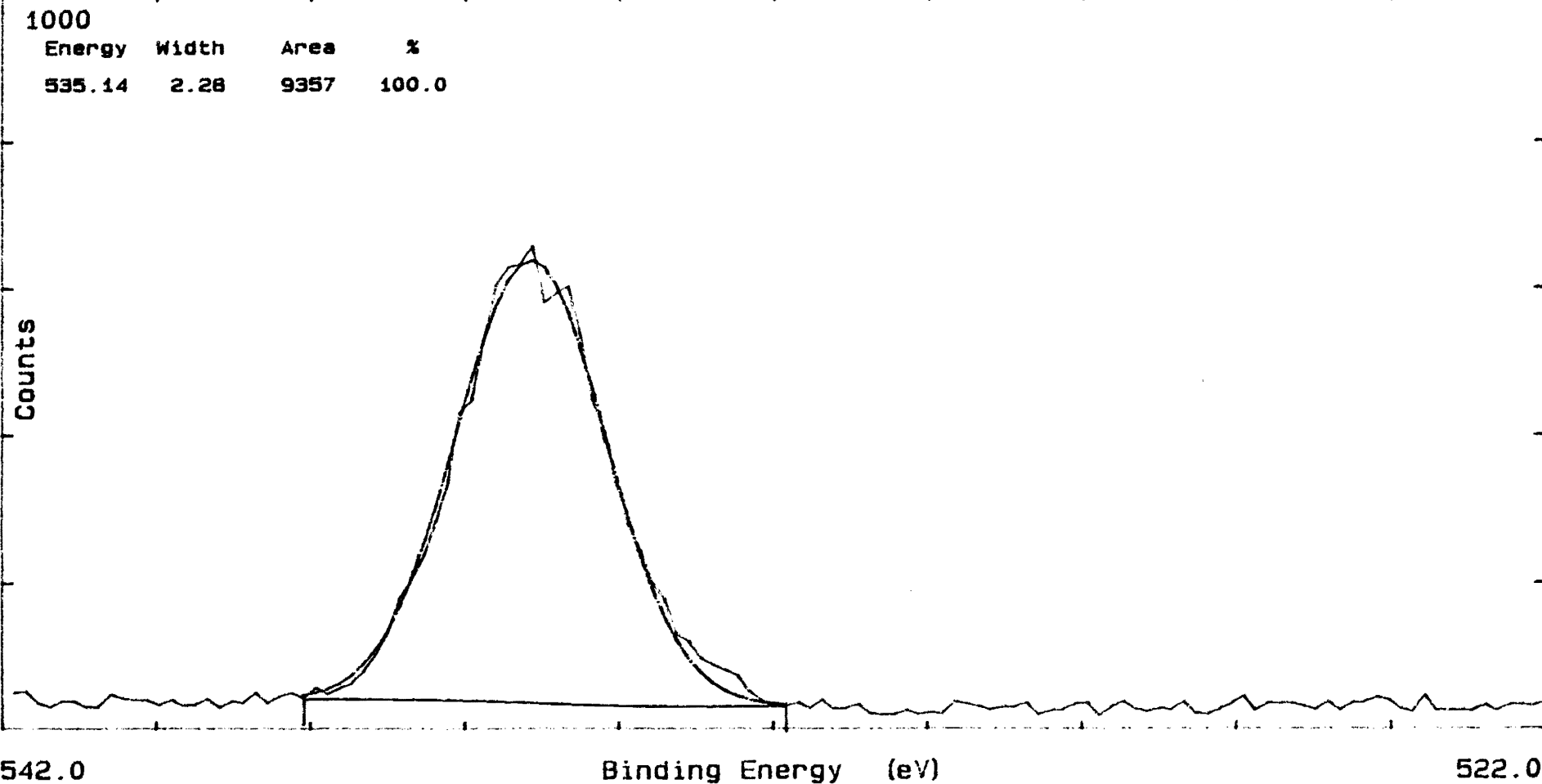


Figure 23

File: LDEF035	Date: 8/28/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: CM01-31 EXPOSED MIRROR (WINDOWED), SiO _x on Al 1/2 PERIMETER FROM CENTER			Operator: TAP

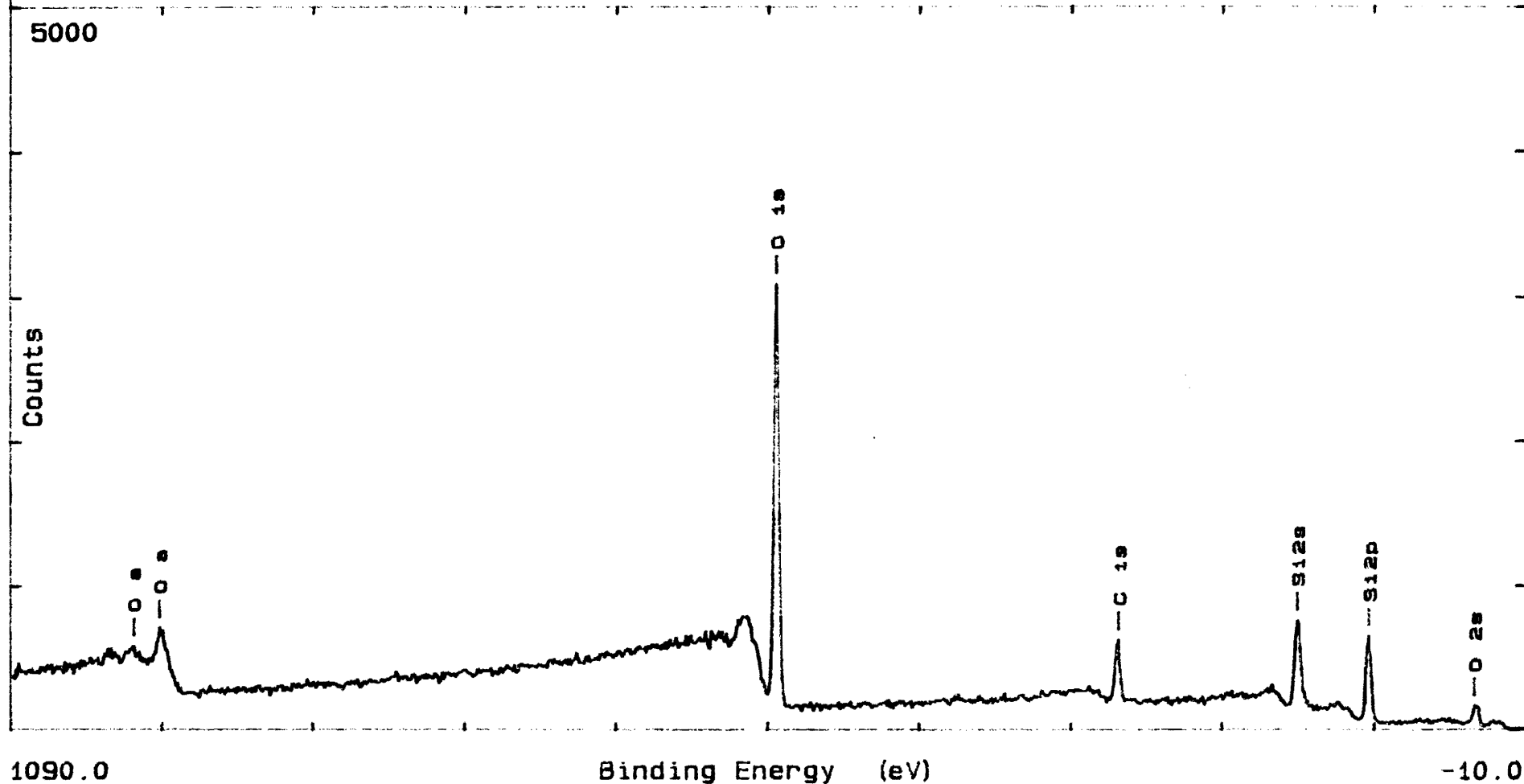


Figure 24

File: LDEF035

Date: 8/28/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-2

of Scans: 3

Resolution: 2

Description: CM01-31 EXPOSED MIRROR (WINDOWED), SiO_x on Al
1/2 PERIMETER FROM CENTER, 0 1s SPECTRUM

Operator: TAP

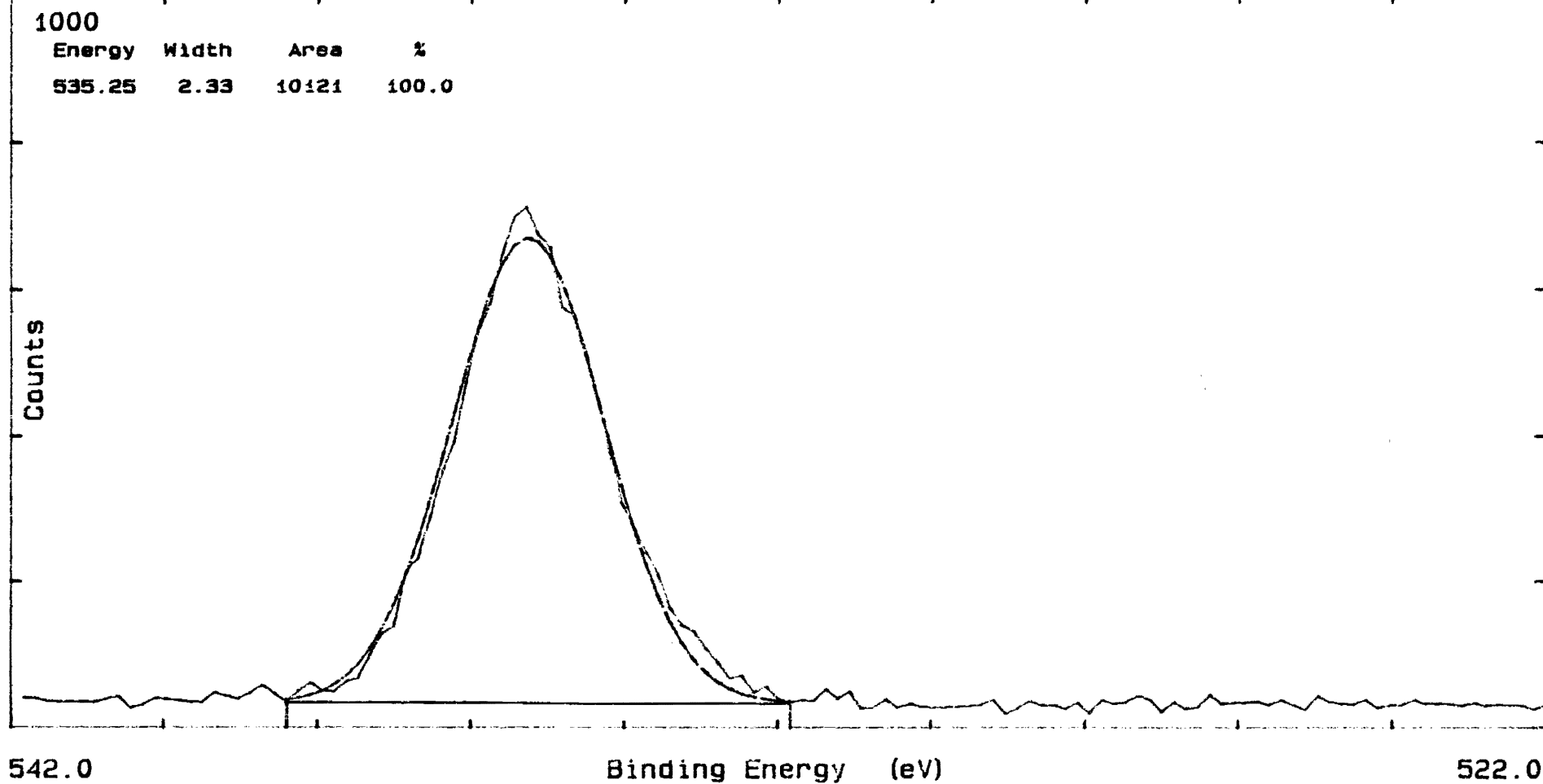


Figure 25

File: LDEF035

Date: 8/28/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 3

Disc: LDEF-2

of Scans: 5

Resolution: 2

Description: CM01-31 EXPOSED MIRROR (WINDOWED), SiO_x on Al
1/2 PERIMETER FROM CENTER, Si 2s SPECTRUM

Operator: TAP

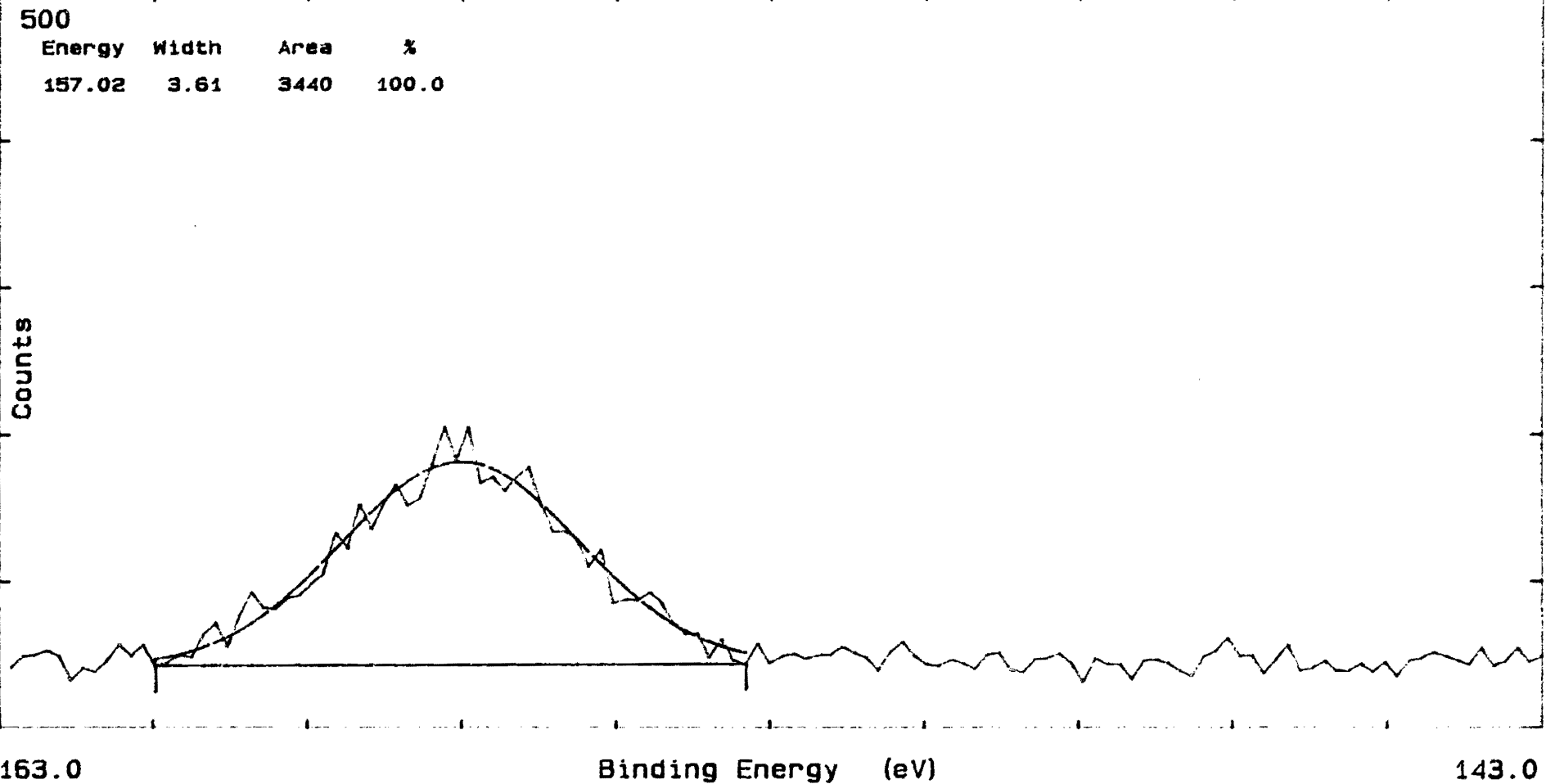


Figure 26

File: LDEF042	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4

Description: CM01-31 EXPOSED MIRROR, SiO_x on Al
 GENERAL SURVEY. BEFORE SPUTTERING

Operator: TAP

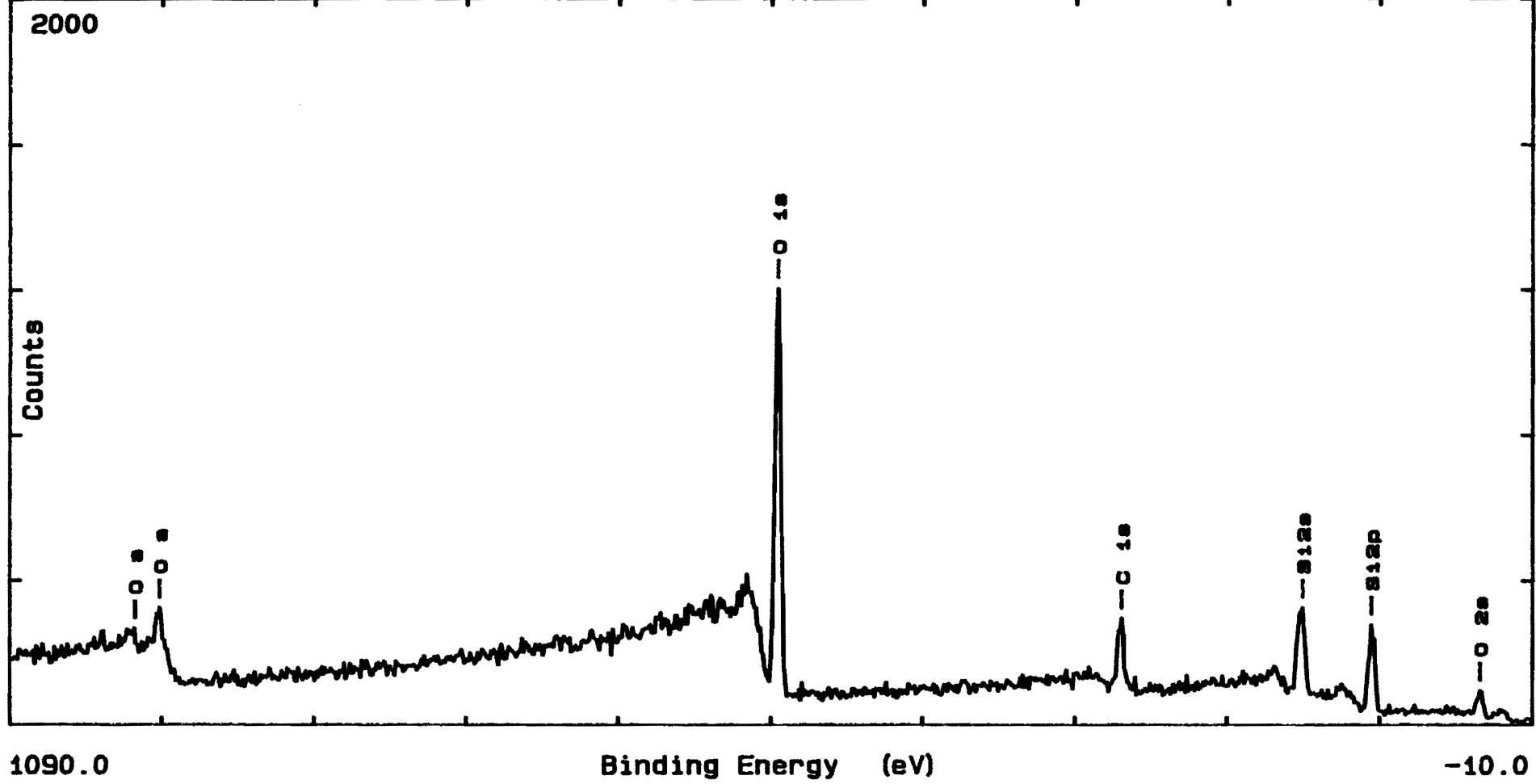


Figure 27

File: LDEF043	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM01-31 EXPOSED MIRROR, SiO _x on Al GENERAL SURVEY, 2 MIN. SPUTTERING	Operator: TAP		

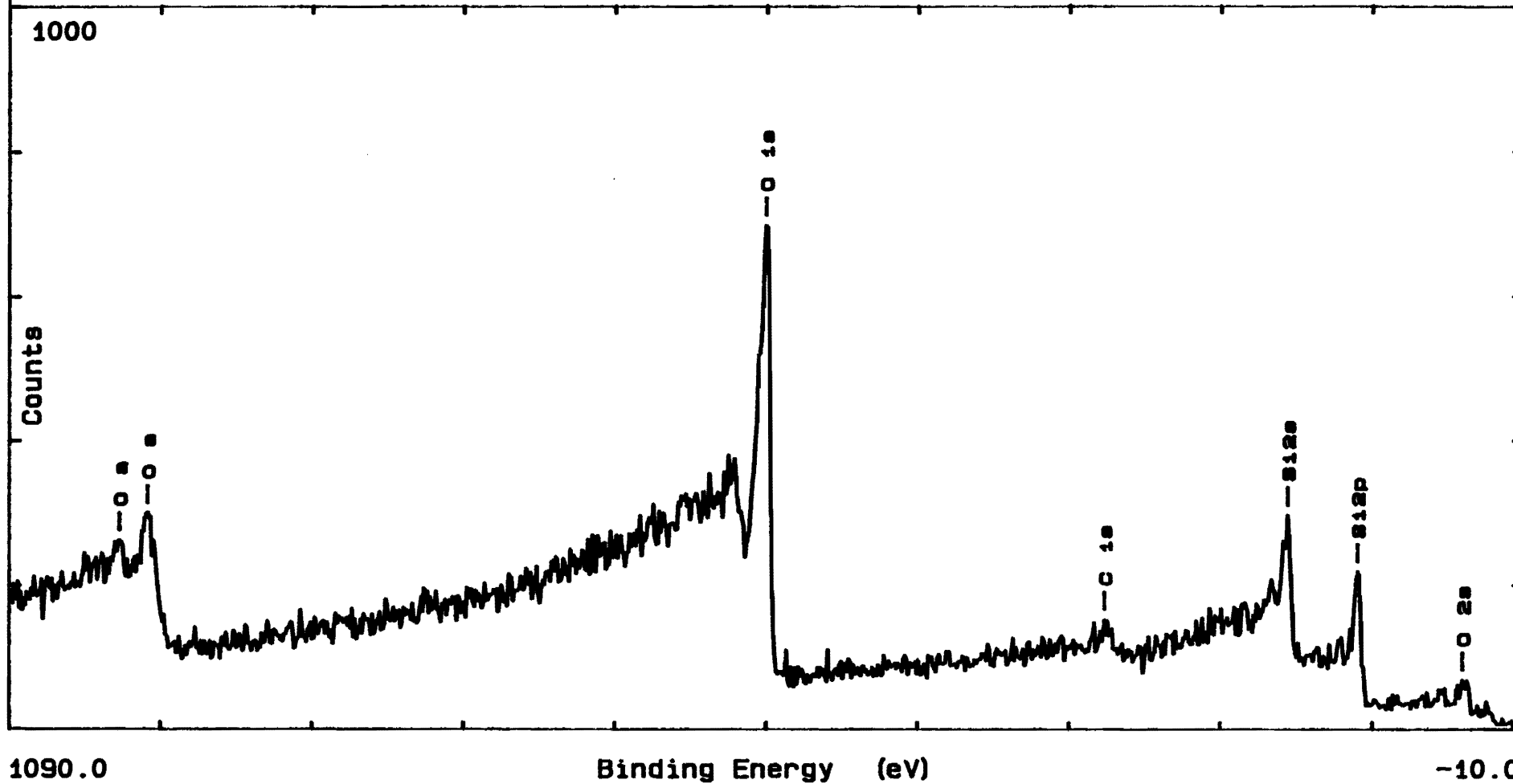


Figure 28

File: LDEF030	Date: 8/27/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al CENTER REGION			Operator: TAP

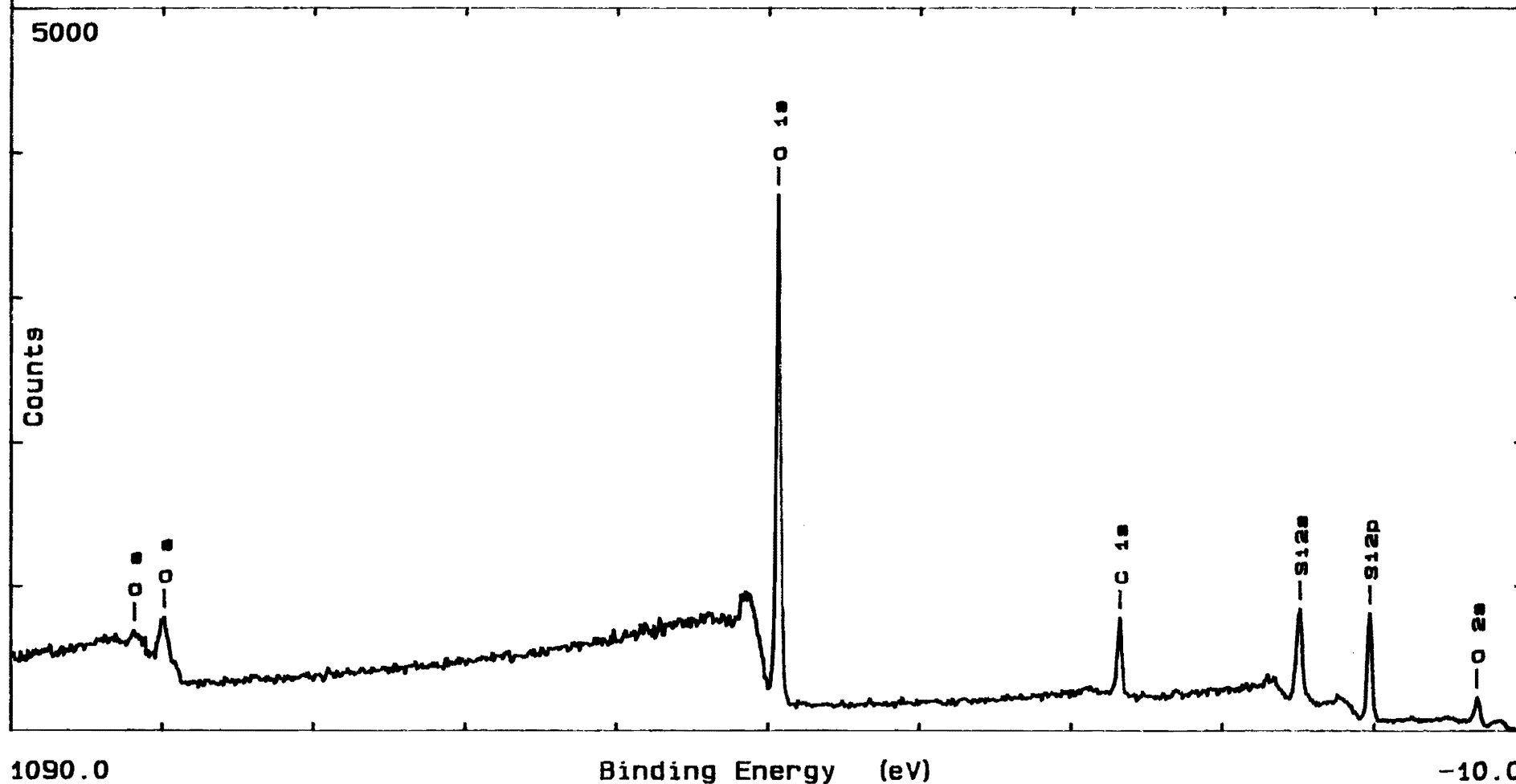


Figure 29

File: LDEF030	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-2	# of Scans: 3	Resolution: 2
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al CENTER REGION, O 1s SPECTRUM			Operator: TAP

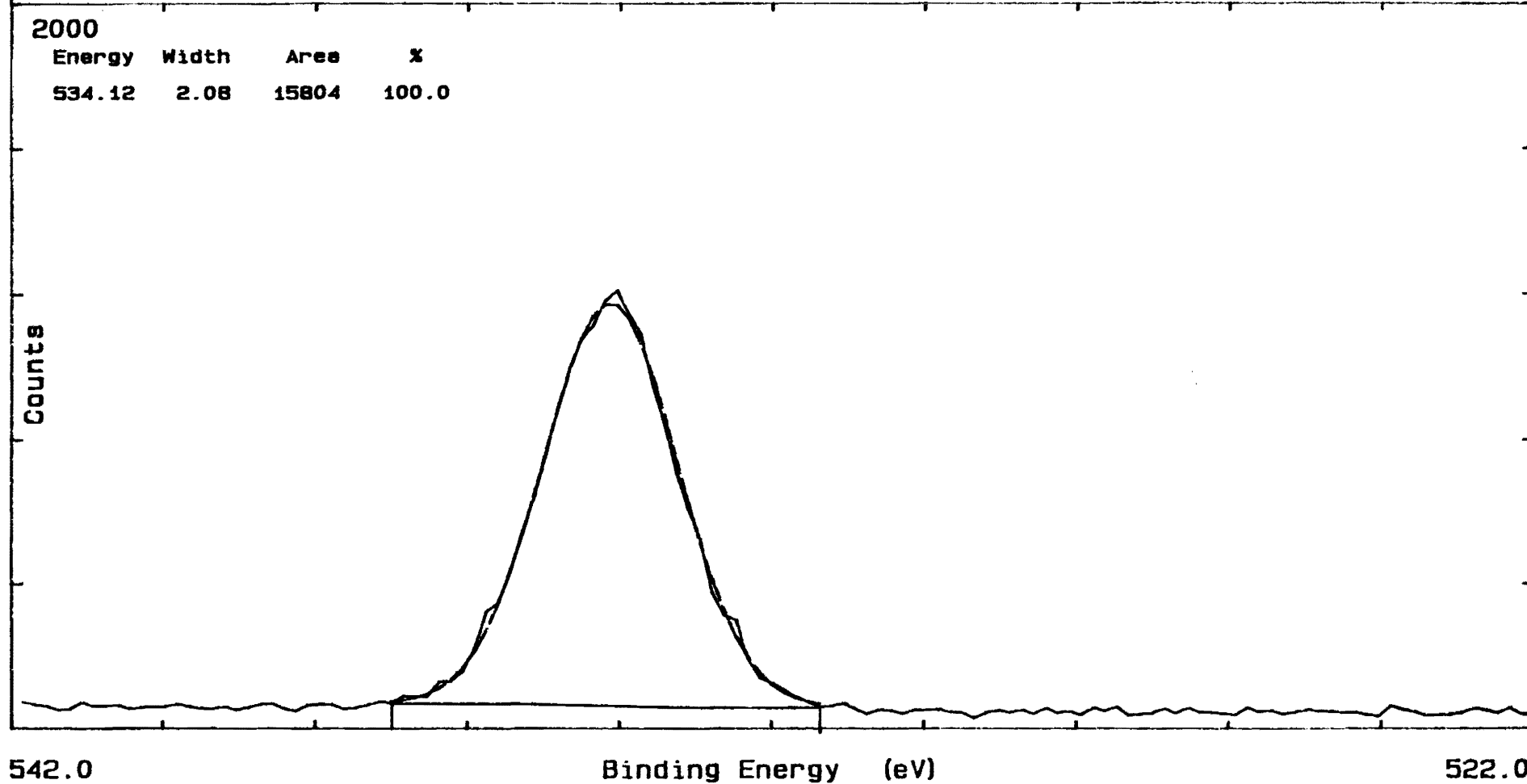


Figure 30

File: LDEF030	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-2	# of Scans: 5	Resolution: 2
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al CENTER REGION, Si 2s SPECTRUM			Operator: TAP

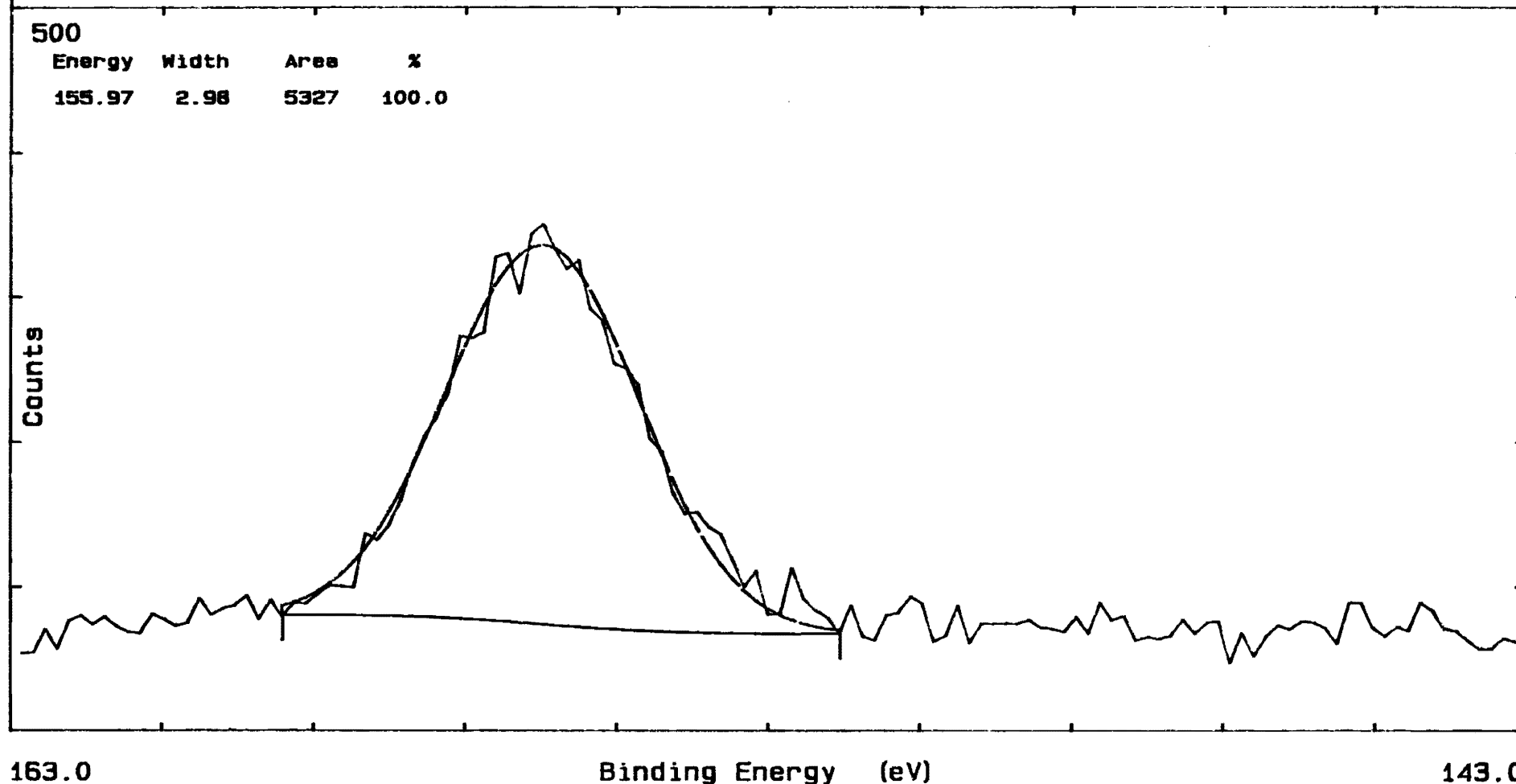


Figure 31

File: LDEF030	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 4	Disc: LDEF-2	# of Scans: 5	Resolution: 2
Description:	CM01-45 EXPOSED MIRROR, SiOx on Al		Operator: TAP
	CENTER REGION, C 1s SPECTRUM		

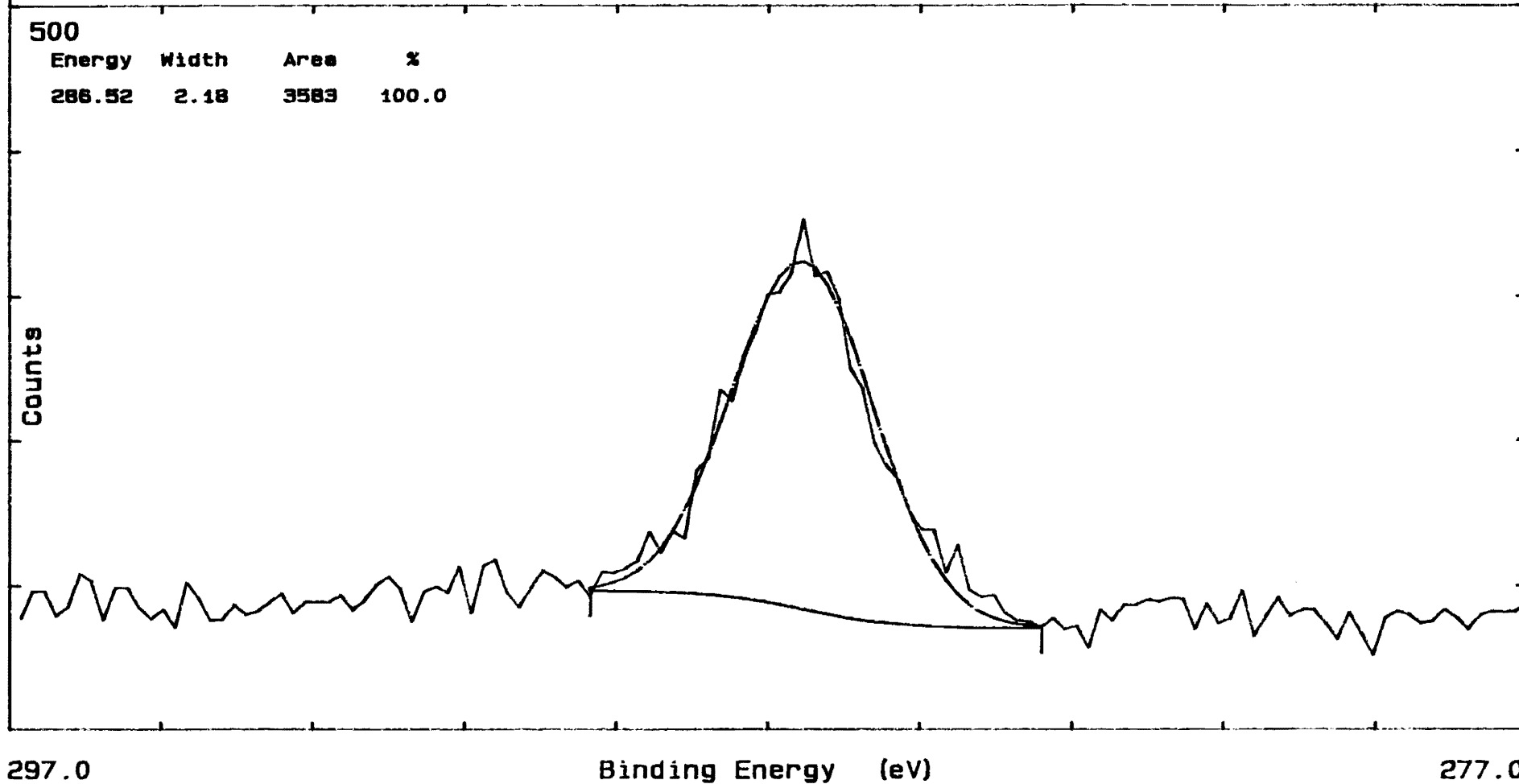


Figure 32

File: LDEF031	Date: 8/27/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al 1/2 RADIUS FROM PERIMETER			Operator: TAP

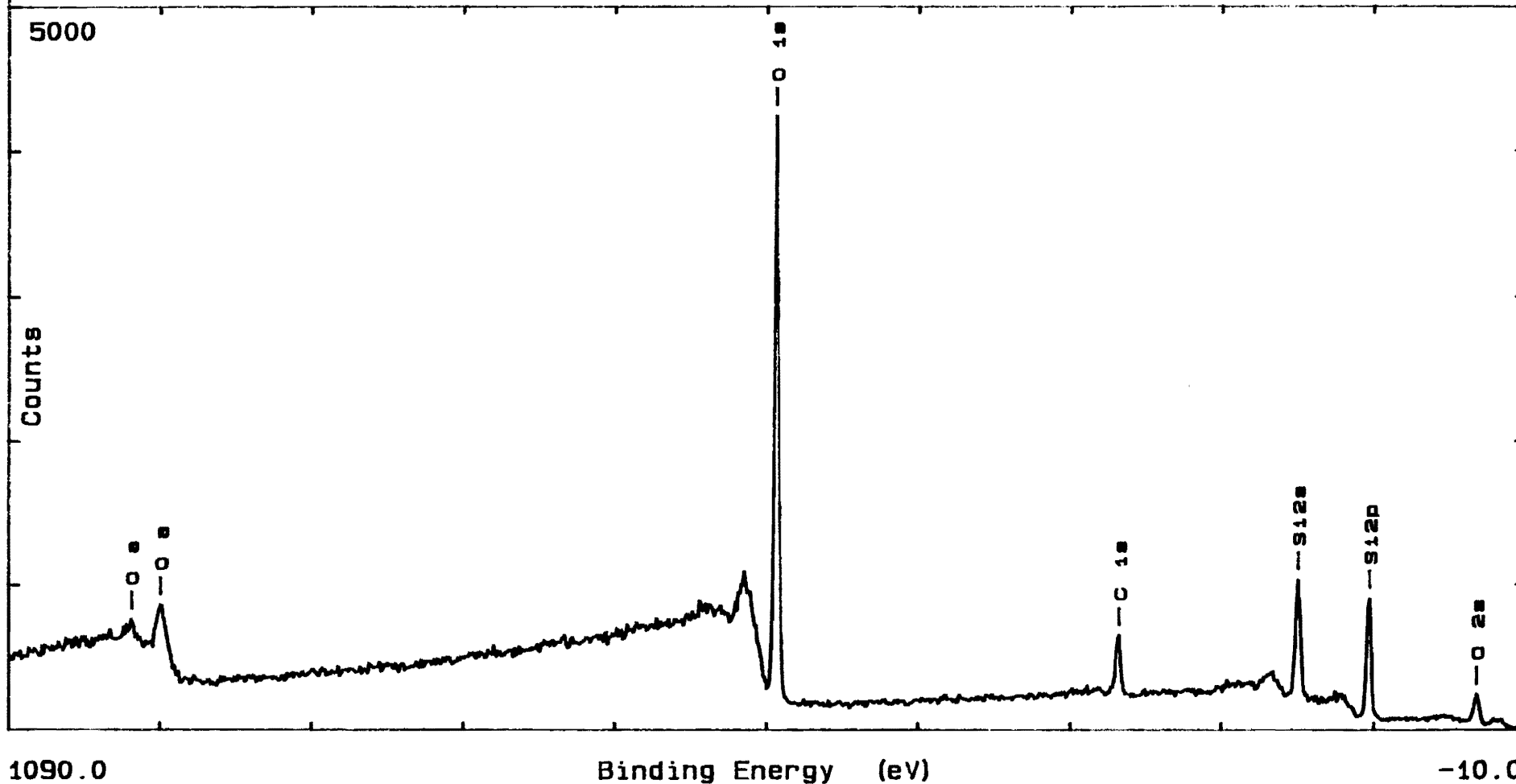


Figure 33

File: LDEF031	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 2	Disc: LDEF-2	# of Scans: 3	Resolution: 2
Description:	CM01-45 EXPOSED MIRROR, SiOx on Al		Operator: TAP
	1/2 RADIUS FROM PERIMETER, 0 1s SPECTRUM		

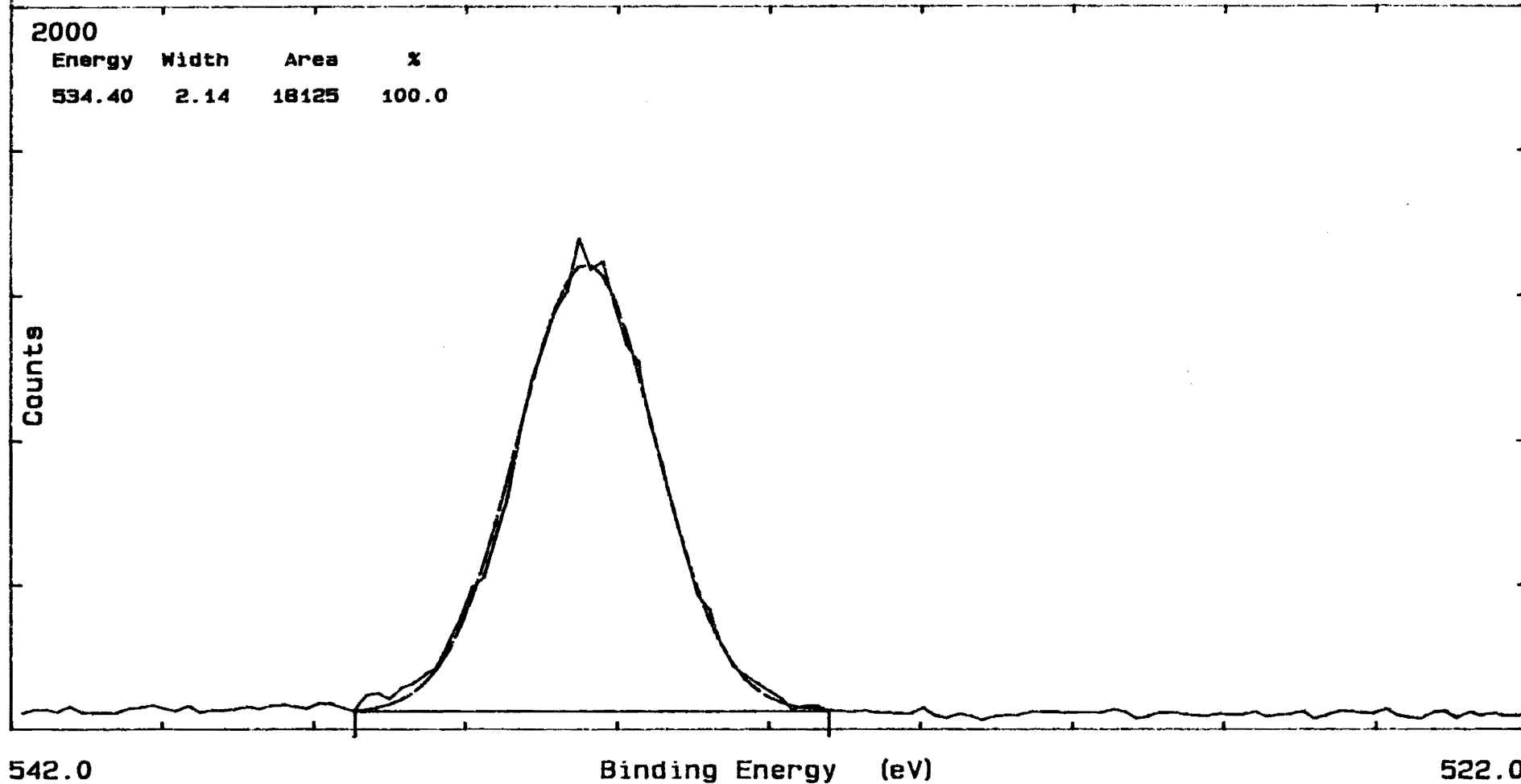


Figure 34

File: LDEF031	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 3	Disc: LDEF-2	# of Scans: 5	Resolution: 2
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al 1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM			Operator: TAP

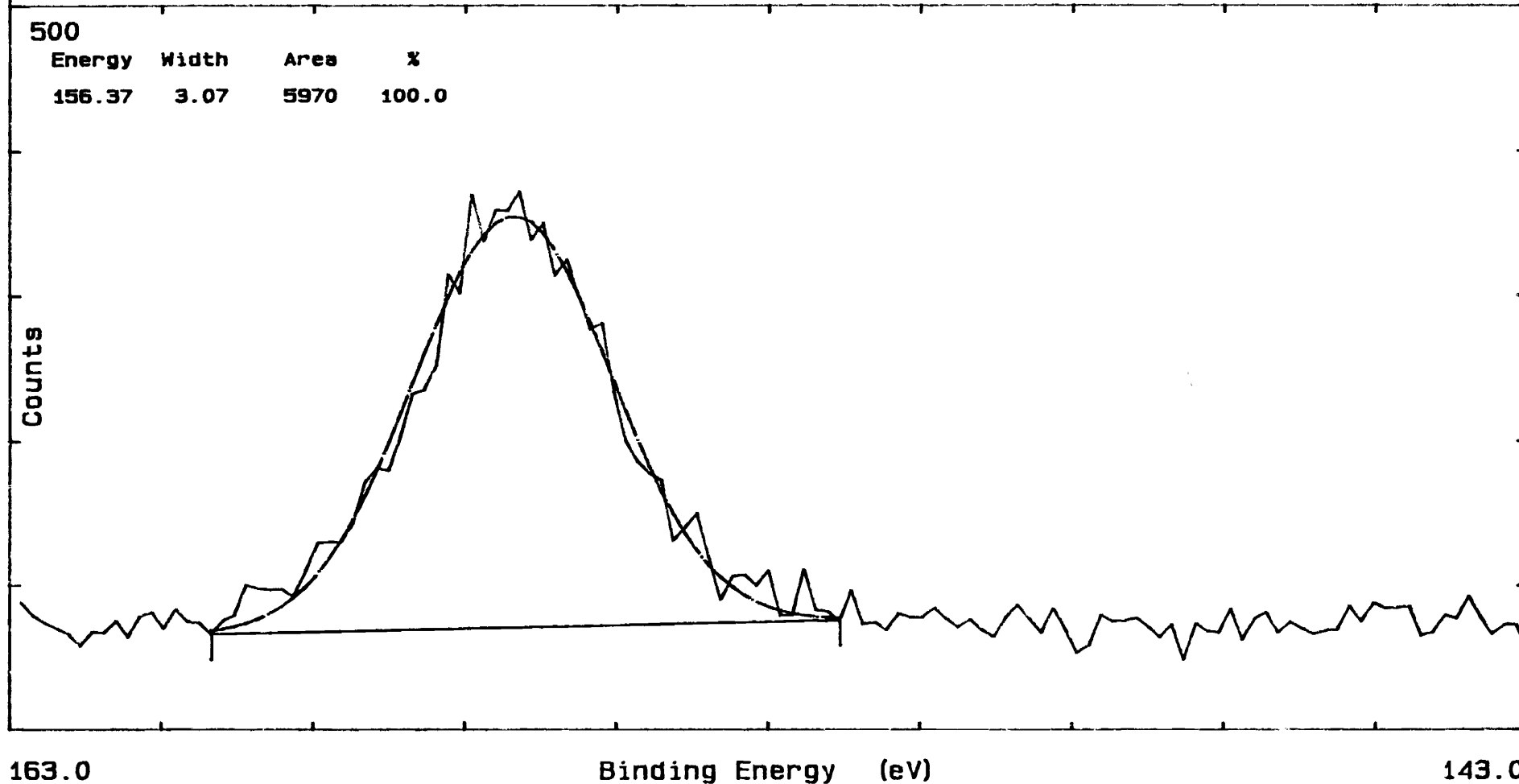


Figure 35

File: LDEF031	Date: 8/27/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
Region 4	Disc: LDEF-2	# of Scans: 5	Resolution: 2
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al 1/2 RADIUS FROM PERIMETER, C 1s SPECTRUM			Operator: TAP

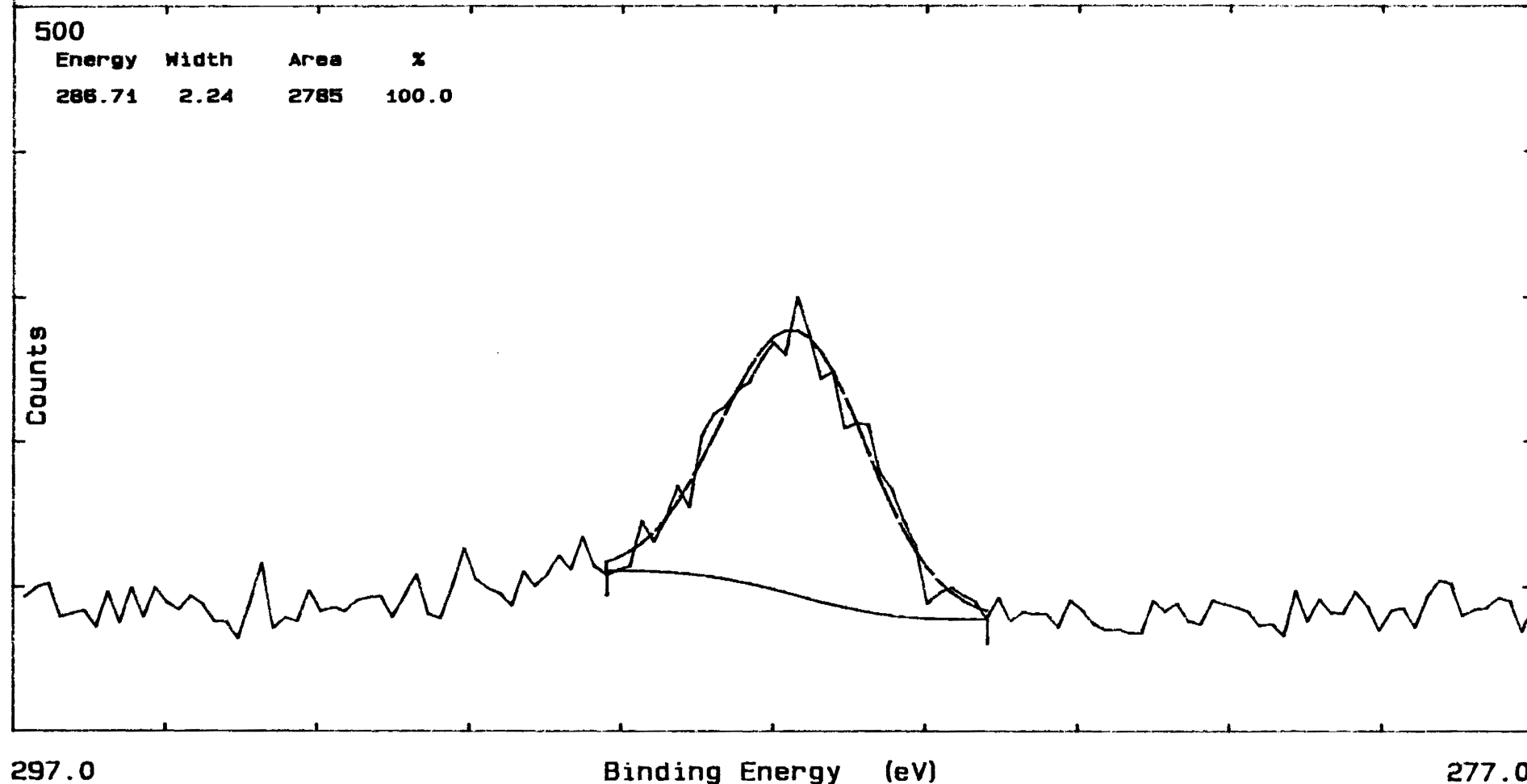


Figure 36

File: LDEF044	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM01-45 EXPOSED MIRROR, SiO _x on Al GENERAL SURVEY. BEFORE SPUTTERING	Operator: TAP		

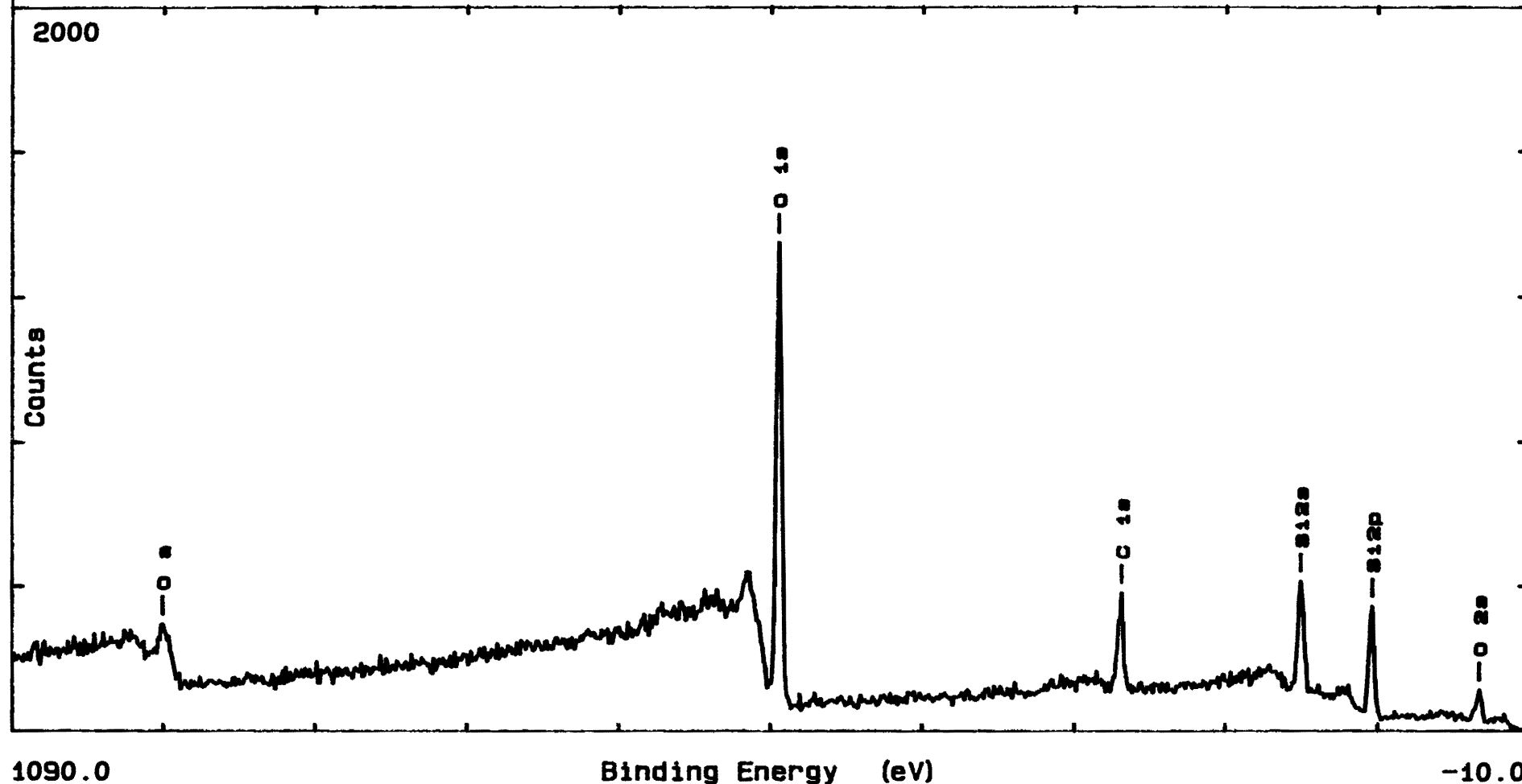


Figure 37

File: LDEF045	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM01-45 EXPOSED MIRROR, SiO ₂ on Al GENERAL SURVEY, 2 MIN. SPUTTERING			Operator: TAP

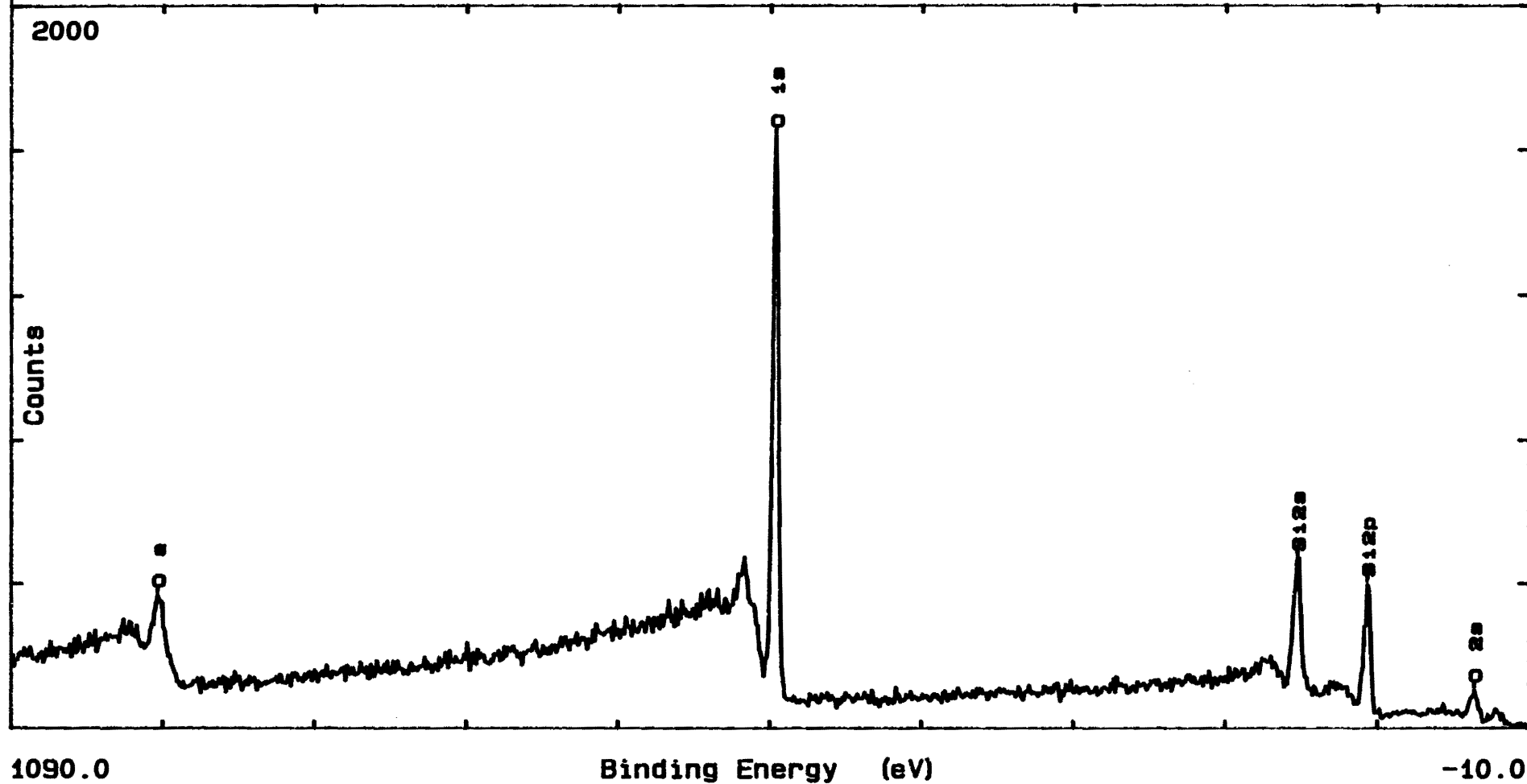


Figure 38

File: LDEF036	Date: 8/28/1992	Spot Size: 1000 u	Flood Gun: 0.0 eV
Region 1	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: CM02-15 EXPOSED MIRROR, SiO _x on Al, TRAILING EDGE CENTER REGION			Operator: TAP

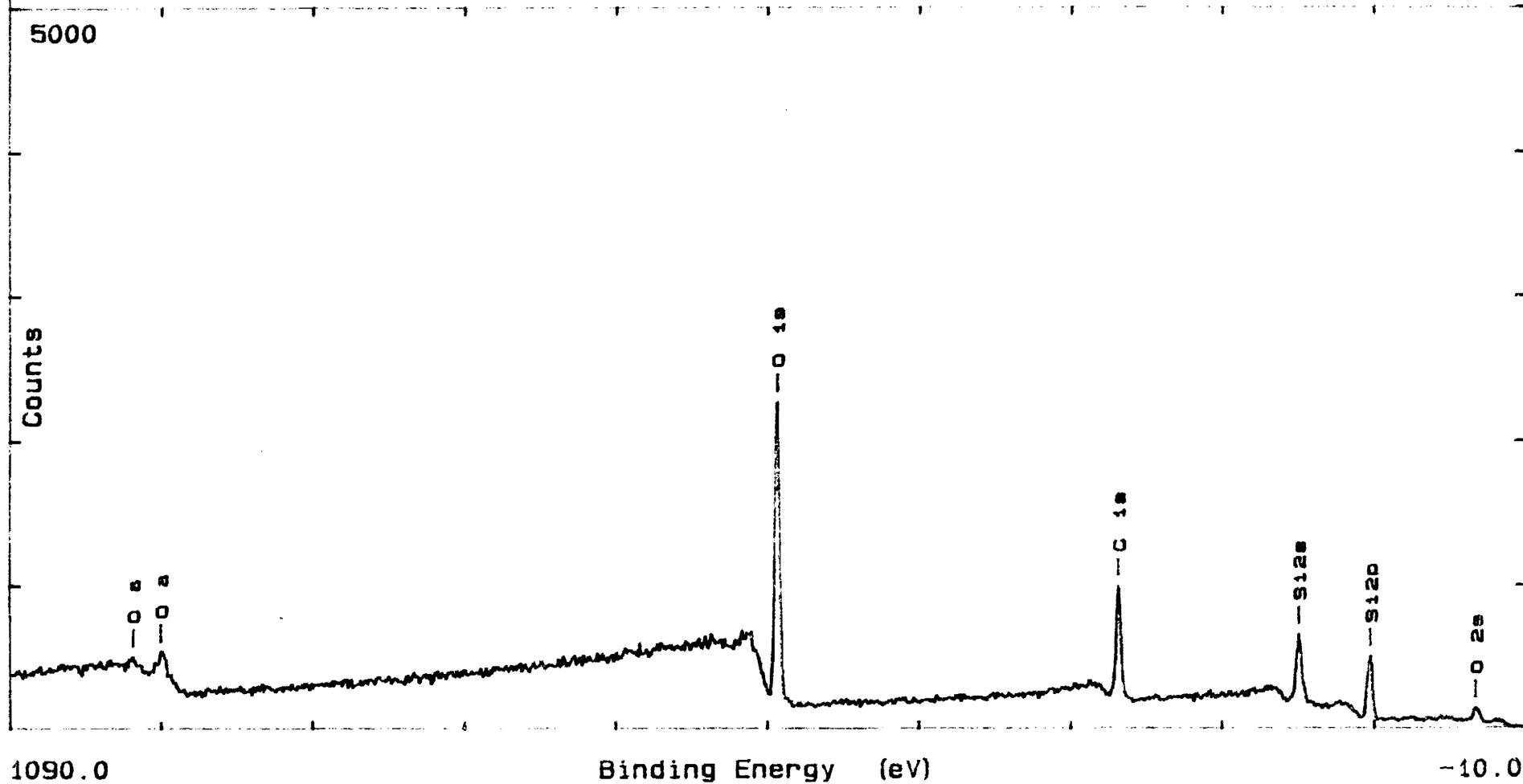


Figure 39

File: LDEF036

Date: 8/28/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-2

of Scans: 3

Resolution: 2

Description: CM02-15 EXPOSED MIRROR, SiO₂ on Al, TRAILING EDGE
CENTER REGION, 0 1s SPECTRUM

Operator: TAP

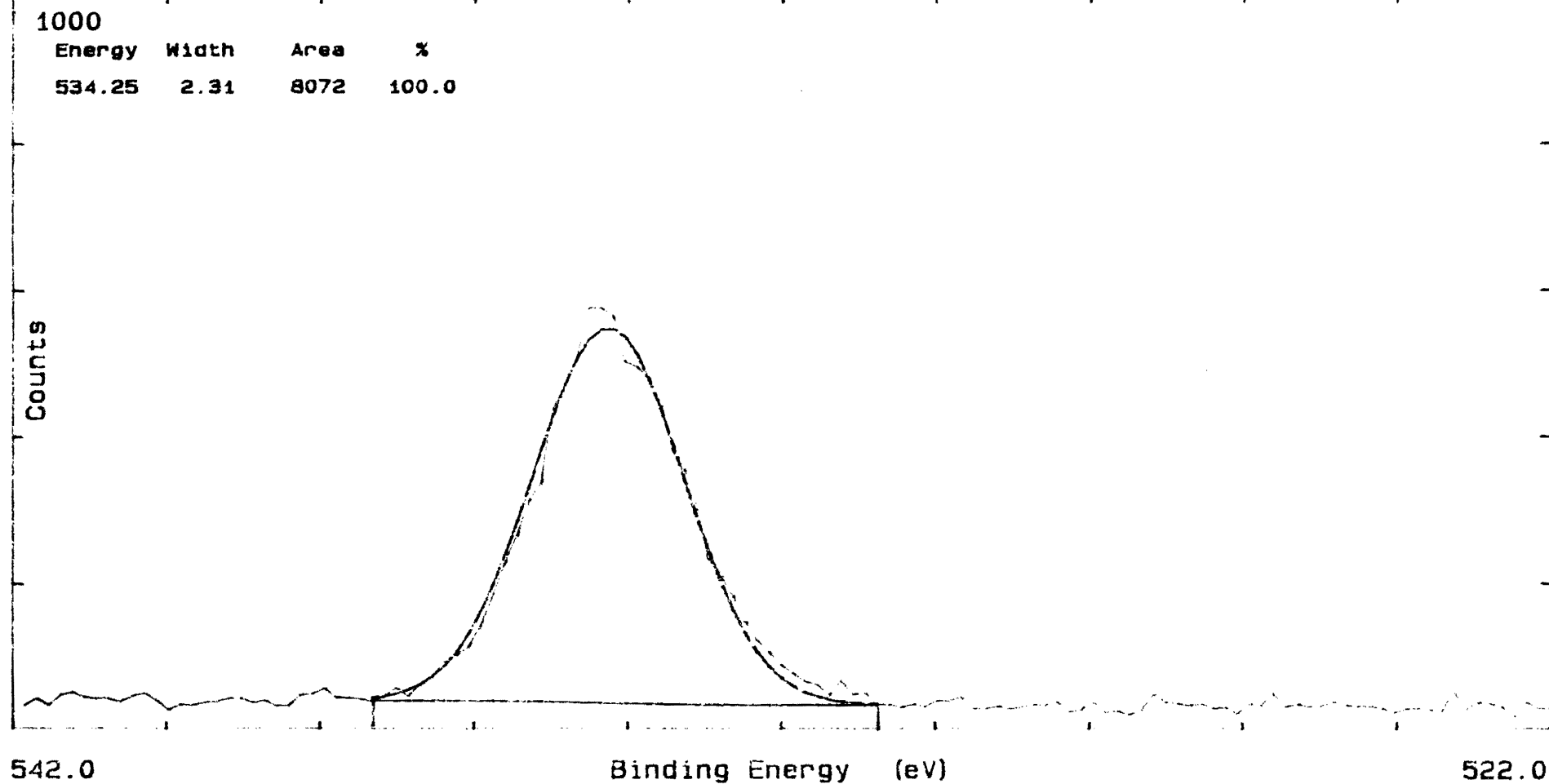


Figure 40

File: LDEF036

Date: 8/28/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 3

Disc: LDEF-2

of Scans: 5

Resolution: 2

Description: CM02-15 EXPOSED MIRROR, SiO₂ on Al, TRAILING EDGE
CENTER REGION, Si 2s SPECTRUM

Operator: TAP

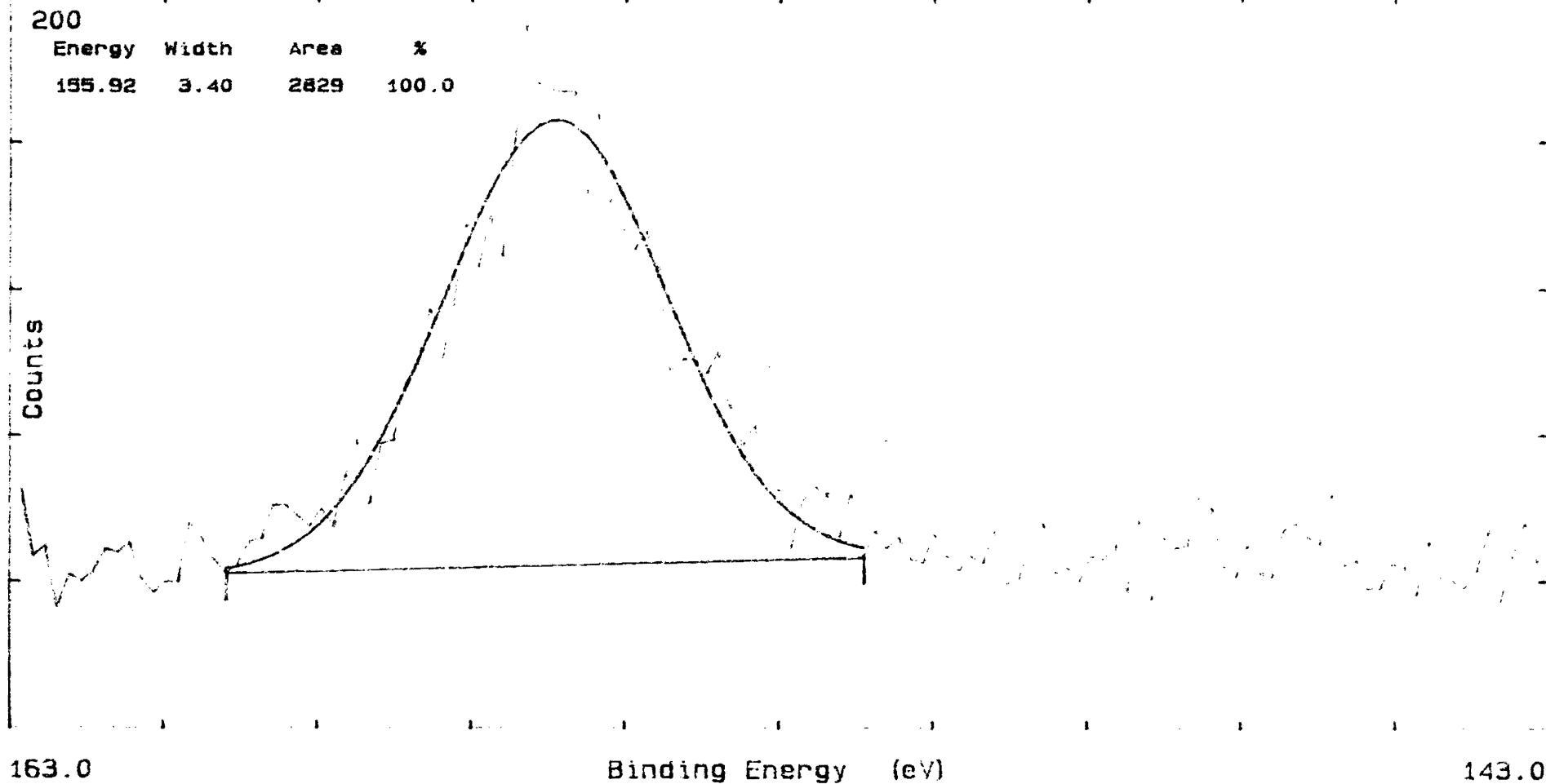


Figure 41

File: LDEF037

Date: 8/28/1992

Spot Size: 1000 μ

Flood Gun: 0.0 eV

Region 1

Disc: LDEF-2

of Scans: 1

Resolution: 4

Description: CM02-15 EXPOSED MIRROR, SiO₂ on Al, TRAILING EDGE
1/2 RADIUS FROM PERIMETER

Operator: TAP

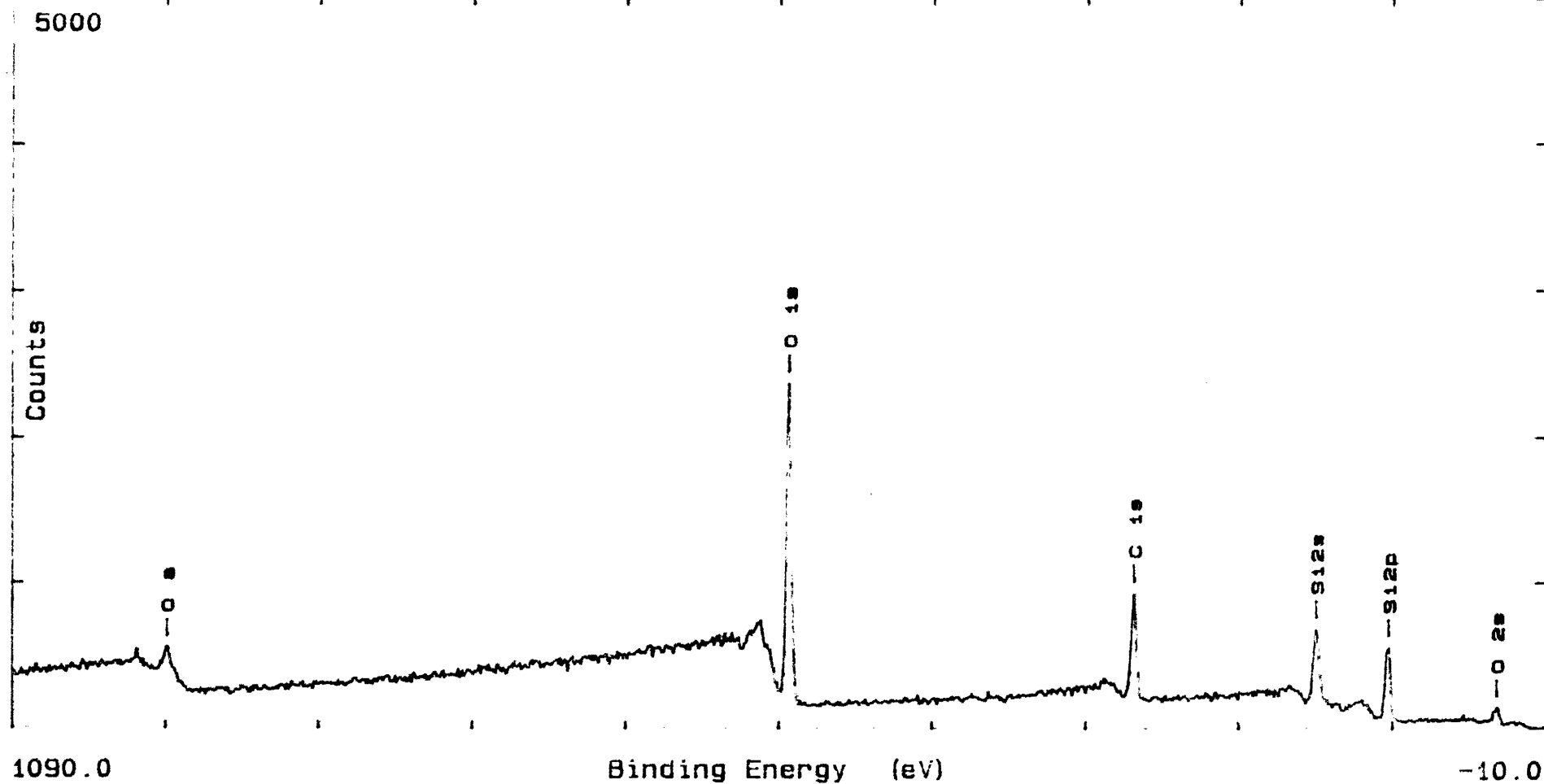


Figure 42

File: LDEF037

Date: 8/28/1992

Spot Size: 300 u

Flood Gun: 0.0 eV

Region 2

Disc: LDEF-2

of Scans: 3

Resolution: 2

Description: CM02-15 EXPOSED MIRROR, SiO_x on Al, TRAILING EDGE
1/2 RADIUS FROM PERIMETER, 0.1s SPECTRUM

Operator: TAP

1000

Energy	Width	Area	%
534.11	2.30	7512	100.0

Counts

542.0

Binding Energy (eV)

522.0

File: LDEF037

Date: 8/28/1992

Spot Size: 300 μ

Flood Gun: 0.0 eV

Region 3

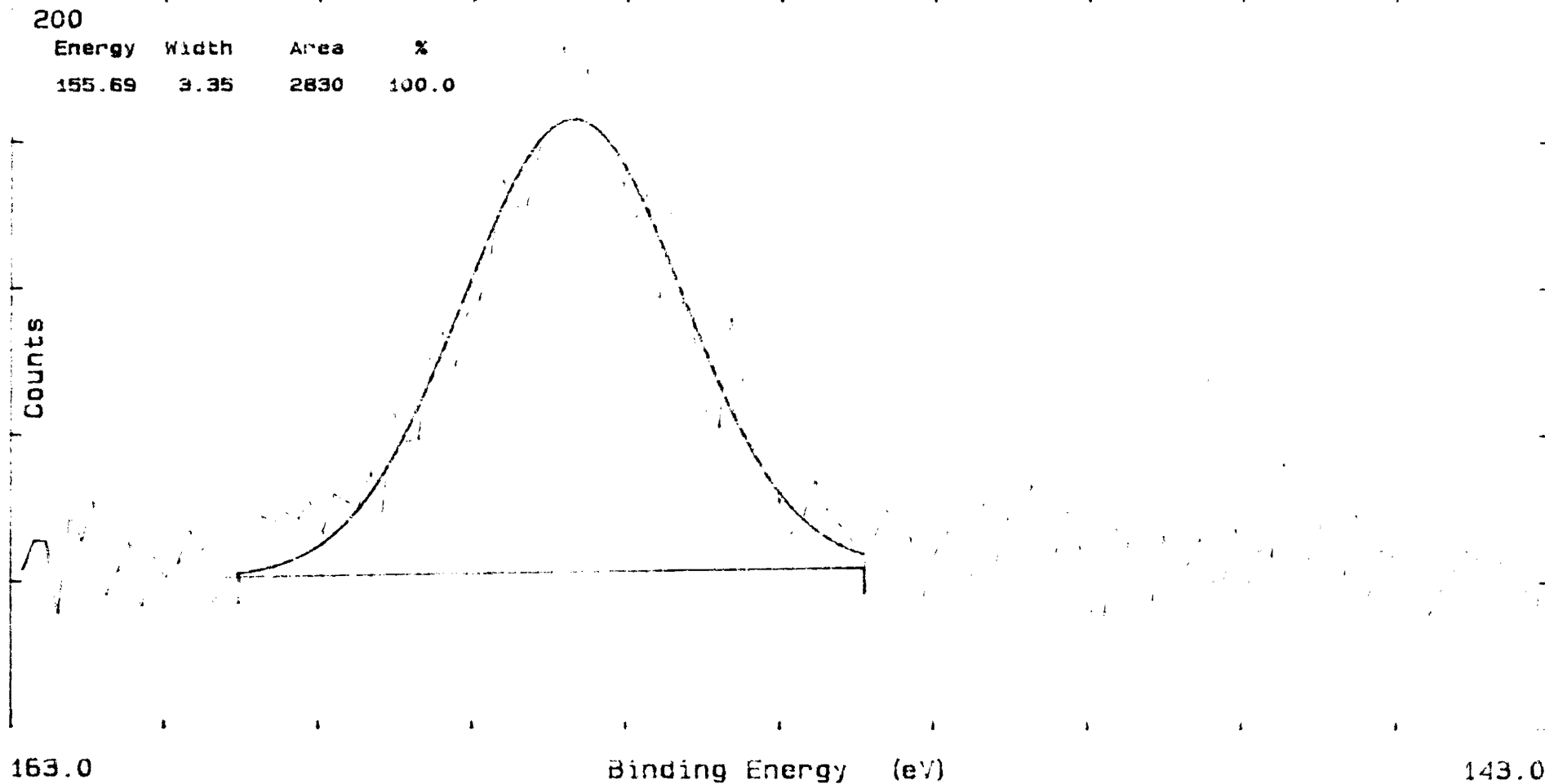
Disc: LDEF-2

of Scans: 5

Resolution: 2

Description: CM02-15 EXPOSED MIRROR, SiO_x on Al, TRAILING EDGE
1/2 RADIUS FROM PERIMETER, Si 2s SPECTRUM

Operator: TAP



File: LDEF046	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM02-15 EXPOSED MIRROR, SiO ₂ on Al, TRAILING EDGE GENERAL SURVEY, BEFORE SPUTTERING			
			Operator: TAP

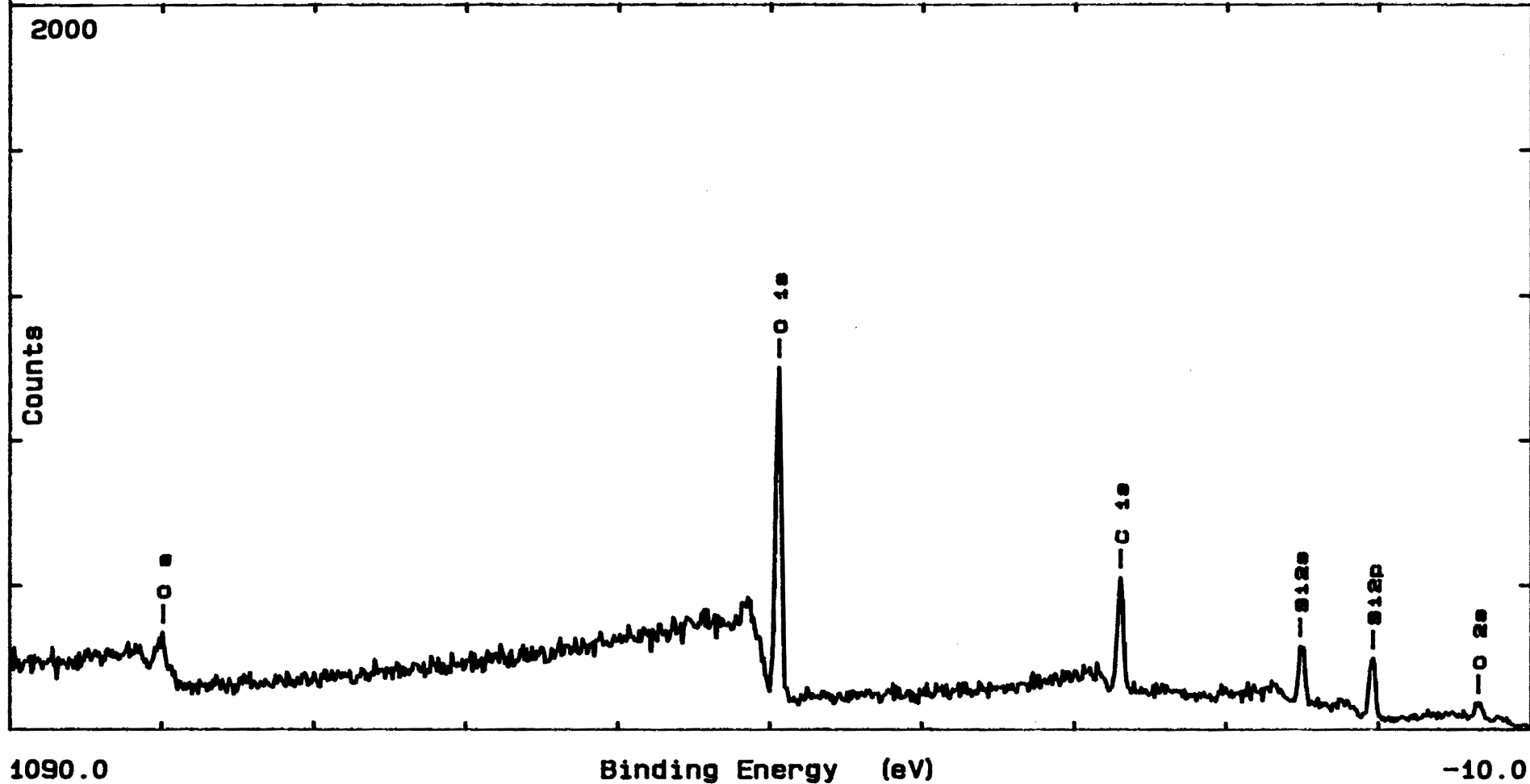


Figure 45

File: LDEF047	Date: 9/3/1992	Spot Size: 300 u	Flood Gun: 0.0 eV
	Disc: LDEF-2	# of Scans: 2	Resolution: 4
Description: CM02-15 EXPOSED MIRROR, SiO _x on Al, TRAILING EDGE GENERAL SURVEY, 2 MIN. SPUTTERING			
			Operator: TAP

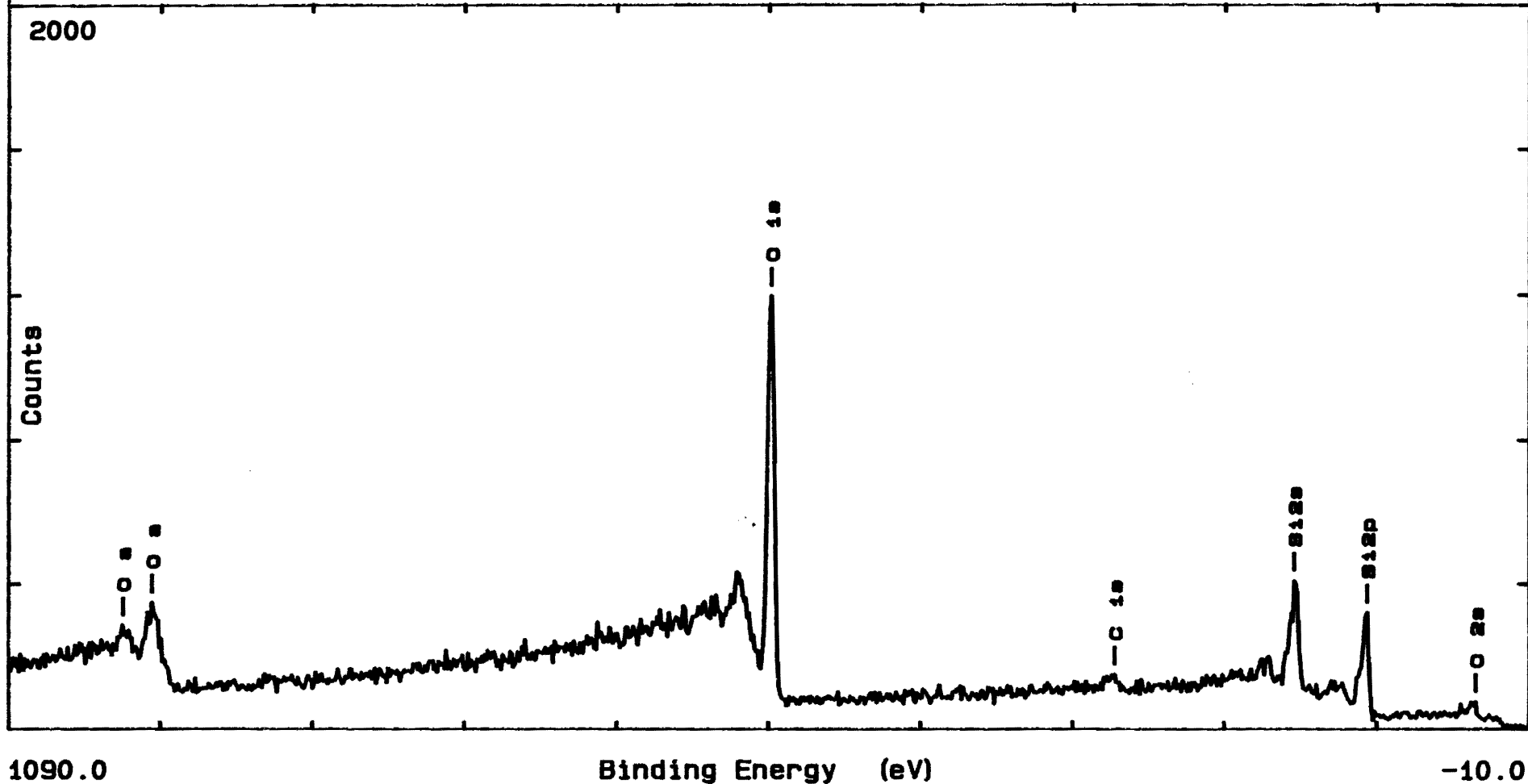


Figure 46

File: LDEF048	Date: 9/11/1992	Spot Size: 300 u	Flood Gun: 2.0 eV
	Disc: LDEF-2	# of Scans: 1	Resolution: 4

Description: SiO STANDARD with SCREEN

Operator: WBC

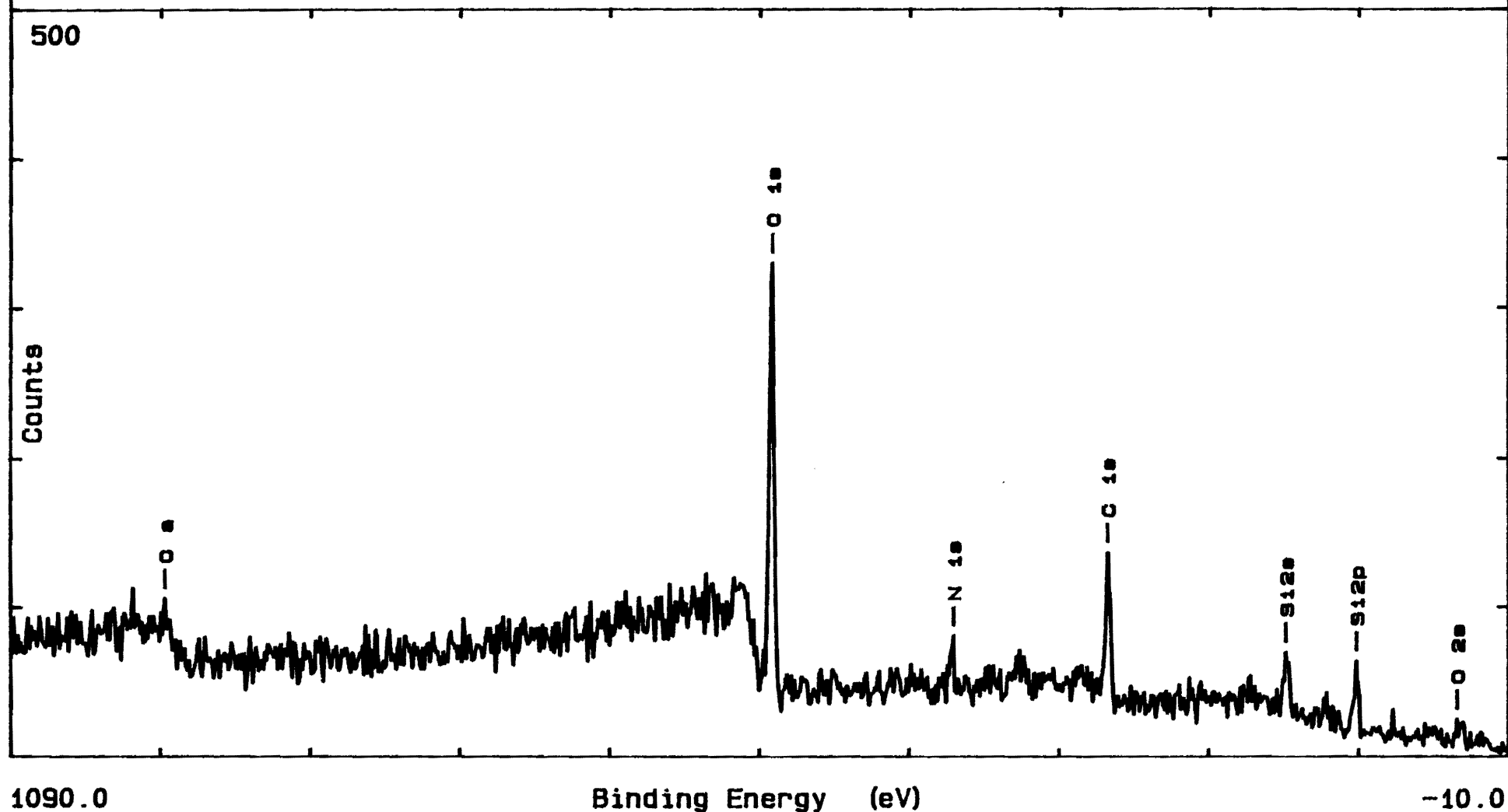


Figure 47

File: LDEF050	Date: 9/14/1992	Spot Size: 300 u	Flood Gun: 2.0 eV
	Disc: LDEF-2	# of Scans: 1	Resolution: 4
Description: SiO STANDARD with SCREEN AFTER BEING HEATED TO 300 C			Operator: TAP

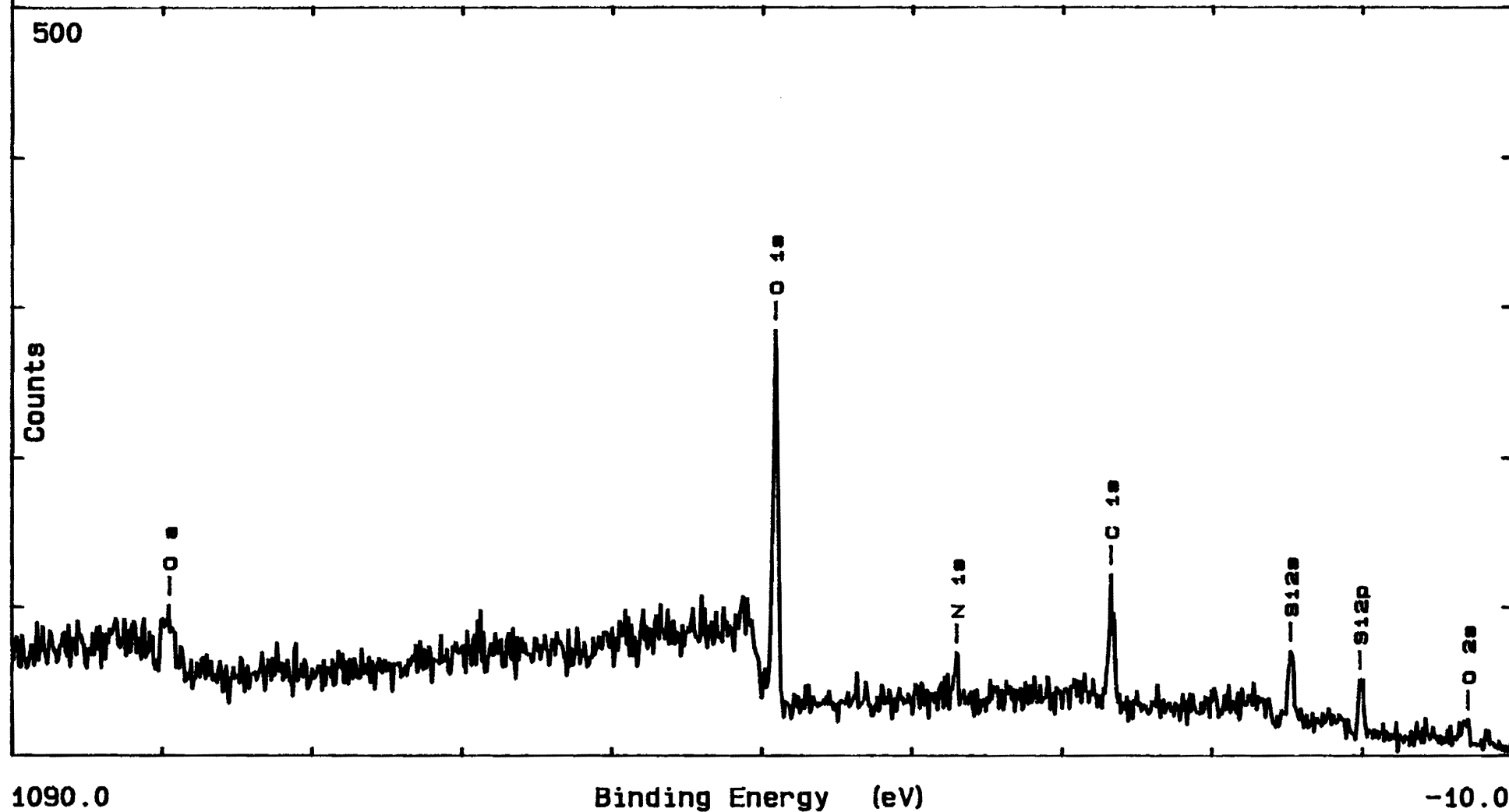


Figure 48

8-15-92

ELECTRON SPECTROSCOPY FOR CHEMICAL ANALYSIS -- SAMPLE ANALYSIS

REPORT # LDEF-03

Prepared by:

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for:

NASA/MSFC
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under:

PO # H-13010D

October 12, 1992

This document reports the results of ESCA analyses performed on the following samples:

CM01-14, CM01-25, CM02-25, CM02-34,
IV-10, IV-16, IV-22, IV-28, IV-38, IV-47, IV-80,
EOIM-3 04-34

A general description of the ESCA data is contained in previous reports. Sputter depth profiles were performed on the CM0x-xx samples in at least two spots. These were carried out under the same conditions used for sputtering previous samples. A sputter rate calibration performed on sample CM01-14 indicated that the sputter rate was about 0.1 Å/s. No sputtering was performed on the IV-xx samples or sample # EOIM-3 04-34. Details of the sample analyses follow.

Reports on ESCA Analyses

CM0x-xx Samples:

Two spots were examined on each sample (with the single exception that three were examined on sample # CM01-14). Each spot was examined as follows: first a general survey was taken, second a depth profile was performed and finally another general survey was made (with the exception that a second general survey was not performed on the first spot examined on sample # CM01-14).

CM01-14: Exposed under window (SiO_x on Al)

Three spots were examined on this specimen. The depth profile on spot 1 was made by alternately collecting data and sputtering every 50 s ($\Delta t = 50$ s) for a total of 2450 s (after an initial sputter of 100 s). Spot 2 was profiled for a total time of 2400 s using a $\Delta t = 100$ s. Spot 3 was profiled for a total time of 190 s using a $\Delta t = 10$ s. Data were collected for the O 1s and the Si 2s photoemission peaks during profiling.

Figure 1 is the general survey taken of spot 1 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 1. The small N 1s photoemission peak evident on figure 1 was not included in the semiquantitative analysis. The depth profile of spot 1 is displayed in figure 2. Note that spot 1 was sputtered for 100 s prior to profiling. A general survey was not performed after this profile.

Figure 3 is the general survey taken of spot 2 prior to depth profiling. The results of a semiquantitative analysis taken from this survey are presented in Table 2. The small N 1s photoemission peak evident on figure 1 was not included in the

semiquantitative analysis. The depth profile of this spot is displayed in figure 4. Figure 5 displays the general survey obtained after profiling spot 2. No N is evident after profiling. The results of a semiquantitative analysis taken from this survey are presented in Table 3.

Figure 6 is the general survey taken of spot 3 prior to depth profiling. The results of a semiquantitative analysis taken from this survey are presented in Table 4. N was not observed on spot 3. The depth profile of this spot is displayed in figure 7. Figure 8 displays the general survey obtained after profiling spot 3. The results of a semiquantitative analysis taken from this survey are presented in Table 5.

Table 1: Semiquantitative Composition of
Spot 1 on Sample CM01-14 from
Figure 1 Prior to Sputtering

Element	Approximate Atomic Percent
O	30
Si	10
C	60

Table 2: Semiquantitative Composition of
Spot 2 on Sample CM01-14 from
Figure 3 Prior to Sputtering

Element	Approximate Atomic Percent
O	31
Si	10
C	59

Table 3: Semiquantitative Composition of
Spot 2 on Sample CM01-14 from
Figure 5 After Profiling

Element	Approximate Atomic Percent
O	58
Si	40
C	2

Table 4: Semiquantitative Composition of
Spot 3 on Sample CM01-14 from
Figure 6 Prior to Sputtering

Element	Approximate Atomic Percent
O	30
Si	10
C	60

Table 5: Semiquantitative Composition of
Spot 3 on Sample CM01-14 from
Figure 8 After Profiling

Element	Approximate Atomic Percent
O	45
Si	37
C	18

These data indicate that there is more O on the surface than in the bulk and that the O to Si ratio decreases for the first 100 s of sputtering after which it gradually increases. Note that since 100 s of sputtering is about 10 Å in SiO_x, the initial decrease in the O to Si ratio may be due to O containing surface contamination. The long term, gradual increase in the O to Si ratio may be an artifact produced by the preferential sputtering of Si during depth profiling. Thus no clear, unambiguous evidence of a change in the O content of the SiO_x coating with depth was observed. A maximum depth of about 250 Å was reached in profiling this sample.

There is substantial C on the surface of this sample. Its distribution with depth was not followed during depth profiling.

CM01-25: Exposed, SiO_x on Aluminum

Two spots were examined on this specimen. The depth profile on spot 1 was made with $\Delta t = 10$ s for a total sputtering time of 490 s, or a total depth of about 49 Å. Spot 2 was profiled for a total time of 762 s (total depth ~76 Å) using a $\Delta t = 20$ s. Data were collected for the O 1s, Si 2s and the C 1s photoemission peaks during profiling.

Figure 9 is the general survey taken of spot 1 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 6. The depth profile of spot 1 is displayed in figure 10. Figure 11 is the general survey taken after profiling spot 1. The results of a semiquantitative composition analysis taken from this survey are presented in Table 7.

Figure 12 is the general survey taken of spot 2 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 8. The first 320 s of the depth profile of spot 1 is displayed in figure 13. This profile was extended for 442 s without significant change. Figure 14 is the general survey taken after profiling spot 2. The results of a semiquantitative composition analysis taken from this survey are presented in Table 9.

Table 6: Semiquantitative Composition of
Spot 1 on Sample CM01-25 from
Figure 9 Prior to Sputtering

Element	Approximate Atomic Percent
O	51
Si	33
C	14
Na	2

Table 7: Semiquantitative Composition of
Spot 1 on Sample CM01-25 from
Figure 11 After Profiling

Element	Approximate Atomic Percent
O	60
Si	40

Table 8: Semiquantitative Composition of
Spot 2 on Sample CM01-25 from
Figure 12 Prior to Sputtering

Element	Approximate Atomic Percent
O	52
Si	36
C	12

Table 9: Semiquantitative Composition of
Spot 2 on Sample CM01-25 from
Figure 14 After Profiling

Element	Approximate Atomic Percent
O	58
Si	42

During profiling, both O and Si appear to increase in concentration initially. This is due to the removal of a C layer that appears to be about a monolayer thick. The initial decrease in the O to Si ratio observed on CM01-14 is not evident on this sample and the O to Si ratio appears constant throughout the depth profiles. No clear, unambiguous evidence of a change in the O content of the SiO_x coating with depth was observed. A maximum depth of about 76 Å was reached in profiling this sample.

CM02-25: Exposed (Trailing Edge), SiO_x on Al

Two spots were examined on this specimen. The depth profile on spot 1 was made with $\Delta t = 20$ s for a total sputtering time of 680 s, or a total depth of about 68 Å. Spot 2 was profiled for a total time of 500 s (total depth ~50 Å) also using $\Delta t = 20$ s. Data were collected for the O 1s, Si 2s and the C 1s photoemission peaks during profiling.

Figure 15 is the general survey taken of spot 1 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 10. The first 380 s of the depth profile of spot 1 is displayed in figure 16. This profile was extended for 300 s with a slight increase in the O to Si ratio occurring with depth (the C 1s peak was not scanned during the profile extension). Figure 17 is the general survey taken after profiling spot 1. The results of a semiquantitative composition analysis taken from this survey are presented in Table 11.

Figure 18 is the general survey taken of spot 2 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 12. The first 400 s of the depth profile of spot 2 is displayed in figure 19. This profile was extended for 100 s without significant change (the C 1s peak was not scanned during the profile extension). Figure 20 is the general survey taken after profiling spot 2. The results of a semiquantitative composition analysis taken from this survey are presented in Table 13.

Table 10: Semiquantitative Composition of
Spot 1 on Sample CM02-25 from
Figure 15 Prior to Sputtering

Element	Approximate Atomic Percent
O	35
Si	19
C	46

Table 11: Semiquantitative Composition of
Spot 1 on Sample CM02-25 from
Figure 17 After Profiling

Element	Approximate Atomic Percent
O	50
Si	43
C	7

Table 12: Semiquantitative Composition of
Spot 2 on Sample CM02-25 from
Figure 18 Prior to Sputtering

Element	Approximate Atomic Percent
O	35
Si	19
C	46

Table 13: Semiquantitative Composition of
Spot 2 on Sample CM02-25 from
Figure 20 After Profiling

Element	Approximate Atomic Percent
O	50
Si	44
C	6

There appears to be a substantial C layer on this sample about 30 to 40 Å thick. Similarly to CM01-14, which also is covered with much surface C, the O to Si ratio decreases for the first about 100 s of sputtering after which it slowly increases. The small thickness sputtered through in 100 s (~10 Å), precludes a conclusion of an O enhanced surface layer of SiO_x. Thus the depth profiles on this sample do not present clear, unambiguous evidence of a change in the O content of the SiO_x coating with depth. A maximum depth of about 68 Å was reached in profiling this sample.

CM02-34: Exposed (Trailing Edge), SiO_x on Al

Two spots were examined on this specimen. The depth profile on spot 1 was made with $\Delta t = 20$ s for a total sputtering time of 600 s, or a total depth of about 60 Å. Spot 2 was profiled for a total time of 720 s (total depth ~72 Å) also using $\Delta t = 20$ s. Data were collected for the O 1s, Si 2s and the C 1s photoemission peaks during profiling.

Figure 21 is the general survey taken of spot 1 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 14. The depth profile of spot 1 is displayed in figure 22. Figure 23 is the general survey taken after profiling spot 1. The results of a semiquantitative composition analysis taken from this survey are presented in Table 15.

Figure 24 is the general survey taken of spot 2 prior to depth profiling. The results of a semiquantitative composition analysis taken from this survey are presented in Table 16. The depth profile of spot 2 is displayed in figure 25. Figure 26 is the general survey taken after profiling spot 2. The results of a semiquantitative composition analysis taken from this survey are presented in Table 17.

Table 14: Semiquantitative Composition of
Spot 1 on Sample CM02-34 from
Figure 21 Prior to Sputtering

Element	Approximate Atomic Percent
O	39
Si	24
C	37

Table 15: Semiquantitative Composition of
Spot 1 on Sample CM02-25 from
Figure 23 After Profiling

Element	Approximate Atomic Percent
O	36
Si	36
C	28

Table 16: Semiquantitative Composition of
Spot 2 on Sample CM02-34 from
Figure 24 Prior to Sputtering

Element	Approximate Atomic Percent
O	36
Si	23
C	41

Table 17: Semiquantitative Composition of
Spot 2 on Sample CM02-34 from
Figure 26 After Profiling

Element	Approximate Atomic Percent
O	47
Si	41
C	12

The depth profiles collected on this sample are qualitatively similar to those from CM02-25 with the most evident quantitative difference being that the C layer is substantially thicker on CM02-34. Indeed, the C layer on this sample is thicker than that on any of the other three CM0x-xx samples reported on here. This C layer was not entirely penetrated by 720 s of sputtering. As with both CM01-14 and CM02-25, which are also covered with much surface C, the O to Si ratio decreases for the first about 100 s of sputtering after which it slowly increases. The small thickness sputtered through in 100 s (~10 Å), precludes a conclusion of an O enhanced surface layer of SiO_x. Thus the depth profiles on this sample do not present clear, unambiguous evidence of a change in the O content of the SiO_x coating with depth. A maximum depth of about 72 Å was reached in profiling this sample.

IV-xx Samples:

Samples IV-10, IV-16, IV-22, IV-28 and IV-28 were fully exposed during the LDEF mission. General surveys were taken of two spots on each of these samples. High resolution spectra were taken of the major photoemission peaks displayed on the general surveys and fit with gaussians.

Samples IV-47 and IV-80 were half exposed during flight. General surveys were taken of four spots on each of these: two spots in the unexposed region and two in the exposed region.

IV-10: Al + overcoat

Figure 27 is the general survey taken from spot 1. Table 18 displays the semiquantitative composition determined from this spectrum. Figures 28 - 30 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Figure 31 is the general survey taken from spot 2. Table 19 displays the semiquantitative composition determined from this spectrum. Figures 32 - 34 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Table 18: Semiquantitative Composition of Spot 1
on Sample IV-10 from Figure 27

Element	Approximate Atomic Percent
O	43
Si	32
C	25

Table 19: Semiquantitative Composition of Spot 2
on Sample IV-10 from Figure 31

Element	Approximate Atomic Percent
O	47
Si	31
C	22

IV-16: Ag + overcoat

Figure 35 is the general survey taken from spot 1. Table 20 displays the semiquantitative composition determined from this spectrum. Figures 36 - 40 are high resolution spectra of the O 1s, Si 2s, C 1s, Al 2p and Ag 3d photoemission peaks, respectively.

Figure 41 is the general survey taken from spot 2. Table 21 displays the semiquantitative composition determined from this spectrum. Figures 42 - 46 are high resolution spectra of the O

1s, Si 2s, C 1s, Al 2p and Ag 3d photoemission peaks, respectively.

Table 20: Semiquantitative Composition of Spot 1 on Sample IV-16 from Figure 35

Element	Approximate Atomic Percent
O	50
Si	15
C	20
Al	12
Ag	3

Table 21: Semiquantitative Composition of Spot 2 on Sample IV-16 from Figure 41

Element	Approximate Atomic Percent
O	41
Si	14
C	22
Al	16
Ag	7

IV-22: Enhanced Al + overcoat

Figure 47 is the general survey taken from spot 1. Table 22 displays the semiquantitative composition determined from this spectrum. Figures 48 - 50 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Figure 51 is the general survey taken from spot 2. Table 23 displays the semiquantitative composition determined from this spectrum. Figures 52 - 54 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Table 22: Semiquantitative Composition of Spot 1
on Sample IV-22 from Figure 47

Element	Approximate Atomic Percent
O	53
Si	33
C	14

Table 23: Semiquantitative Composition of Spot 2
on Sample IV-22 from Figure 51

Element	Approximate Atomic Percent
O	57
Si	34
C	9

IV-28: Al + ??

Figure 55 is the general survey taken from spot 1. Table 24 displays the semiquantitative composition determined from this spectrum. Figures 56 - 58 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Figure 59 is the general survey taken from spot 2. Table 25 displays the semiquantitative composition determined from this spectrum. Figures 60 - 62 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Table 24: Semiquantitative Composition of Spot 1
on Sample IV-28 from Figure 55

Element	Approximate Atomic Percent
O	54
Si	29
C	17

Table 25: Semiquantitative Composition of Spot 2
on Sample IV-28 from Figure 59

Element	Approximate Atomic Percent
O	51
Si	36
C	13

IV-38: Enhanced Al + overcoat

Figure 63 is the general survey taken from spot 1. Table 26 displays the semiquantitative composition determined from this spectrum. Figures 64 - 66 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Figure 67 is the general survey taken from spot 2. Table 27 displays the semiquantitative composition determined from this spectrum. Figures 68 - 70 are high resolution spectra of the O 1s, Si 2s and C 1s photoemission peaks, respectively.

Table 26: Semiquantitative Composition of Spot 1
on Sample IV-38 from Figure 63

Element	Approximate Atomic Percent
O	53
Si	33
C	14

Table 27: Semiquantitative Composition of Spot 2
on Sample IV-38 from Figure 67

Element	Approximate Atomic Percent
O	53
Si	35
C	12

IV-47: Niobium

Figure 71 is the general survey taken from spot 1 in the unexposed region of the sample. Table 28 presents the results of the semiquantitative analysis made from this spectrum. Figures 72 - 75 are high resolution spectra of the O 1s, Si 2s, C 1s and Nb 3d photoemission peaks, respectively.

Figure 76 is the general survey taken from spot 2 in the unexposed region of the sample. Table 29 presents the results of the semiquantitative analysis made from this spectrum. Figures 77 - 80 are high resolution spectra of the O 1s, Si 2s, C 1s and Nb 3d photoemission peaks, respectively.

Figure 81 is the general survey taken from spot 3 in the exposed region of the sample. Table 30 presents the results of the semiquantitative analysis made from this spectrum. Figures 82 - 85 are high resolution spectra of the O 1s, C 1s, Nb 3d and Pb 4f photoemission peaks, respectively.

Figure 86 is the general survey taken from spot 4 in the exposed region of the sample. Table 31 presents the results of the semiquantitative analysis made from this spectrum. Figures 87 - 90 are high resolution spectra of the O 1s, C 1s, Nb 3d and Pb 4f photoemission peaks, respectively.

Table 28: Semiquantitative Composition of Spot 1 from the Unexposed Region of Sample IV-47 from Figure 71

Element	Approximate Atomic Percent
O	54
Si	16
C	22
Nb	8

Table 29: Semiquantitative Composition of Spot 2 from the Unexposed Region of Sample IV-47 from Figure 76

Element	Approximate Atomic Percent
O	51
Si	16
C	25
Nb	8

Table 30: Semiquantitative Composition of Spot 3 from the Exposed Region of Sample IV-47 from Figure 81

Element	Approximate Atomic Percent
O	39
C	49
Nb	11
Pb	1

Table 31: Semiquantitative Composition of Spot 4 from the Exposed Region of Sample IV-47 from Figure 86

Element	Approximate Atomic Percent
O	43
C	44
Nb	11
Pb	2

Significant differences exist between the unexposed and exposed regions of this sample. Si was only observed on the unexposed region (both spots) while Pb was only observed on the exposed region (both spots). There also is more C on the exposed region than the unexposed region.

The binding energies of the Nb 3d_{5/2} photoemission peaks in the unexposed region (207.3 eV calibrated to C 1s of adventitious C at 284.8 eV) and the exposed region (207.1 eV) are similar to

those of Nb_2O_5 and NbO_2 .^{1,2} Pure Nb has a $3d_{5/2}$ B.E. of 201.5 eV.^{1,3}

Likewise, the Pb on the exposed region of the sample has a $4f_{7/2}$ B.E. (138.8 eV calibrated to C 1s of adventitious C at 284.8 eV) similar to that of oxidized forms of Pb (Pb_3O_4 at 137.4 eV⁴, PbO at 137.7 eV⁵, and PbO_2 at 136.8 eV⁴.) Pure Pb has a $4f_{7/2}$ B.E. of 136.6 eV.⁶

IV-80: Ag Alloy + overcoat

Figure 91 is the general survey taken from spot 1 in the unexposed region of the sample. Table 32 presents the results of the semiquantitative analysis made from this spectrum. Figures 92 and 93 are high resolution spectra of the O 1s and C 1s photoemission peaks, respectively.

Figure 94 is the general survey taken from spot 2 in the unexposed region of the sample. Table 33 presents the results of the semiquantitative analysis made from this spectrum. Figures 95 - 98 are high resolution spectra of the O 1s, Si 2s, C 1s and Ag 3d photoemission peaks, respectively.

Figure 99 is the general survey taken from spot 3 in the exposed region of the sample. Table 34 presents the results of the semiquantitative analysis made from this spectrum. Figures 100 - 103 are high resolution spectra of the O 1s, Si 2s, C 1s and Ag 3d photoemission peaks, respectively.

Figure 104 is the general survey taken from spot 4 in the exposed region of the sample. Table 35 presents the results of the semiquantitative analysis made from this spectrum. Figures 105 - 108 are high resolution spectra of the O 1s, Si 2s, C 1s and Ag 3d photoemission peaks, respectively.

Table 32: Semiquantitative Composition of Spot 1 from the Unexposed Region of Sample IV-80 from Figure 91

Element	Approximate Atomic Percent
O	29
C	52
Al	19

Table 33: Semiquantitative Composition of Spot 2 from the Unexposed Region of Sample IV-80 from Figure 94

Element	Approximate Atomic Percent
O	48
Si	23
C	23
Ag	6

Table 34: Semiquantitative Composition of Spot 3 from the Exposed Region of Sample IV-80 from Figure 99

Element	Approximate Atomic Percent
O	48
Si	29
C	19
Ag	4

Table 35: Semiquantitative Composition of Spot 4 from the Exposed Region of Sample IV-80 from Figure 104

Element	Approximate Atomic Percent
O	55
Si	30
C	14
Ag	1

The most striking observation regarding this sample is that spot 1 in the unexposed region displayed Al and no Si and Ag while the other spots displayed Si and Ag but no Al. All spots displayed O. The composition of spot 2 in the unexposed region was thus similar to both spots 3 and 4 in the exposed region.

EOIM-3 04-34: Al + MgF₂ overcoat

Figures 109 and 110 are general surveys taken from the unexposed region of this sample. The results of semiquantitative analyses from these spectra are presented in tables 36 and 37, respectively. Figures 111 and 112 are general surveys taken from the exposed region of this sample. The results of semiquantitative analyses from these spectra are presented in tables 38 and 39, respectively.

Table 36: Semiquantitative Composition of Spot 1 from the Unexposed Region of Sample EOIM-3 04-34 from Figure 109

Element	Approximate Atomic Percent
F	35
O	11
C	21
Mg	32
Ar	1

Table 37: Semiquantitative Composition of Spot 2 from the Unexposed Region of Sample EOIM-3 04-34 from Figure 110

Element	Approximate Atomic Percent
F	36
O	11
C	22
Mg	30
Ar	1

Table 38: Semiquantitative Composition of Spot 3 from the Exposed Region of Sample EOIM-3 04-34 from Figure 111

Element	Approximate Atomic Percent
F	20
O	31
Si	10
C	14
Mg	25
Ar	<1

Table 39: Semiquantitative Composition of Spot 4 from the Exposed Region of Sample EOIM-3 04-34 from Figure 112

Element	Approximate Atomic Percent
F	21
O	27
Si	13
C	17
Mg	21
Ar	1

The unexposed and exposed regions of this sample differed in that 1) the unexposed region displayed no Si while the exposed region did and 2) there is about 2.5 times more O on the exposed region than on the unexposed region. There is also a small amount of Ar present over the sample. The sample surface charged about 6 volts under x-ray bombardment which is indicative of an electrical insulator.

References:

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File: LDEF051	Date: 9/16/1992	Spot Size: 1000 u	Flood Gun: 5.0 eV
	Disc: LDEF-2	# of Scans: 1	Resolution: 4

Description: CM01-14: EXPOSED UNDER WINDOW (SiO₂ ON AL)

Operator: TAP

SPOT 1

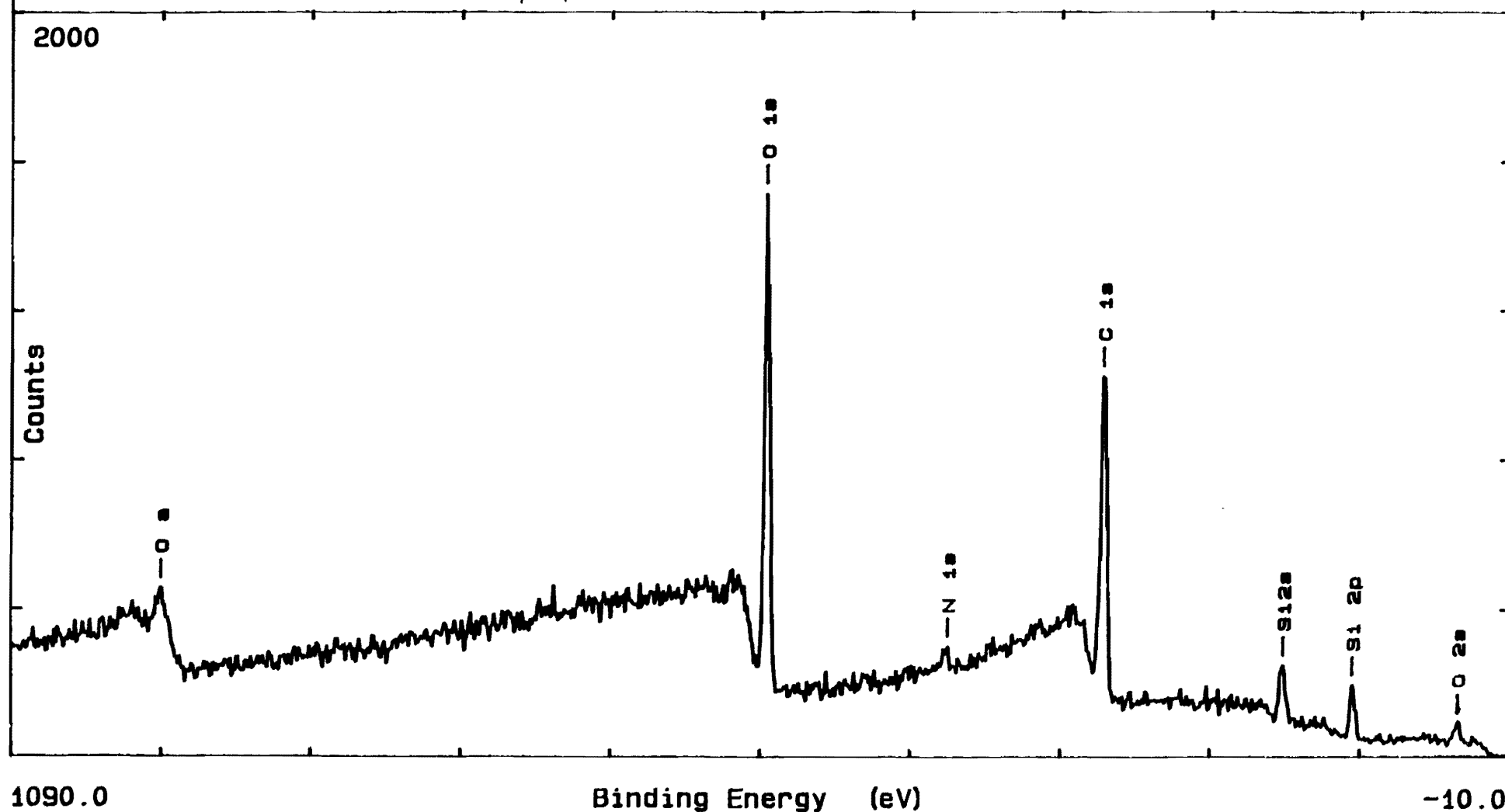


Figure 1

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File: LDEF053

Date: 9/16/1992

Spot Size: 300 u

Flood Gun: 1.0 eV

Disc: LDEF-2

Resolution: 4

Description: CM01-14: EXPOSED UNDER WINDOW (SiO₂ ON Al)
AFTER 100 S SPUTTER SPOT 1

Operator: TAP

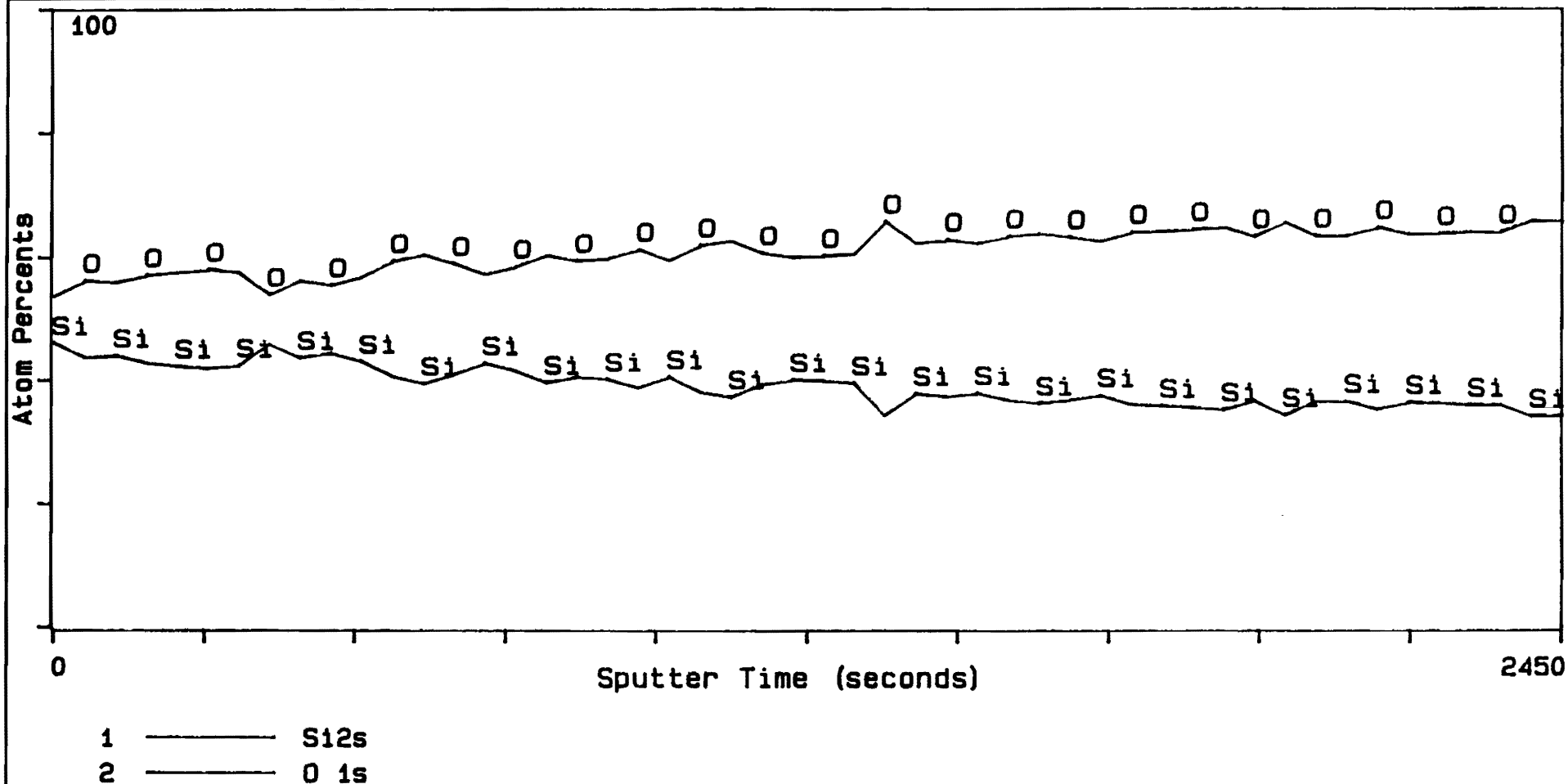
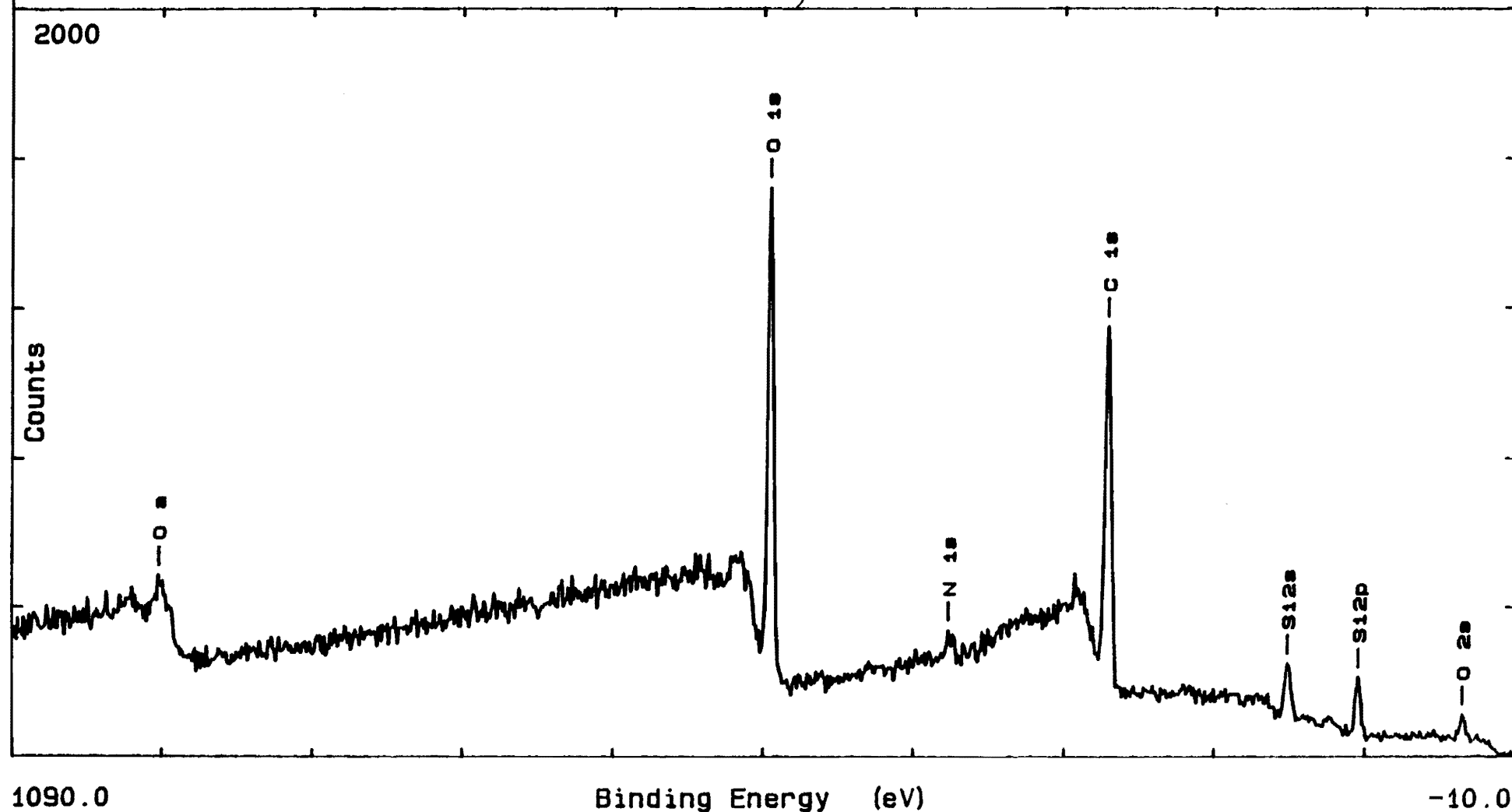


Figure 2

File: LDEF054	Date: 9/17/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4
Description: CM01-14: EXPOSED UNDER WINDOW (SiO _x ON Al) SECOND SPOT BEFORE SPUTTERING	Operator: TAP		



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF055

Date: 9/17/1992

Spot Size: 300 u

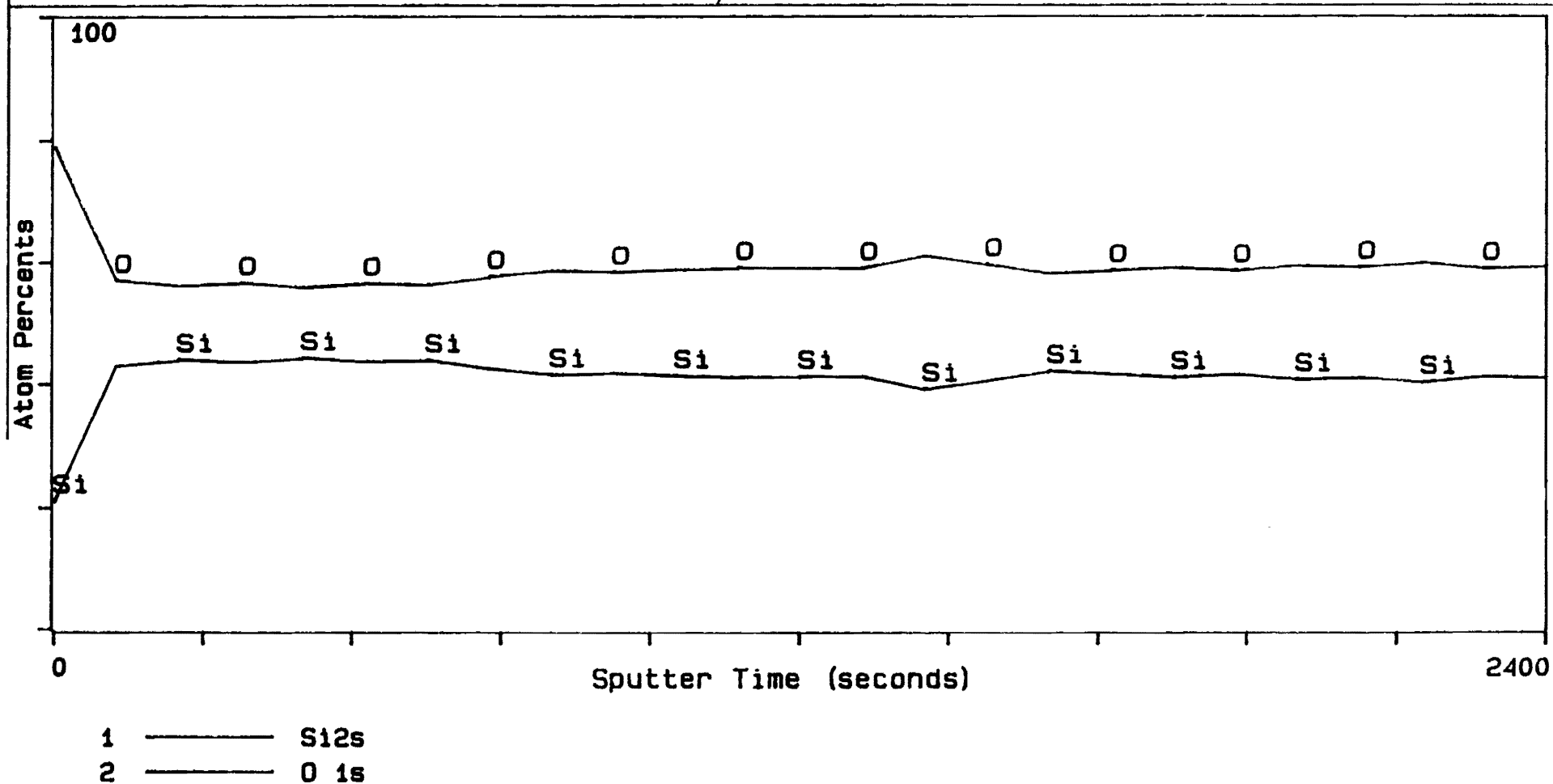
Flood Gun: 1.0 eV

Disc: LDEF-3

Resolution: 4

Description: CM01-14: EXPOSED UNDER WINDOW (SiO₂ ON Al)
SECOND SPOT, DELTA t=100 S,

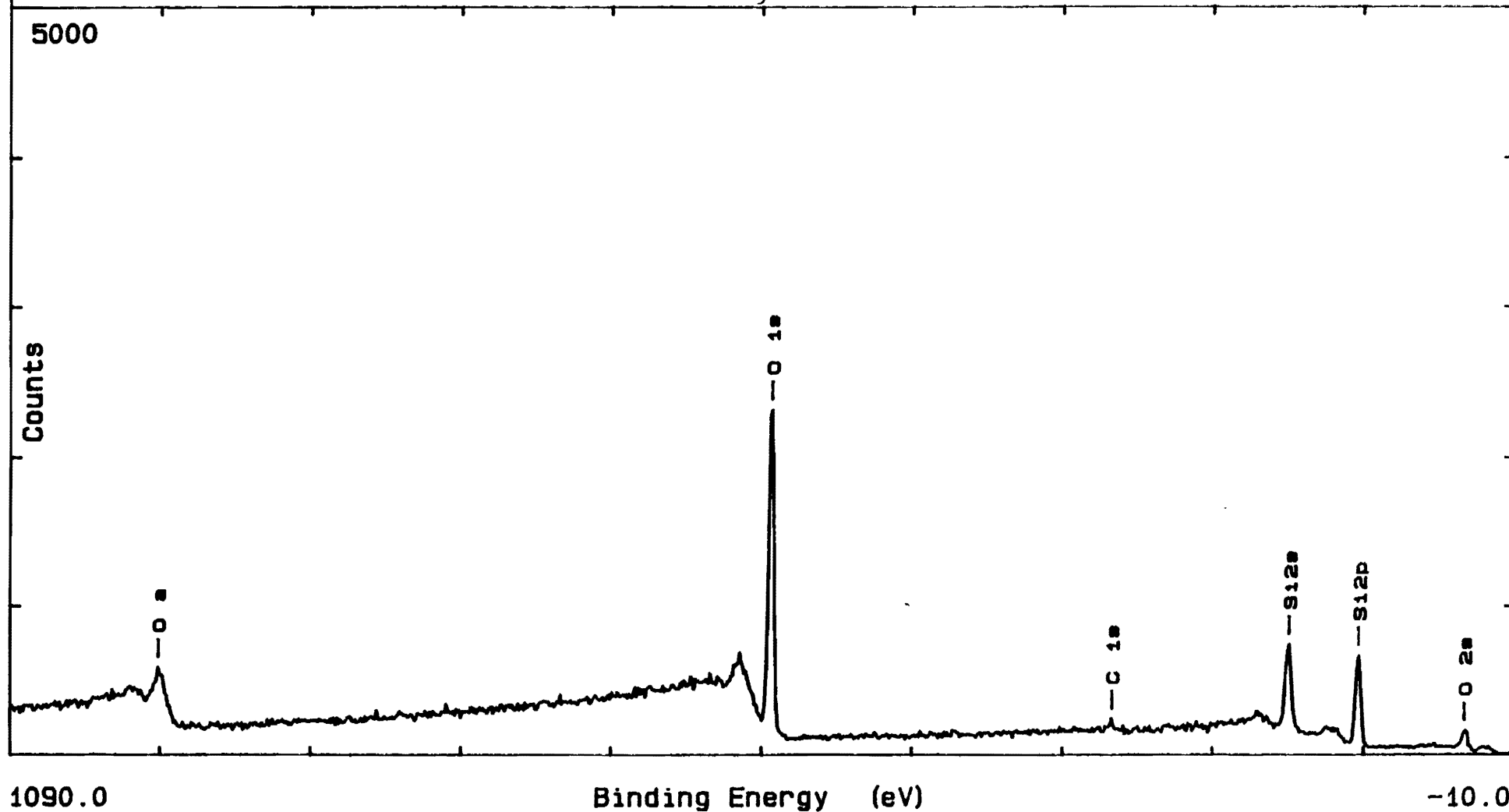
Operator: TAP



File: LDEF056	Date: 9/17/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4

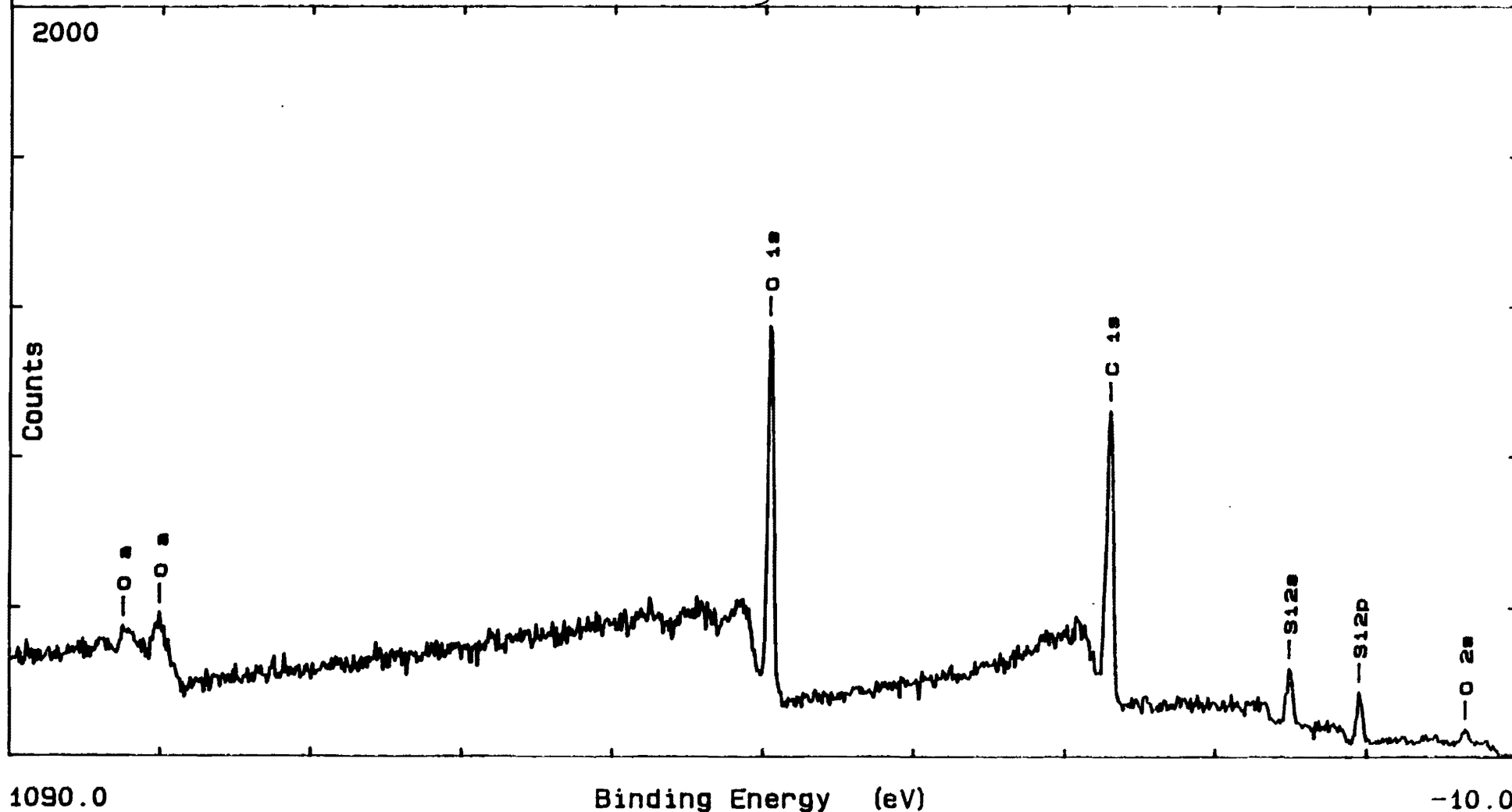
Description: CM01-14: EXPOSED UNDER WINDOW (SiO_x ON Al)
SECOND SPOT AFTER SPUTTERING,

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF057	Date: 9/17/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4
Description: CM01-14: EXPOSED UNDER WINDOW (SiO ₂ ON Al) THIRD SPOT BEFORE SPUTTERING,			Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF058

Date: 9/17/1992

Spot Size: 300 u

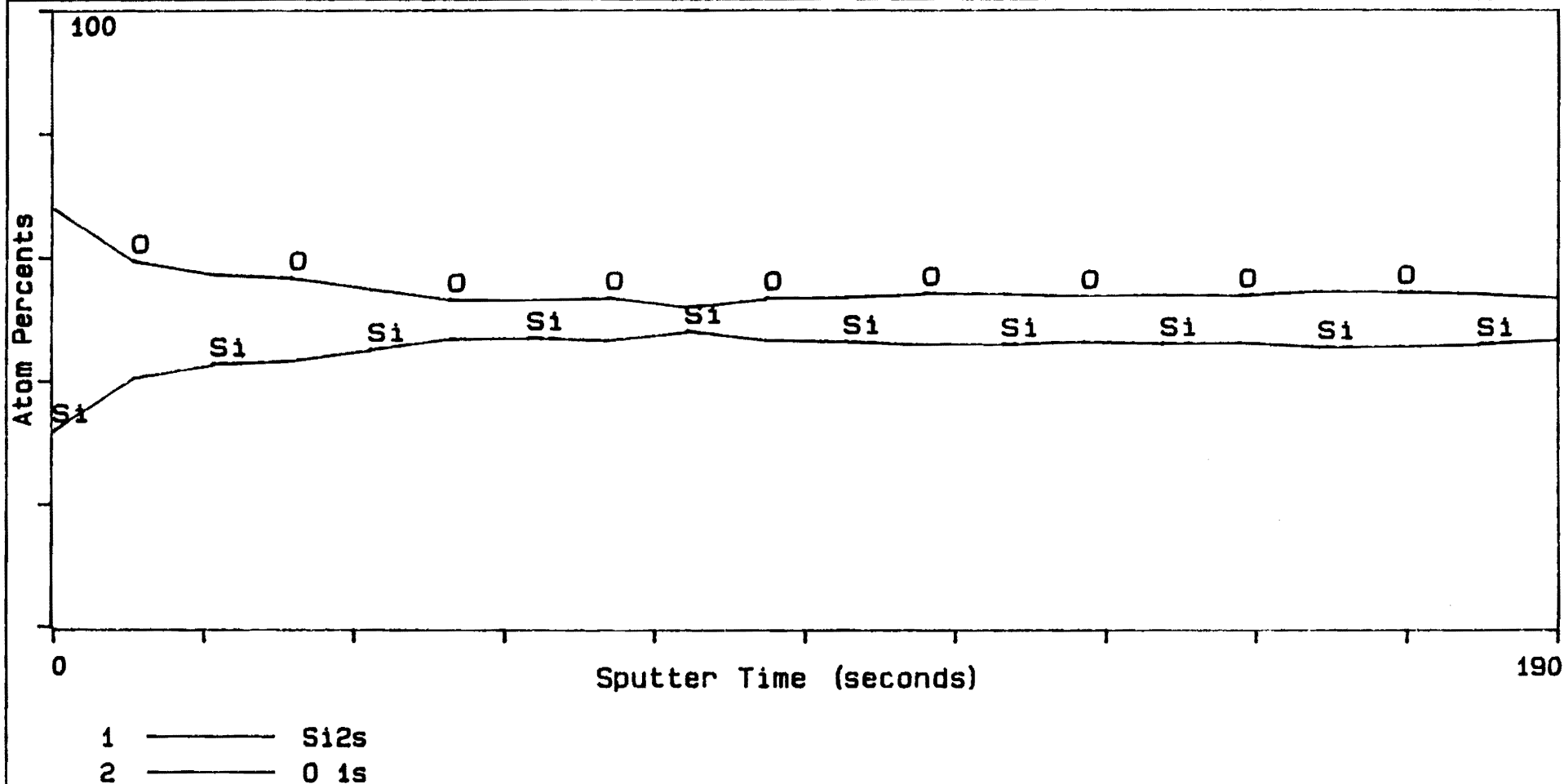
Flood Gun: 1.0 eV

Disc: LDEF-3

Resolution: 4

Description: CM01-14: EXPOSED UNDER WINDOW (SiO₂ ON Al)
THIRD SPOT, DELTA t=10 S,

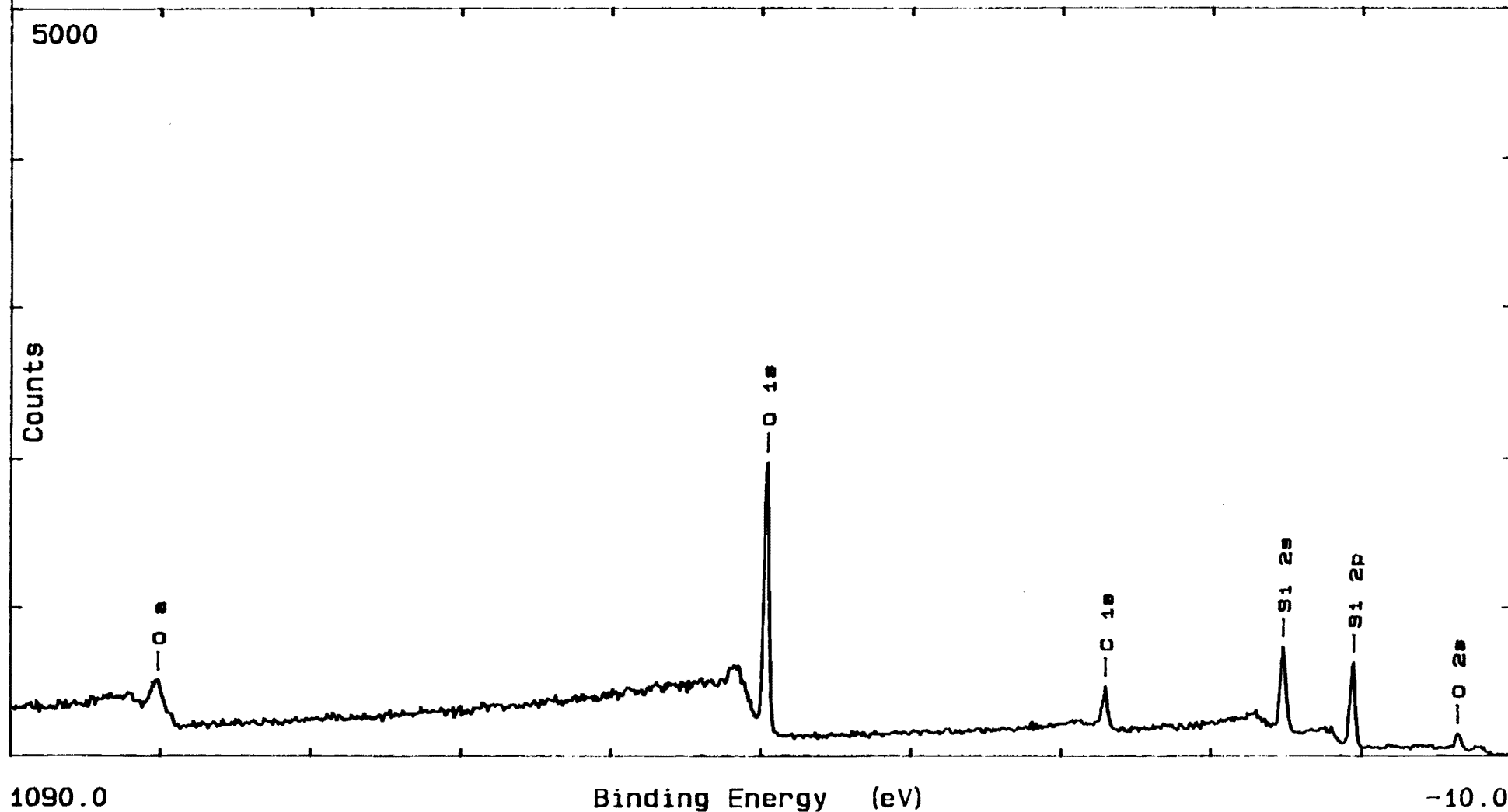
Operator: TAP



File: LDEF059	Date: 9/17/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4

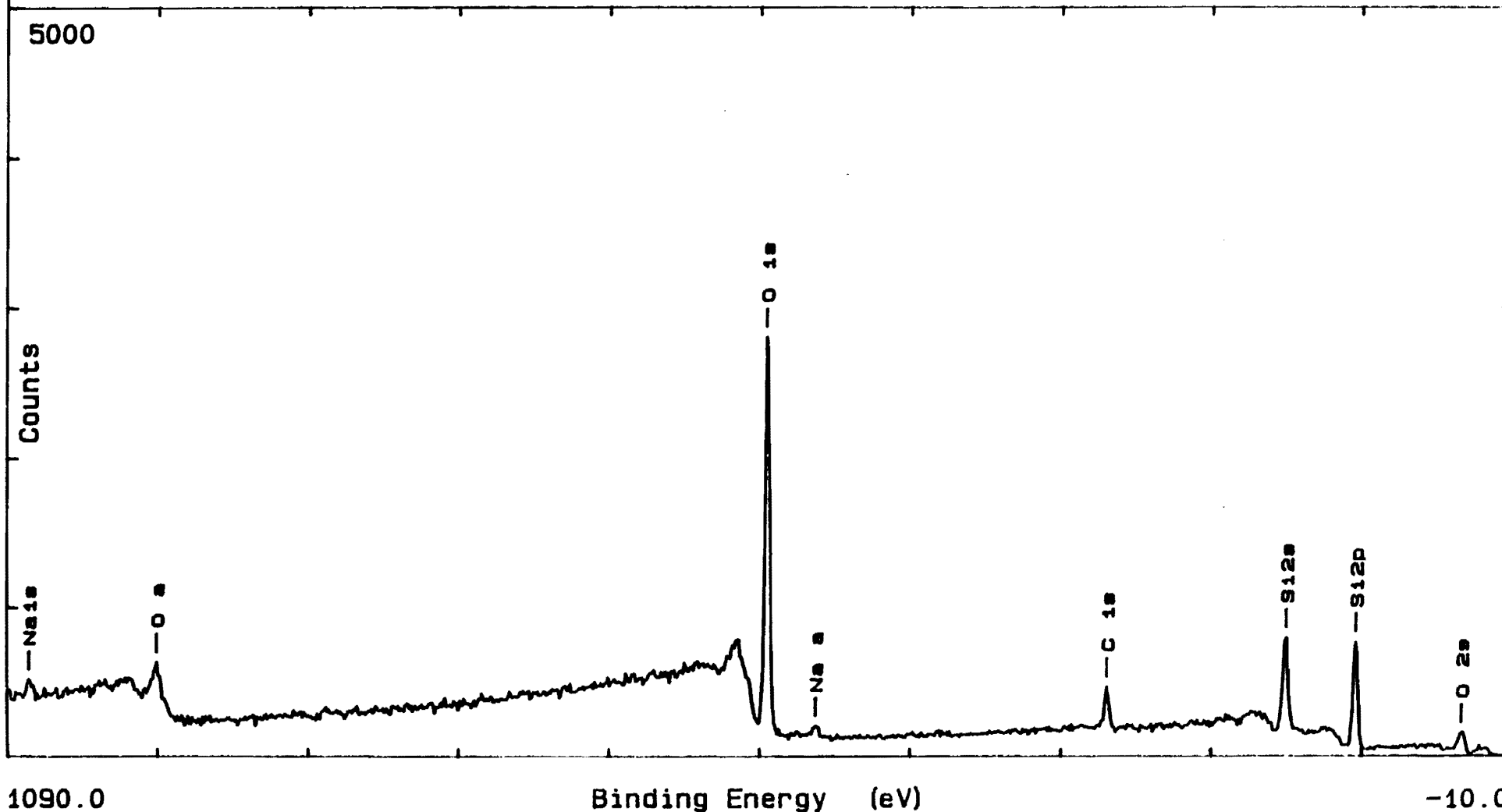
Description: CM01-14: EXPOSED UNDER WINDOW (SiO_x ON Al)
THIRD SPOT AFTER SPUTTERING 190 S.

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF060	Date: 9/17/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4
Description: CM01-25: EXPOSED, SiO ₂ ON Al FIRST SPOT BEFORE SPUTTERING	Operator: TAP		



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF061

Date: 9/17/1992

Spot Size: 300 u

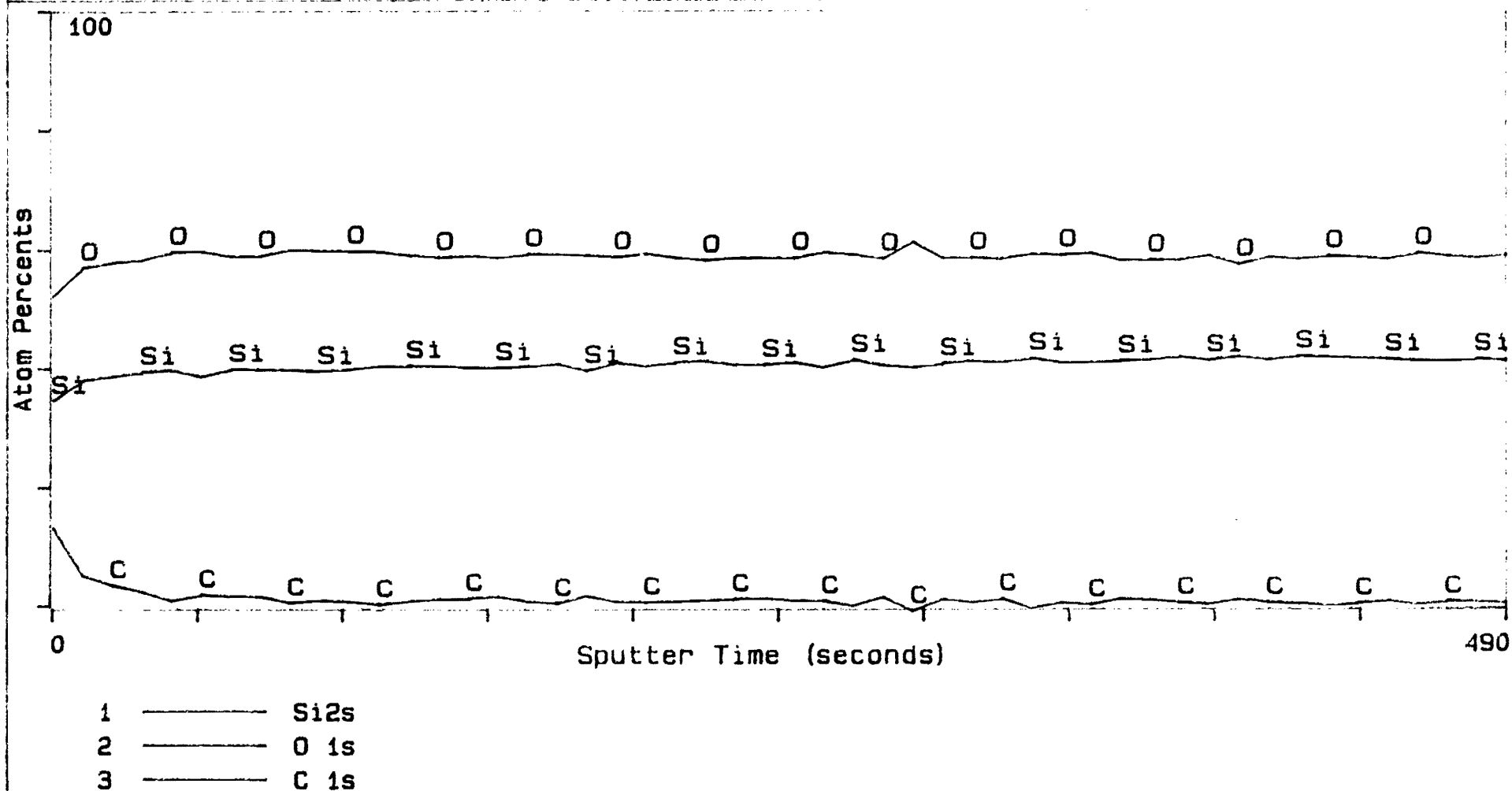
Flood Gun: 1.0 eV

Disc: LDEF-3

Resolution: 4

Description: CM01-25: EXPOSED (SiO₂ ON Al)
FIRST SPOT, DELTA t=10 S.

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF062

Date: 9/17/1992

Spot Size: 1000 μ

Flood Gun: 1.0 eV

Disc: LDEF-3

of Scans: 1

Resolution: 4

Description: CM01-25: EXPOSED, SiO_x ON Al
FIRST SPOT AFTER SPUTTERING 490 S.

Operator: TAP

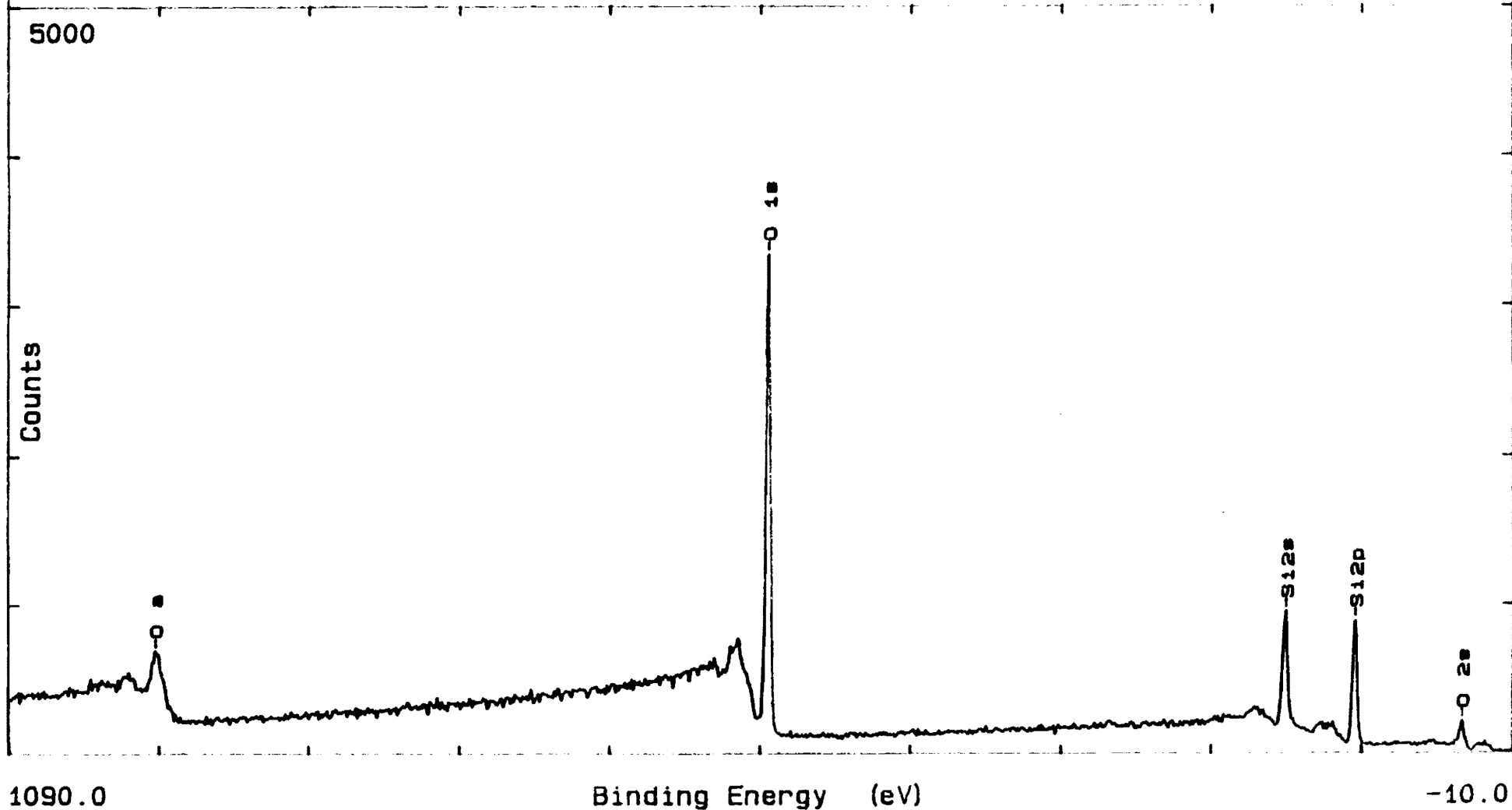


Figure 11

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File: LDEF063

Date: 9/18/1992

Spot Size: 1000 u

Flood Gun: 1.0 eV

Disc: LDEF-3

of Scans: 1

Resolution: 4

Description: CM01-25: EXPOSED, SiO₂ ON Al
SECOND SPOT BEFORE SPUTTERING

Operator: TAP

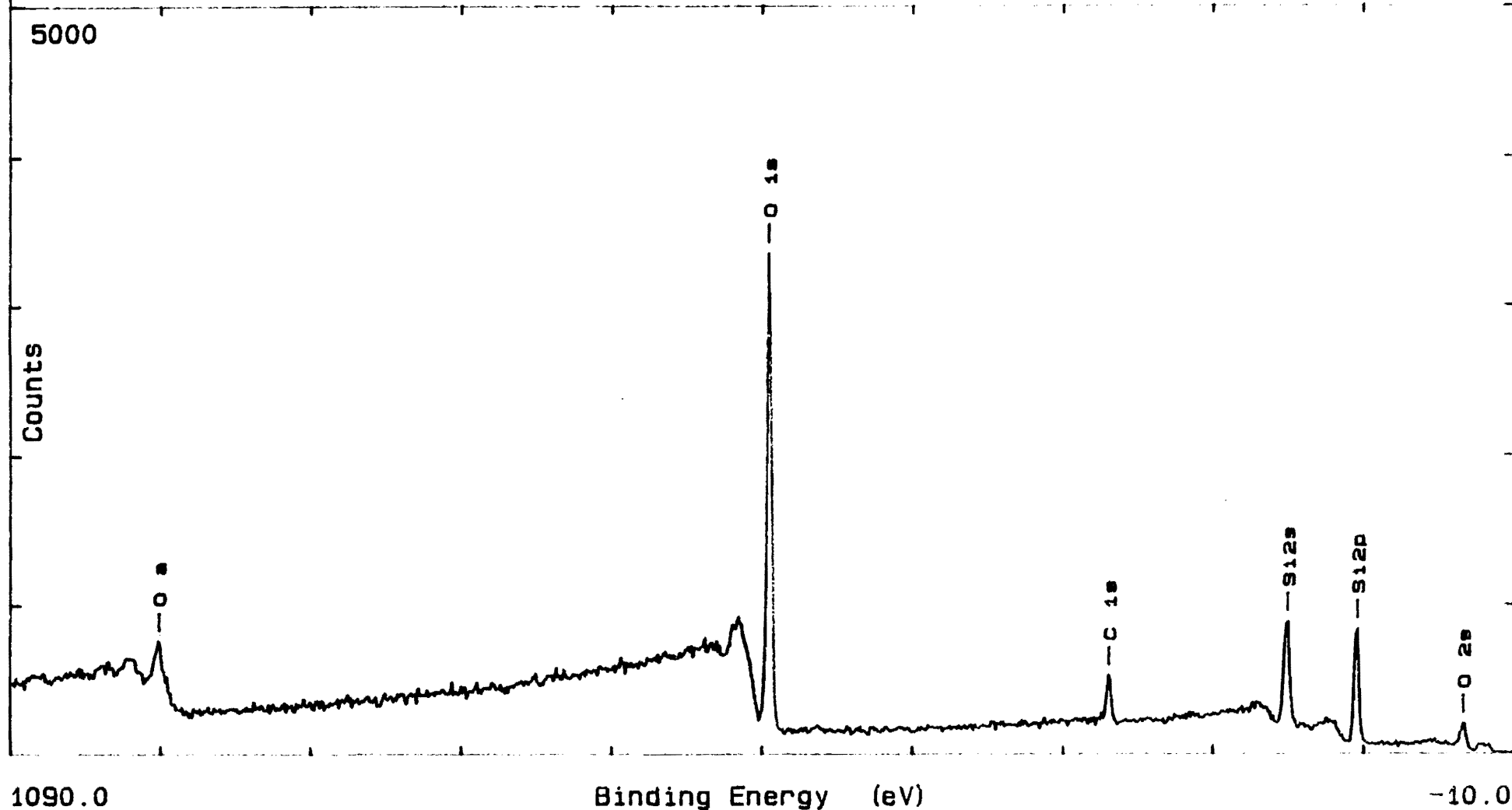


Figure 12

File: LDEF064

Date: 9/18/1992

Spot Size: 300 μ

Flood Gun: 1.0 eV

Disc: LDEF-3

Resolution: 4

Description: CM01-25: SiO_x ON Al
SECOND SPOT, DELTA t=20 S.

Operator: TAP

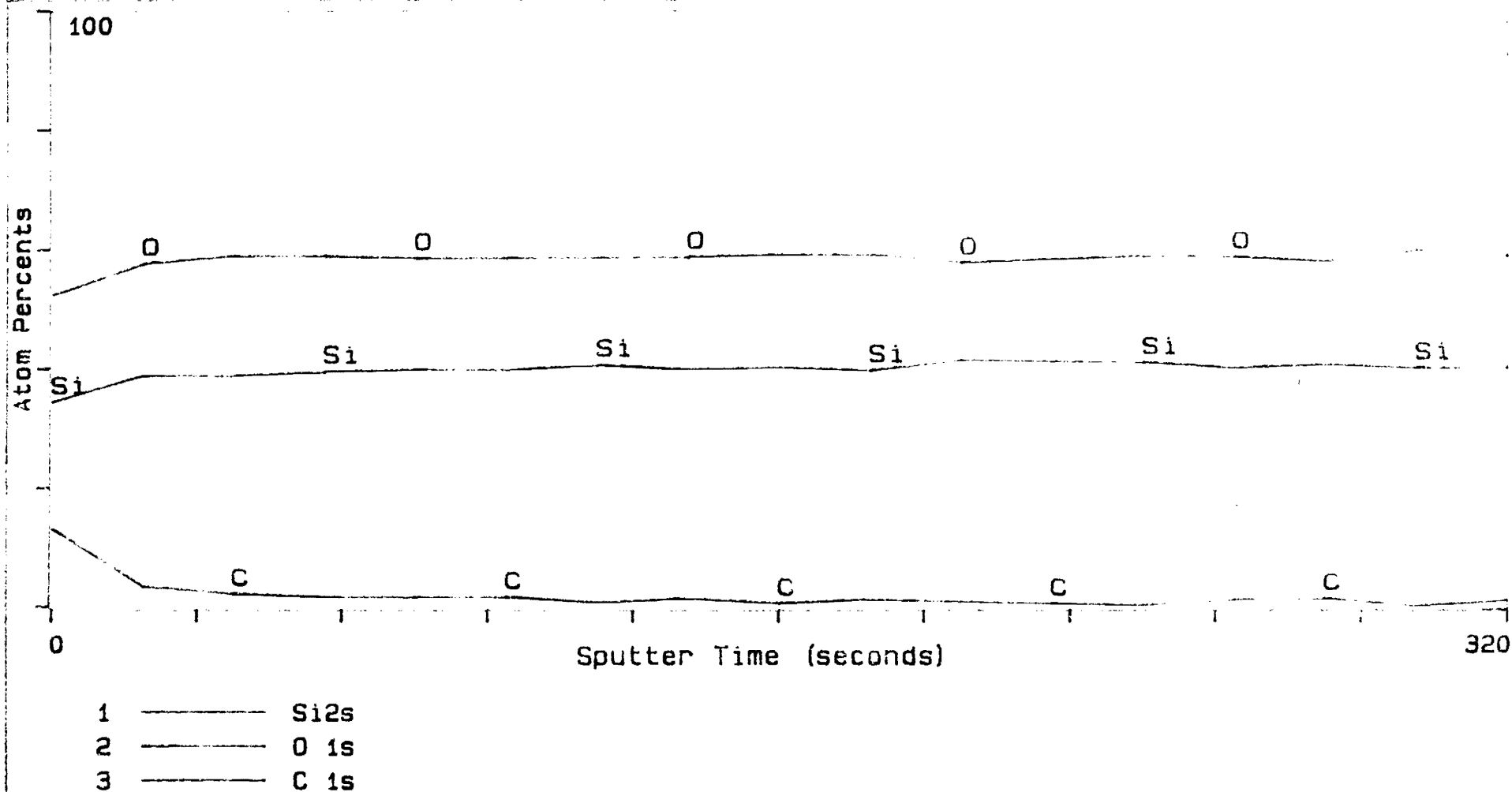


Figure 13

File: LDEF066

Date: 9/18/1992

Spot Size: 1000 u

Flood Gun: 1.0 eV

Disc: LDEF-3

of Scans: 1

Resolution: 4

Description: CM01-25: SiO_x ON AL, SECOND SPOT
AFTER BEING SPUTTERED 762 S.

Operator: TAP

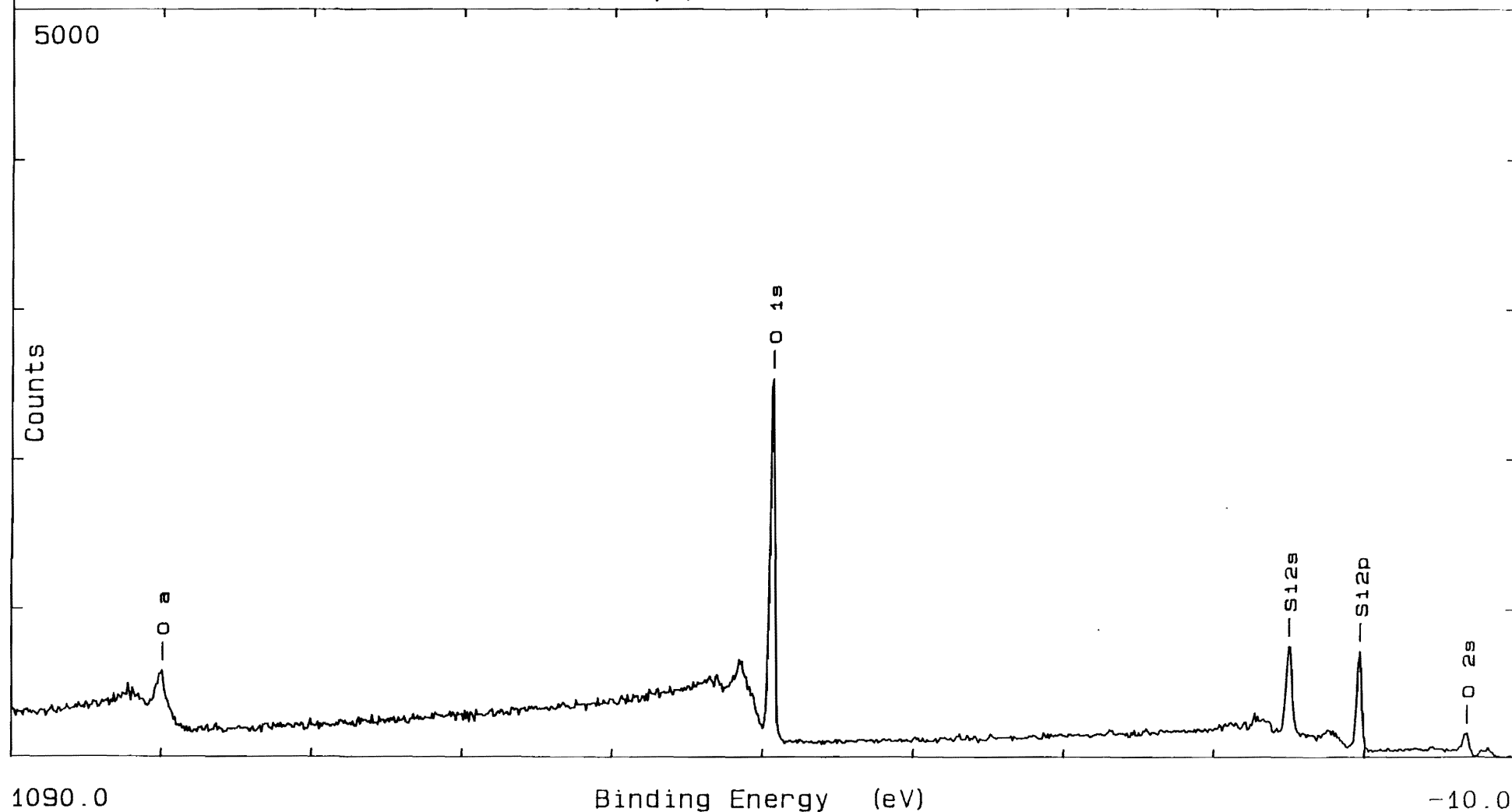


Figure 14

GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF067	Date: 9/18/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-3	# of Scans: 1	Resolution: 4
Description: CM02-25: EXPOSED (TRAILING EDGE), SiO _x ON AL FIRST SPOT, BEFORE BEING SPUTTERED			Operator: TAP

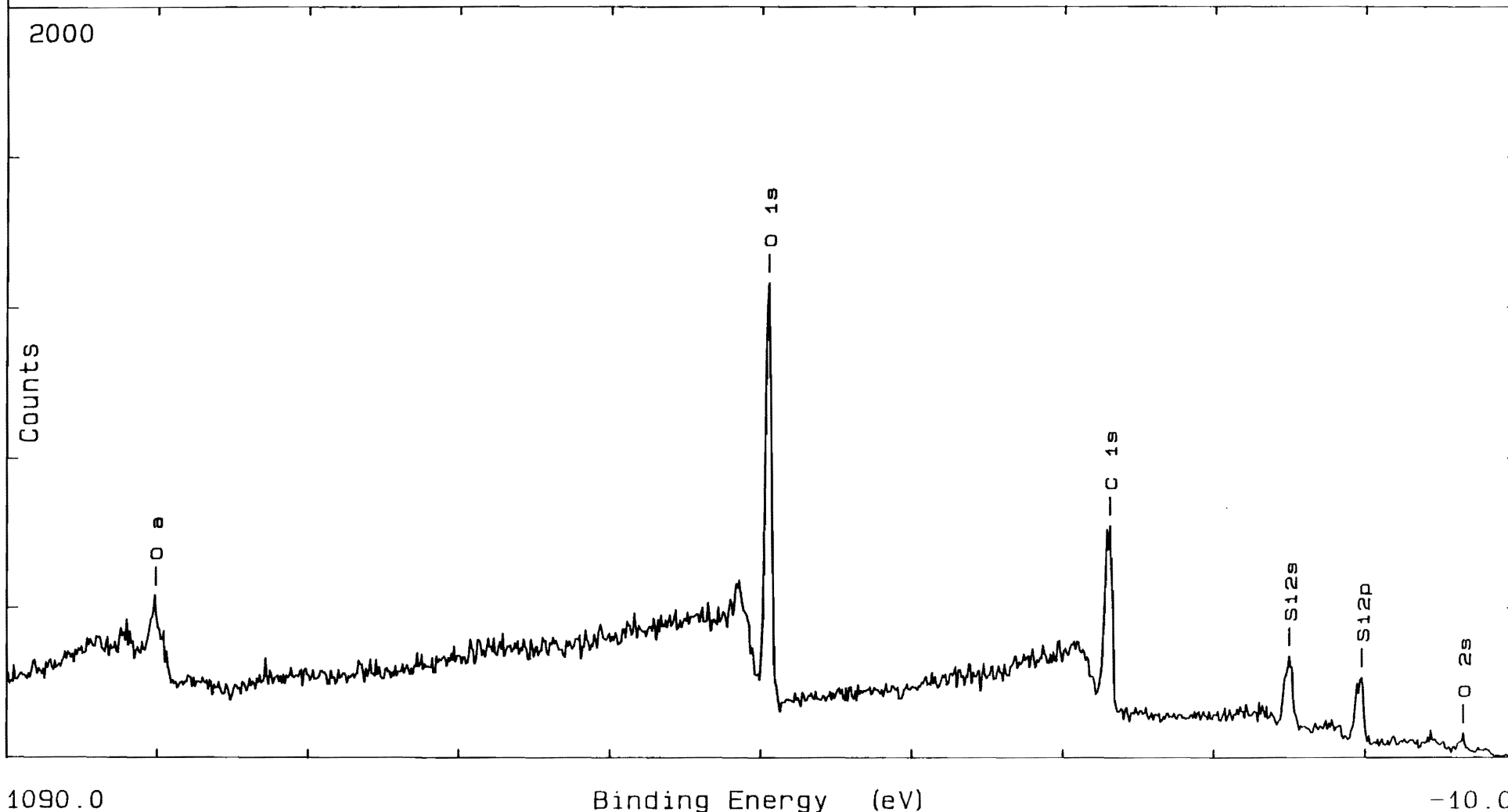


Figure 15

File: LDEF068	Date: 9/18/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: B9826		Resolution: 4

Description: CM02-25: EXPOSED (TRAILING EDGE), SiO_x ON AL
 FIRST SPOT, DELTA t=20 s. Operator: TAP

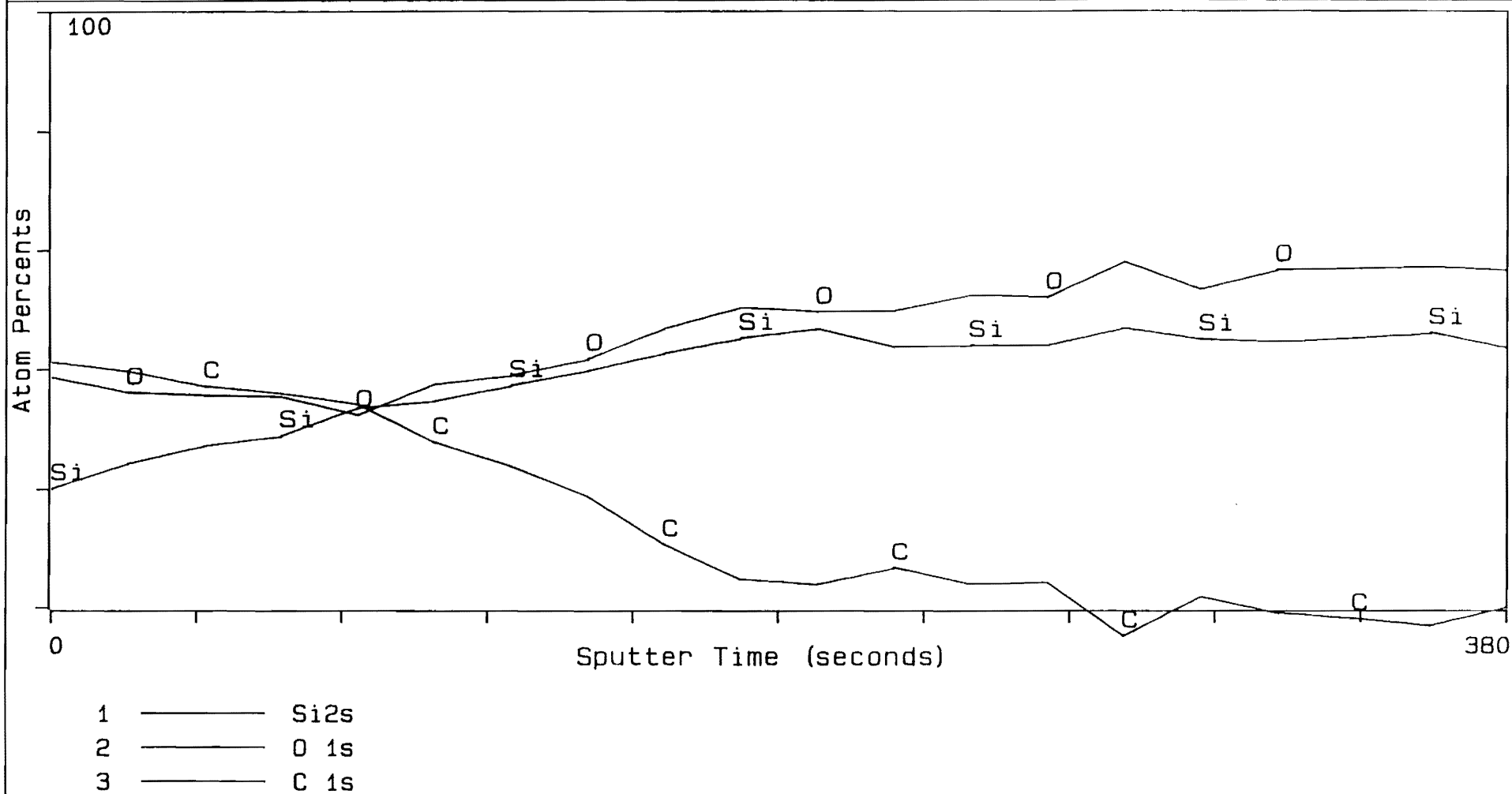


Figure 16

File: LDEF070	Date: 9/18/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4
Description: CM02-25: EXPOSED (TRAILING EDGE), SiO ₂ ON AL FIRST SPOT, AFTER BEING SPUTTERED 680 S.			Operator: TAP

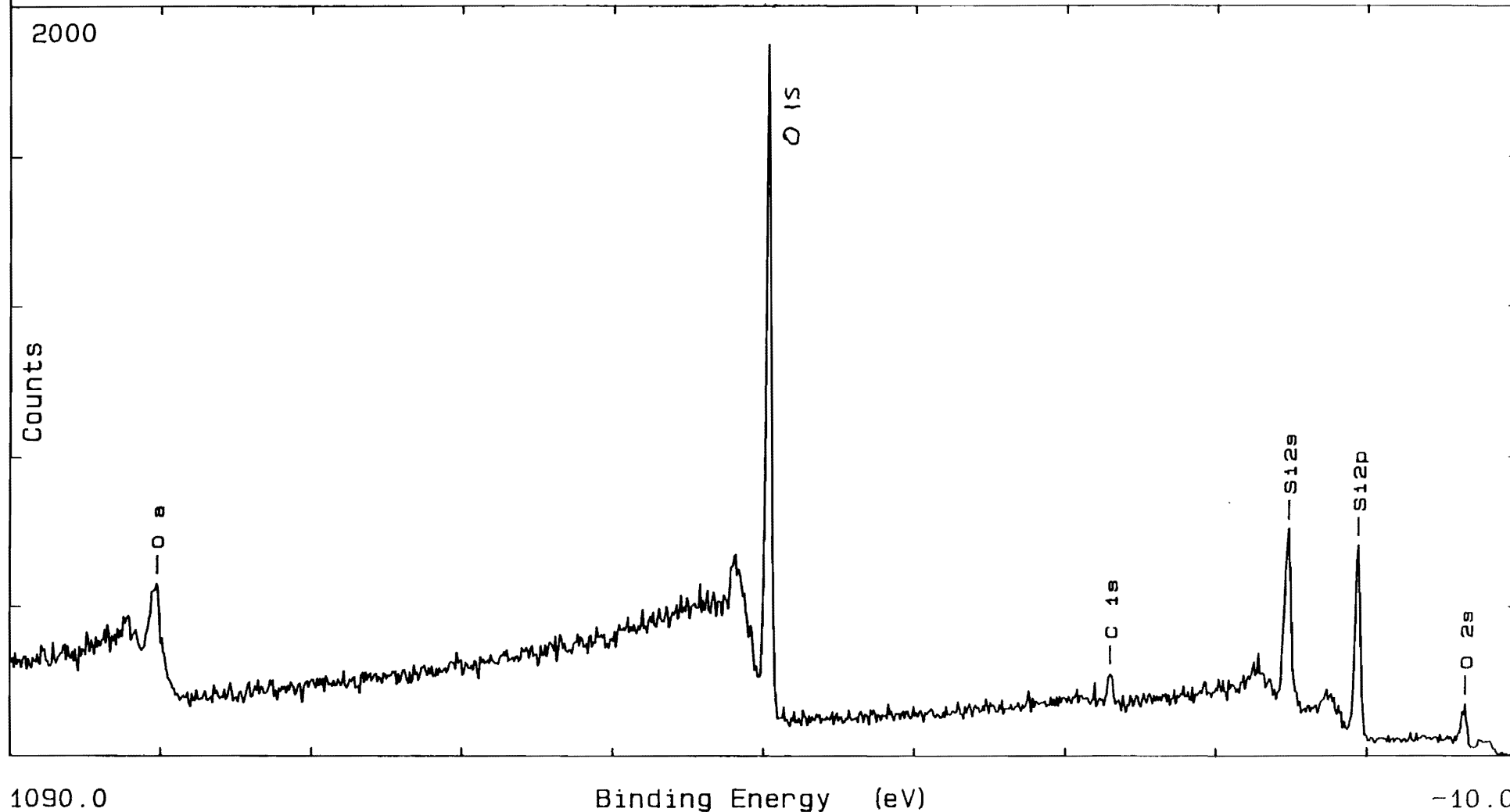


Figure 17

File: LDEF071	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4
Description: CM02-25: EXPOSED (TRAILING EDGE), SiO _x ON AL SECOND SPOT, BEFORE BEING SPUTTERED			Operator: TAP

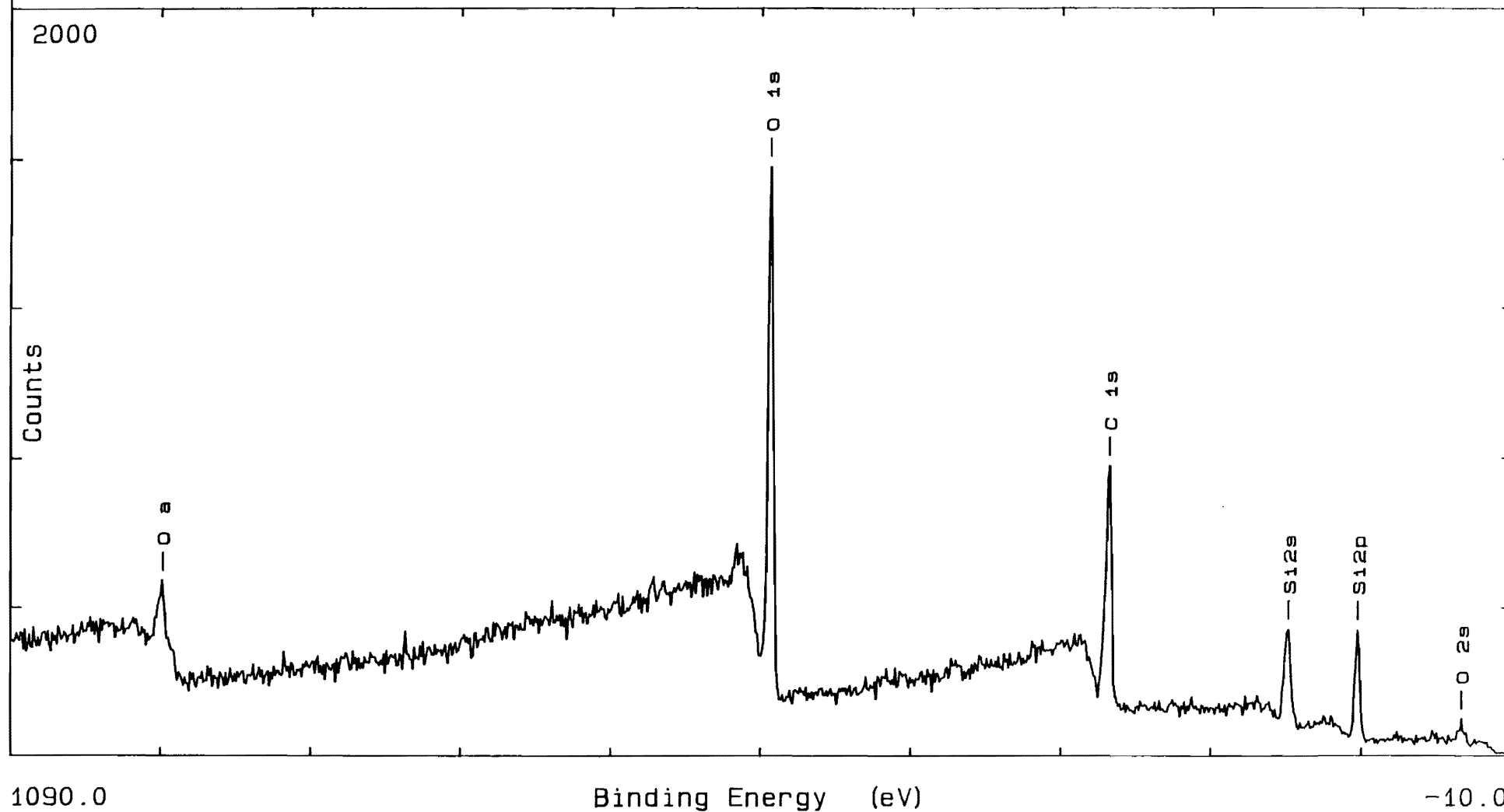


Figure 18

File: LDEF072	Date: 9/19/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: B9826		Resolution: 4
Description: CM02-25: EXPOSED (TRAILING EDGE), SiO _x ON AL SECOND SPOT , DELTA t=20 S.	Operator: TAP		

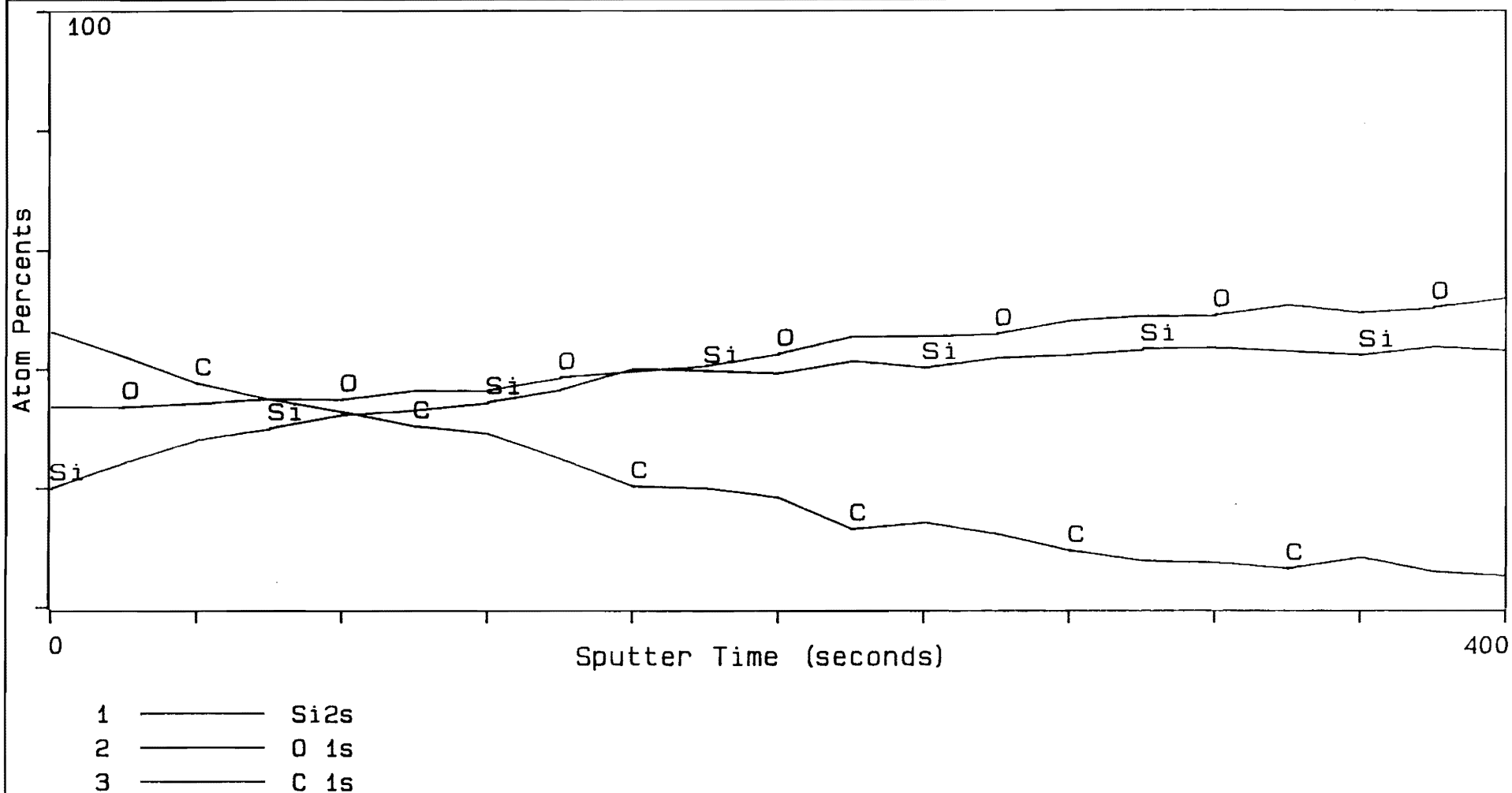


Figure 19

File: LDEF074	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4
Description: CM02-25: EXPOSED (TRAILING EDGE), SiO ₂ ON AL SECOND SPOT, AFTER BEING SPUTTERED 500 S.			Operator: TAP

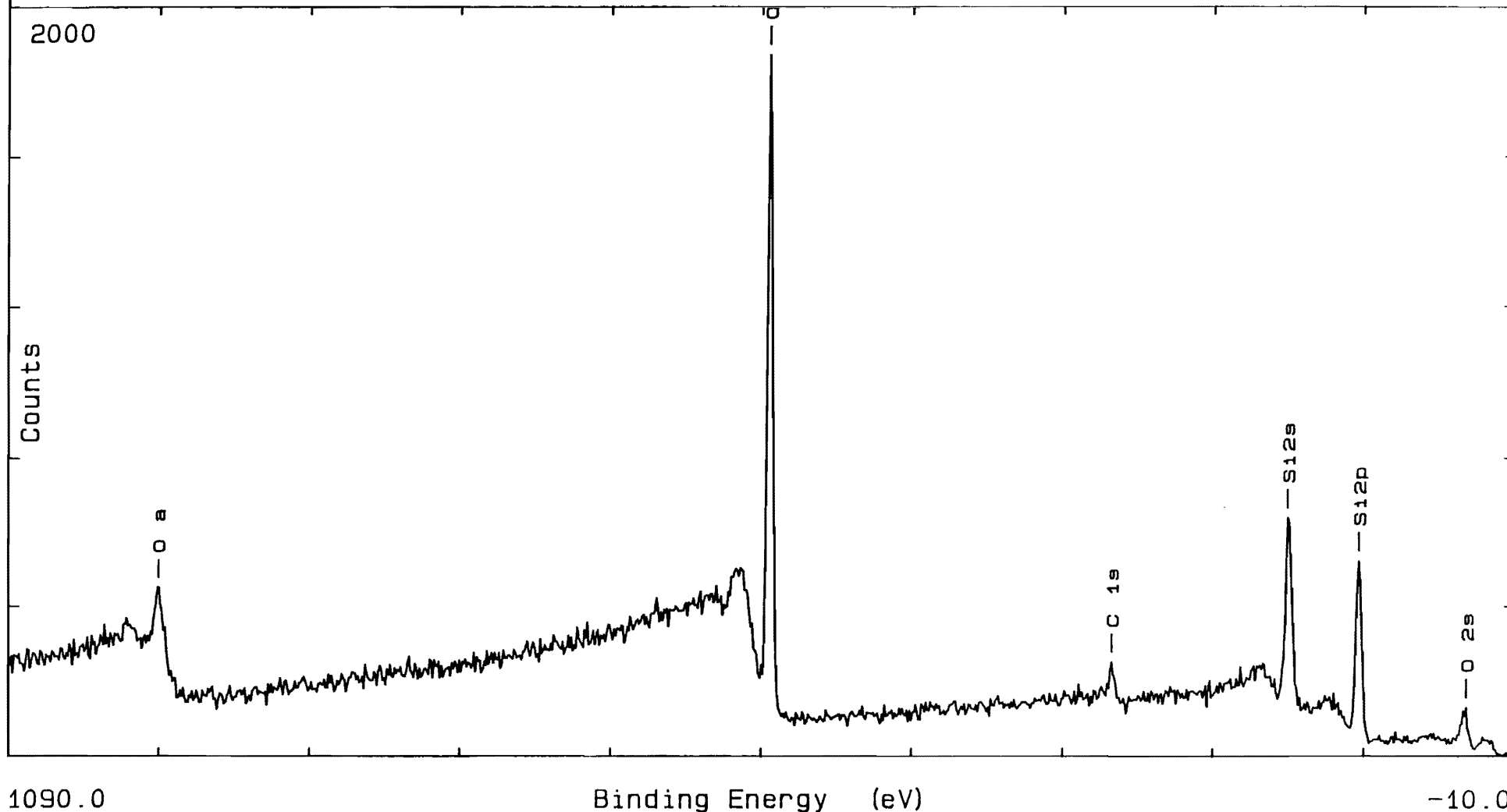
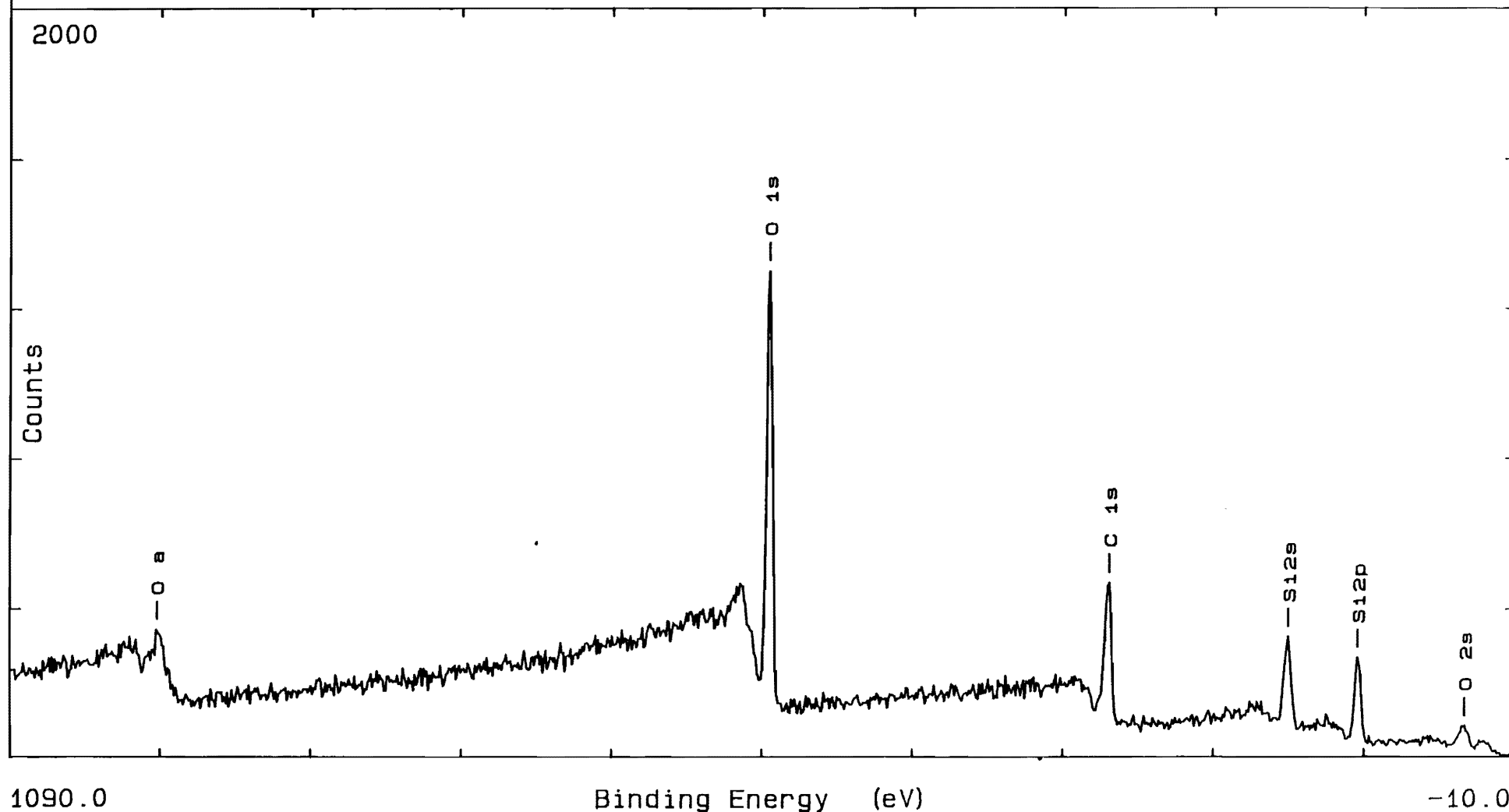


Figure 20

File: LDEF075	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4

Description: CM02-34: EXPOSED (TRAILING EDGE), SiO_x ON AL
FIRST SPOT, BEFORE BEING SPUTTERED

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF076

Date: 9/19/1992

Spot Size: 300 u

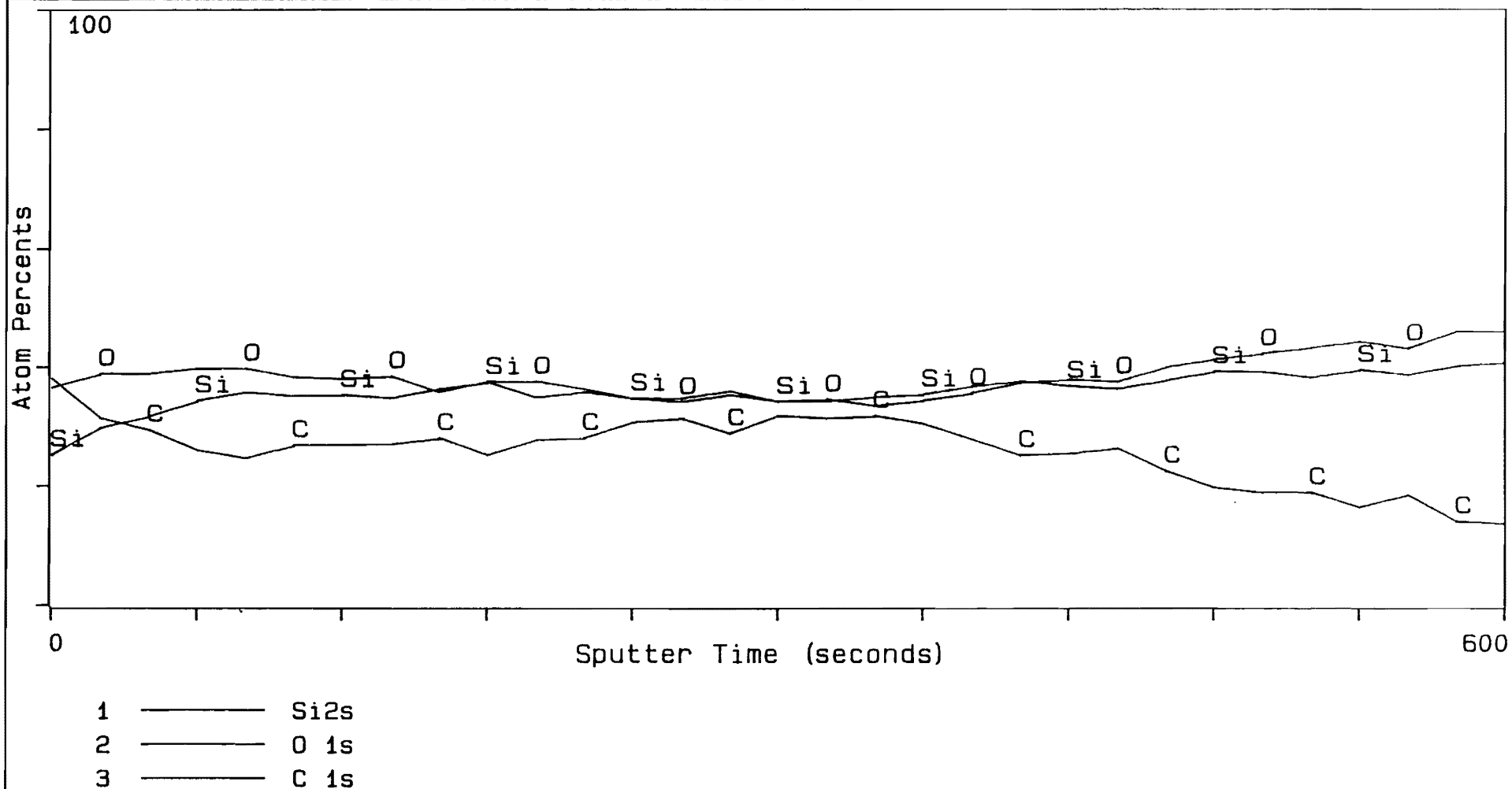
Flood Gun: 1.0 eV

Disc: B9826

Resolution: 4

Description: CM02-34: EXPOSED (TRAILING EDGE), SiO_x ON AL
FIRST SPOT, DELTA t=20 s.

Operator: TAP

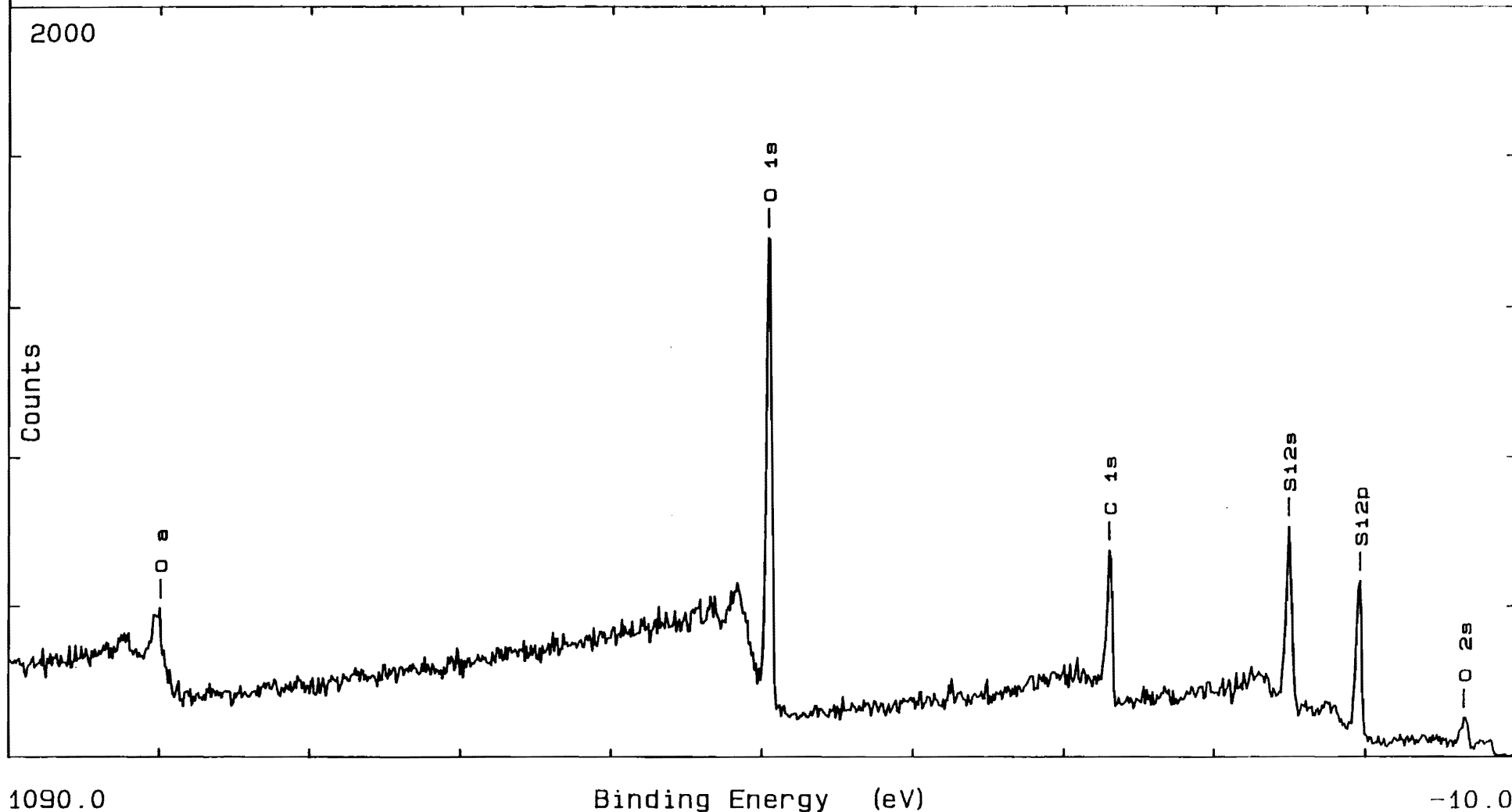


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF077	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4

Description: CM02-34: EXPOSED (TRAILING EDGE), SiO_x ON AL
FIRST SPOT, AFTER BEING SPUTTERED 600 S.

Operator: TAP



File: LDEF078	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4
Description: CM02-34: EXPOSED (TRAILING EDGE), SiO _x ON AL SECOND SPOT, BEFORE BEING SPUTTERED	Operator: TAP		

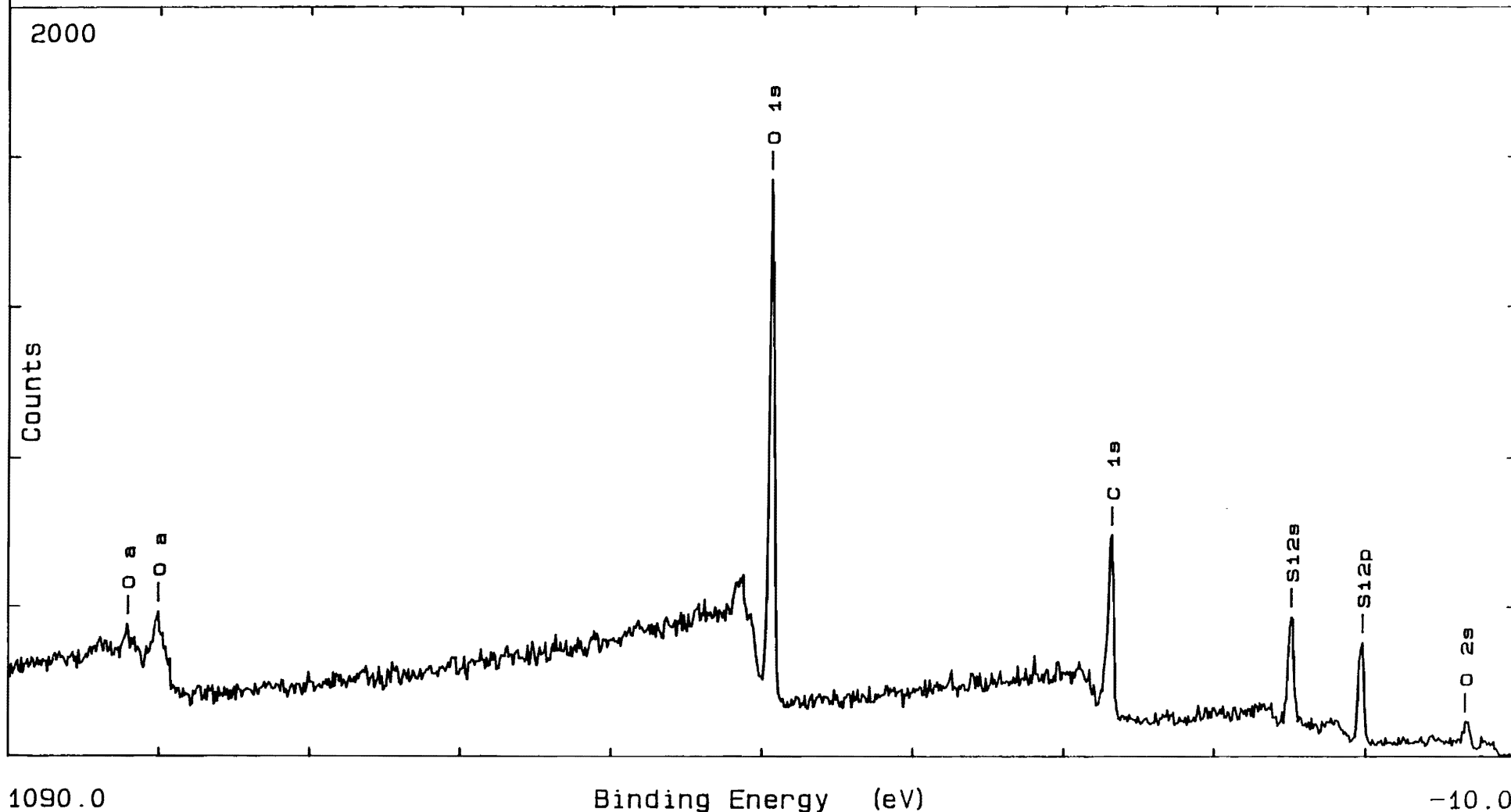


Figure 24

File: LDEF079

Date: 9/19/1992

Spot Size: 300 u

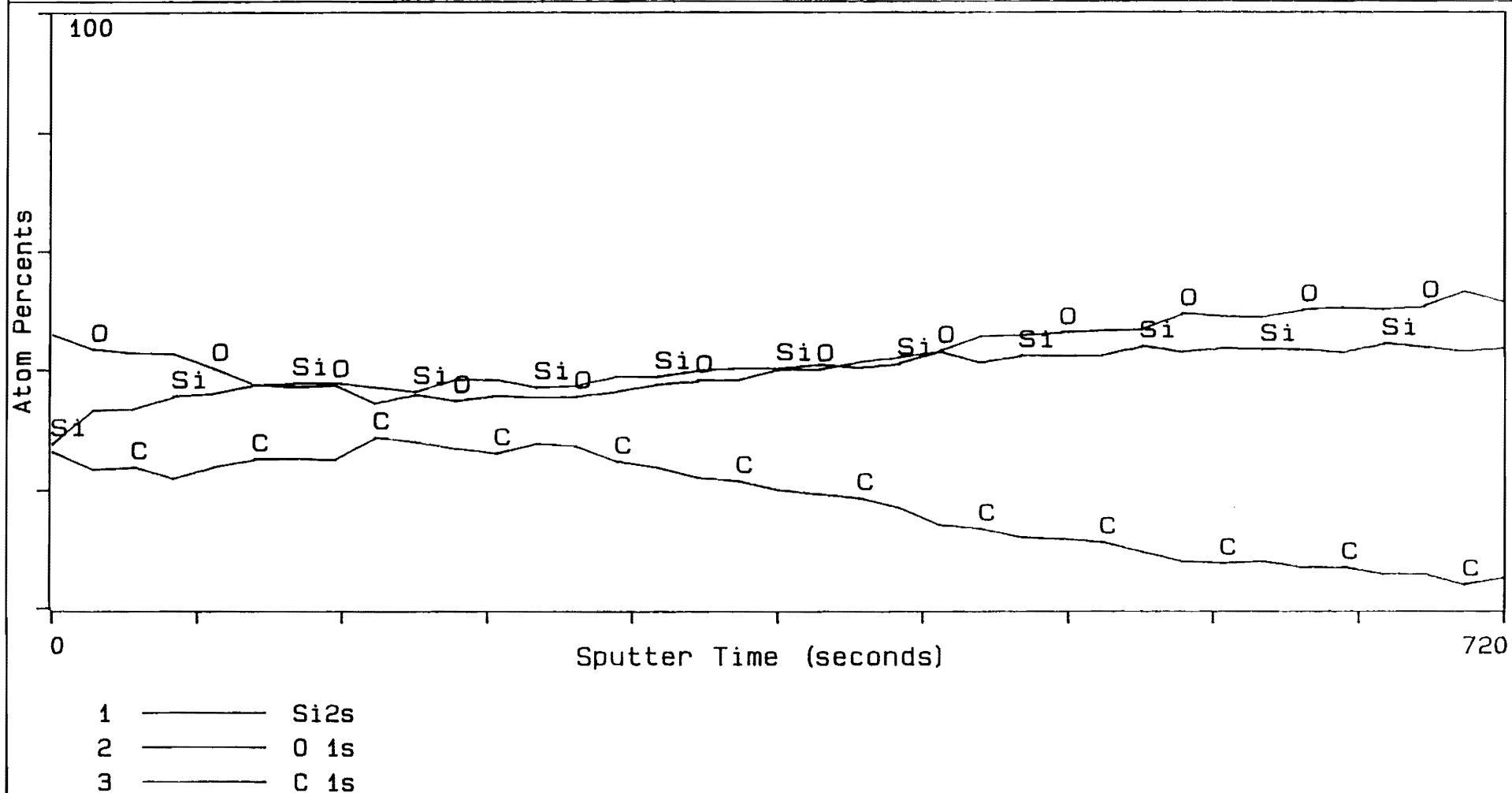
Flood Gun: 1.0 eV

Disc: B9826

Resolution: 4

Description: CM02-34: EXPOSED (TRAILING EDGE), SiO_x ON AL
SECOND SPOT, DELTA t=20 s.

Operator: TAP

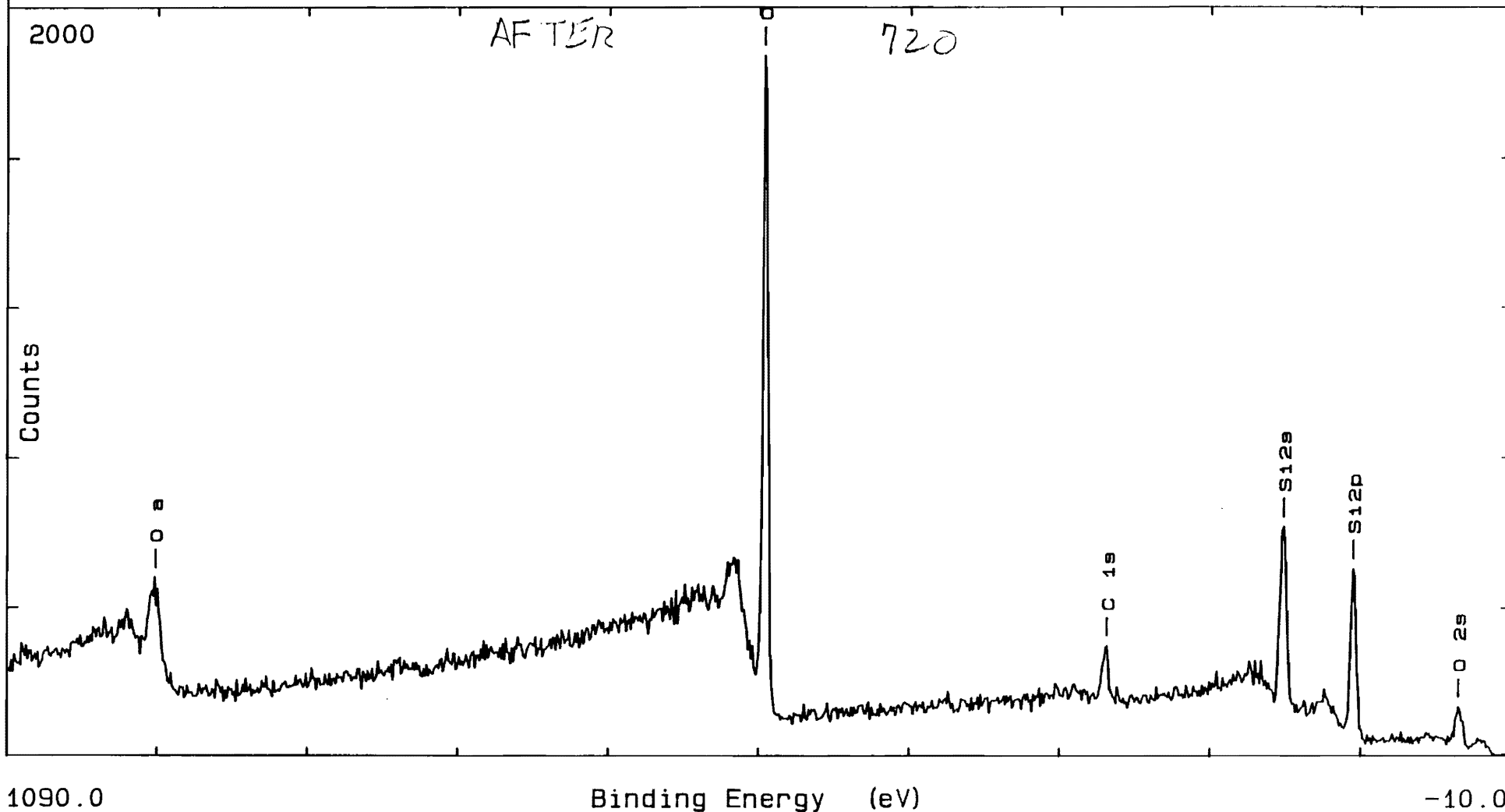


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF080	Date: 9/19/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: B9826	# of Scans: 1	Resolution: 4

Description: CM02-34: EXPOSED (TRAILING EDGE), SiO_x ON AL
SECOND SPOT, ~~BEFORE~~ BEING SPUTTERED 740 s.

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

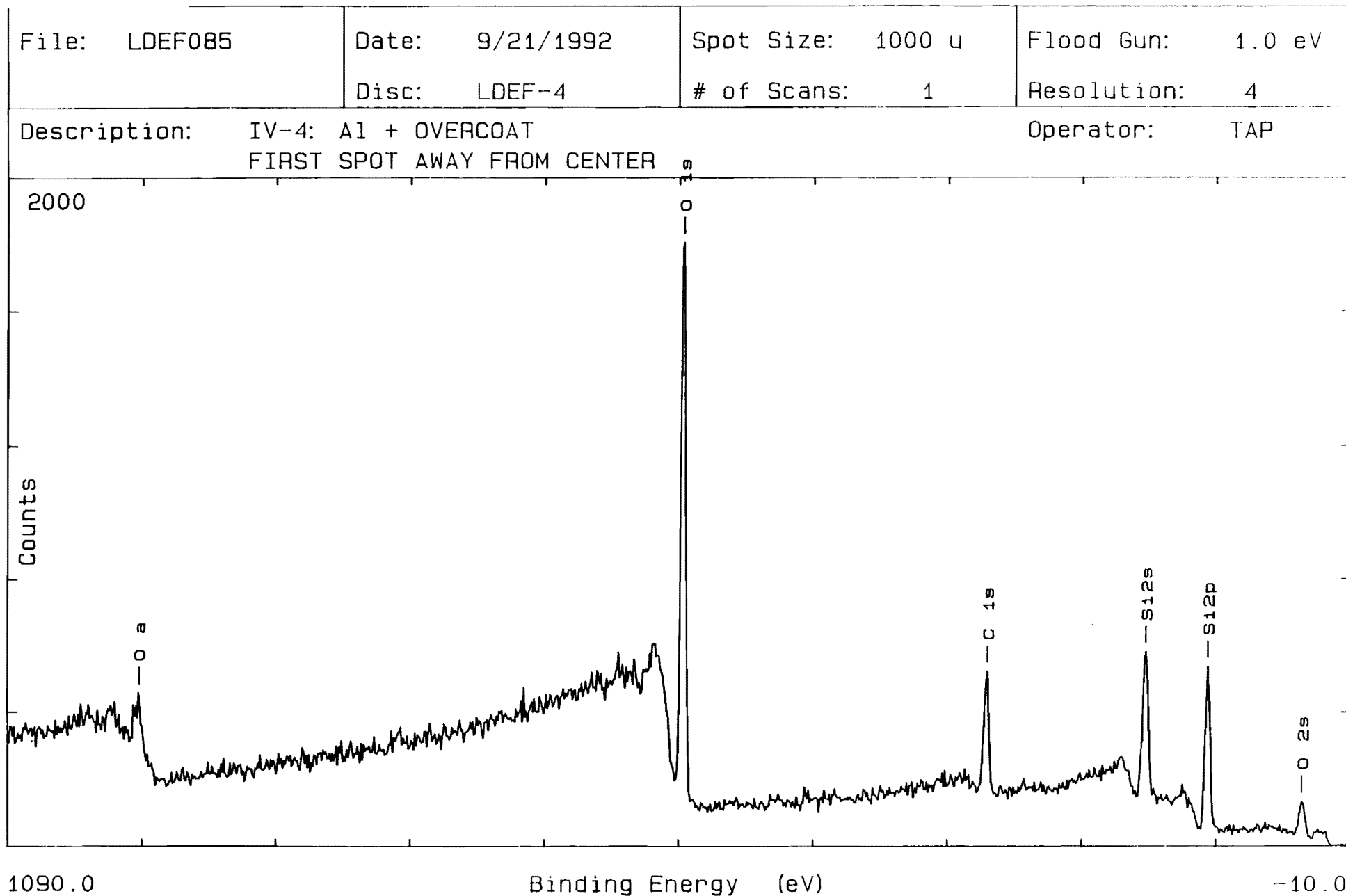
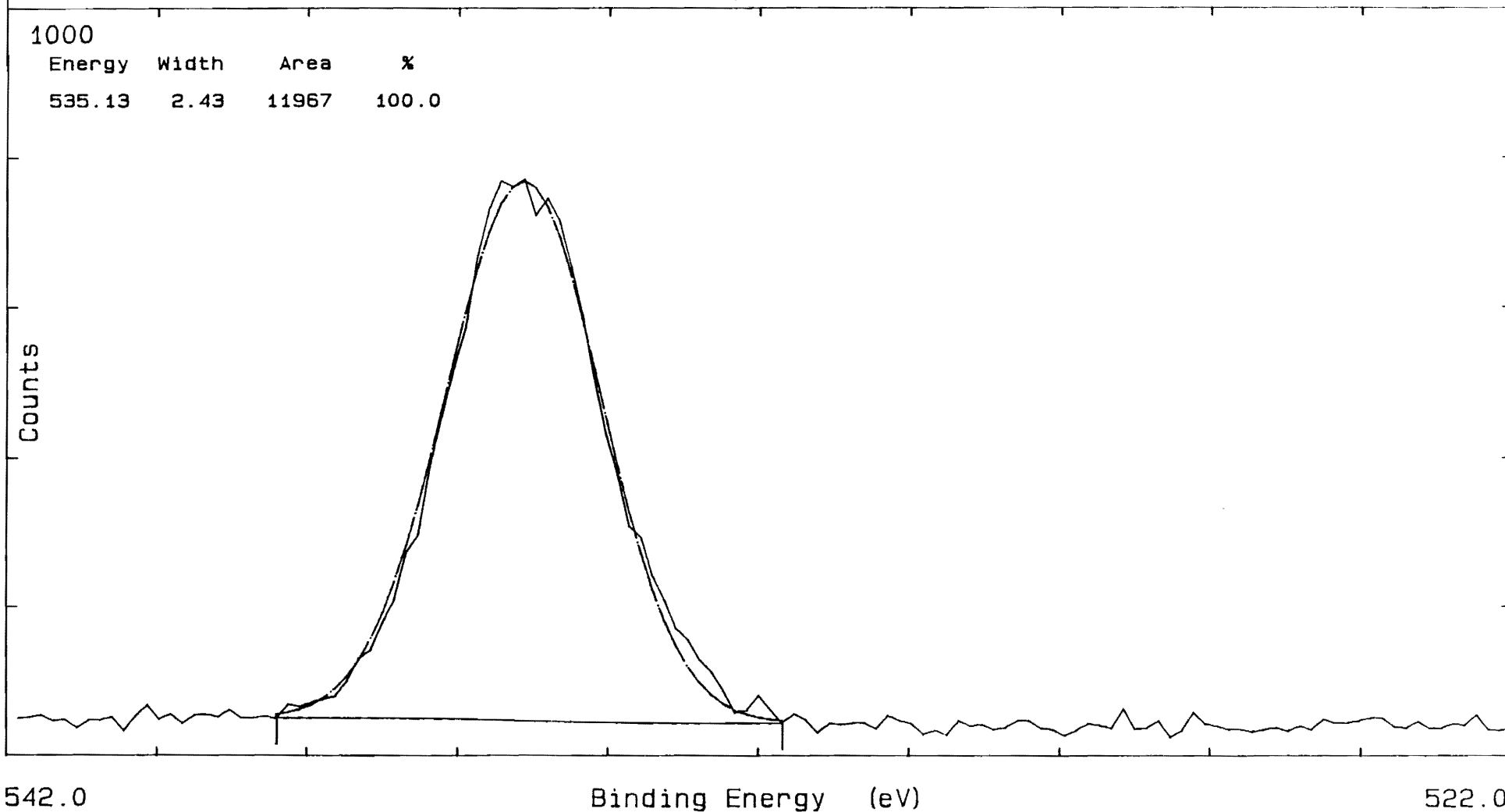


Figure 27

File: LDEF086	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-4	# of Scans: 3	Resolution: 2

Description: IV-4: Al + OVERCOAT
FIRST SPOT AWAY FROM CENTER, 0 1s SPECTRUM

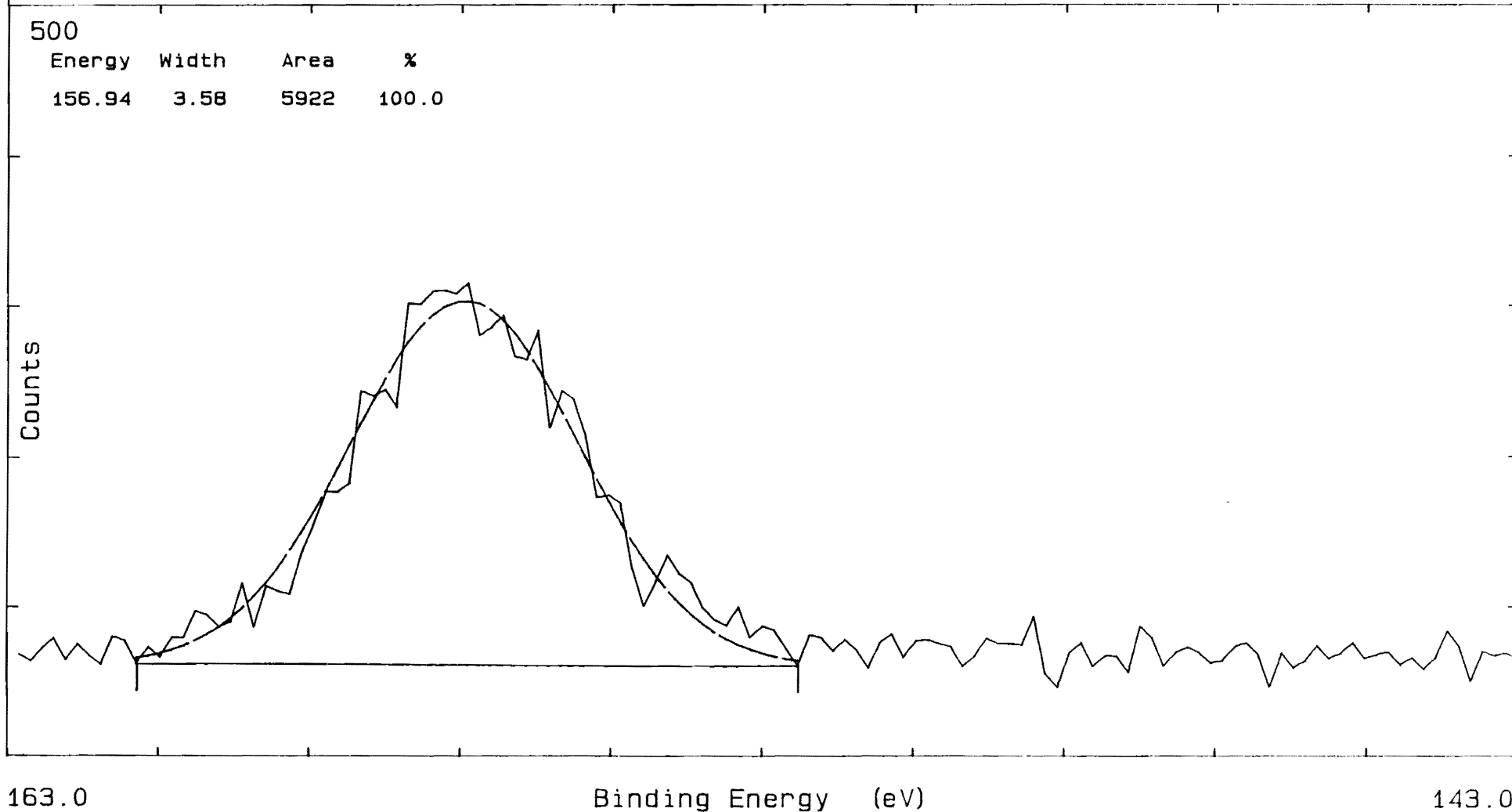
Operator: TAP



File: LDEF086	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-4	# of Scans: 5	Resolution: 2

Description: IV-4: Al + OVERCOAT
FIRST SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF086

Date: 9/21/1992

Spot Size: 300 u

Flood Gun: 1.0 eV

Region 3

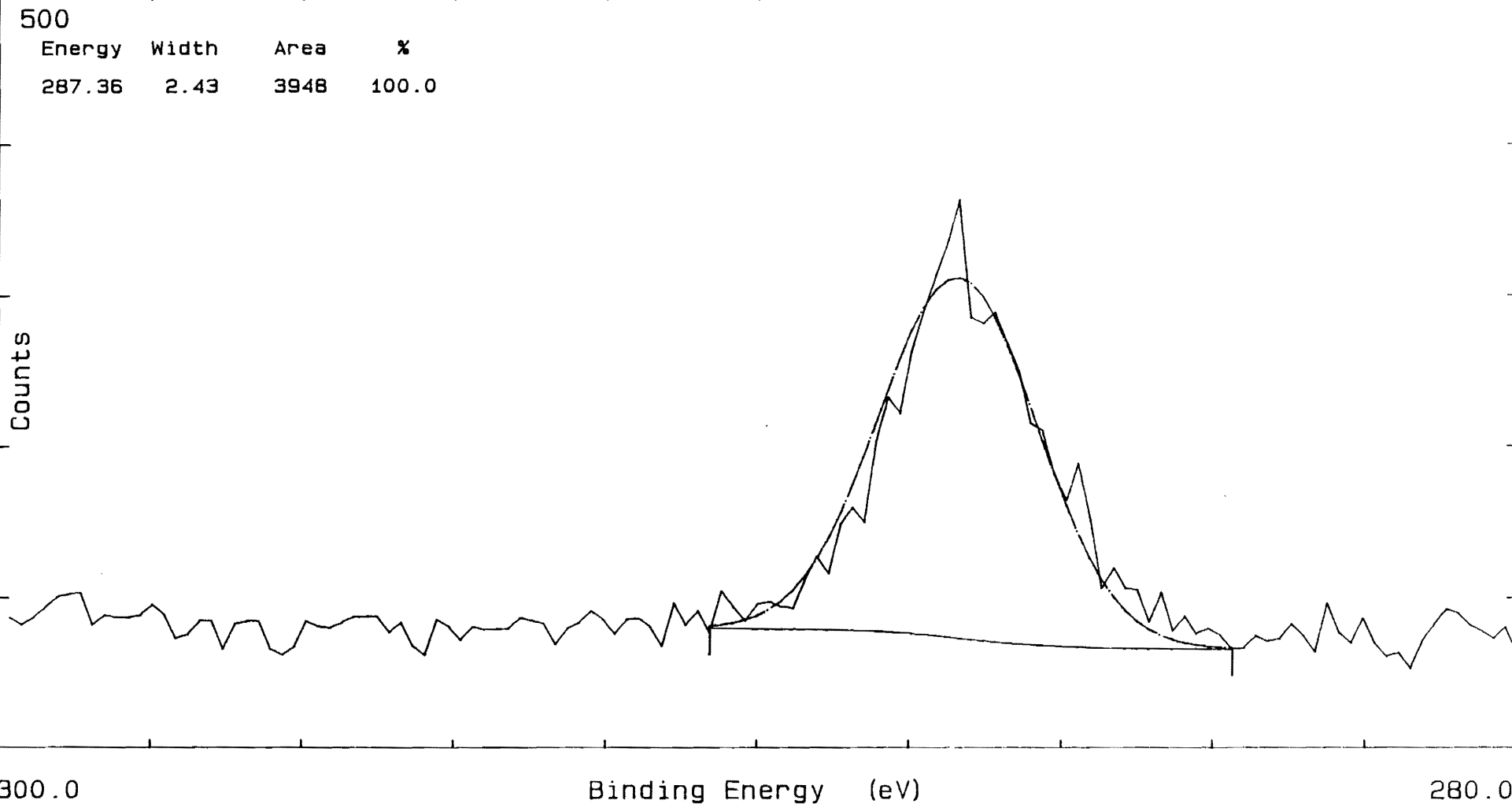
Disc: LDEF-4

of Scans: 5

Resolution: 2

Description: IV-4: Al + OVERCOAT
FIRST SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF087	Date: 9/21/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-10: Al + OVERCOAT SECOND SPOT AWAY FROM CENTER			Operator: TAP

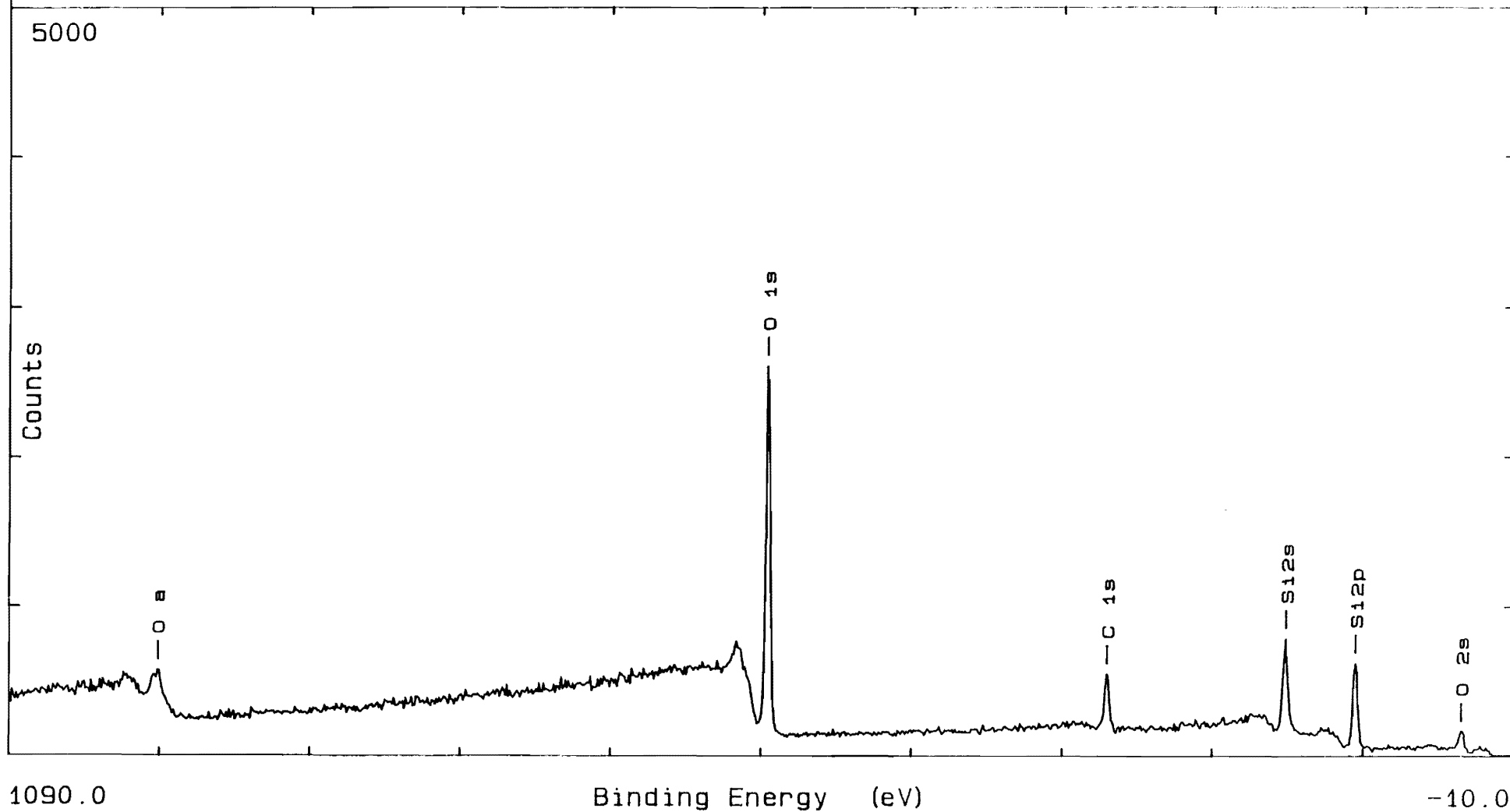
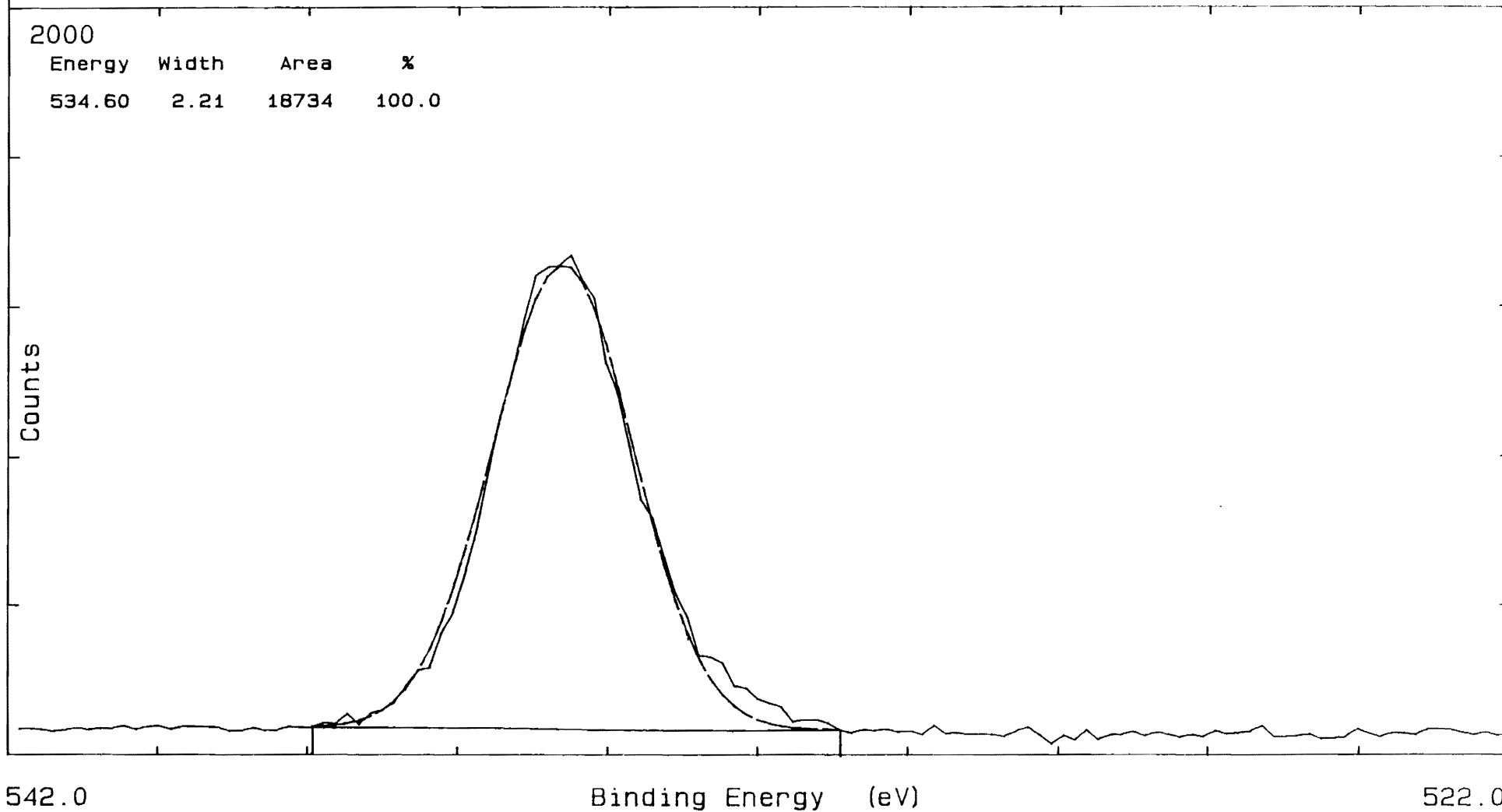


Figure 31

File: LDEF087	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-10: Al + OVERCOAT SECOND SPOT AWAY FROM CENTER, 0 1s SPECTRUM			Operator: TAP

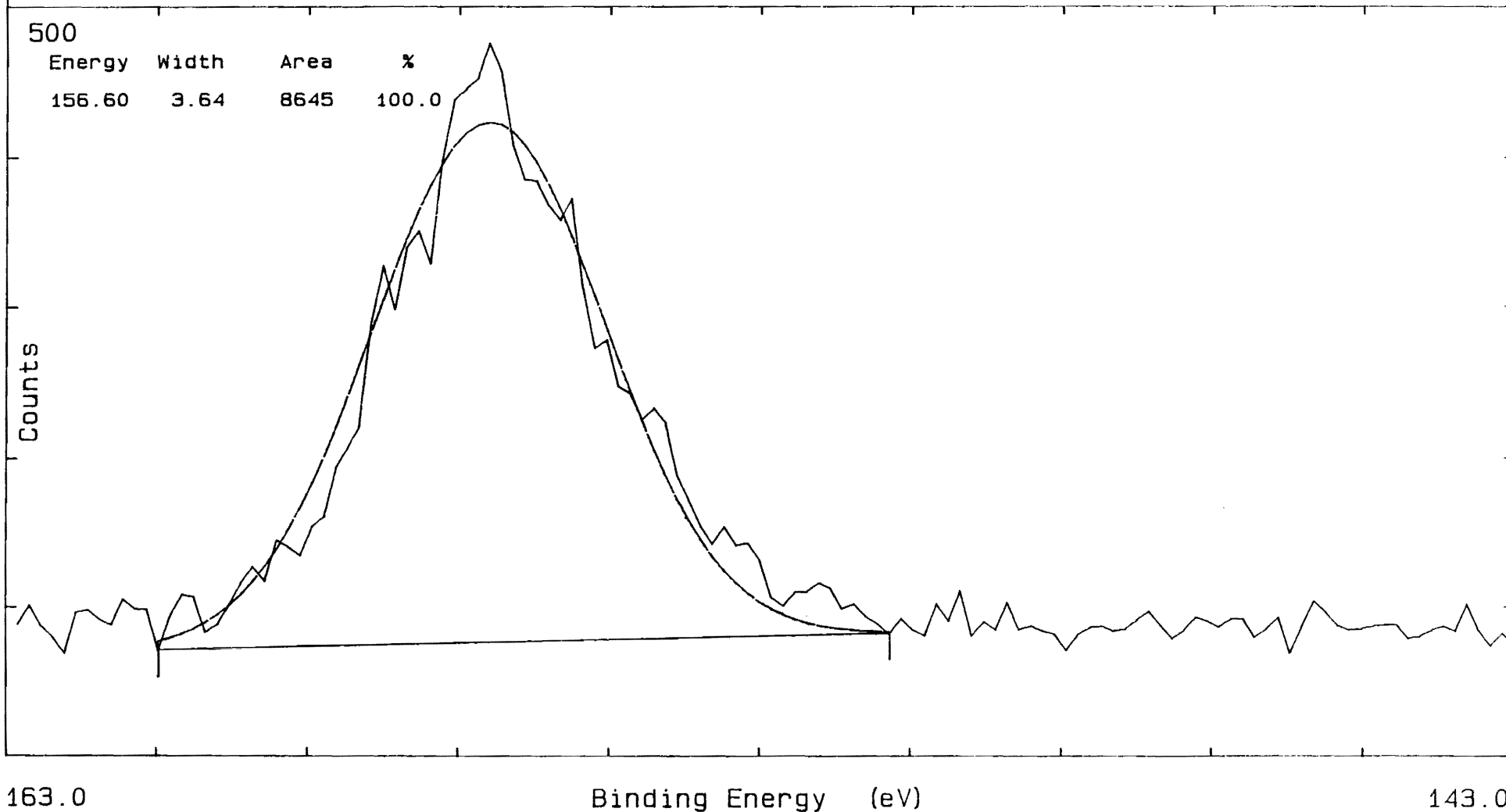


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF087	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-10: Al + OVERCOAT
SECOND SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP



File: LDEF087	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-10: Al + OVERCOAT
SECOND SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP

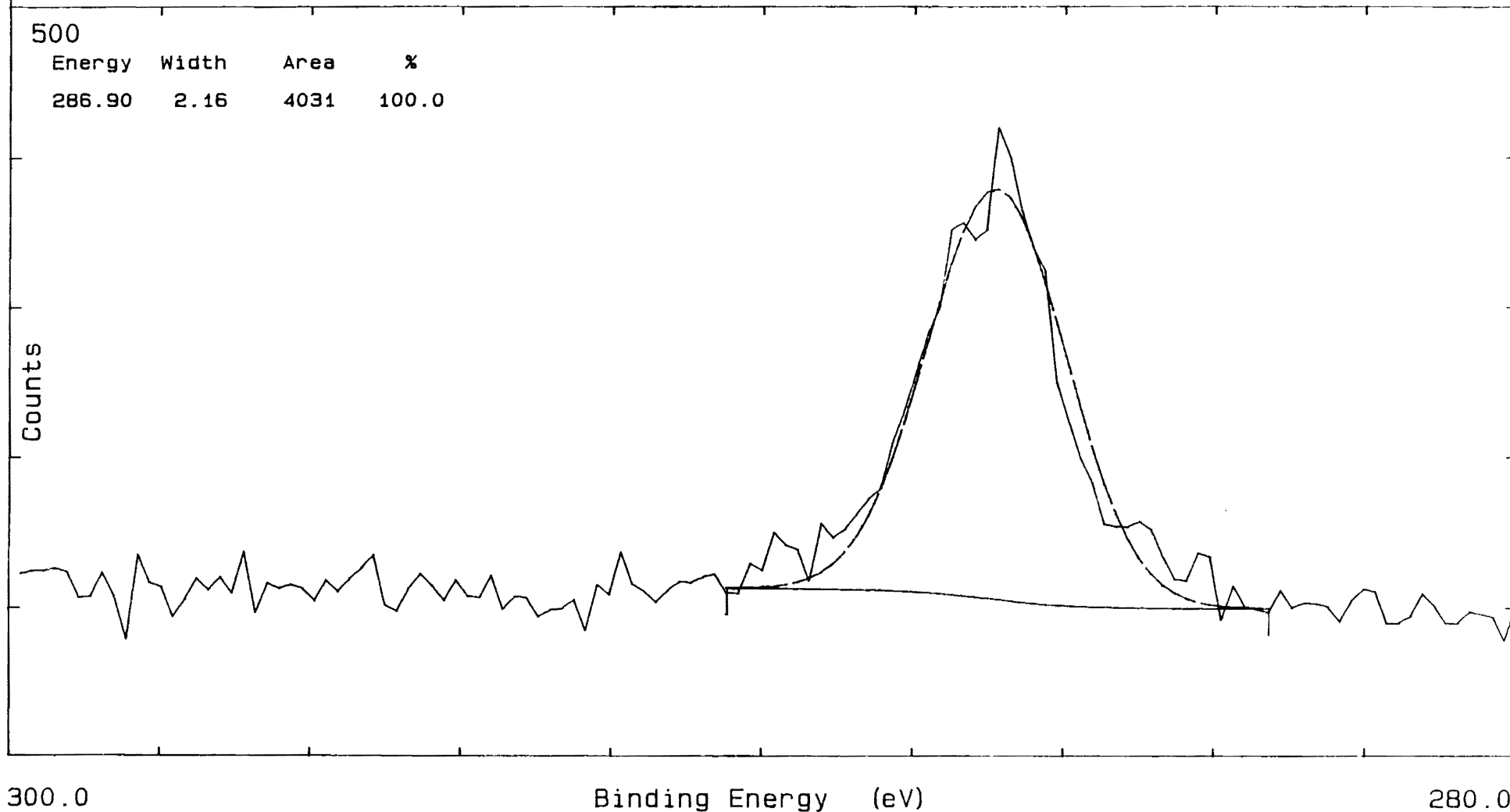


Figure 34

File: LDEF088	Date: 9/21/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-16: Ag + OVERCOAT FIRST SPOT AWAY FROM CENTER			Operator: TAP

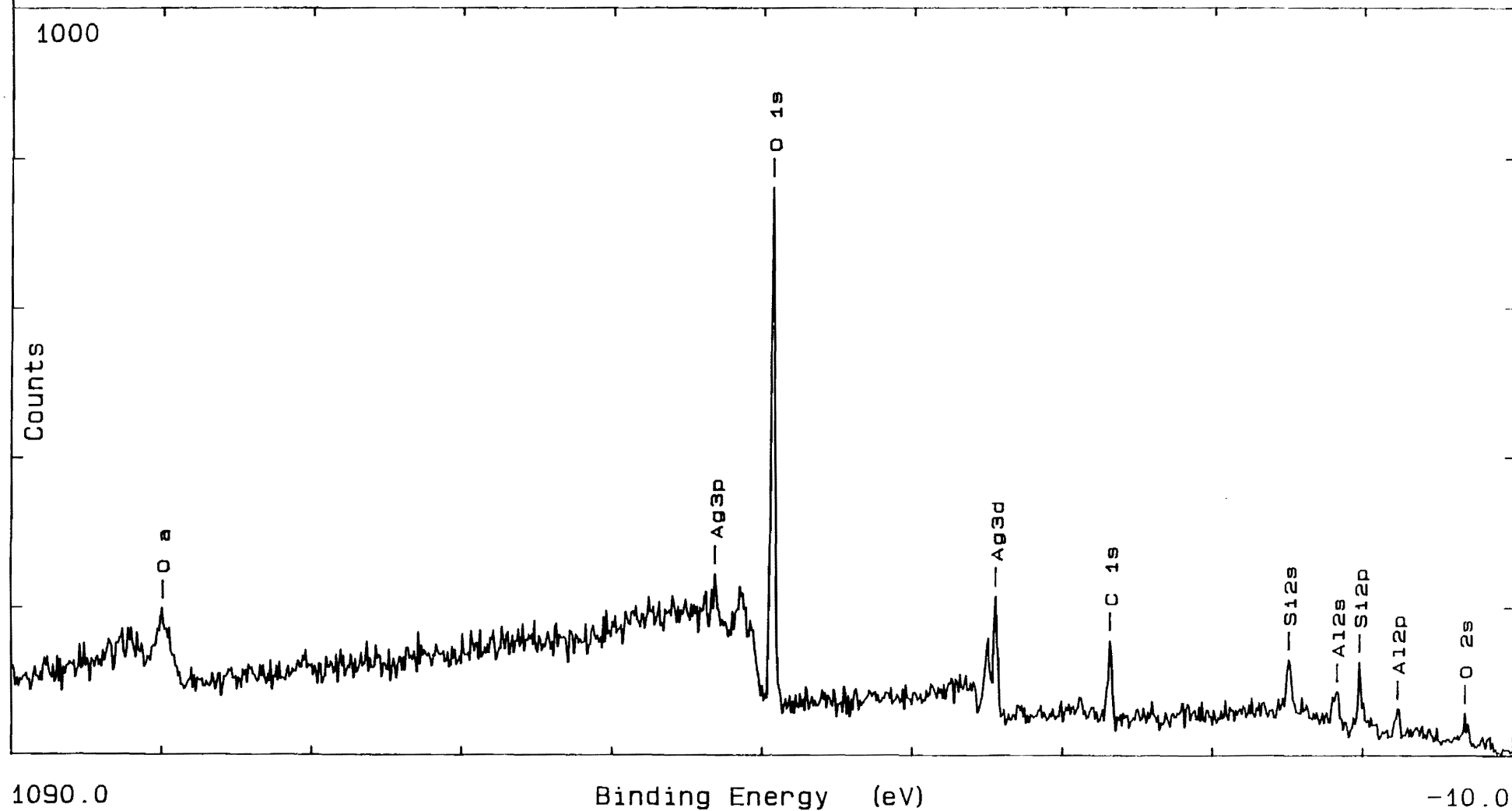
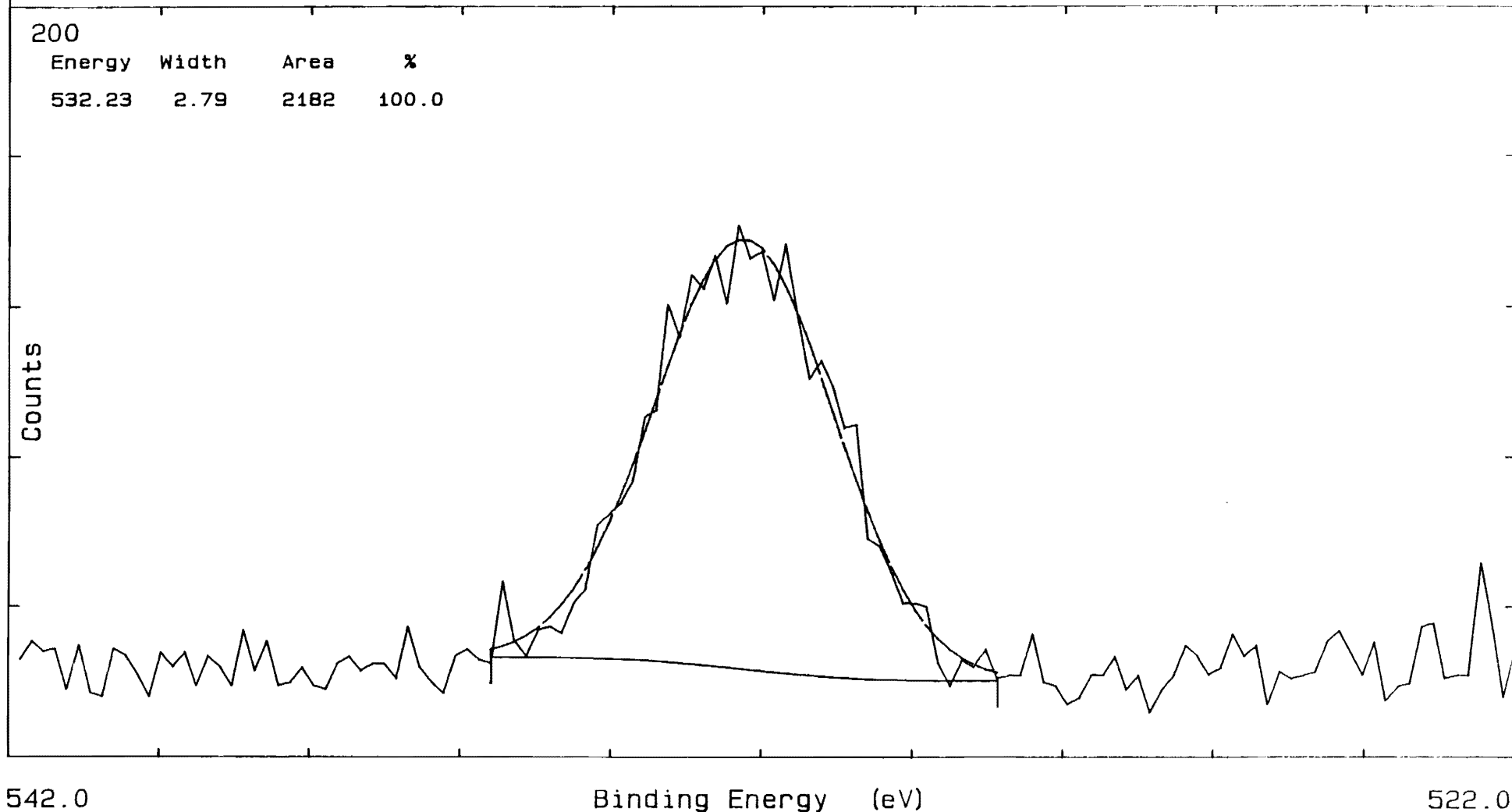


Figure 35

File: LDEF088	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-16: Ag + OVERCOAT
FIRST SPOT AWAY FROM CENTER, 0 1s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF088	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-16: Ag + OVERCOAT
FIRST SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP

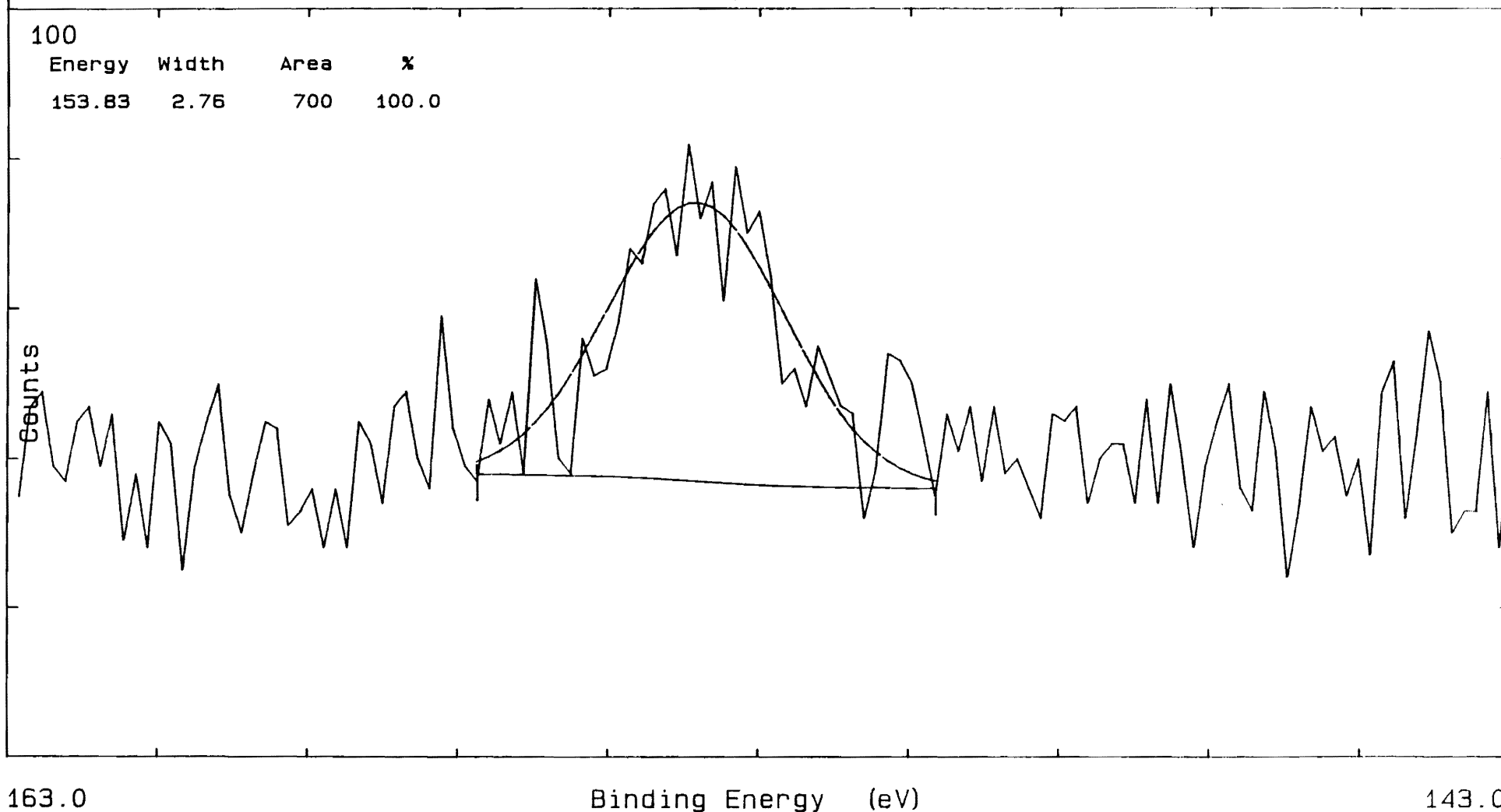
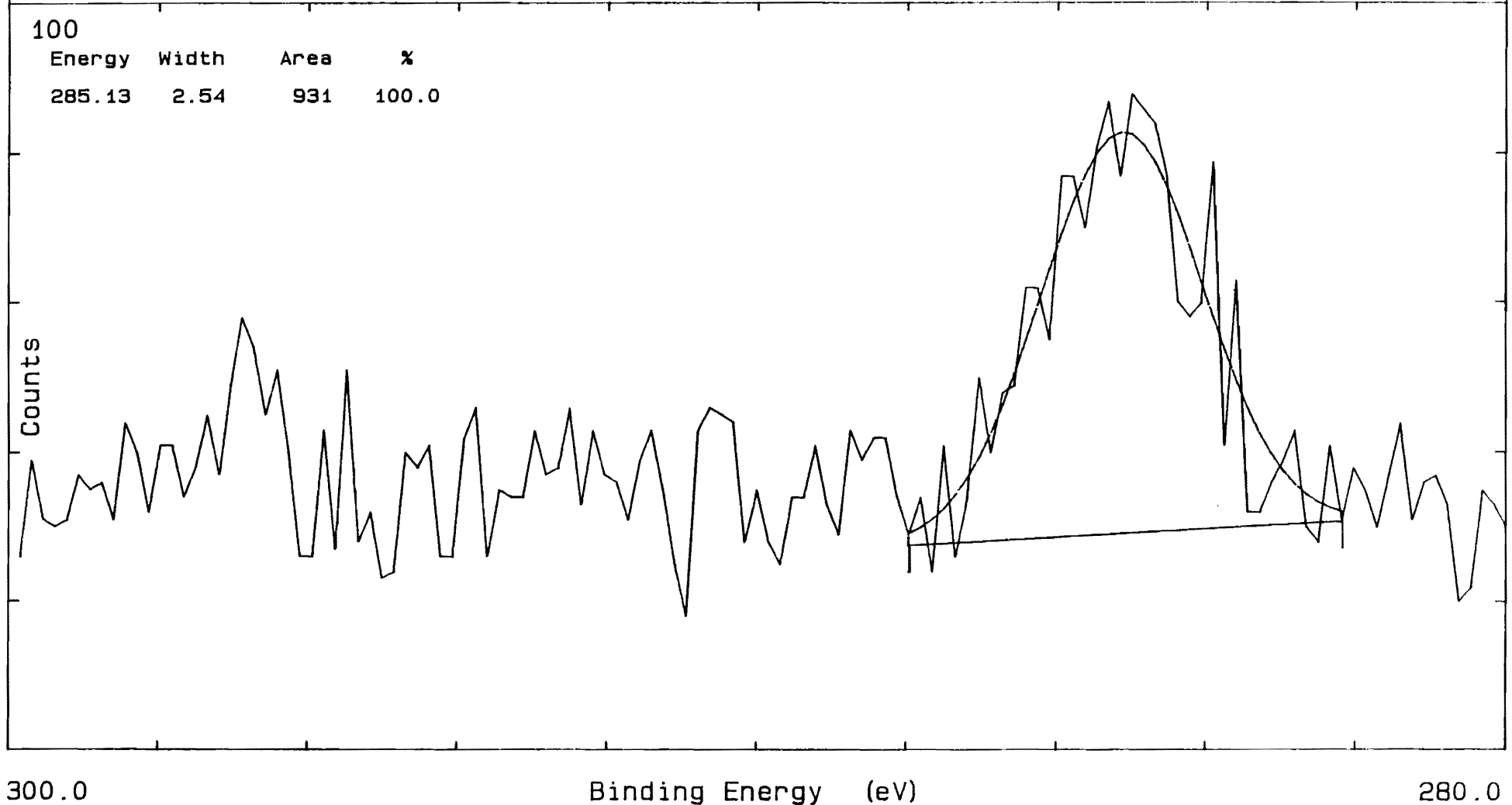


Figure 37

File: LDEF088	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-16: Ag + OVERCOAT FIRST SPOT AWAY FROM CENTER, C 1s SPECTRUM			Operator: TAP

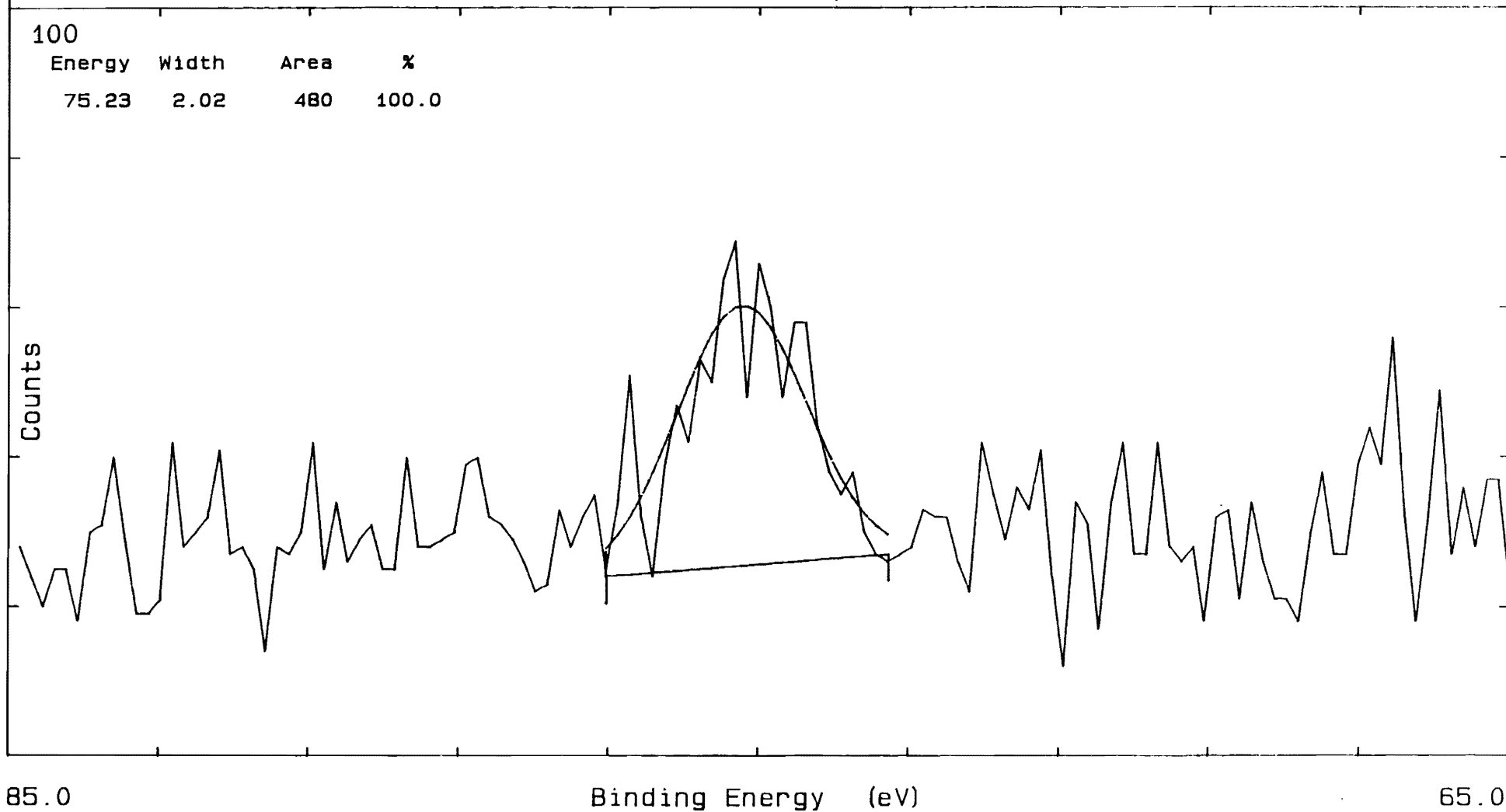


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF089	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-16: Ag + OVERCOAT
FIRST SPOT AWAY FROM CENTER, Al 2p SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF089	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 4	Resolution: 2

Description: IV-16: Ag + OVERCOAT
FIRST SPOT AWAY FROM CENTER, Ag 3d SPECTRUM

Operator: TAP

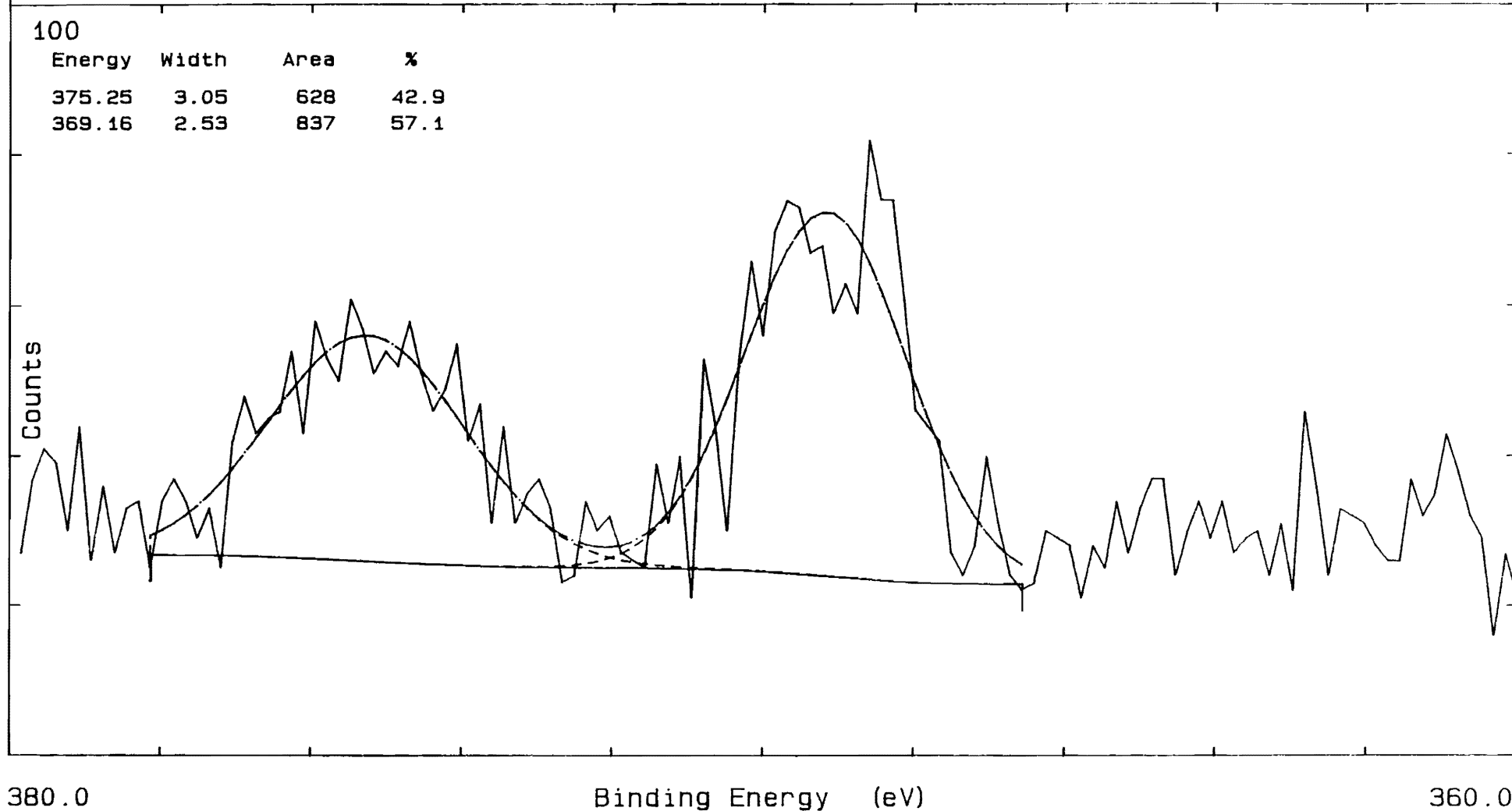


Figure 40

File: LDEF090	Date: 9/21/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-16: Ag + OVERCOAT SECOND SPOT AWAY FROM CENTER			Operator: TAP

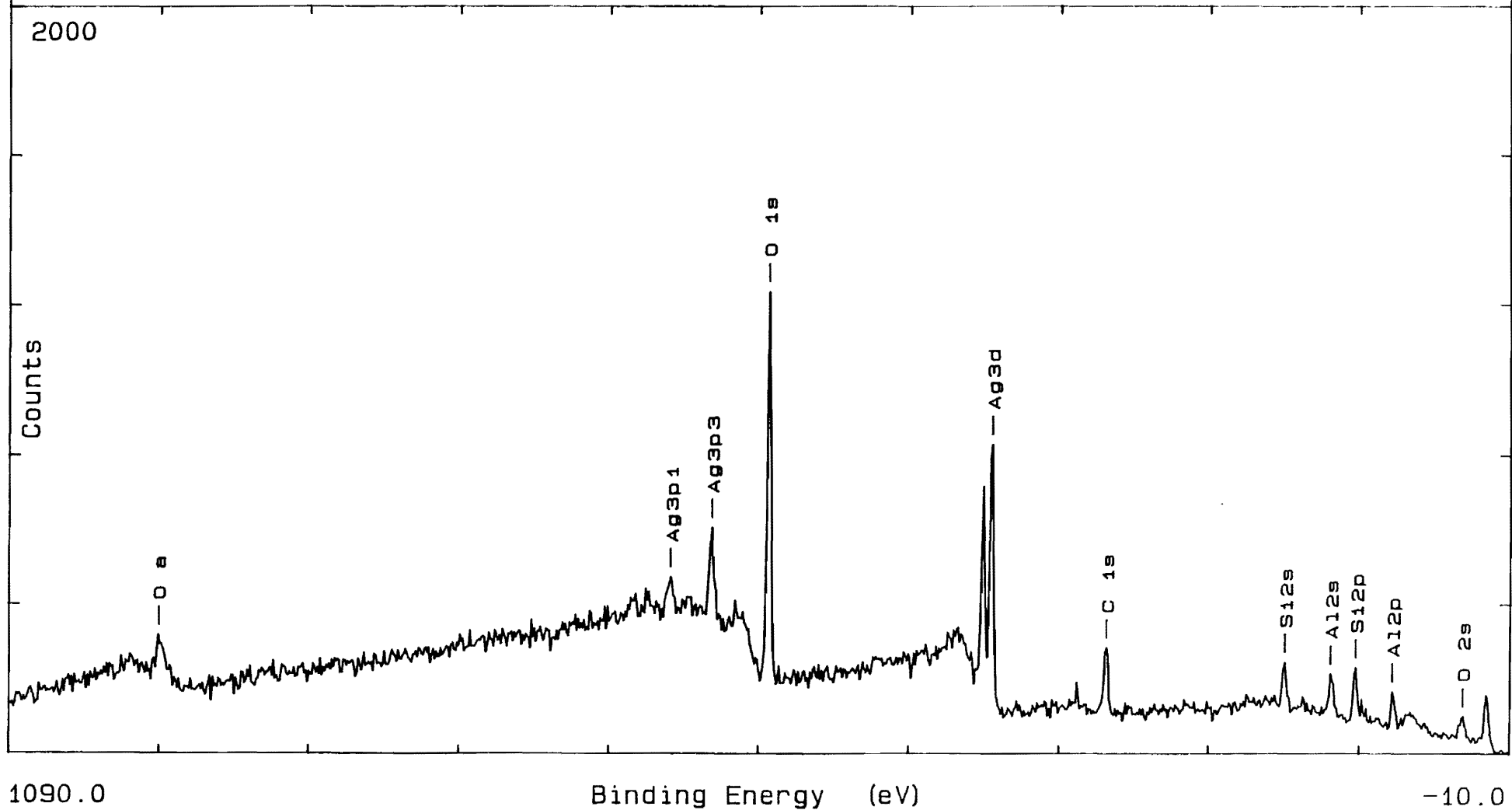
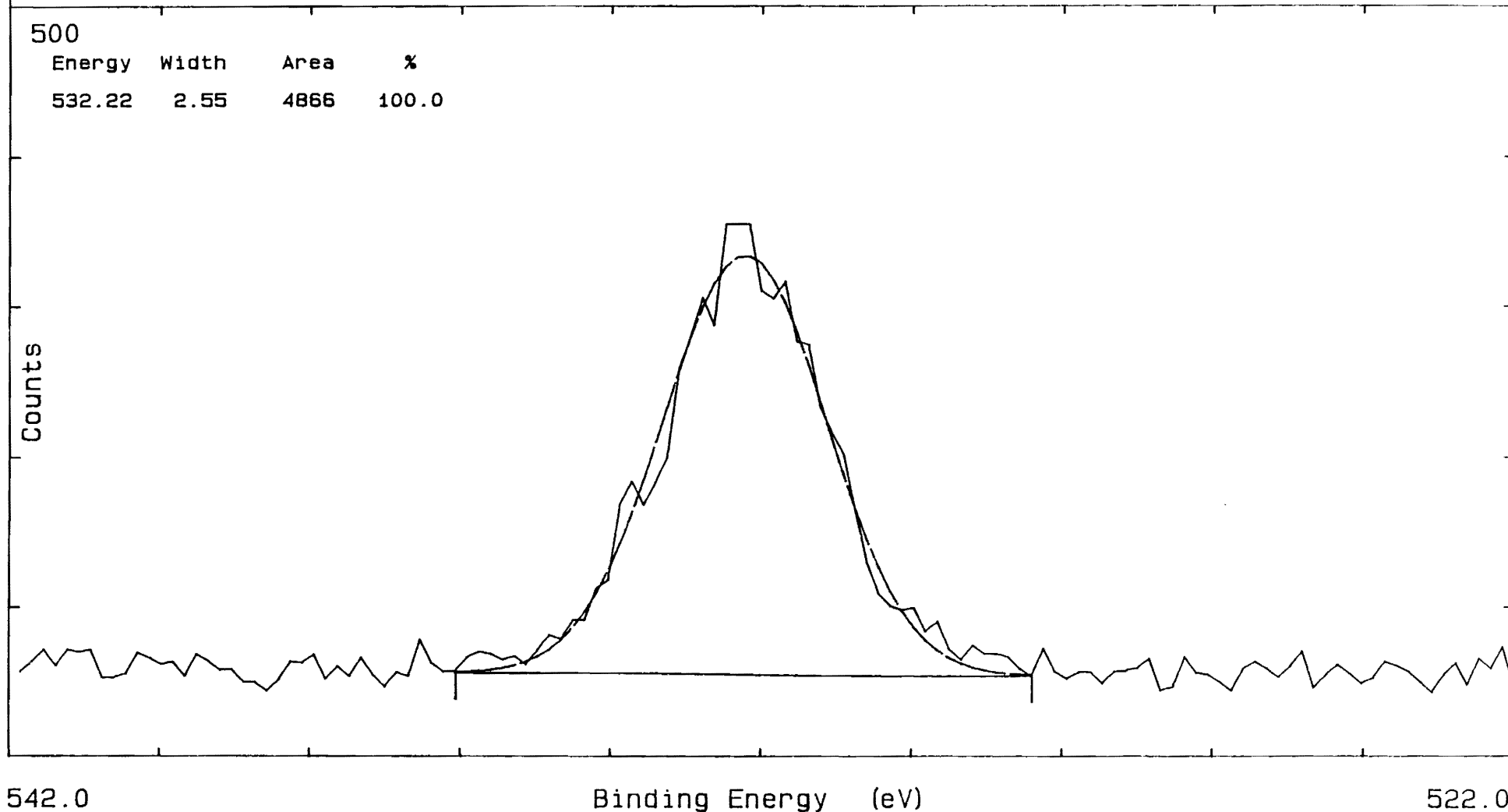


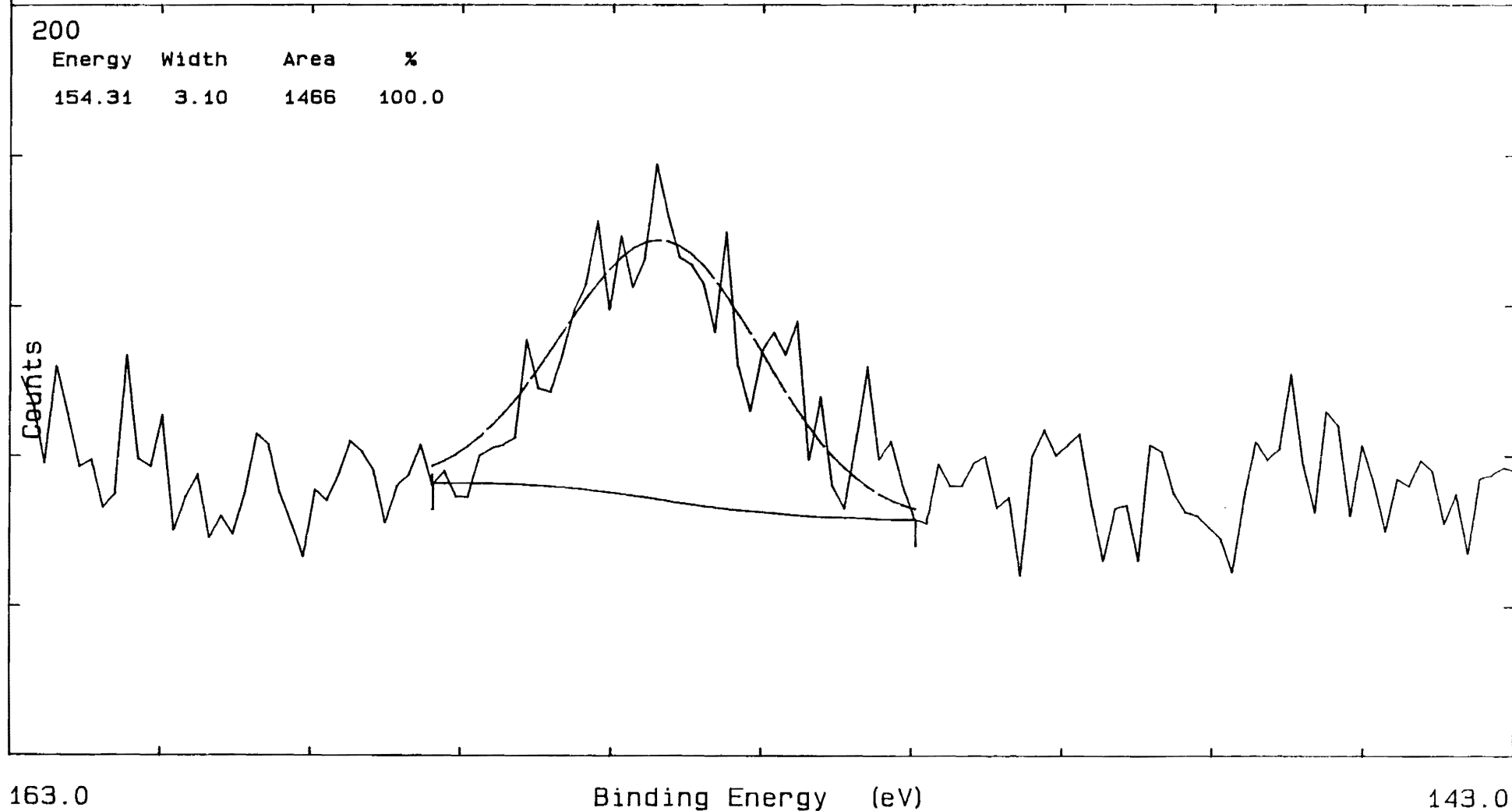
Figure 41

File: LDEF090	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-16: Ag + OVERCOAT SECOND SPOT AWAY FROM CENTER, 0 1s SPECTRUM			Operator: TAP

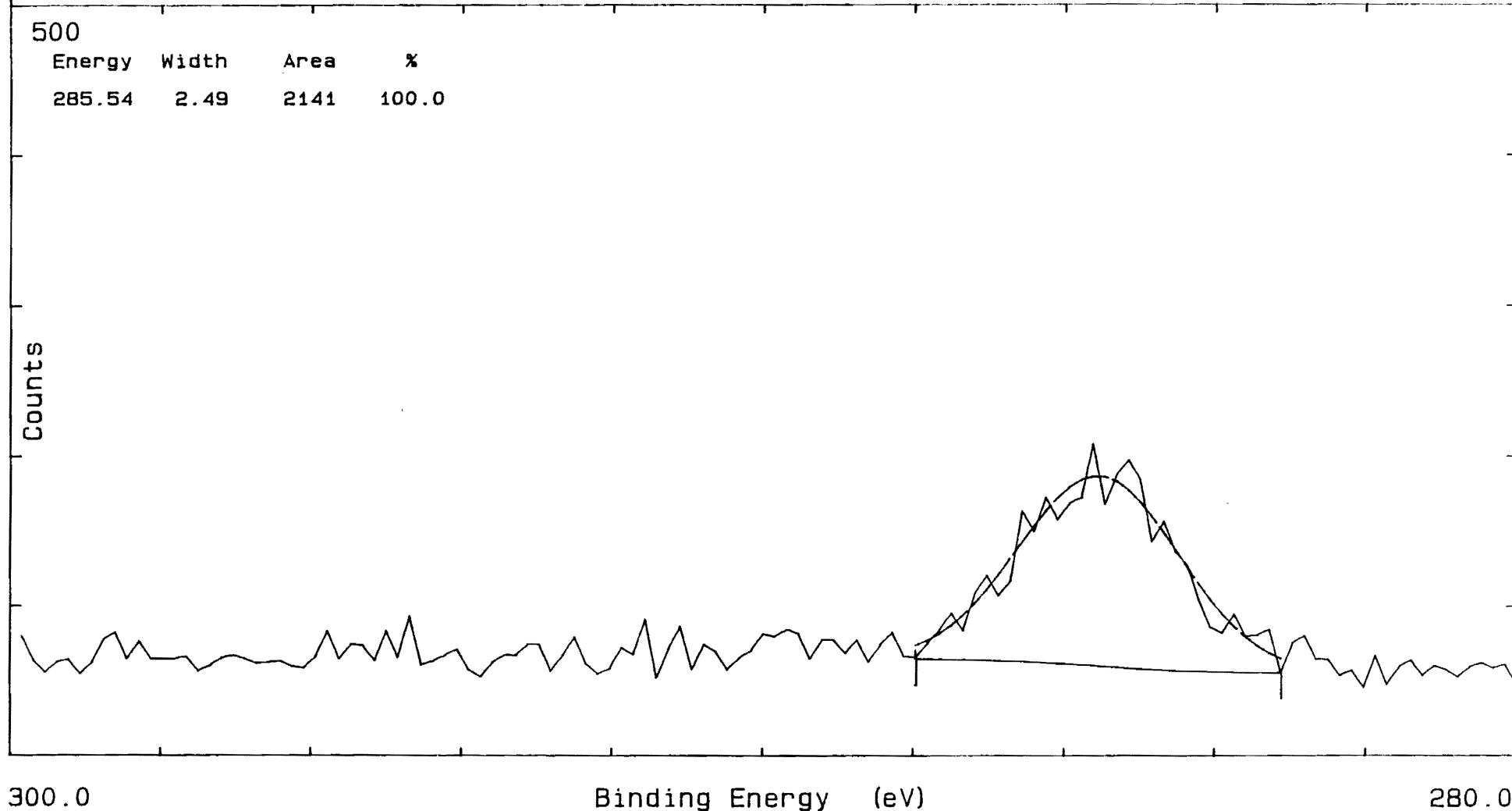


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF090	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-16: Ag + OVERCOAT SECOND SPOT AWAY FROM CENTER, Si 2s SPECTRUM			Operator: TAP

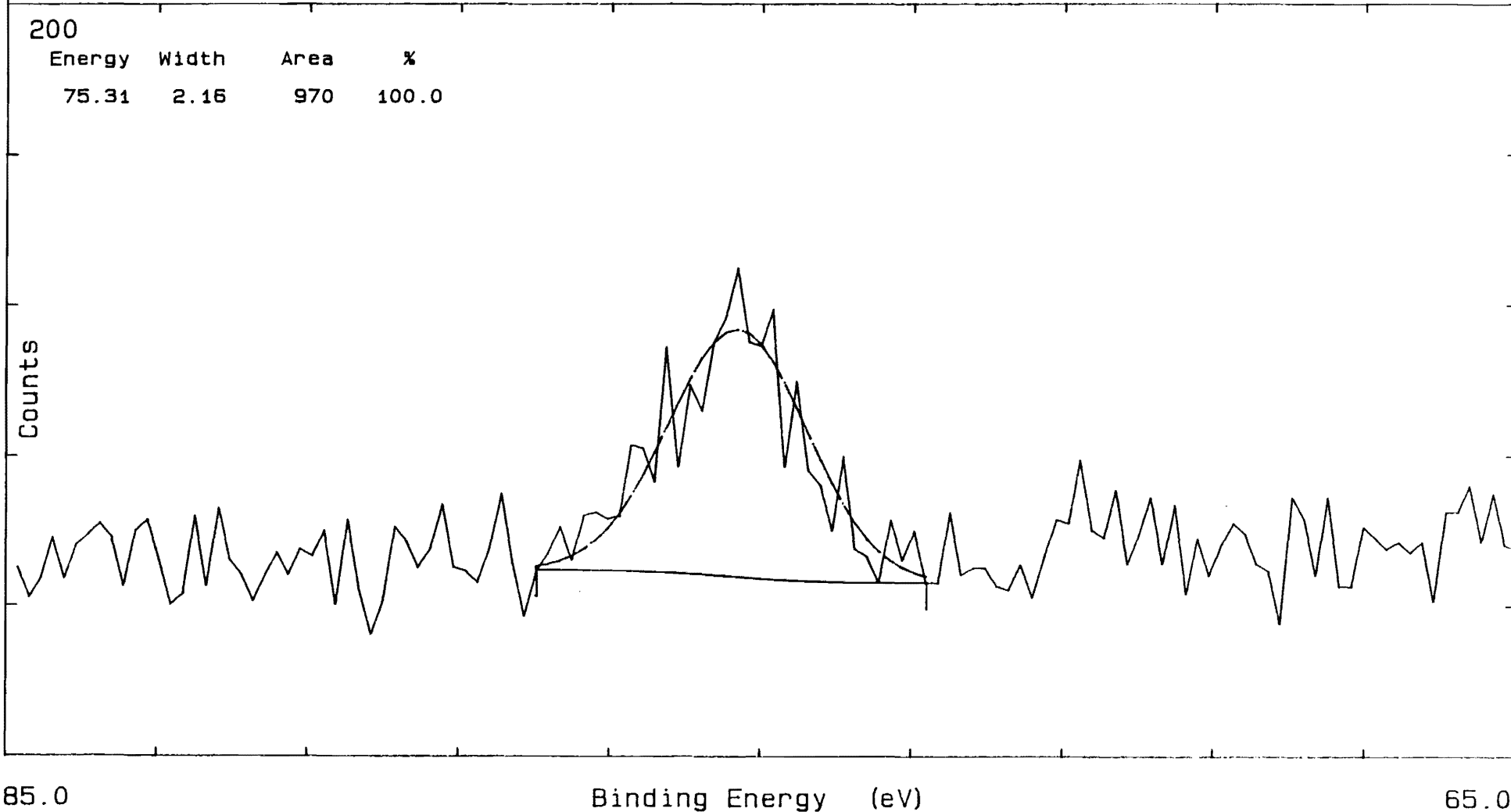


File: LDEF090	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-16: Ag + OVERCOAT SECOND SPOT AWAY FROM CENTER, C 1s SPECTRUM			Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF090	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-16: Ag + OVERCOAT SECOND SPOT AWAY FROM CENTER, Al 2s SPECTRUM			Operator: TAP

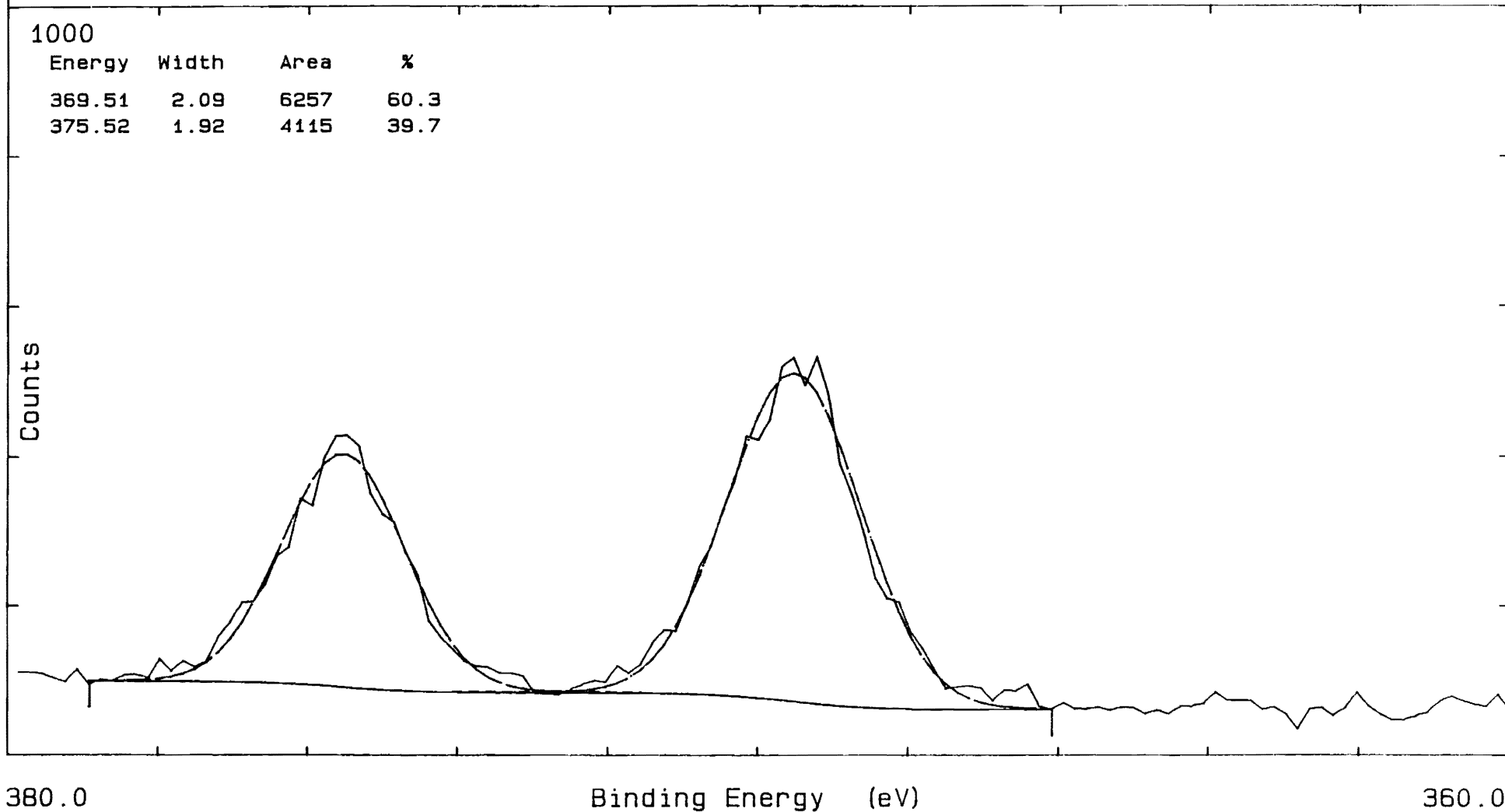


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF090	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 6	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-16: Ag + OVERCOAT
SECOND SPOT AWAY FROM CENTER, Ag 3d SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF092

Date: 9/21/1992

Spot Size: 1000 μ

Flood Gun: 1.0 eV

Region 1

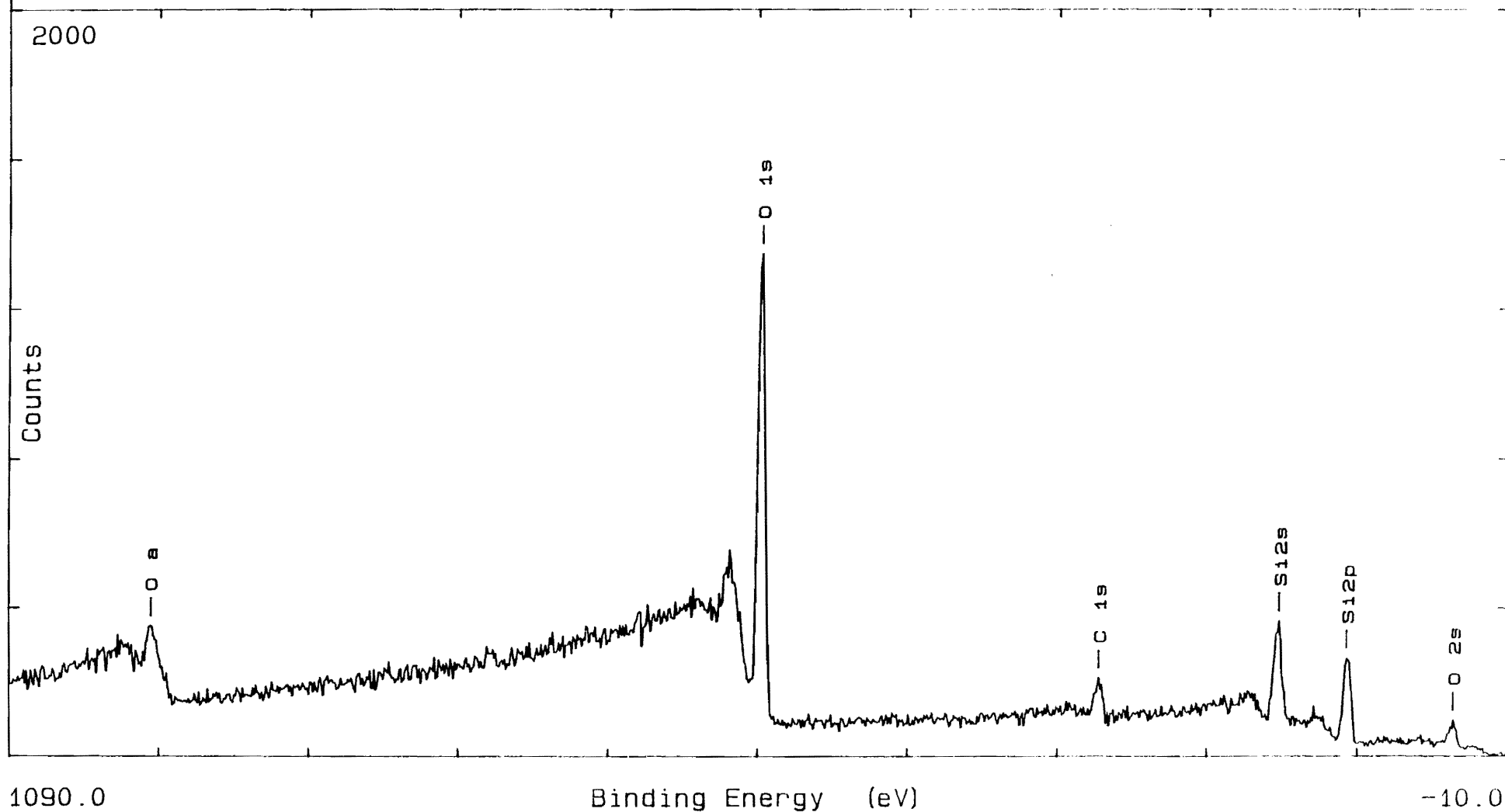
Disc: LDEF-5

of Scans: 1

Resolution: 4

Description: IV-22: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF092	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-22: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER, 0 1s SPECTRUM

Operator: TAP

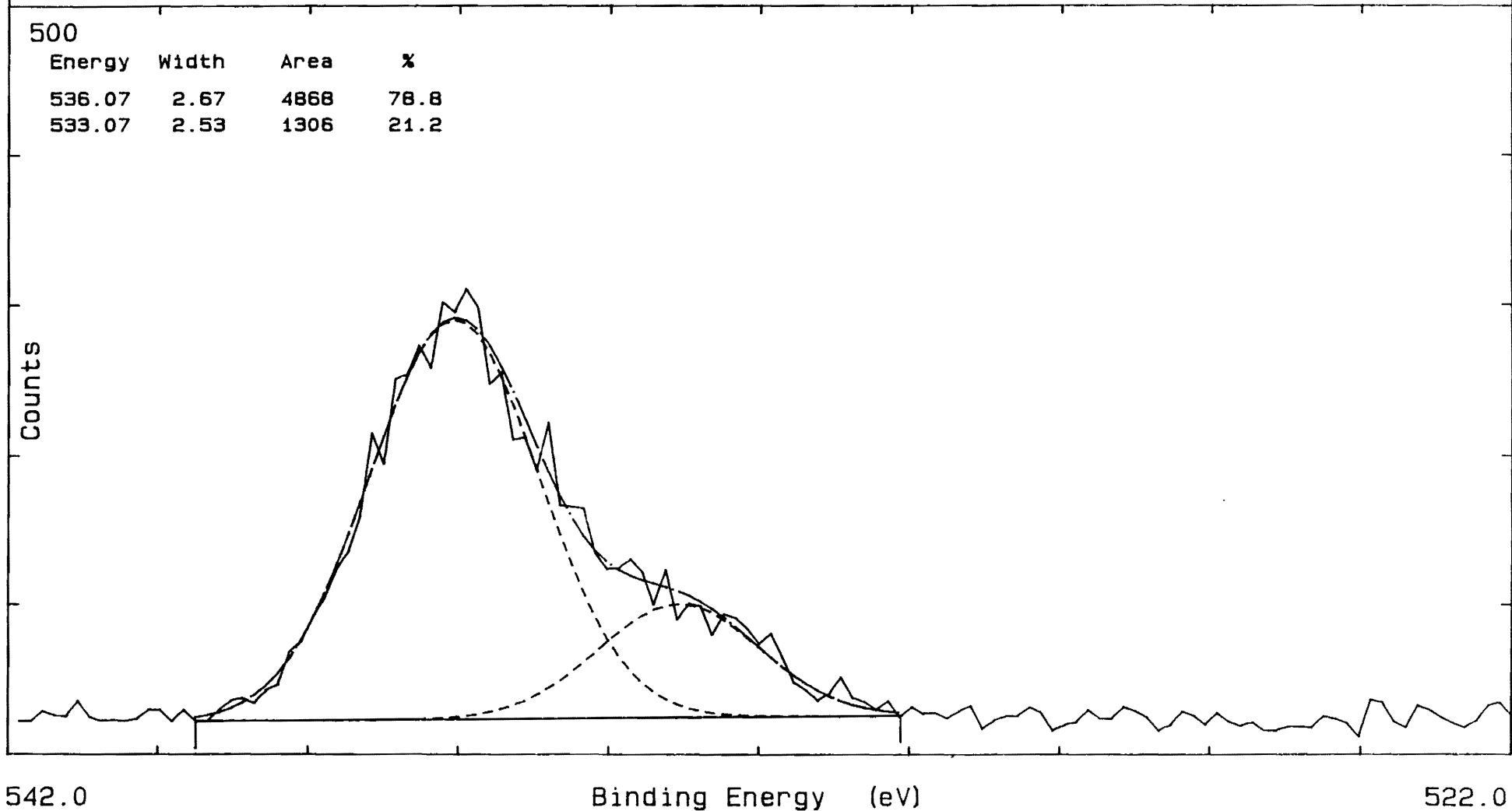
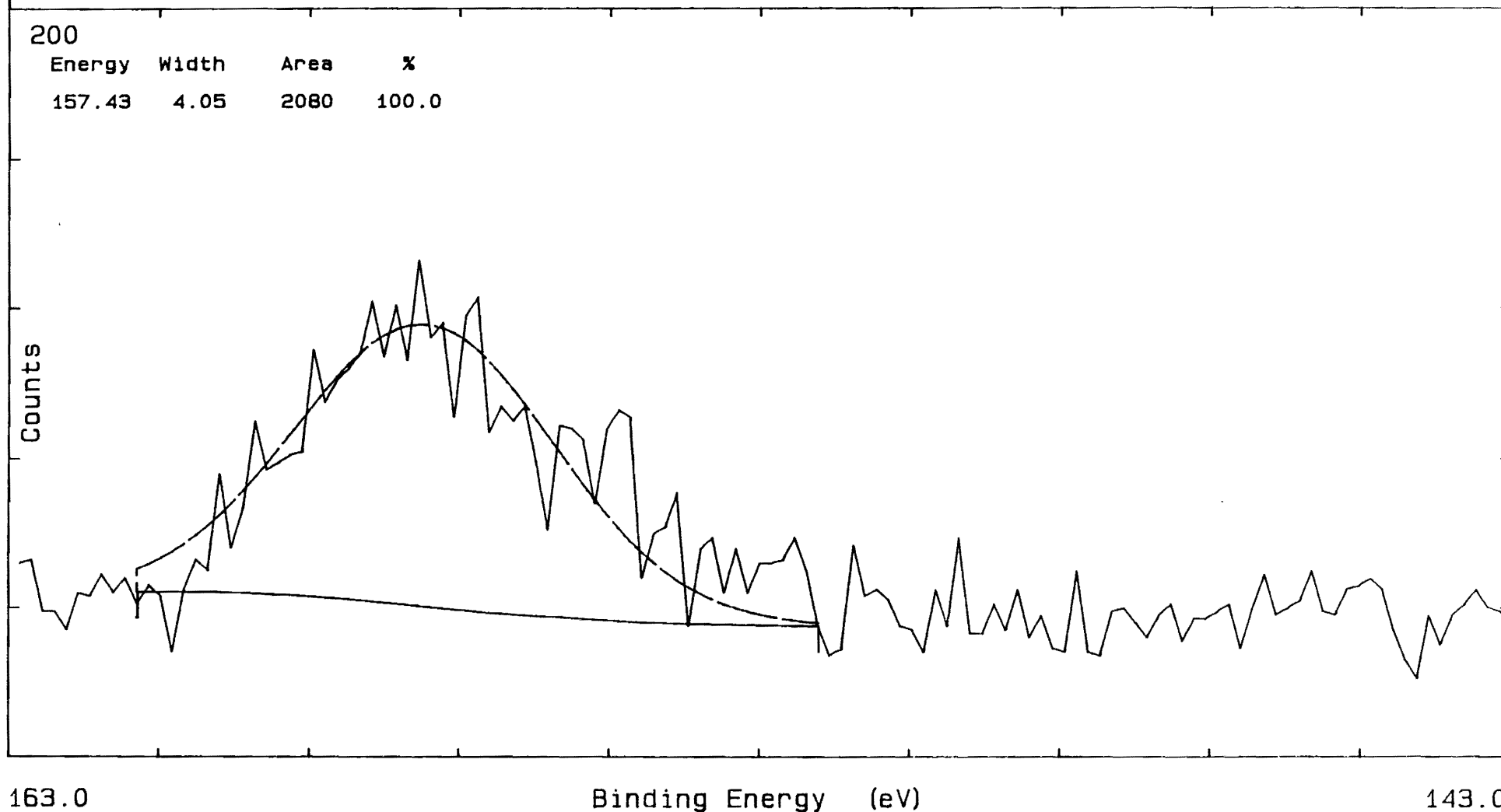


Figure 48

File: LDEF092	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

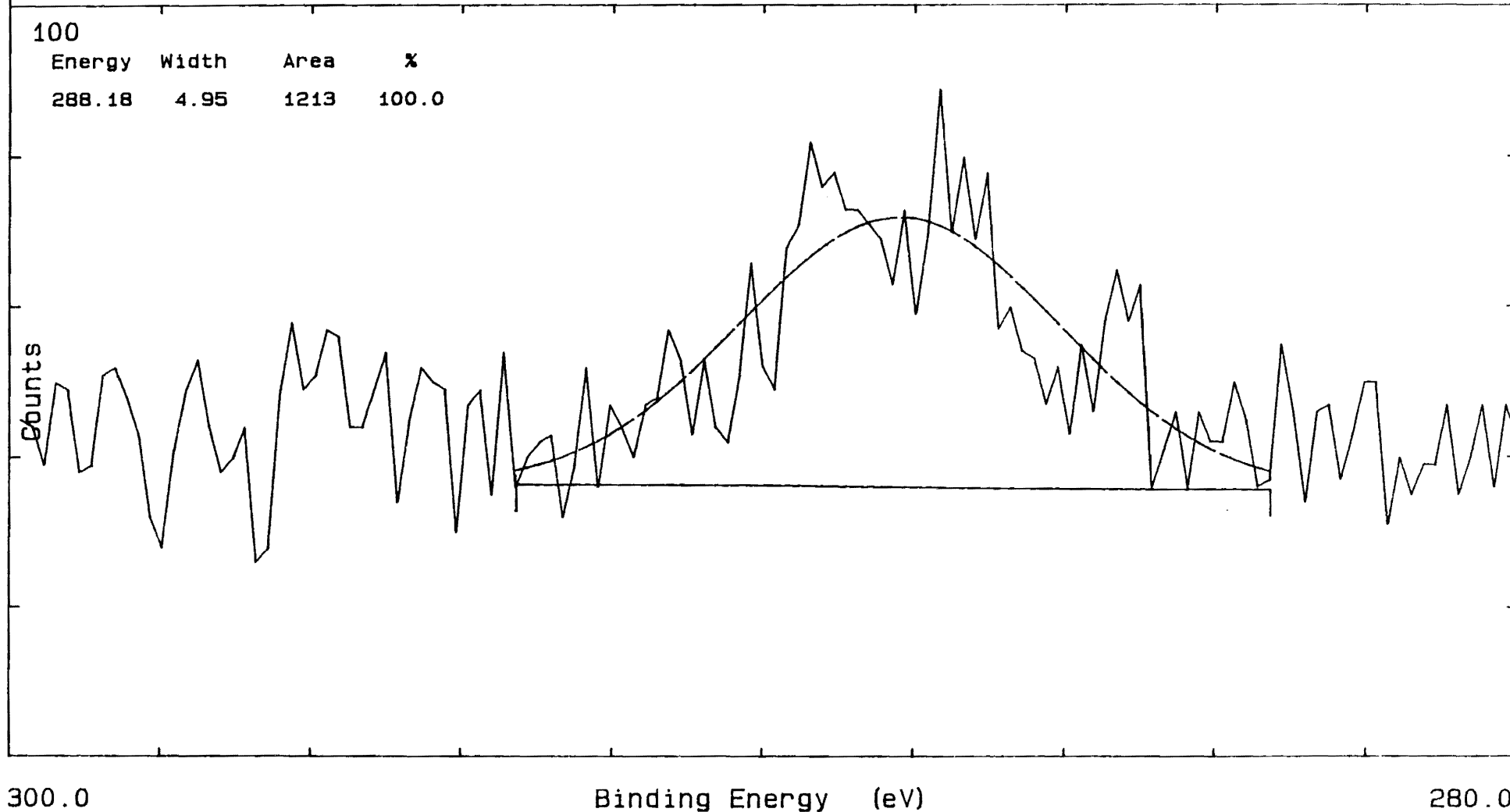
Description: IV-22: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP



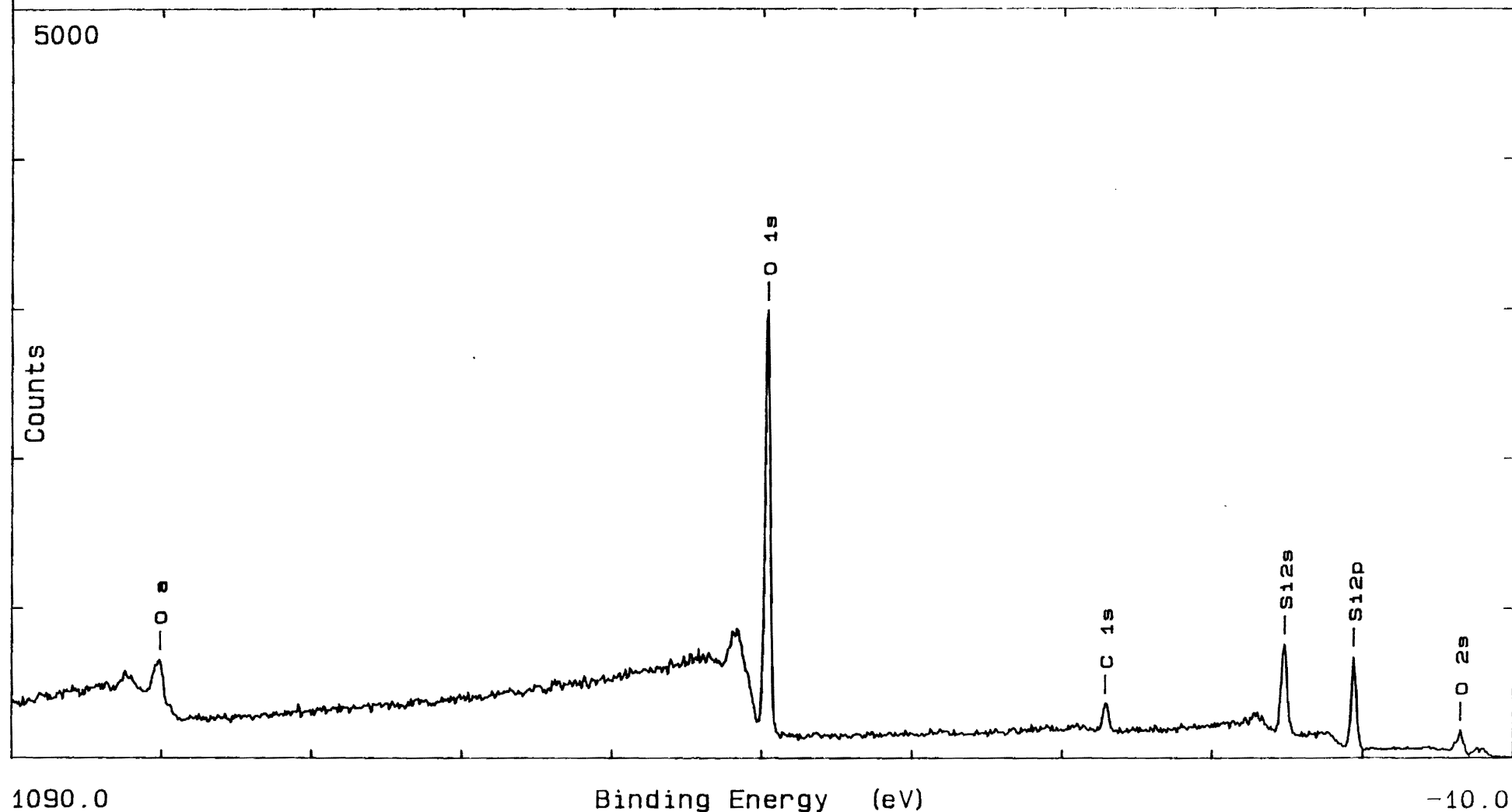
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF092	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-22: ENHANCED AL + OVERCOAT FIRST SPOT AWAY FROM CENTER, C 1s SPECTRUM			Operator: TAP



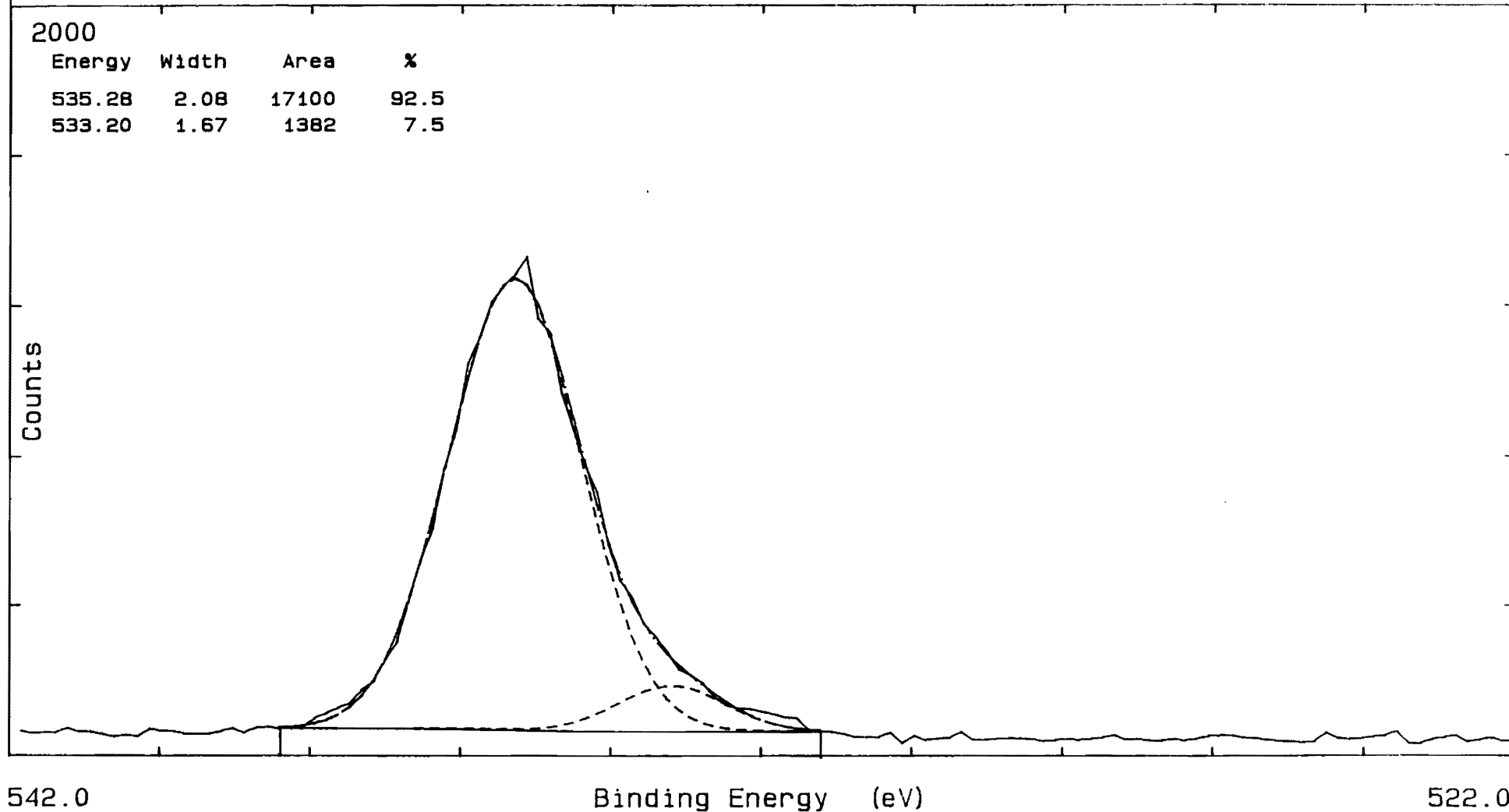
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF093	Date: 9/21/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-22: ENHANCED AL + OVERCOAT SECOND SPOT AWAY FROM CENTER			Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF093	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-22: ENHANCED AL + OVERCOAT SECOND SPOT AWAY FROM CENTER, 0 1s SPECTRUM			Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF093	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-22: ENHANCED AL + OVERCOAT
SECOND SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP

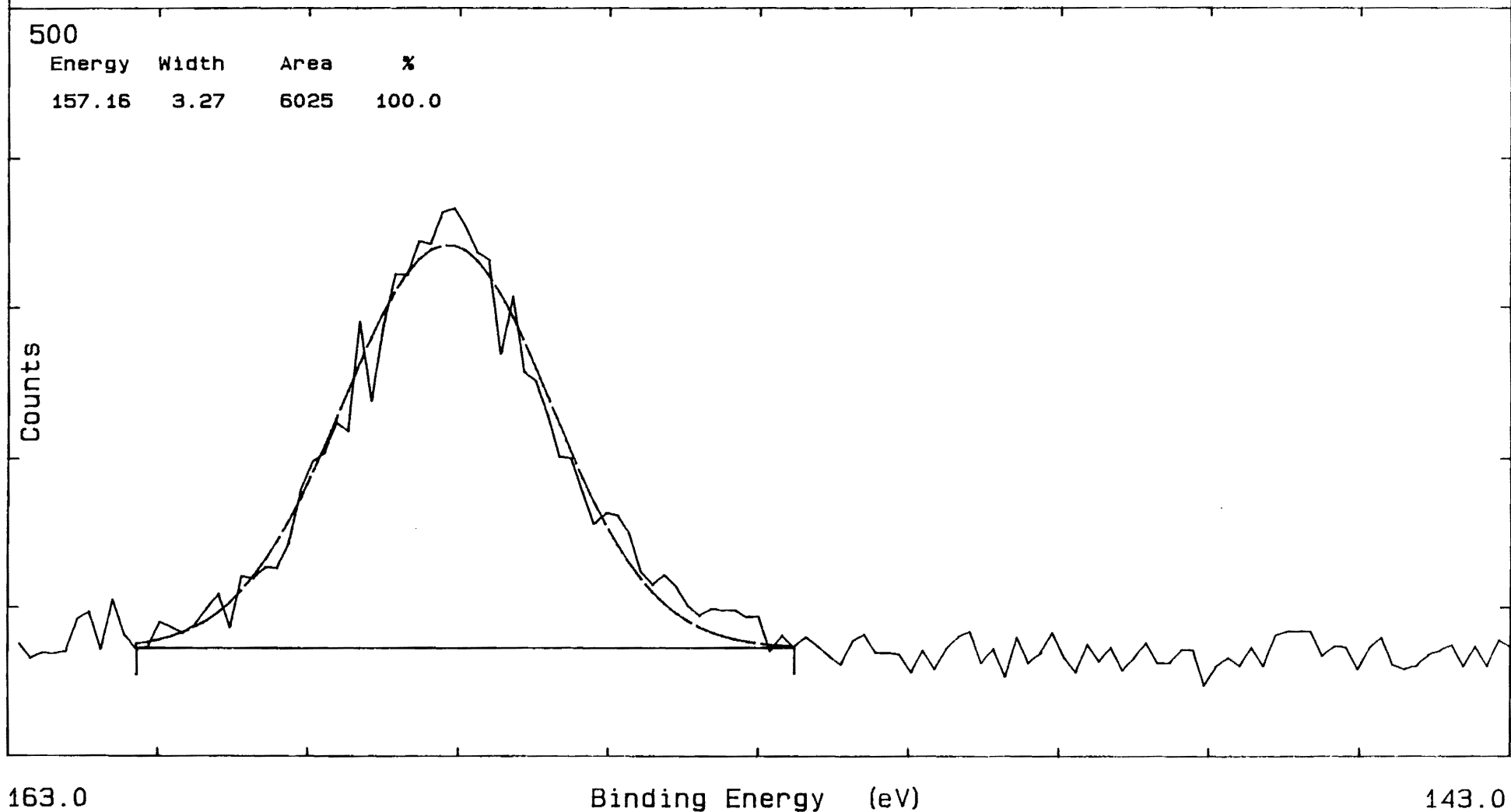
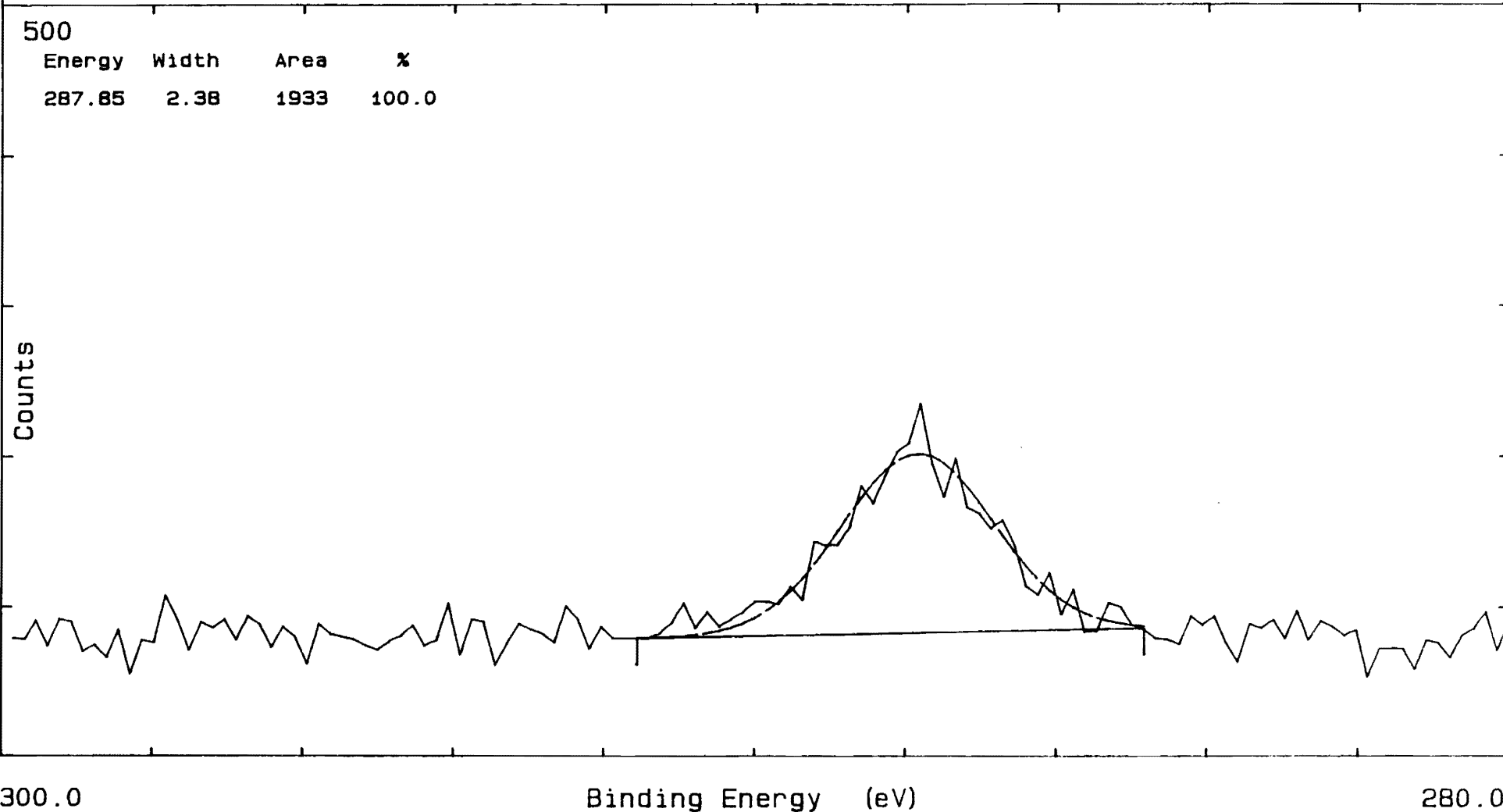


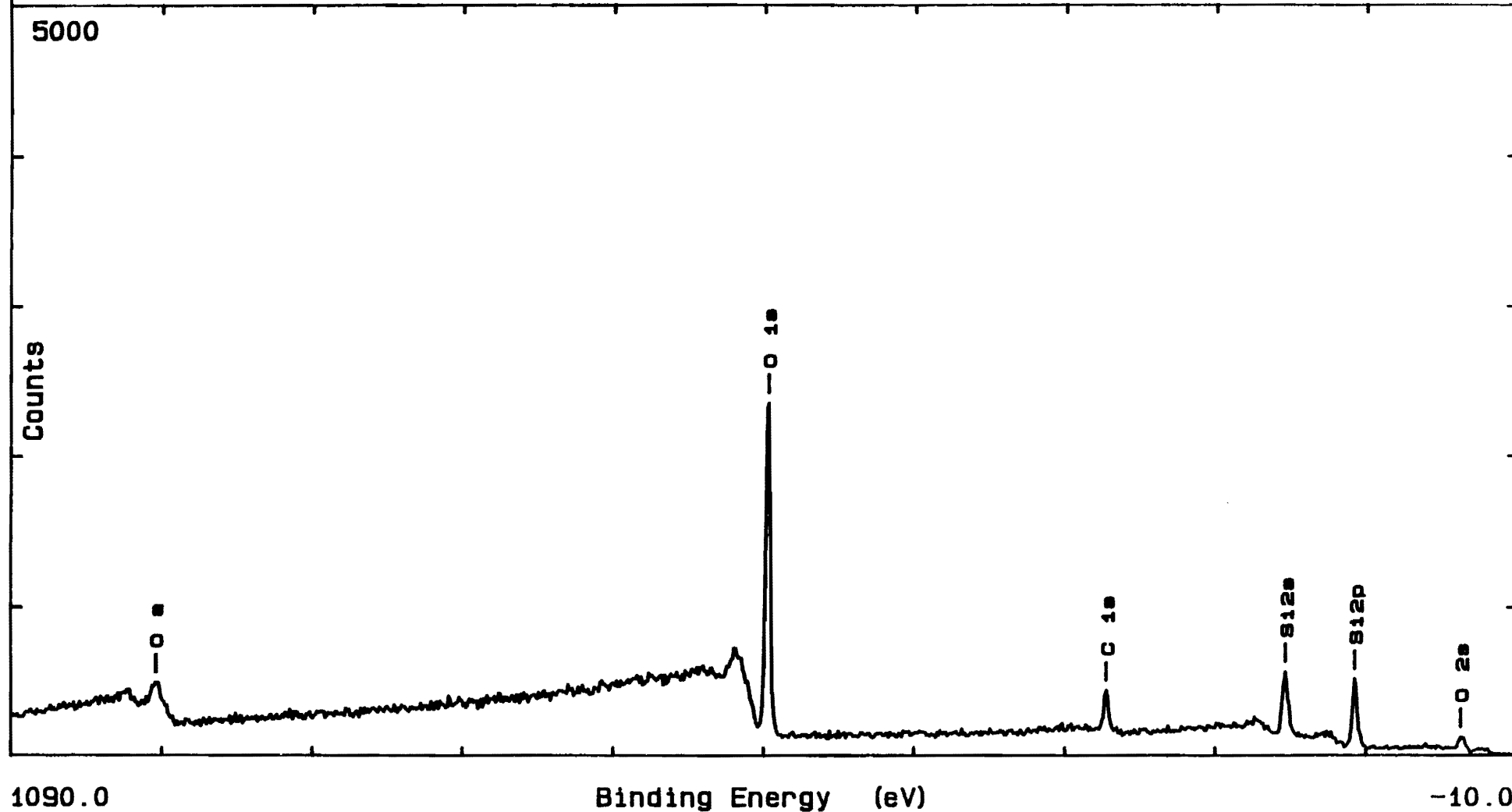
Figure 53

File: LDEF094	Date: 9/21/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-4: ENHANCED Al + OVERCOAT SECOND SPOT AWAY FROM CENTER, C 1s	Operator: TAP
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File: LDEF096	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-28: AL + ?? FIRST SPOT AWAY FROM CENTER			Operator: TAP

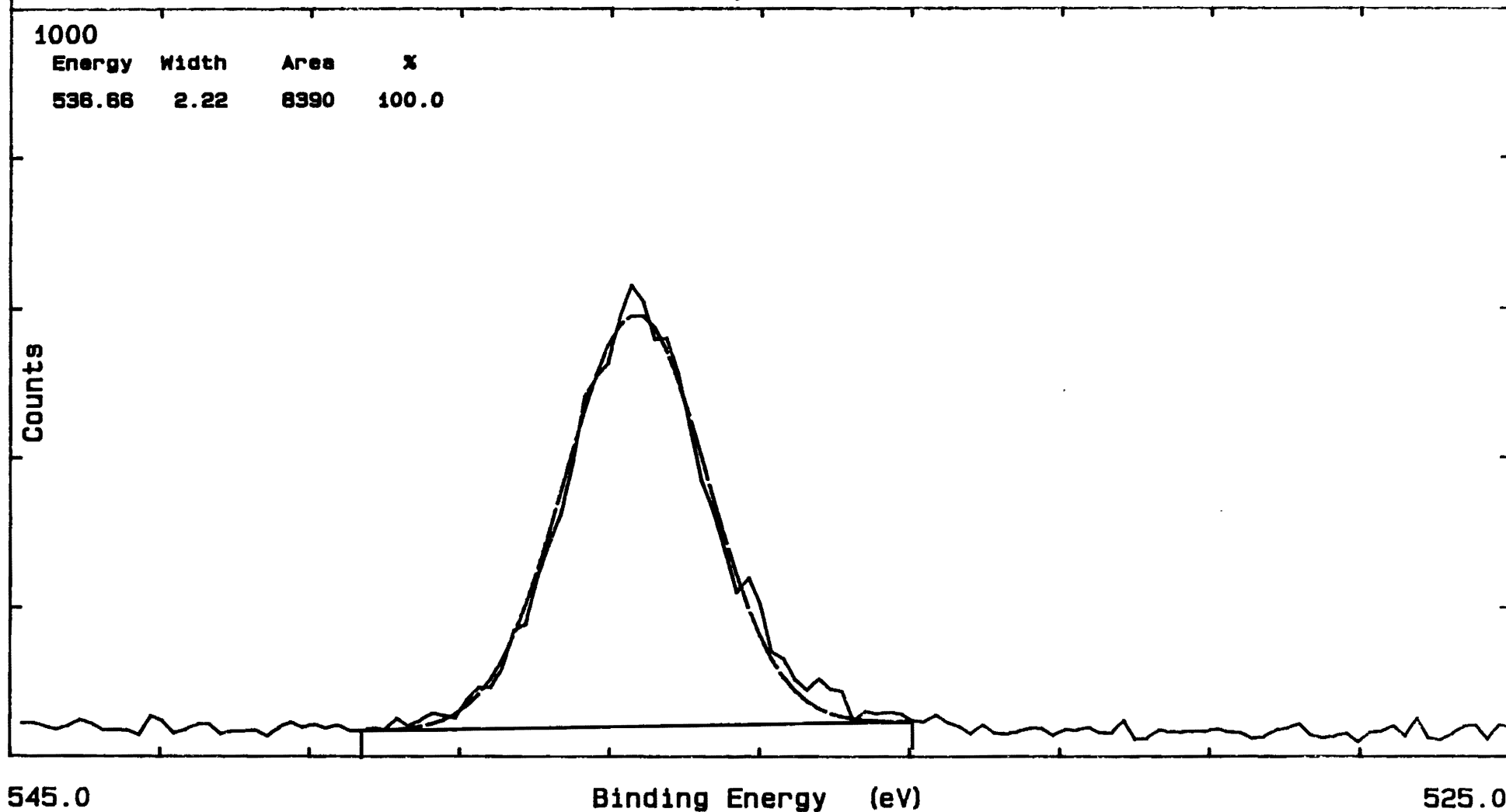


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF096	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-28: AL + ??
FIRST SPOT AWAY FROM CENTER, 0 1s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF096	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-28: AL + ??
FIRST SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP

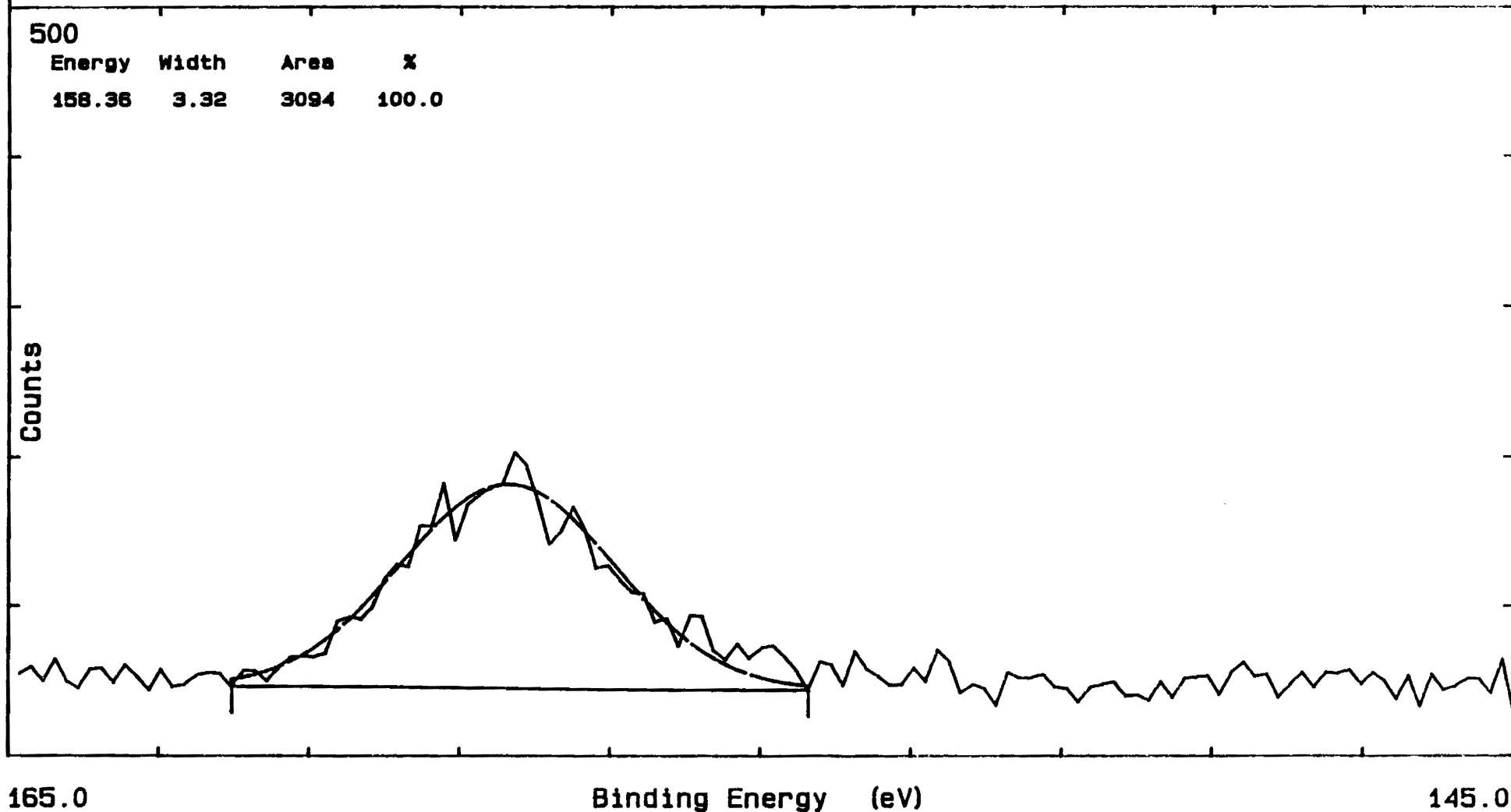


Figure 57

File: LDEF096	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-28: AL + ??
FIRST SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP

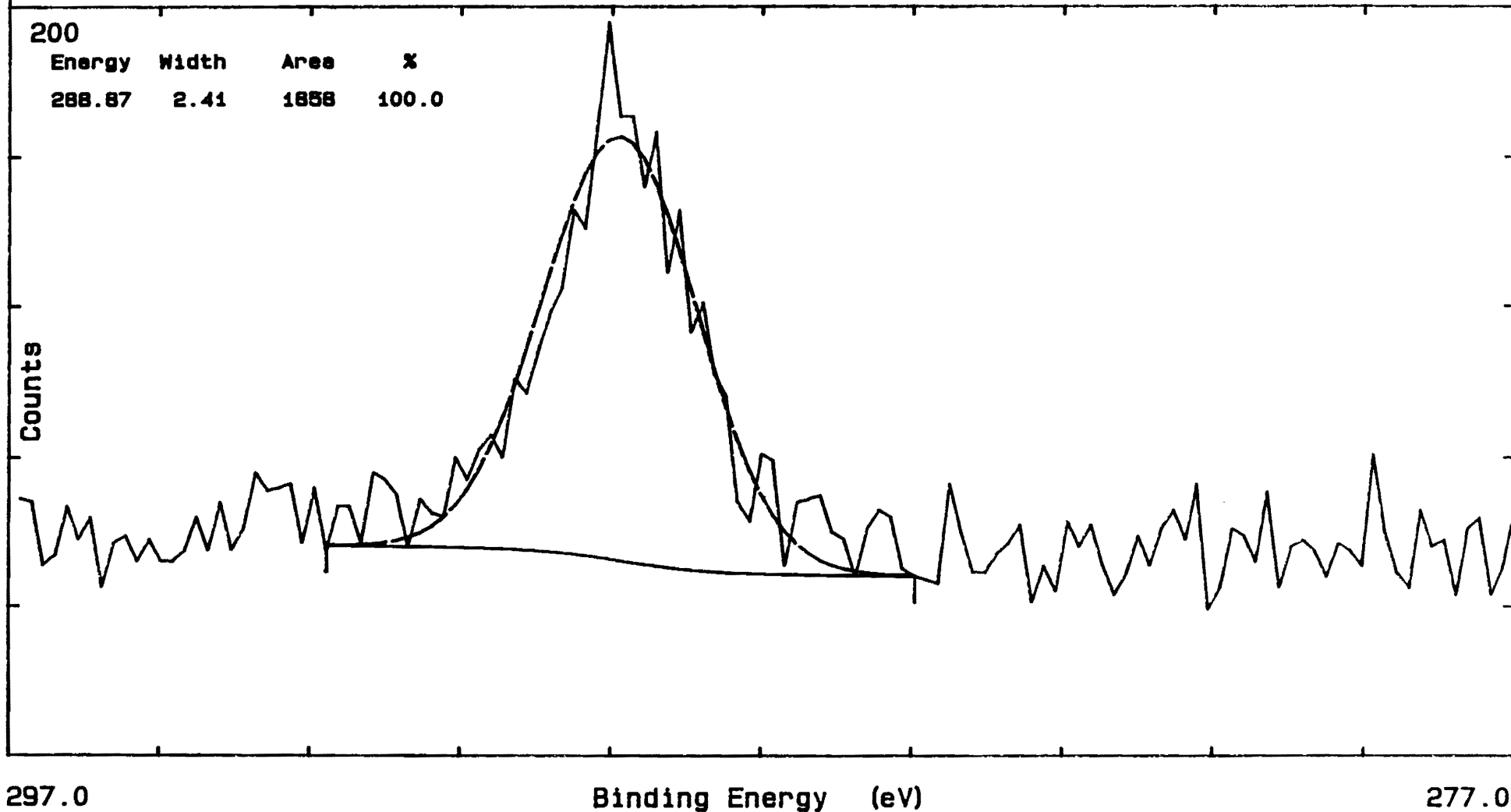


Figure 58

File: LDEF097	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-28: AL + ?? SECOND SPOT AWAY FROM CENTER			Operator: TAP

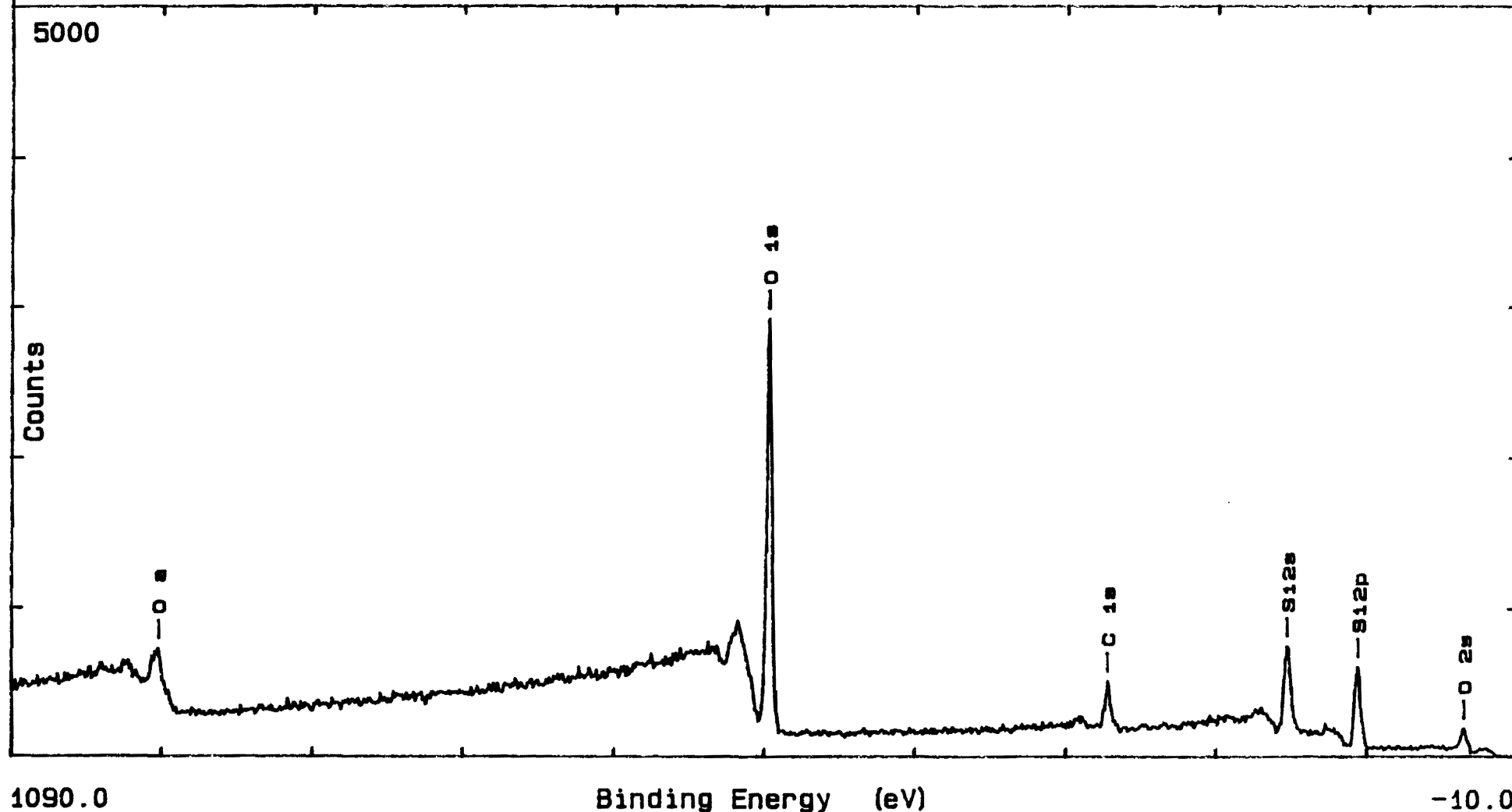


Figure 59

File: LDEF097	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-28: AL + ?? SECOND SPOT AWAY FROM CENTER, 0 1s SPECTRUM			Operator: TAP

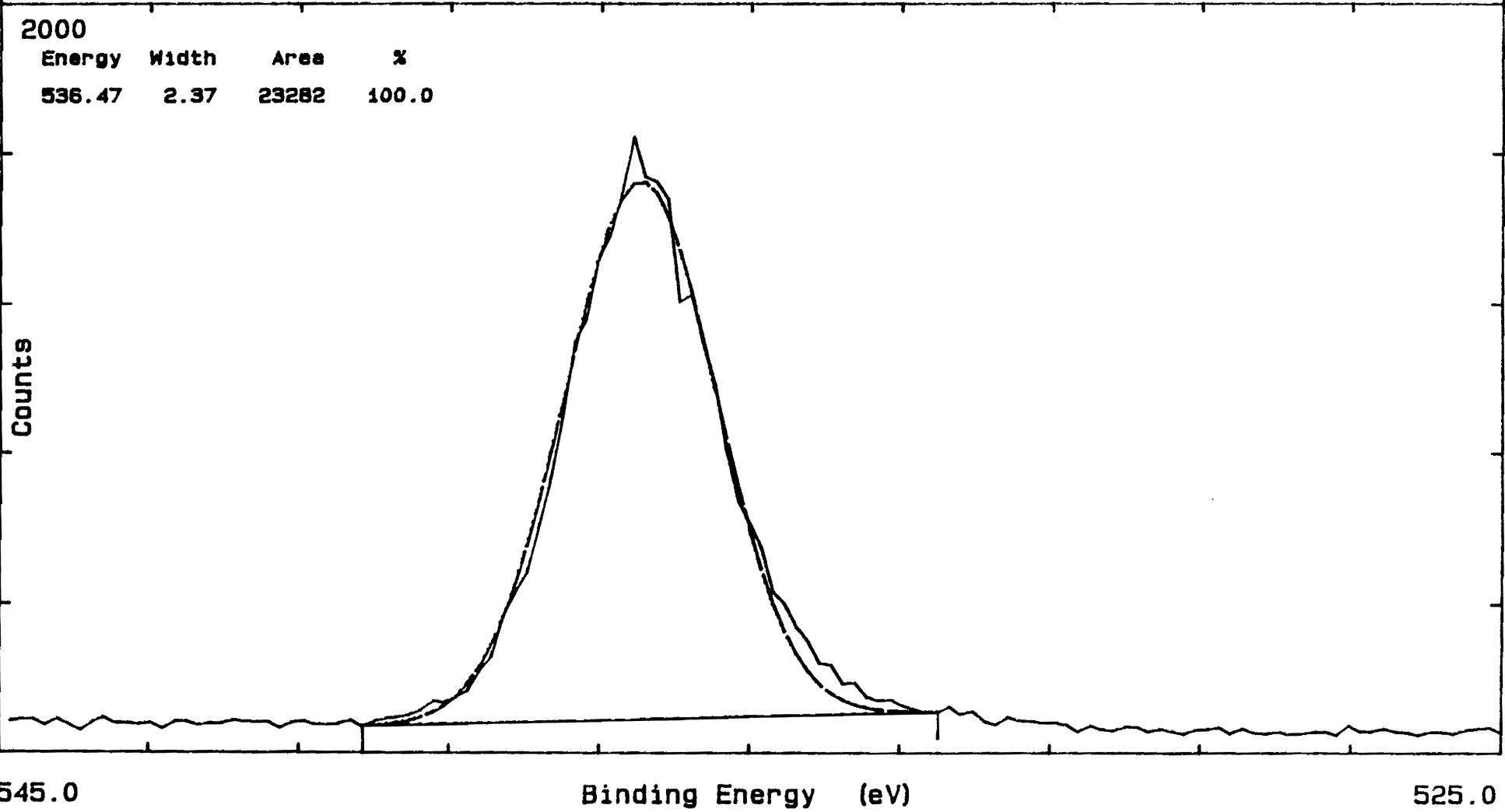


Figure 60

File: LDEF097	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-28: AL + ??
SECOND SPOT AWAY FROM CENTER, Si 2s SPECTRUM

Operator: TAP

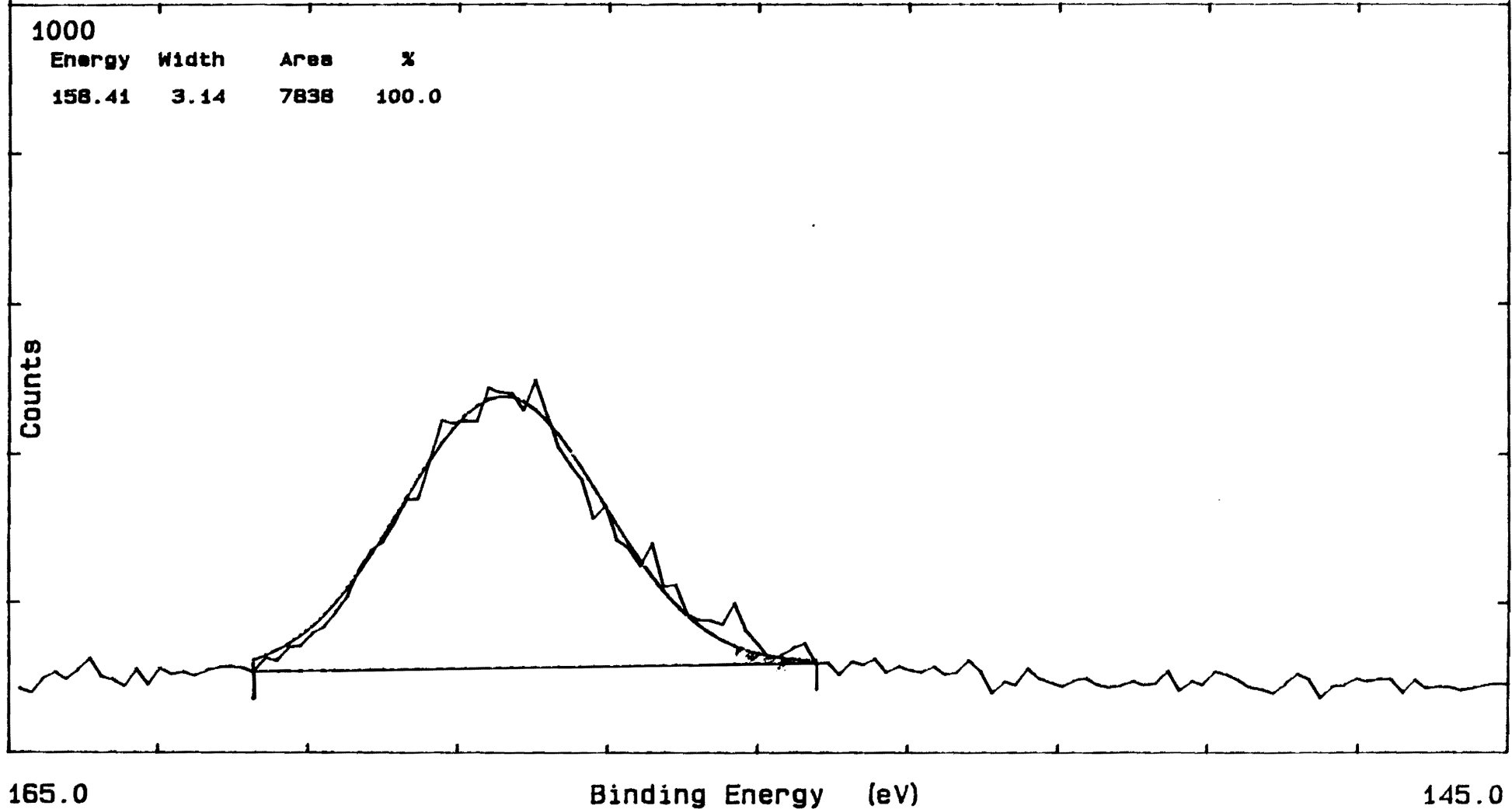
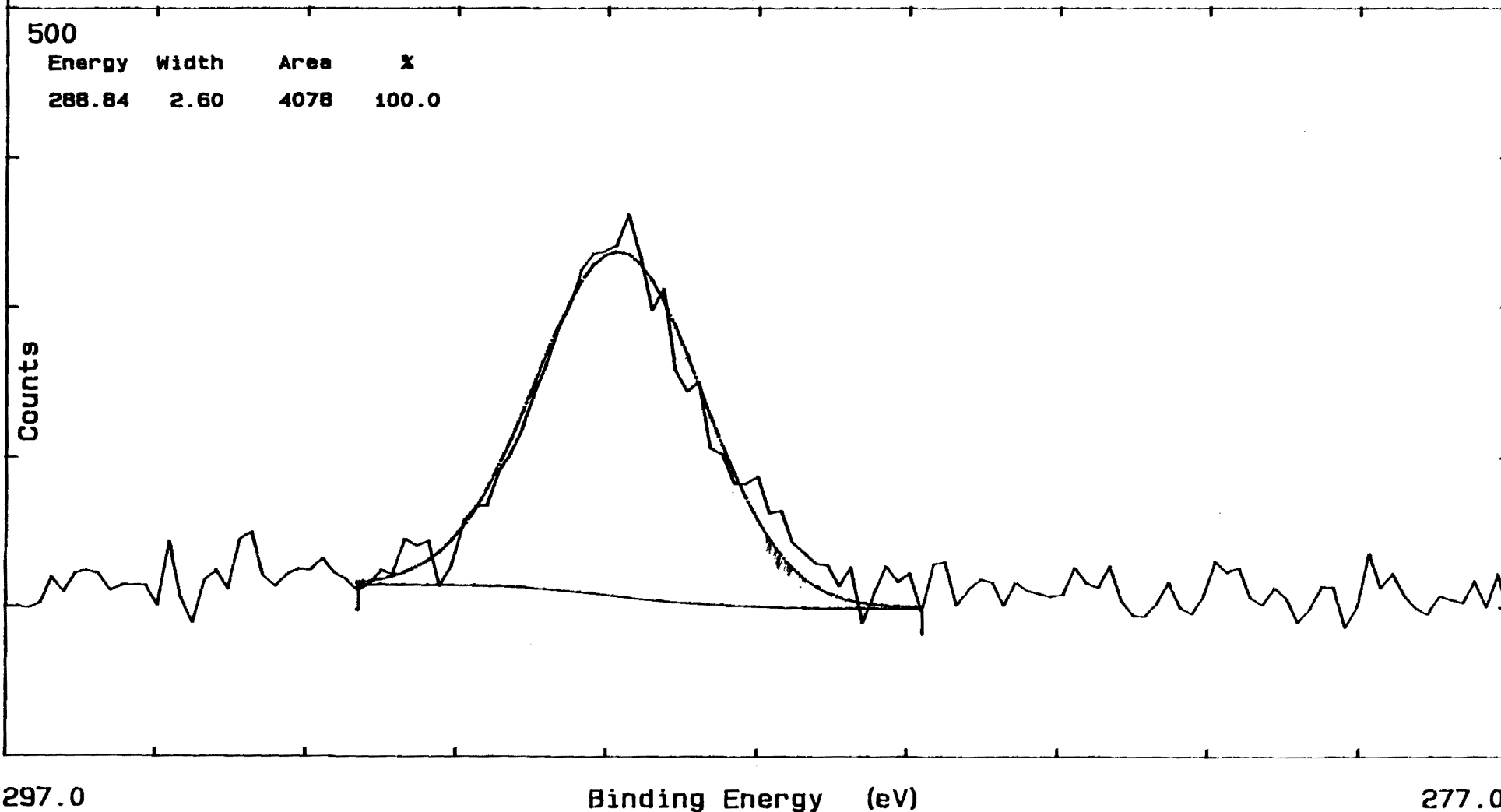


Figure 61

File: LDEF097	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

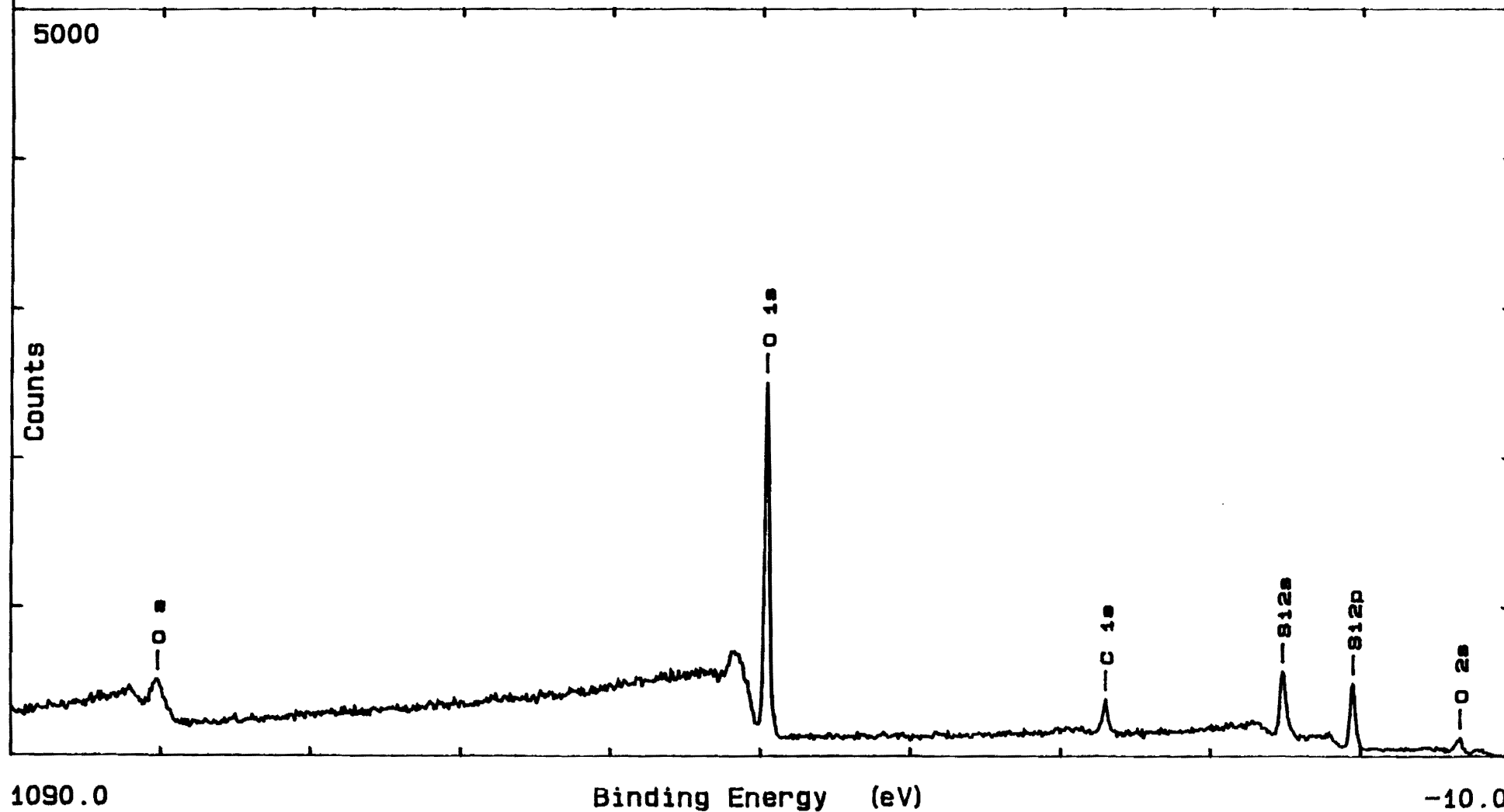
Description: IV-28: AL + ??
SECOND SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF098	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-38: ENHANCED AL + OVERCOAT FIRST SPOT AWAY FROM CENTER			Operator: TAP

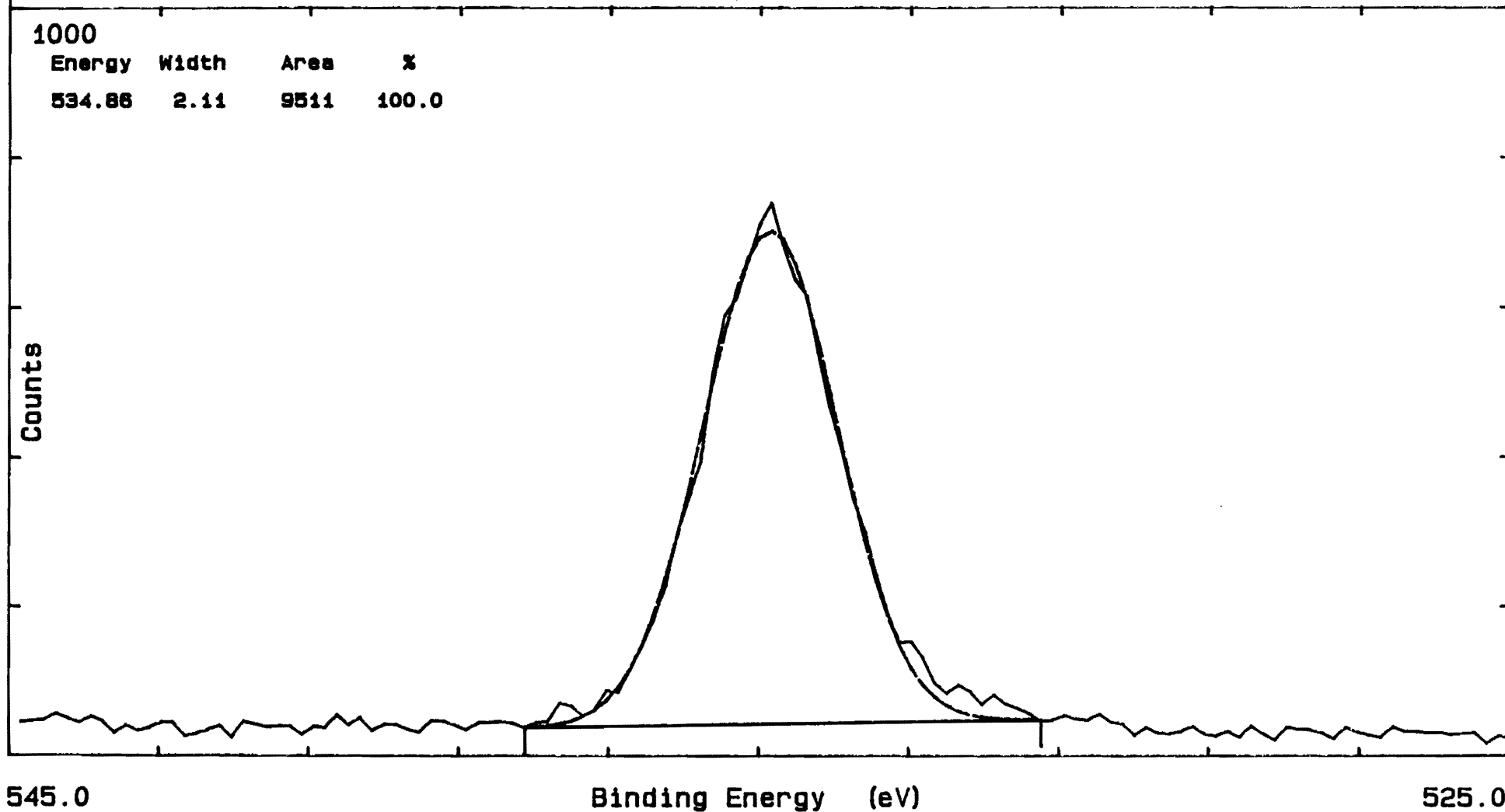


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF098	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-38: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER, 0 1s SPECTRUM

Operator: TAP



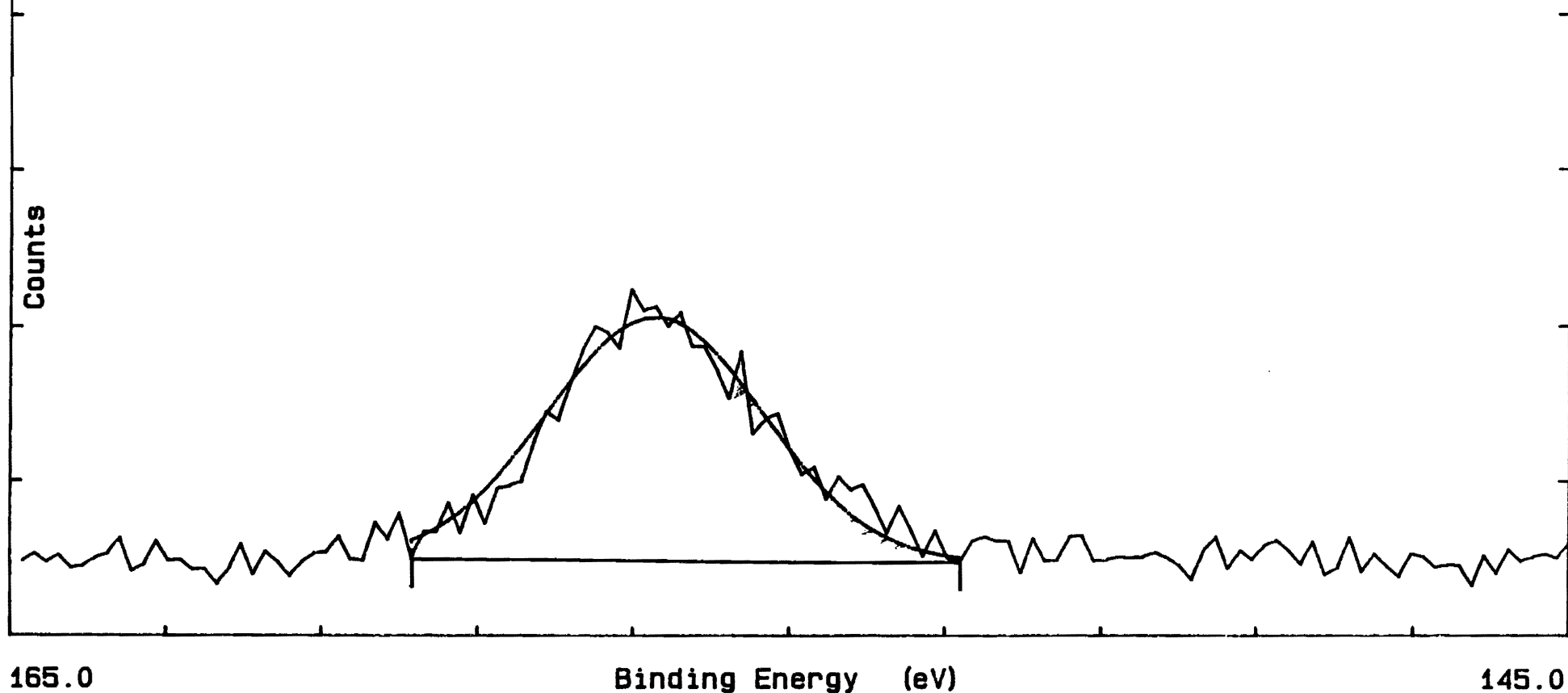
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF098	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-38: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER, S1 2s SPECTRUM

Operator: TAP

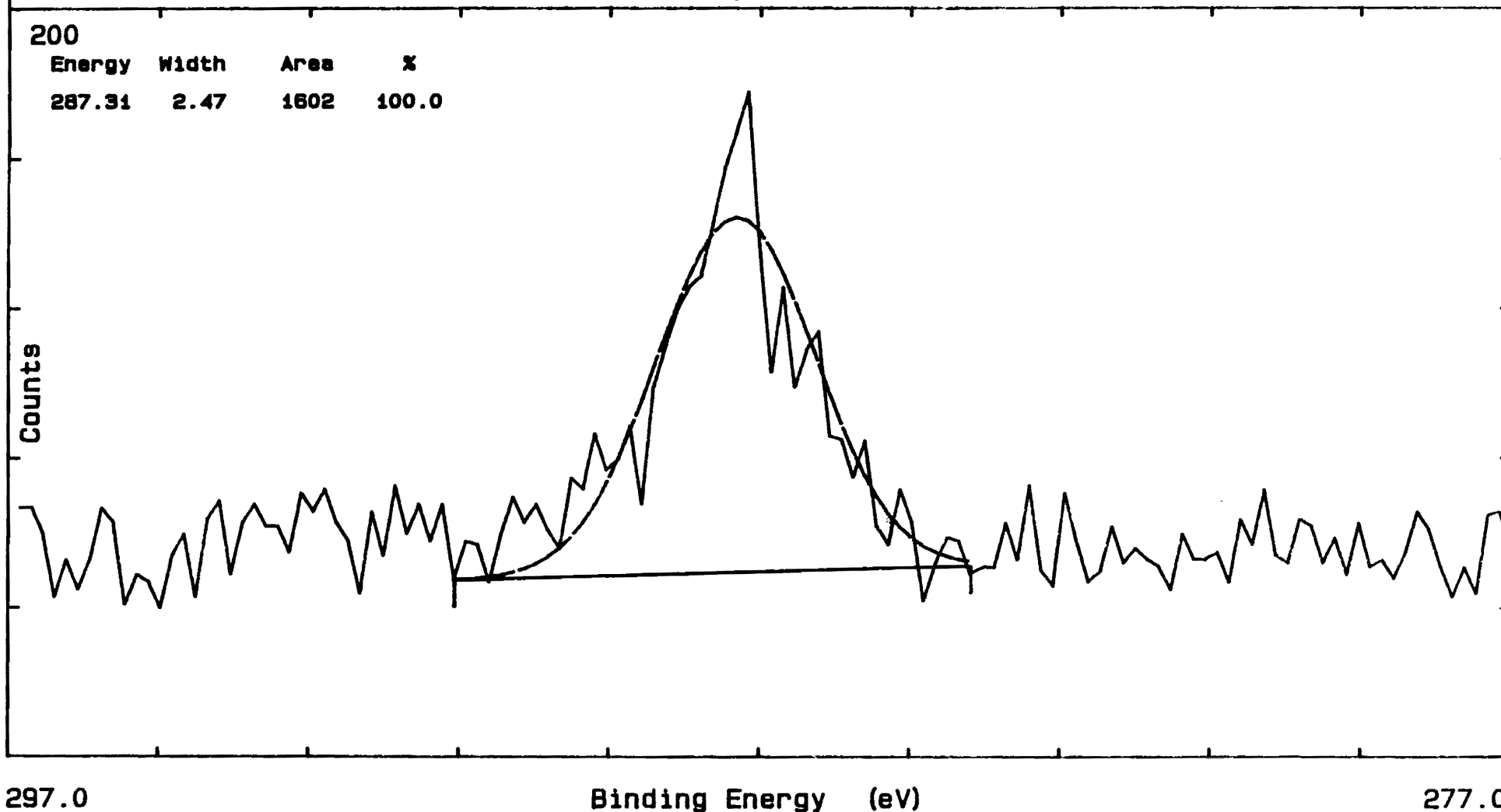
500
Energy Width Area %
156.72 3.26 3509 100.0



File: LDEF098	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-38: ENHANCED AL + OVERCOAT
FIRST SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP



File: LDEF099	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-38: ENHANCED AL + OVERCOAT SECOND SPOT AWAY FROM CENTER			Operator: TAP

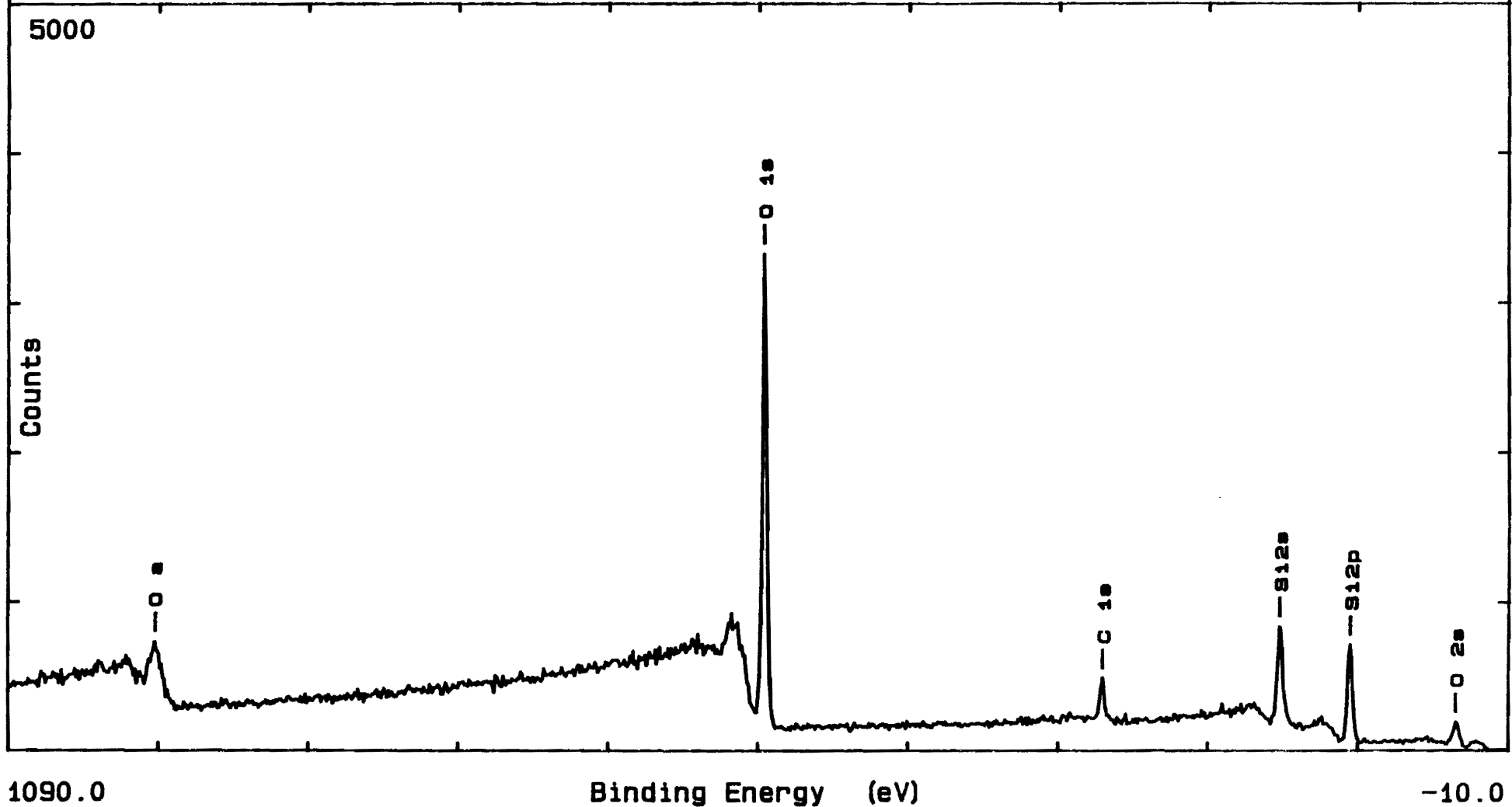


Figure 67

File: LDEF099	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-38: ENHANCED AL + OVERCOAT
SECOND SPOT AWAY FROM CENTER, 0 1s SPECTRUM

Operator: TAP

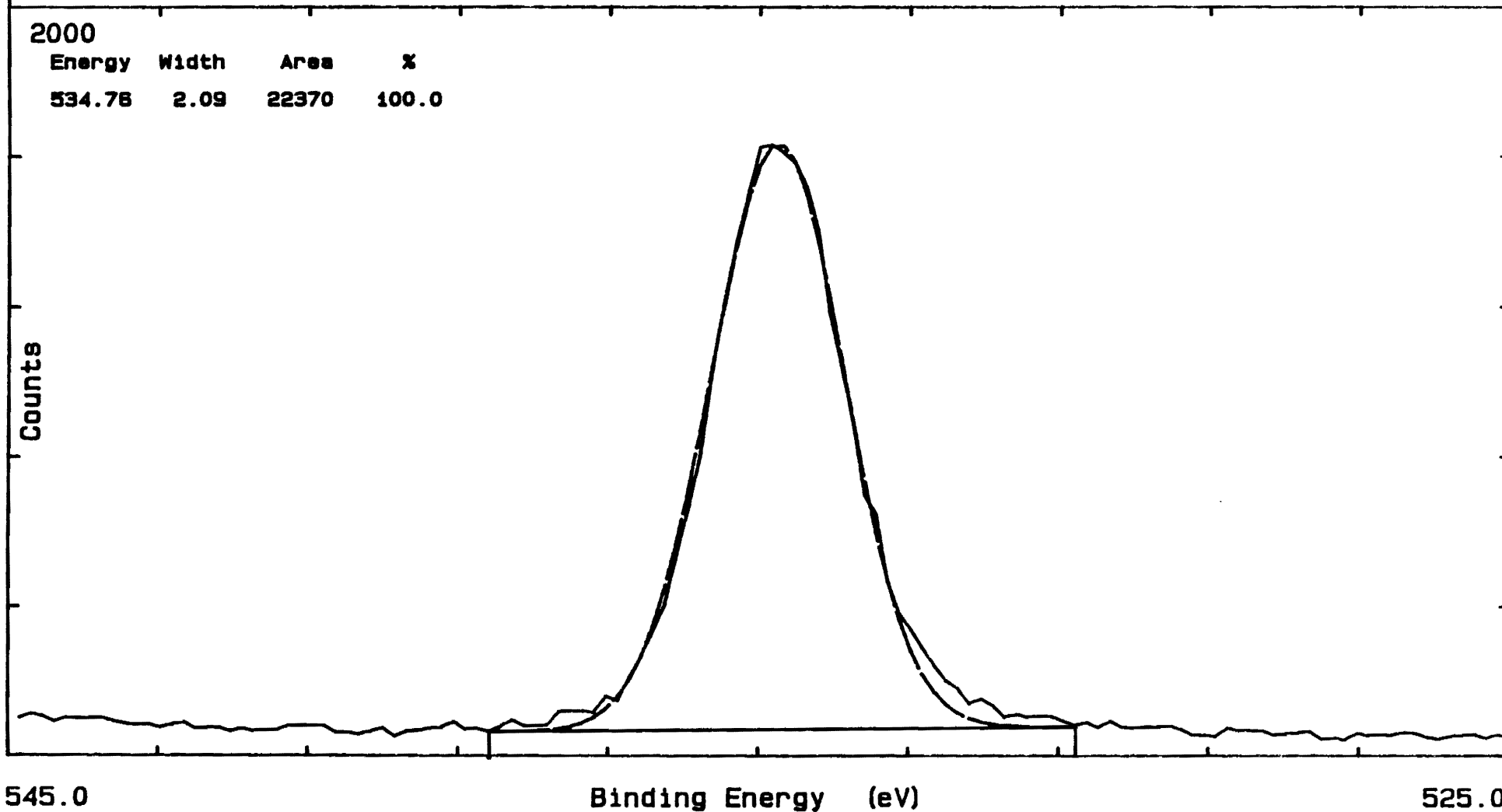
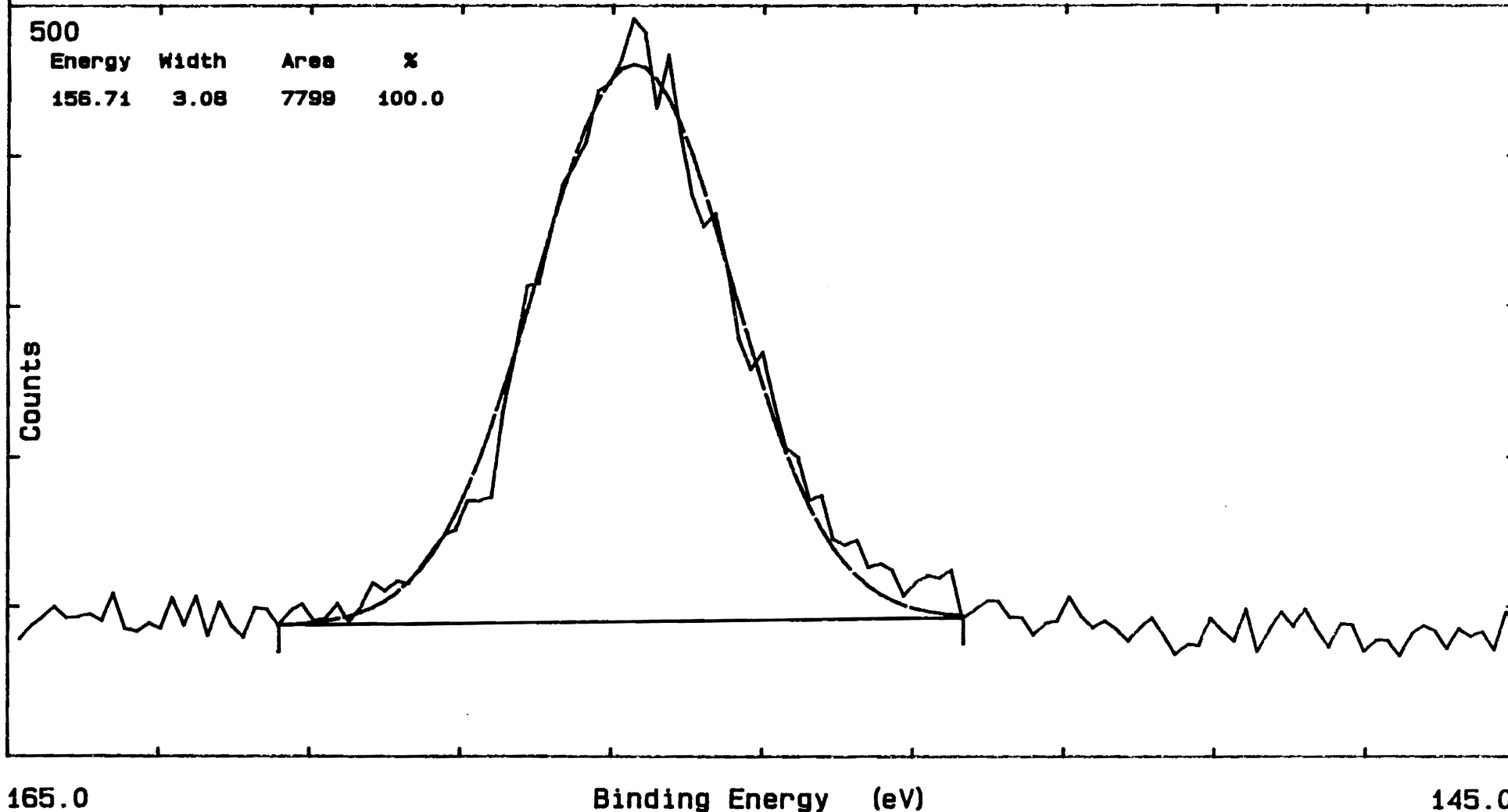


Figure 68

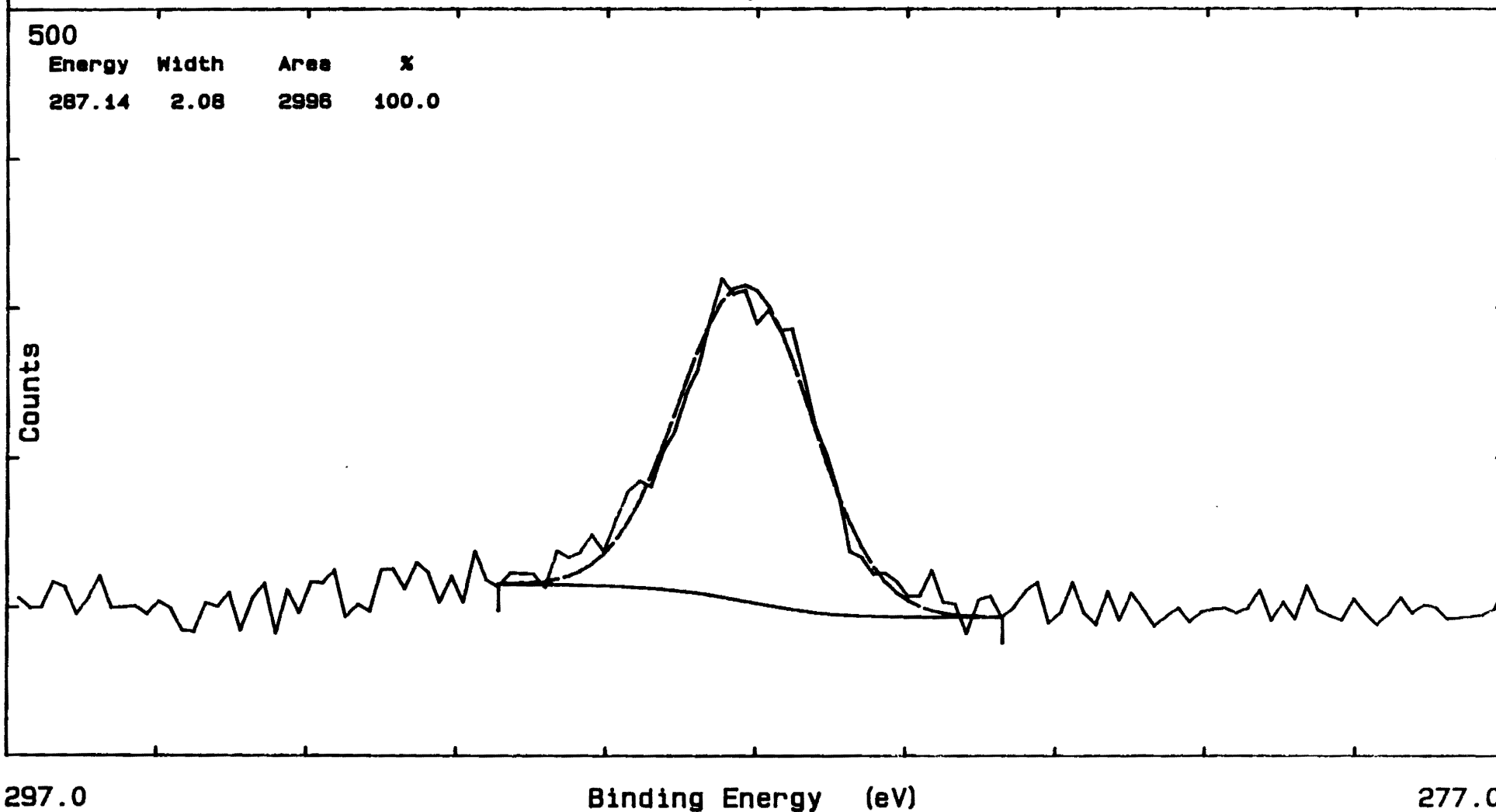
File: LDEF099	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description:	IV-38: ENHANCED AL + OVERCOAT SECOND SPOT AWAY FROM CENTER, Si 2s SPECTRUM		Operator: TAP



File: LDEF099	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

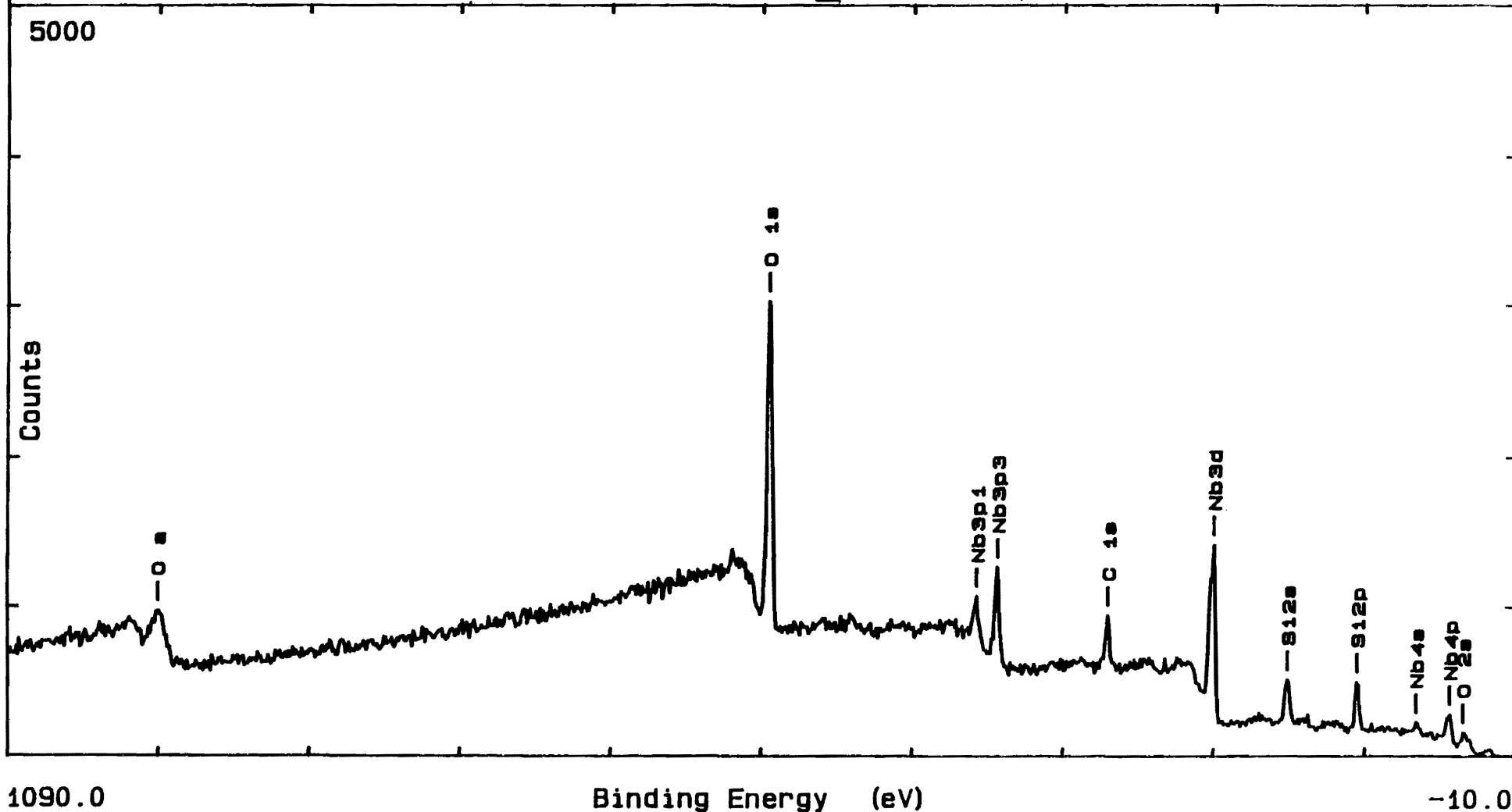
Description: IV-38: ENHANCED AL + OVERCOAT
SECOND SPOT AWAY FROM CENTER, C 1s SPECTRUM

Operator: TAP



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF103	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-47: NIOBIUM		Operator: TAP	
SPOT 1 UNEXPOSED			



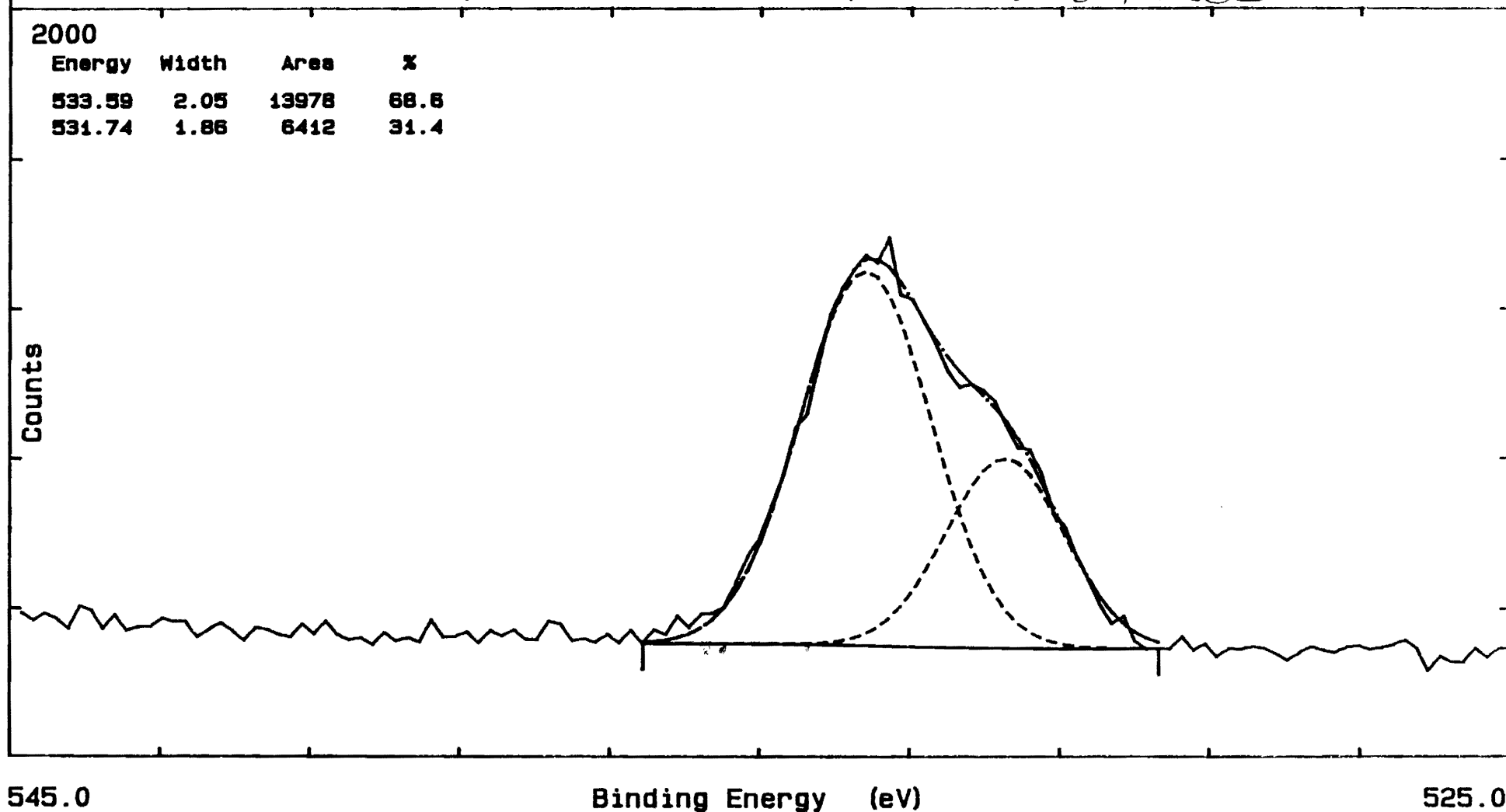
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF103	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-47: NIOBIUM Operator: TAP

. 0 1s SPECTRUM

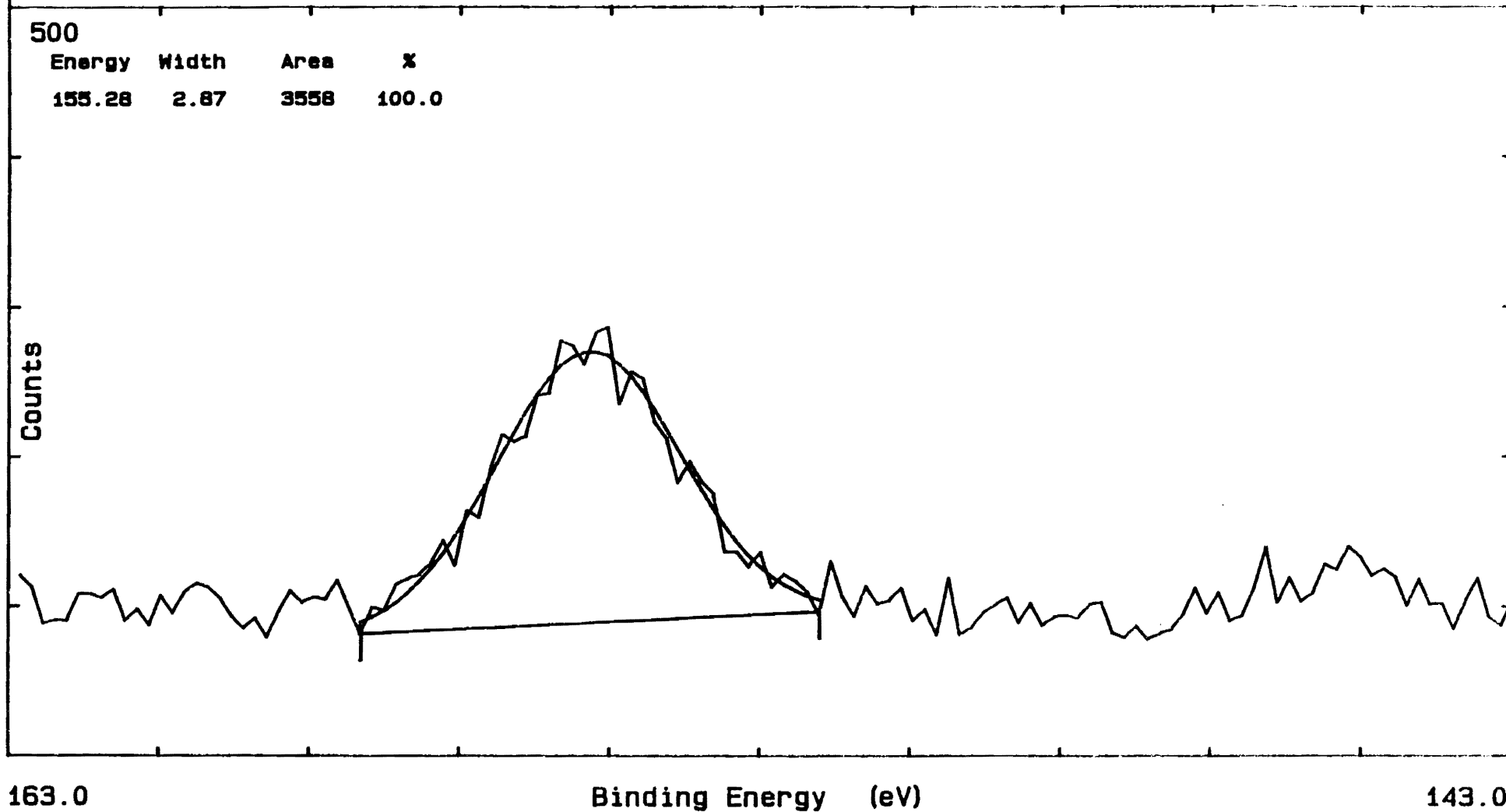
SPOT 1 UNEXPOSED



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF111	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM
SI 2s SPECTRUM
Operator: TAP
SPOT 1 UNEXPOSED



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF103	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM
C 1s SPECTRUM
Operator: TAP
SPOT 1 UNEXPOSED

1000
Energy Width Area %
286.27 2.06 3364 100.0

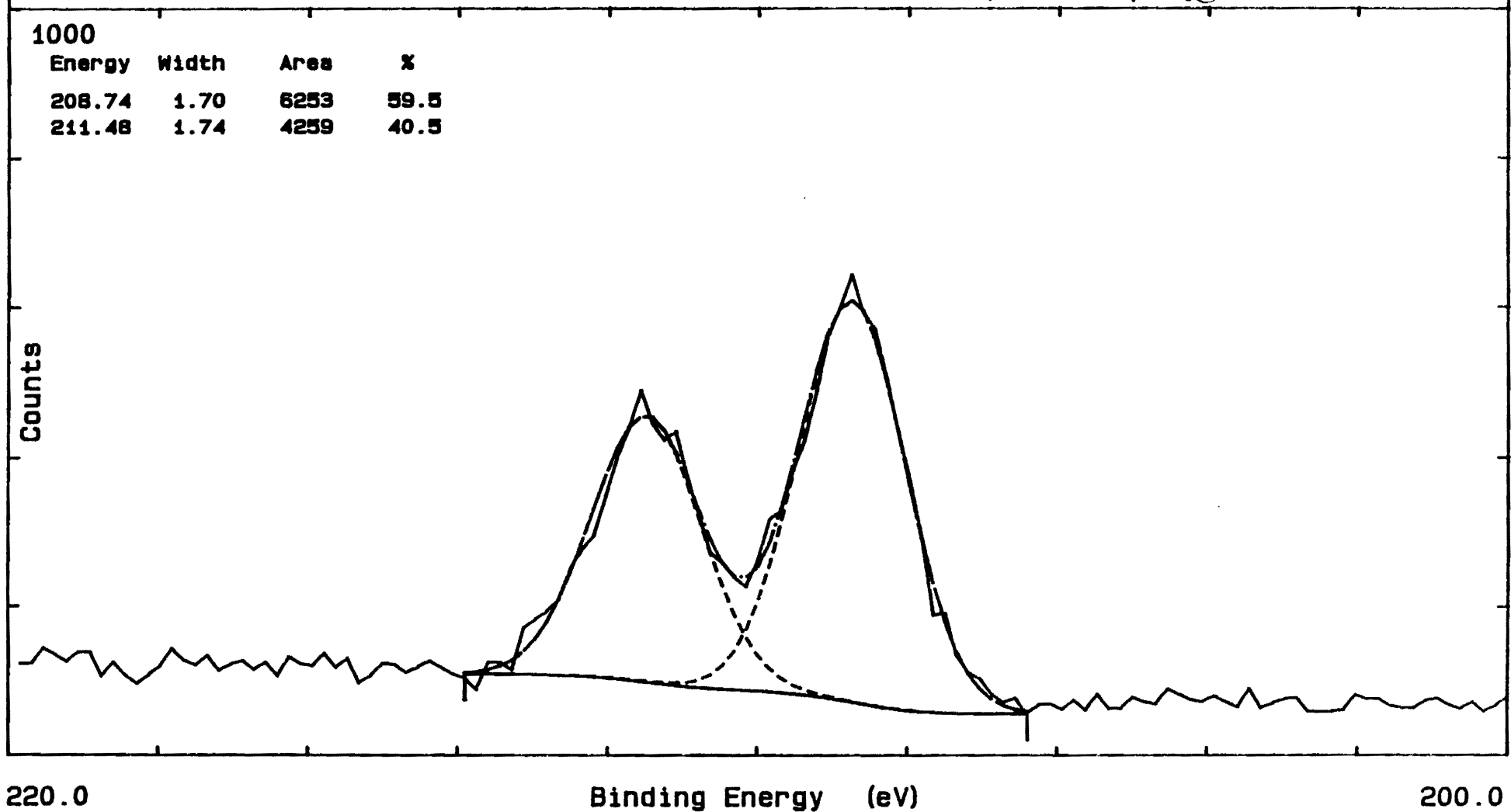
Counts

297.0 Binding Energy (eV) 277.0

GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF103	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-47: NIOBIUM
Nb 3d SPECTRUM
Operator: TAP
SPOT 1 UNEXPOSED



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF104	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-47: NIOBIUM			Operator: TAP
SPOT 2 UNEXPOSED			

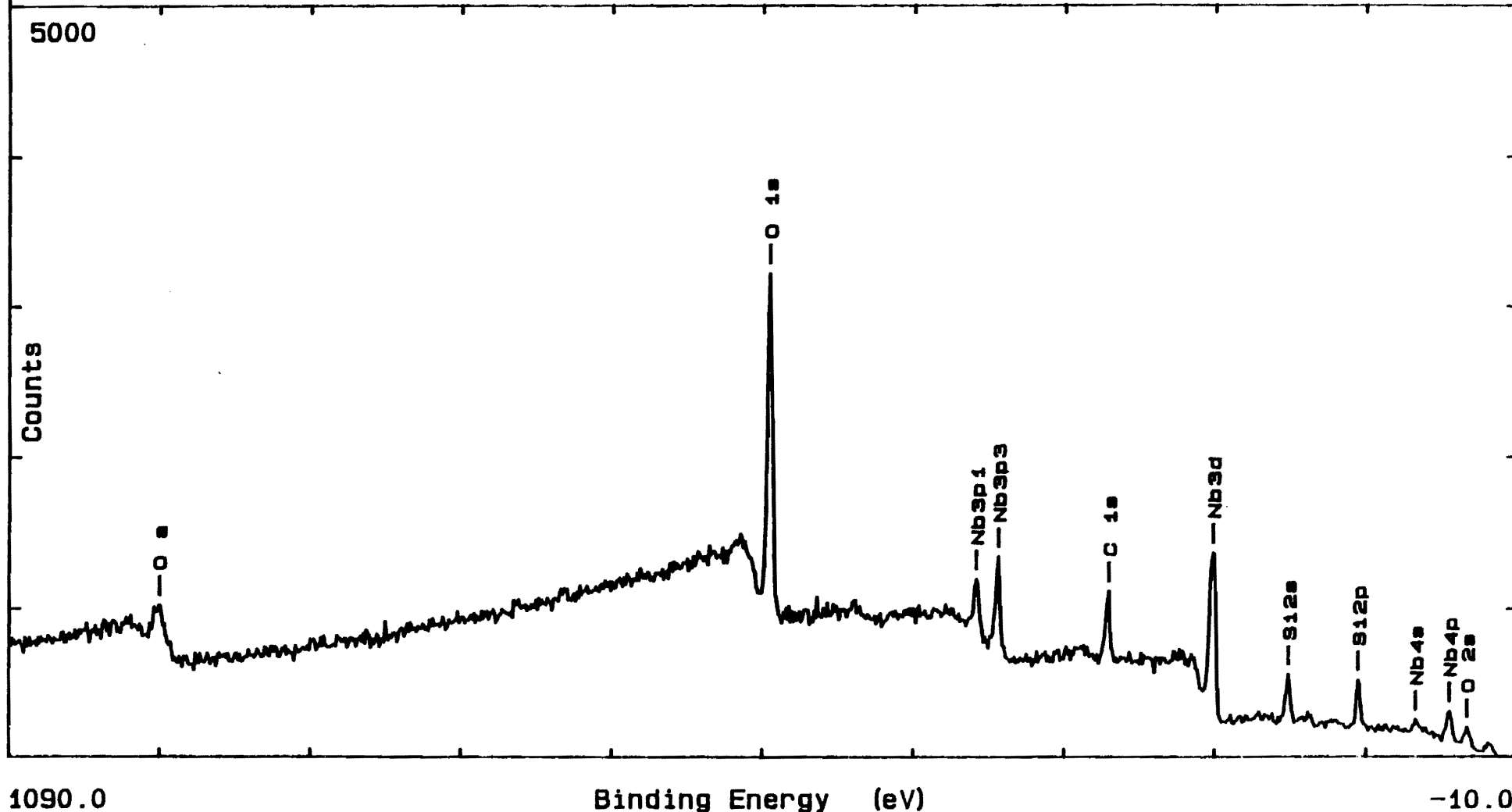


Figure 76

File: LDEF104	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

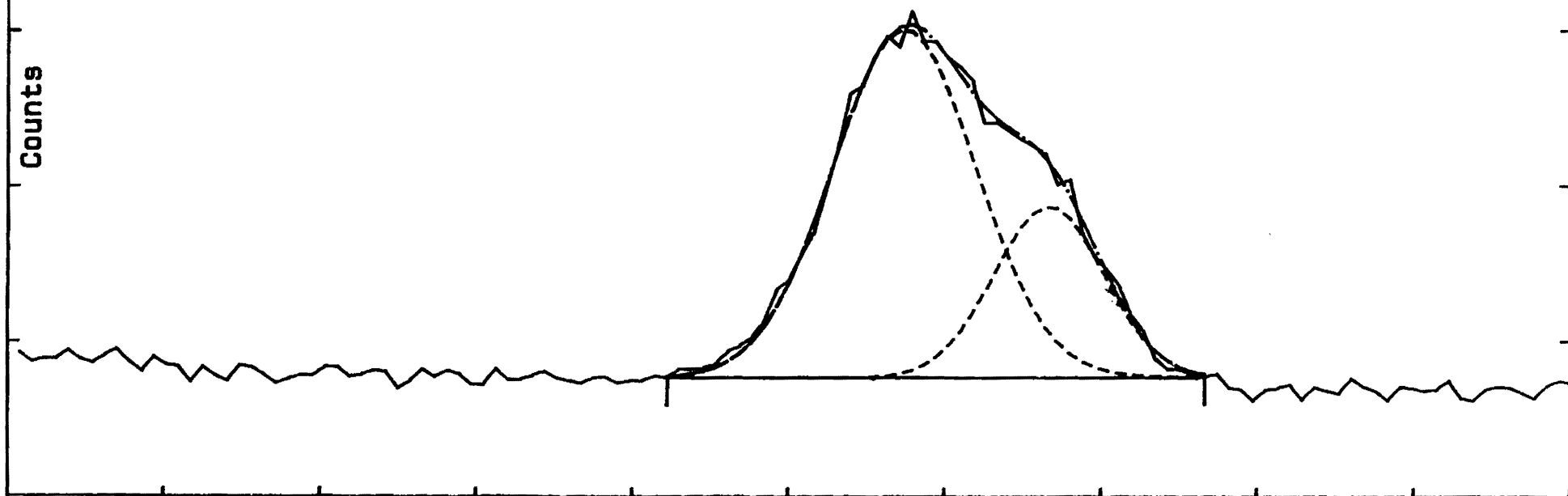
Description: IV-47: NIOBIUM Operator: TAP

0 1s SPECTRUM SPOT 2 UNEXPOSED

2000

Energy	Width	Area	%
533.53	2.15	13124	72.7
531.68	1.65	4933	27.3

Counts

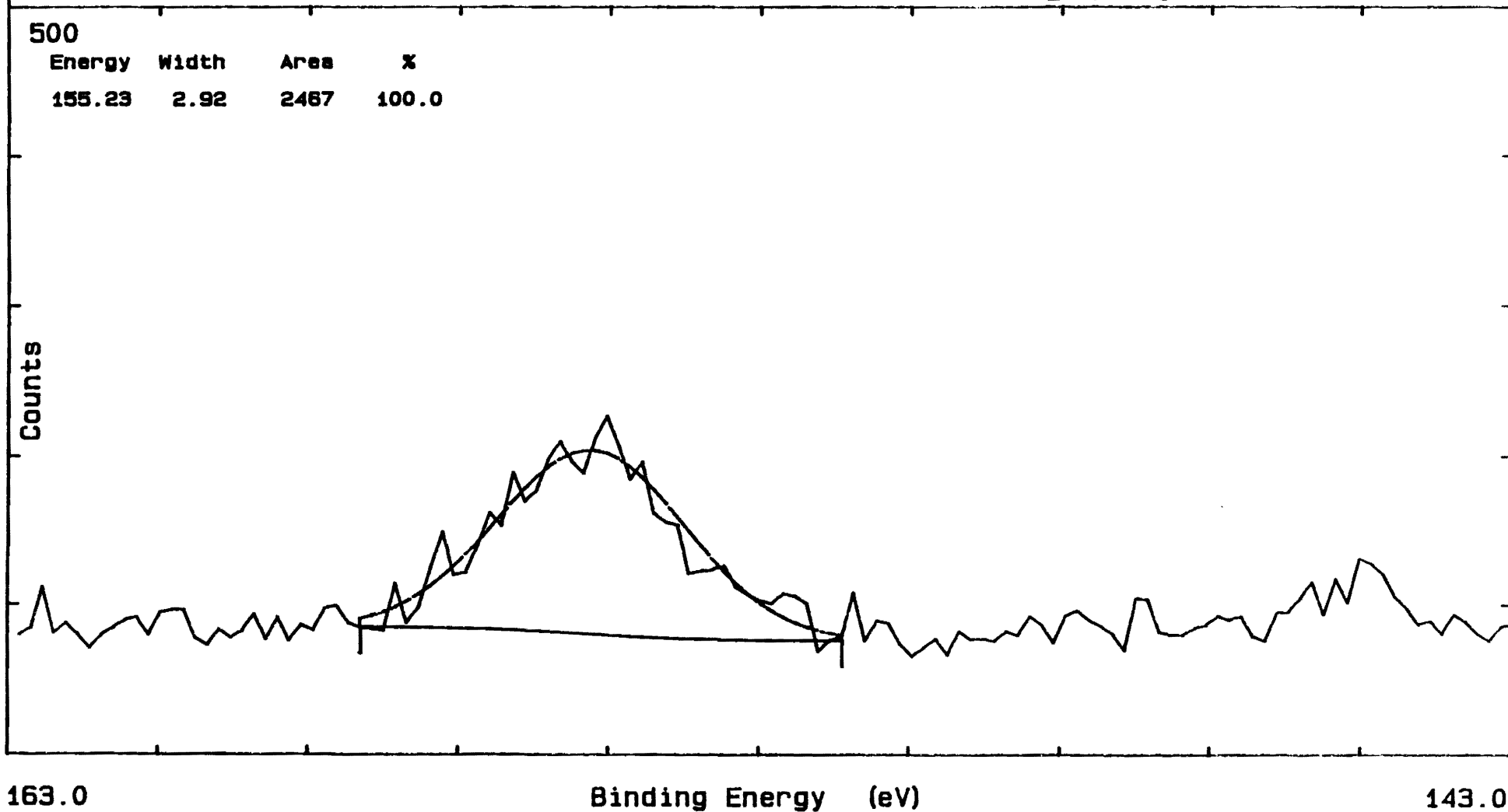


545.0 Binding Energy (eV) 525.0

GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF112	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM
SI 2s SPECTRUM
Operator: TAP
SPOT 2 UNEXPOSED



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF104	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM
C 1s SPECTRUM SPOT 2 UNEXPOSED Operator: TAP

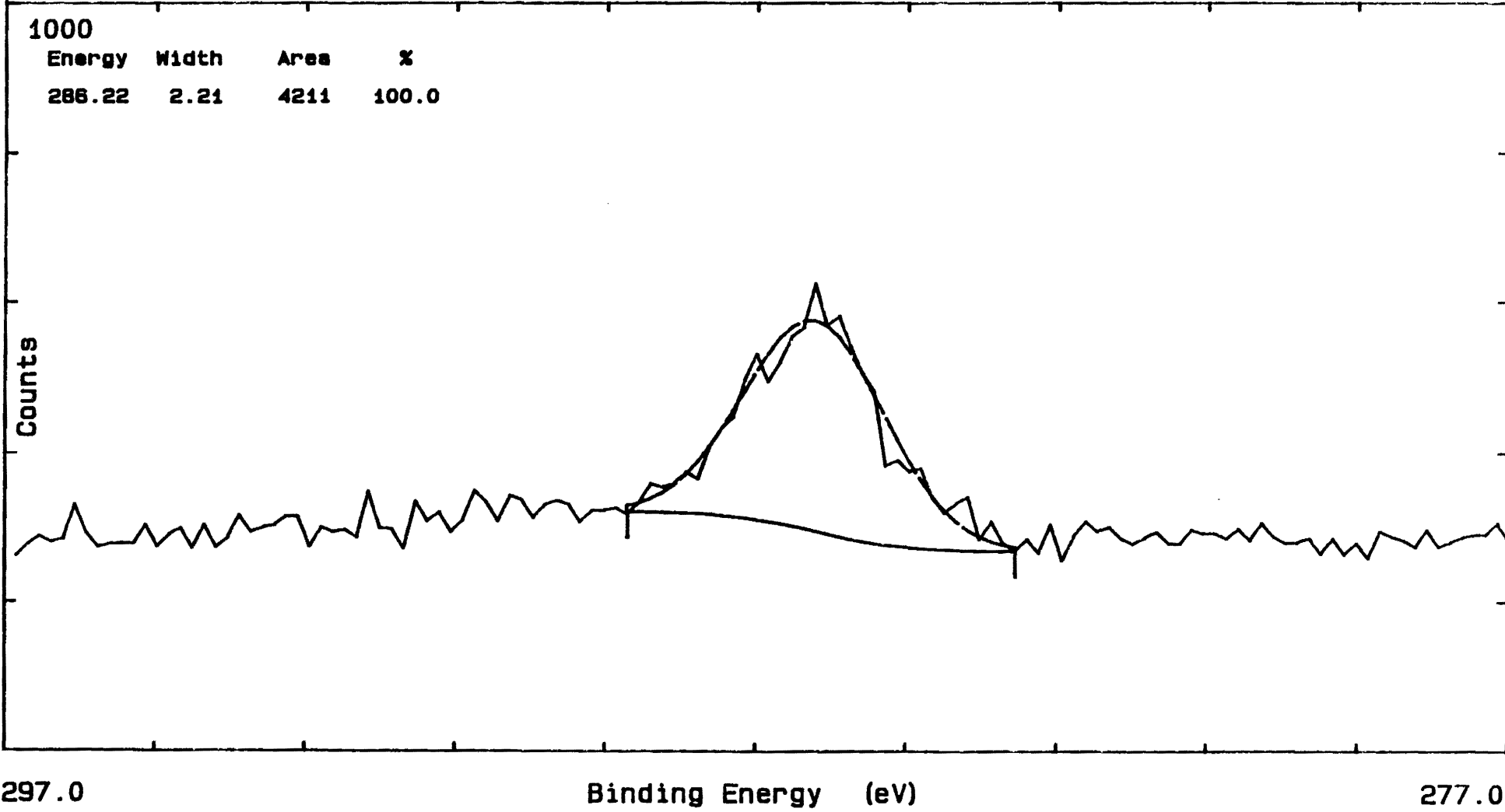


Figure 79

File: LDEF104	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-47: NIOBIUM
Nb 3d SPECTRUM
Operator: TAP
SPOT 2 UNEXPOSED

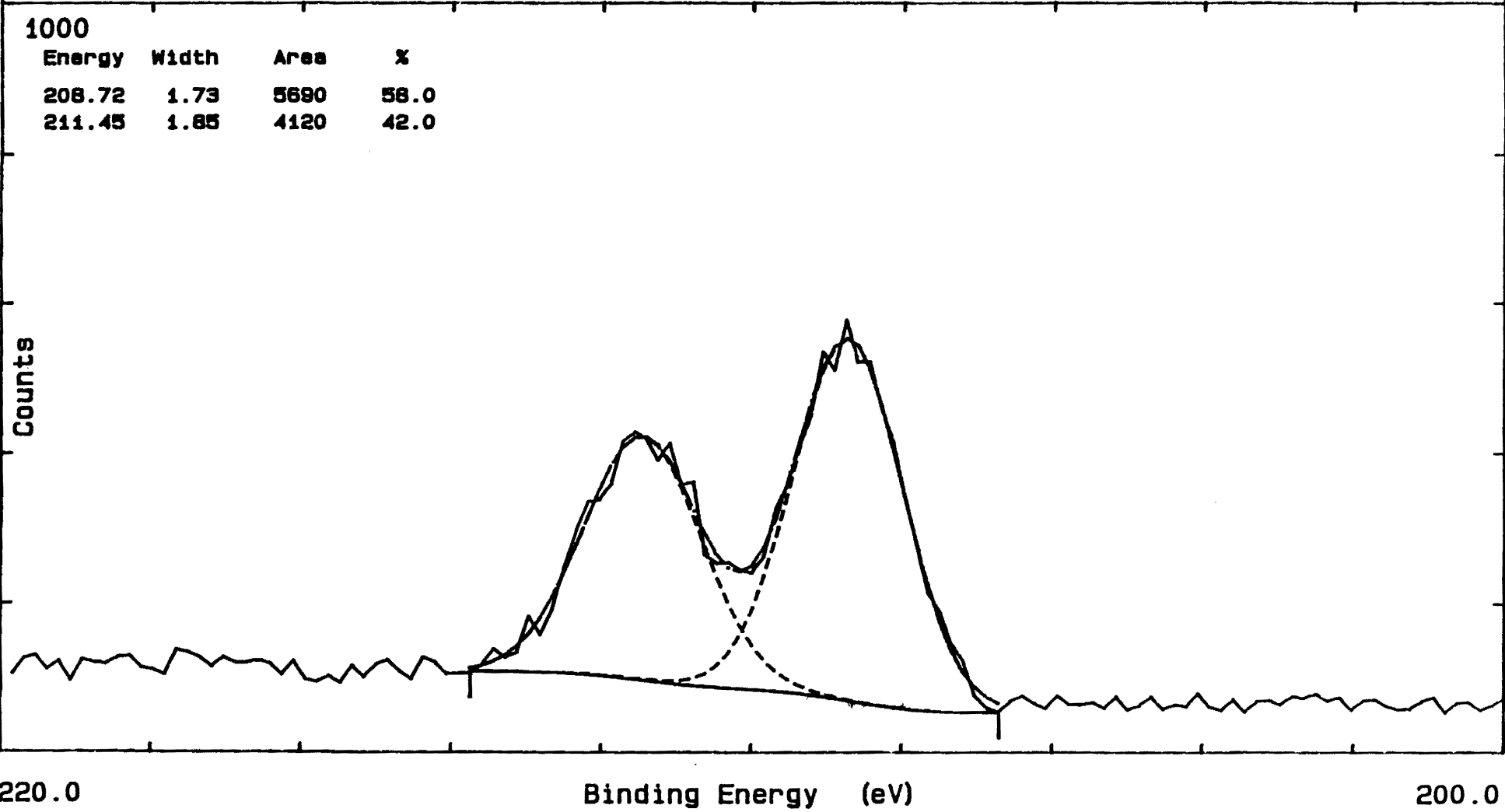


Figure 80

File: LDEF100	Date: 9/22/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 1	Resolution: 4

Description: IV-47: NIOBIUM

Operator: TAP

SPOT 3 EXPOSED

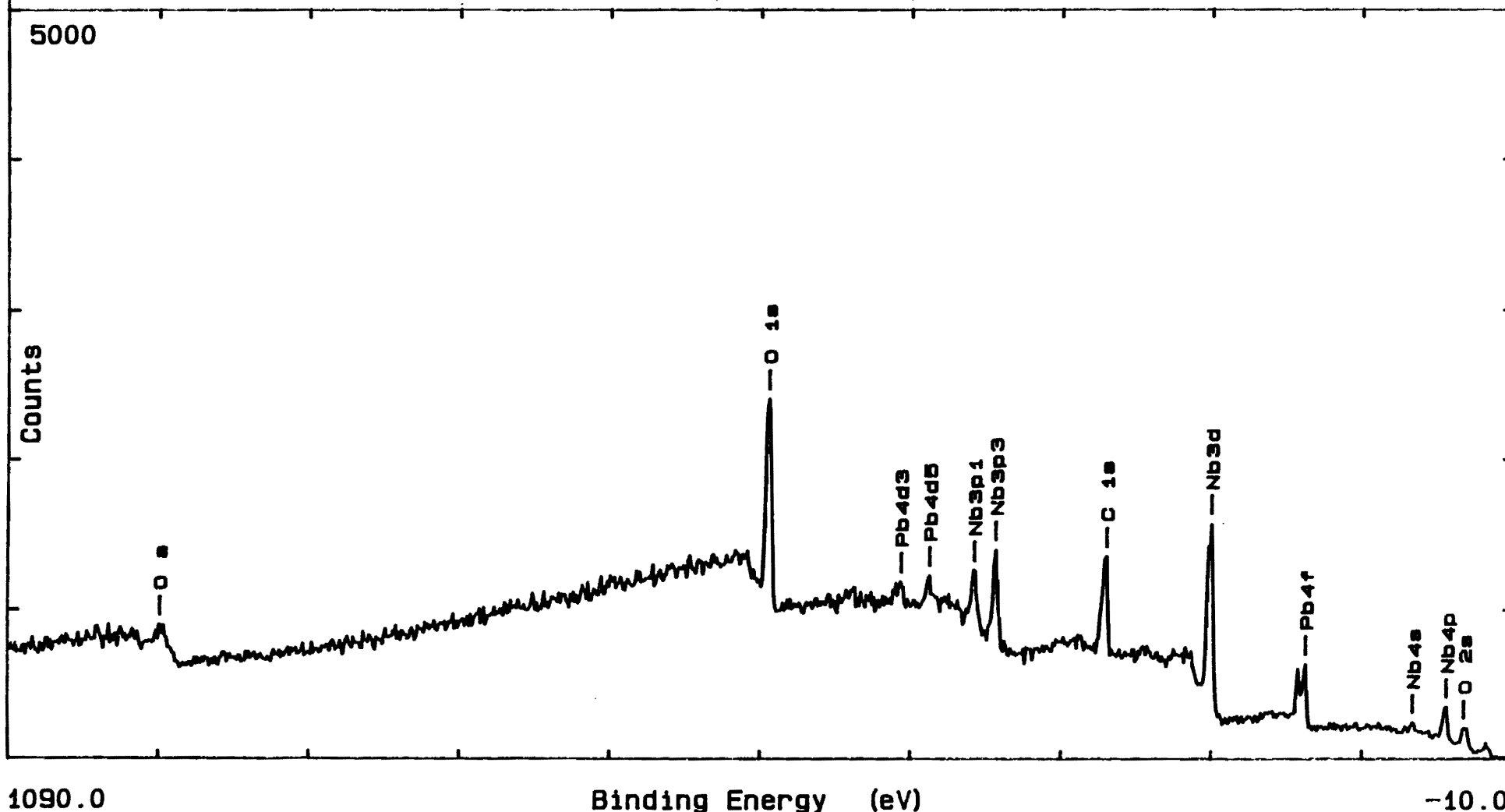


Figure 81

File: LDEF101	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-47: NIOBIUM
0 1s SPECTRUM SPOT 3 EXPOSED Operator: TAP

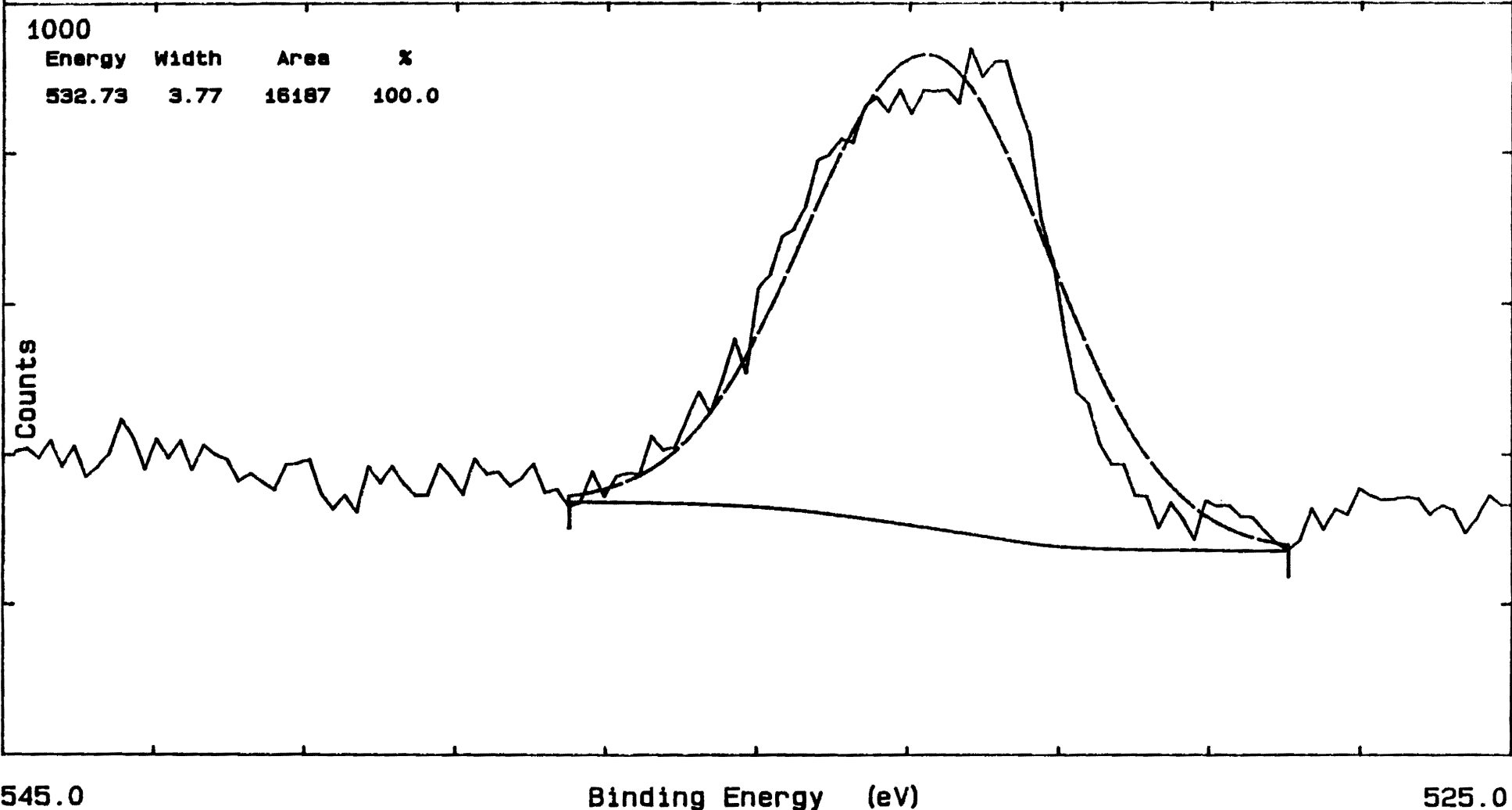
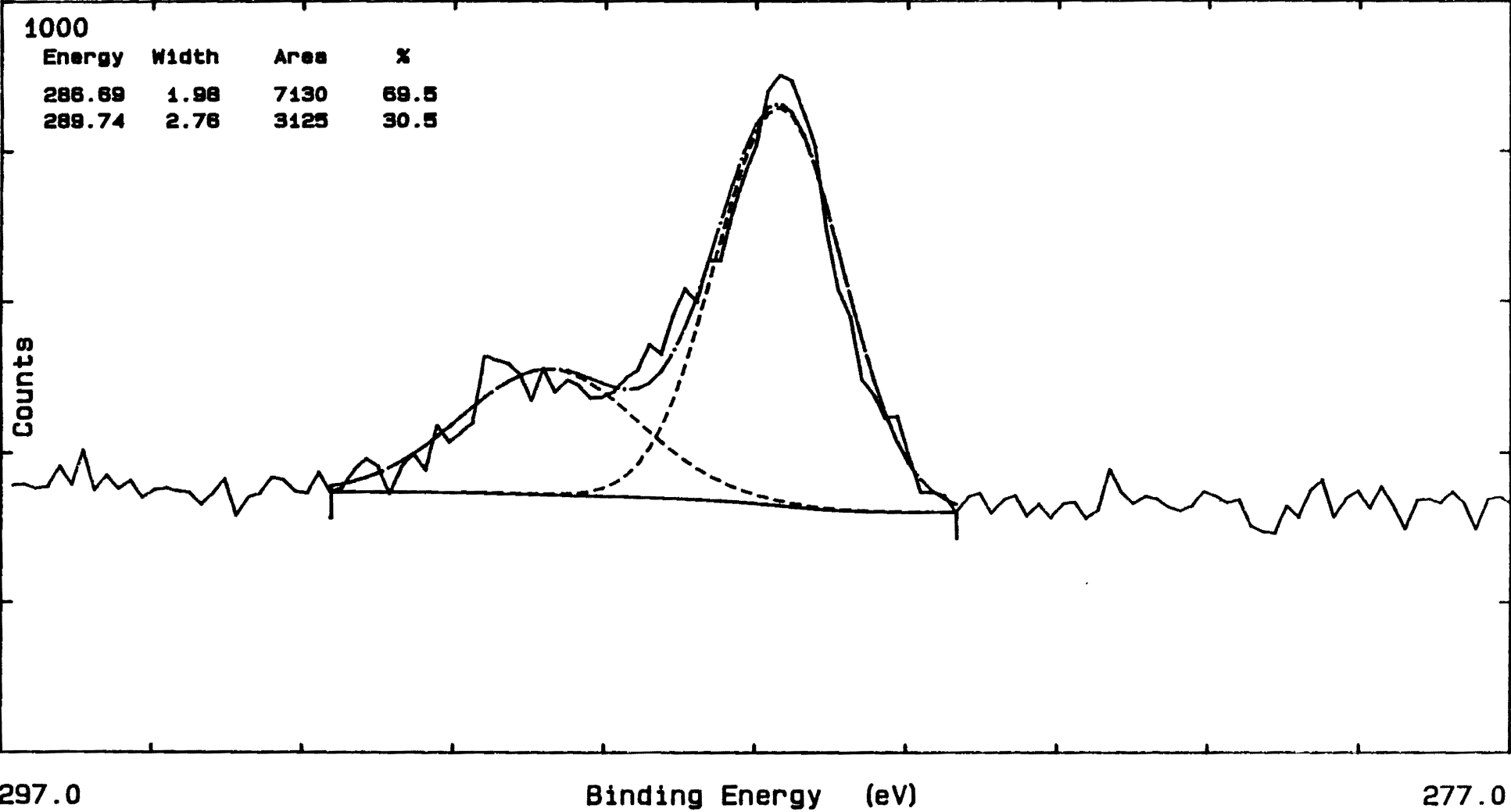


Figure 82

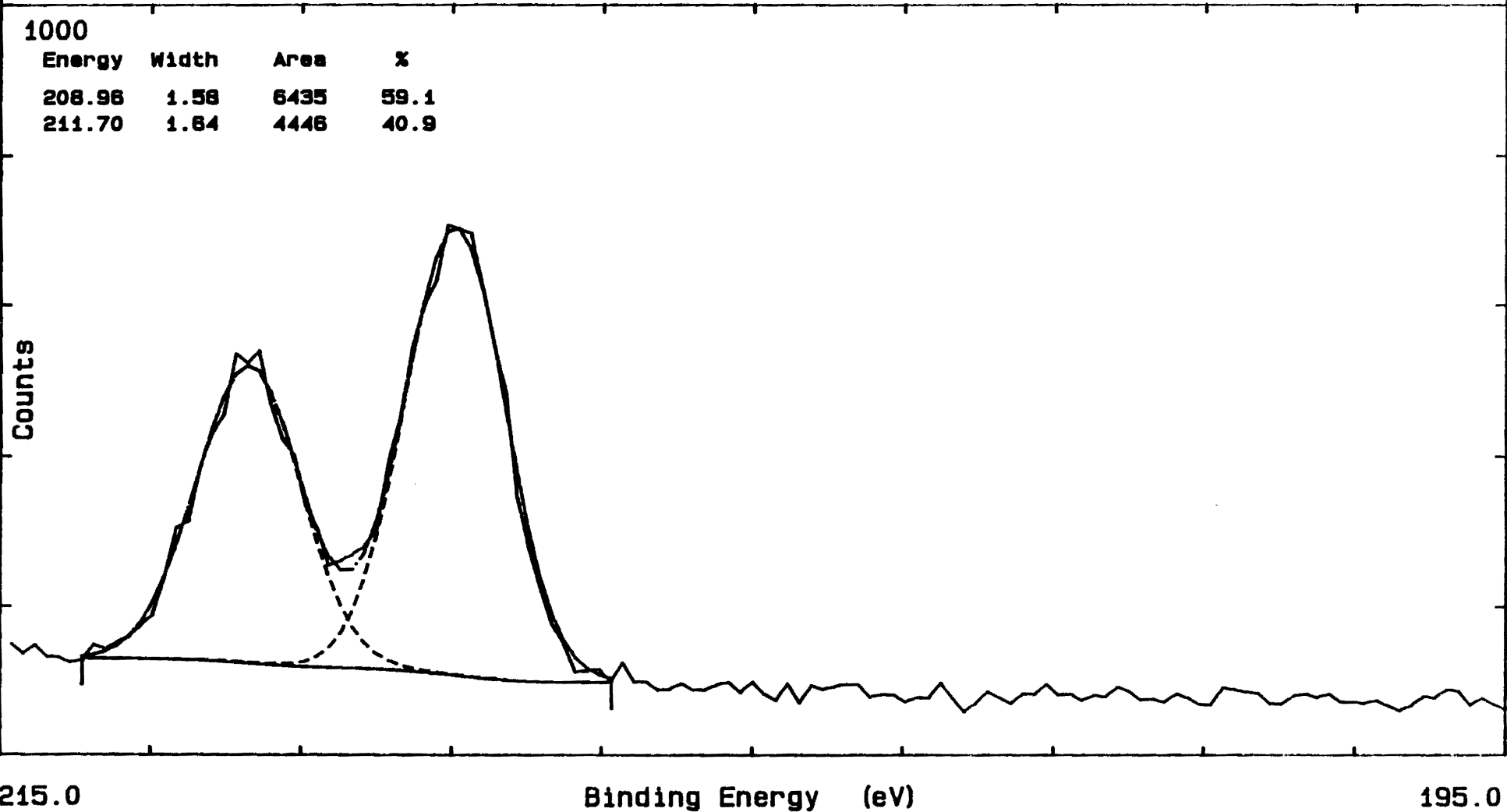
File: LDEF101	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description:
IV-47: NIOBIUM
C 1s SPECTRUM
SPOT 3 EXPOSED
Operator:
TAP



File: LDEF102	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description:
IV-47: NIOBIUM
Nb 3d SPECTRUM
SPOT 3 EXPOSED
Operator:
TAP



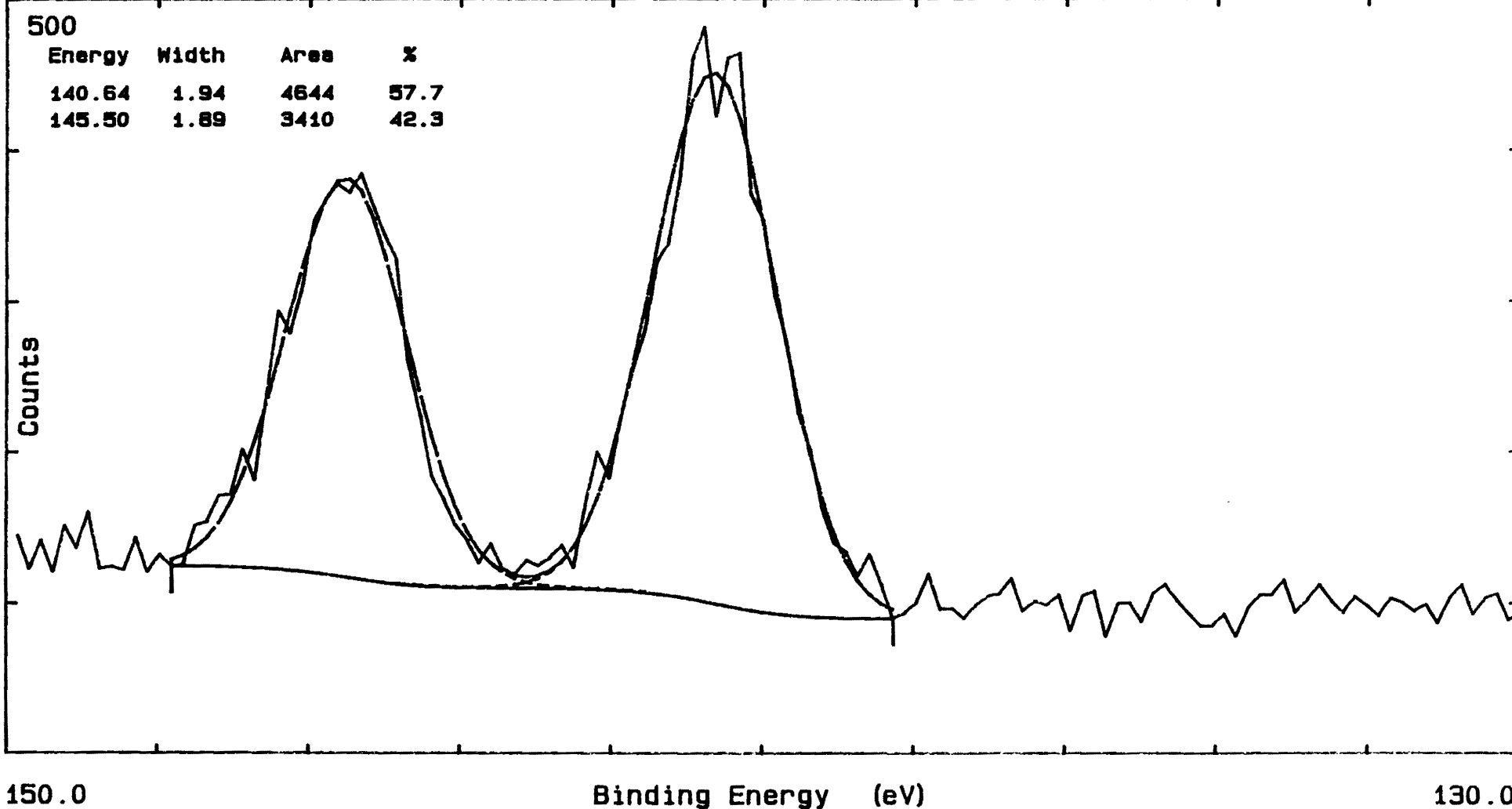
File: LDEF101	Date: 9/22/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM

Operator: TAP

Pb 4f SPECTRUM

SPOT 3 EXPOSED



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF105	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-47: NIOBIUM			Operator: TAP
SPOT 4 EXPOSED			

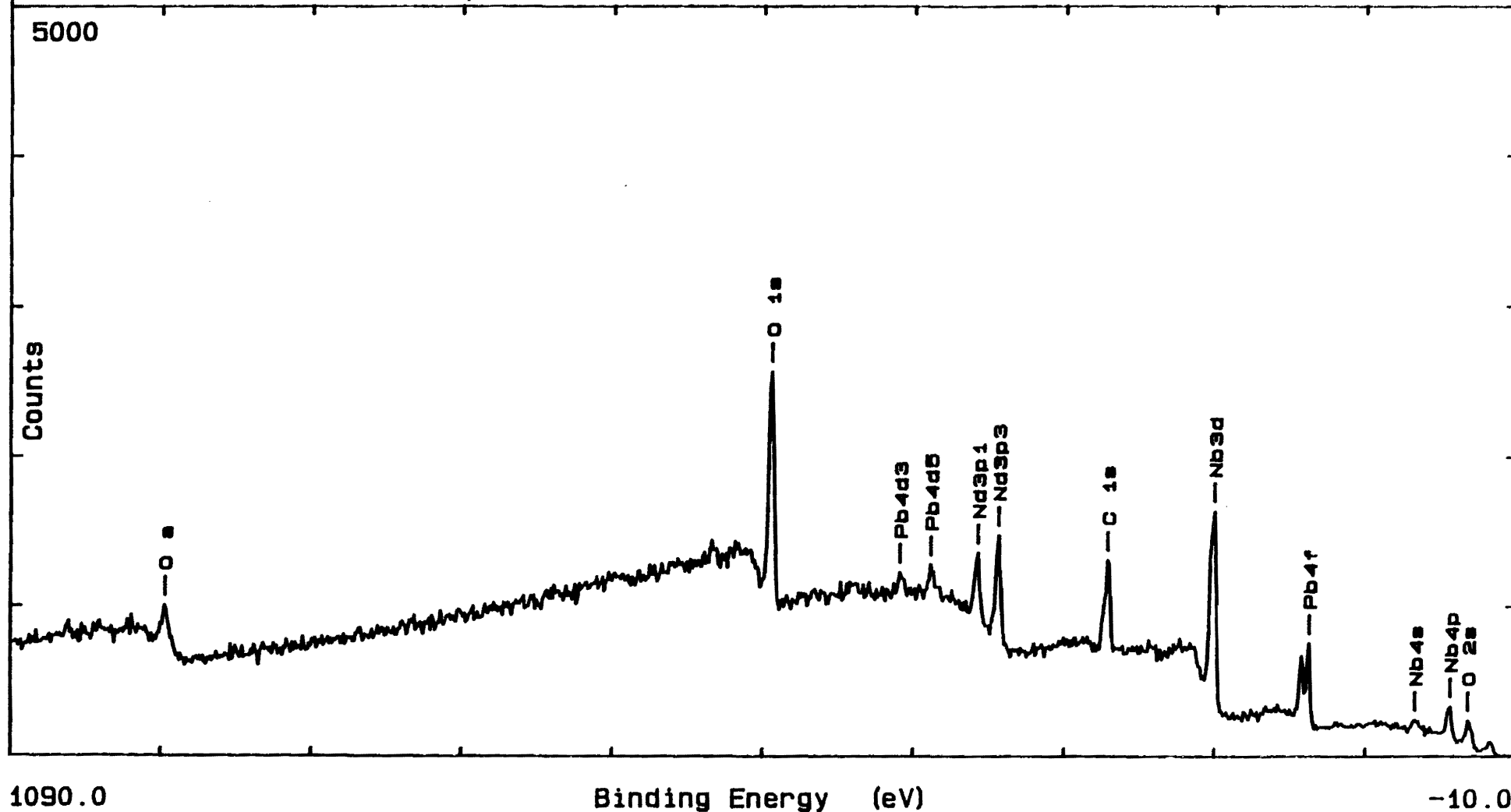


Figure 86

File: LDEF105	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-47: NIOBIUM		Operator: TAP	
0 1s SPECTRUM		SPOT 4 EXPOSED	

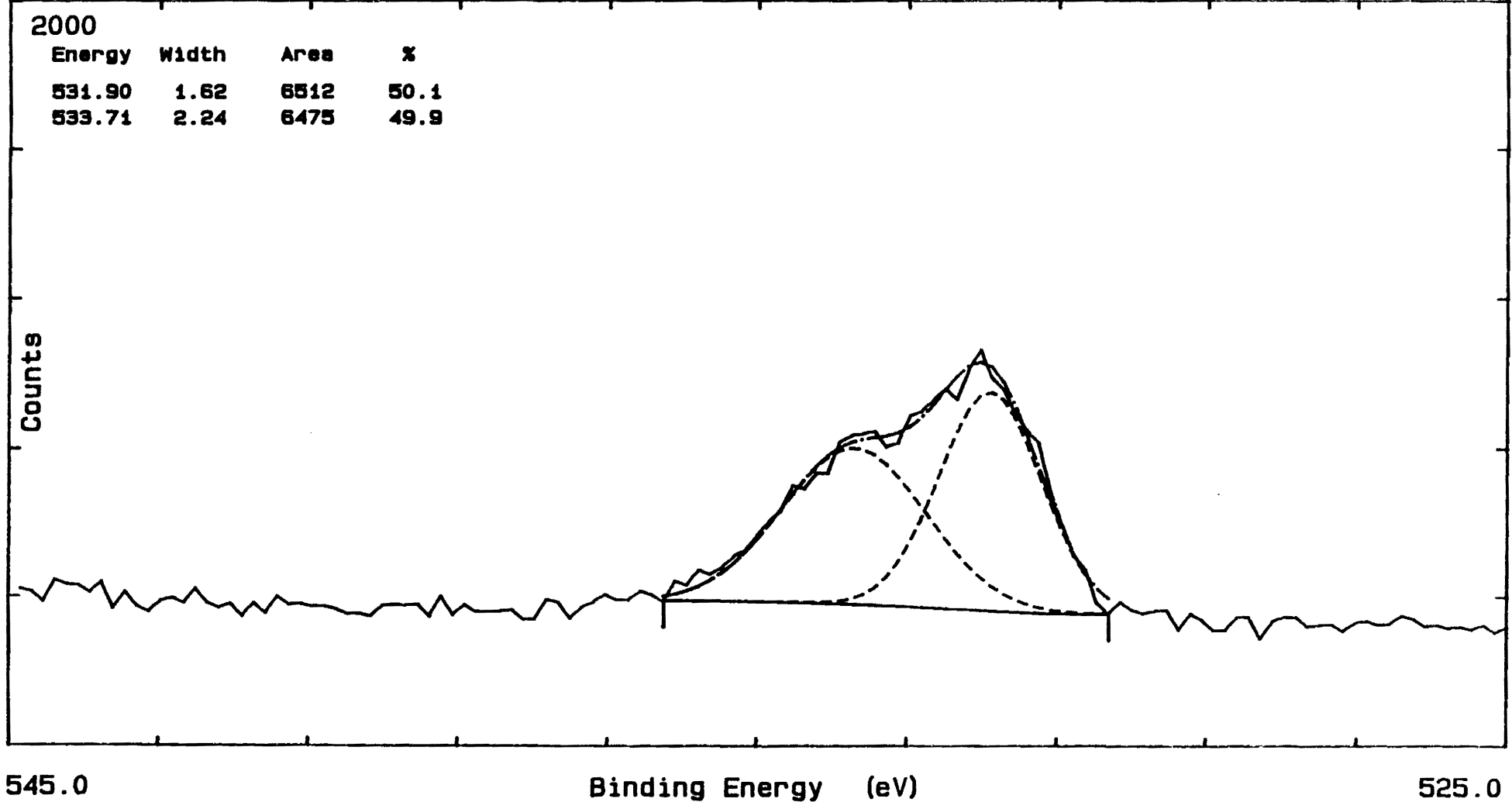


Figure 87

File: LDEF105	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-47: NIOBIUM
C 1s SPECTRUM SPOT 4 EXPOSED Operator: TAP

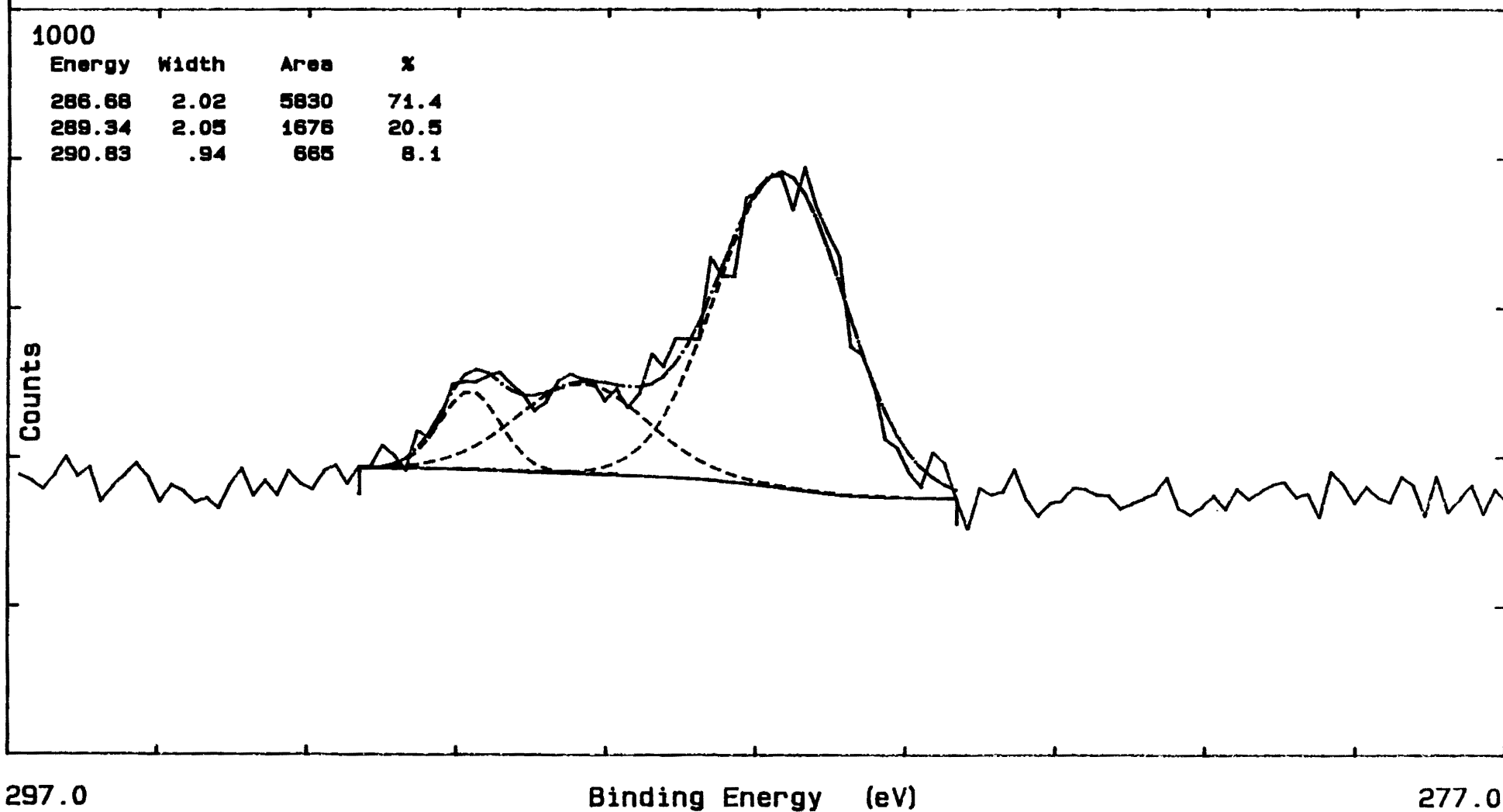
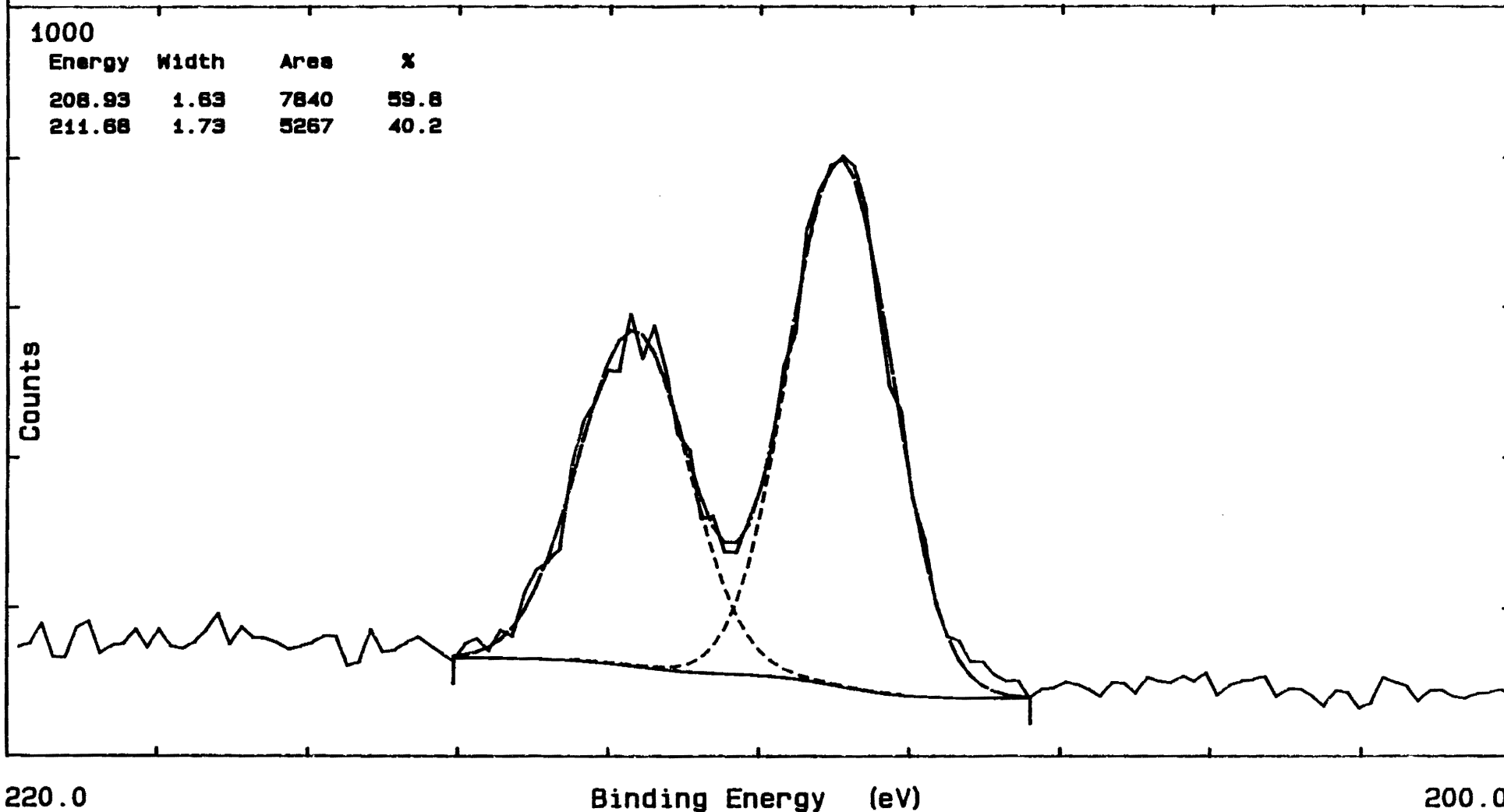


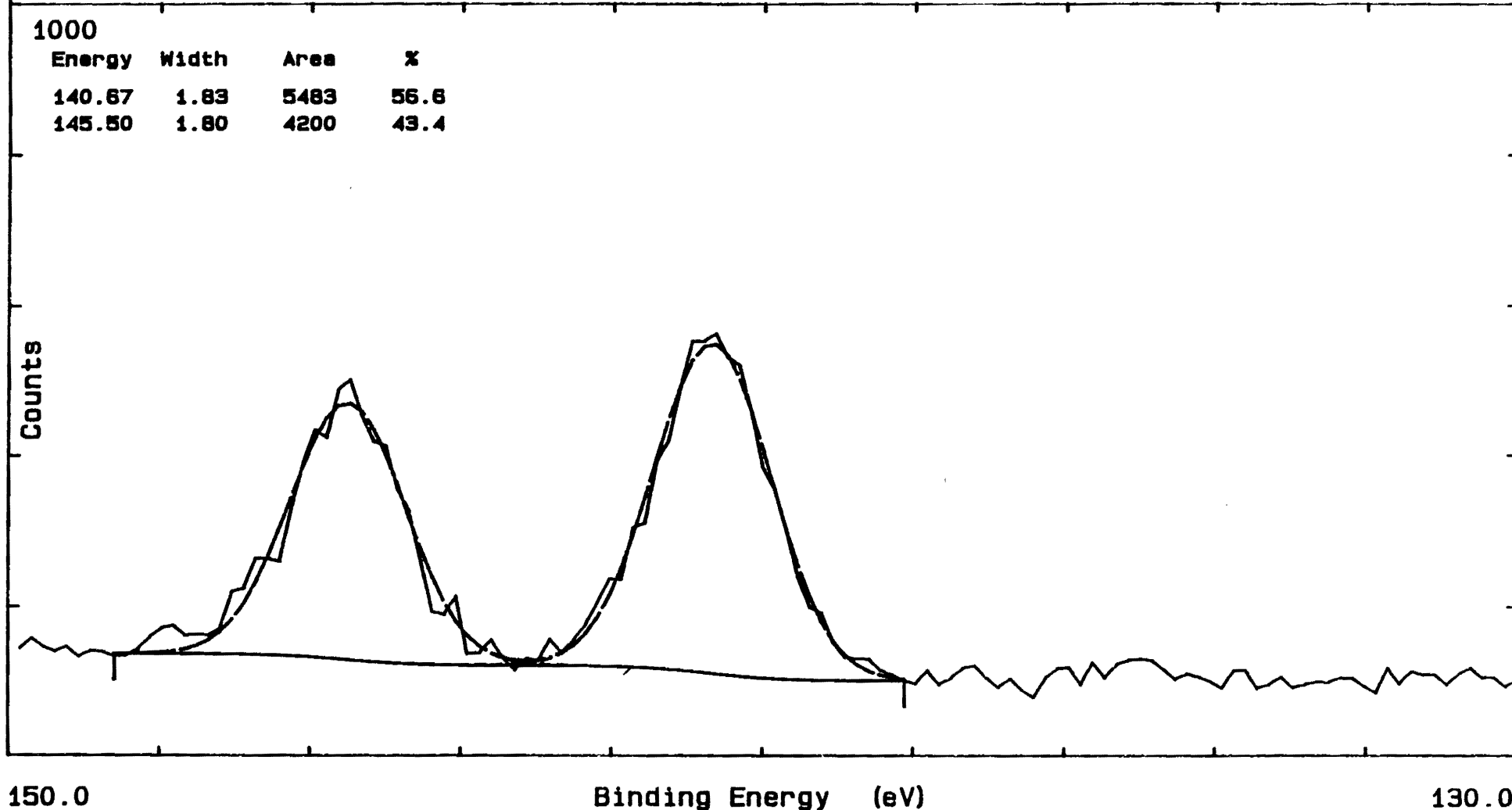
Figure 88

File: LDEF105	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-47: NIOBIUM
Nb 3d SPECTRUM SPOT 4 EXPOSED Operator: TAP



File: LDEF105	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-47: NIOBIUM			Operator: TAP
Pb 4f SPECTRUM SPOT 4 EXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF108	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-80: Ag ALLOY + OVERCOAT			Operator: TAP

SPOT 1 UNEXPOSED

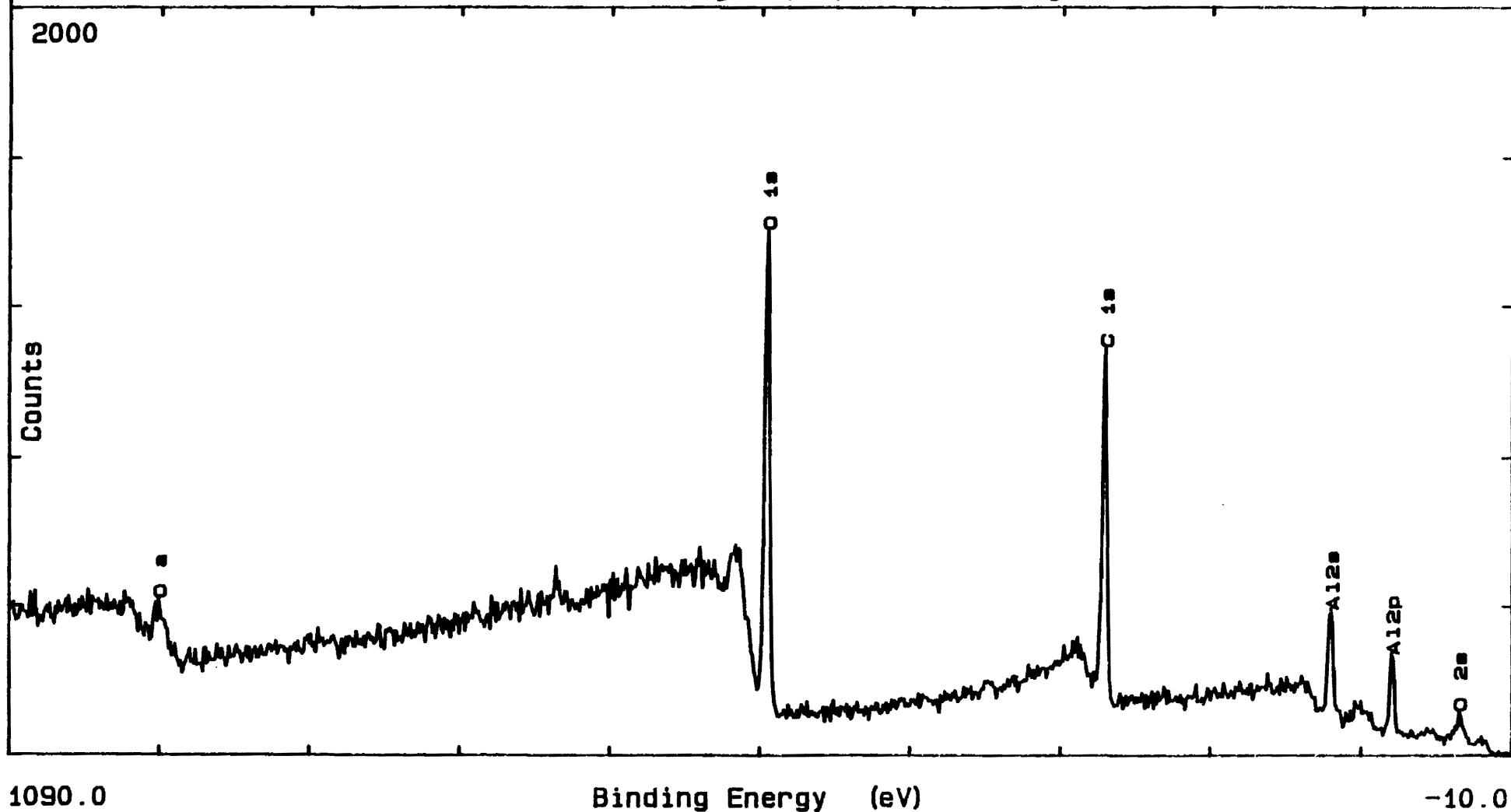
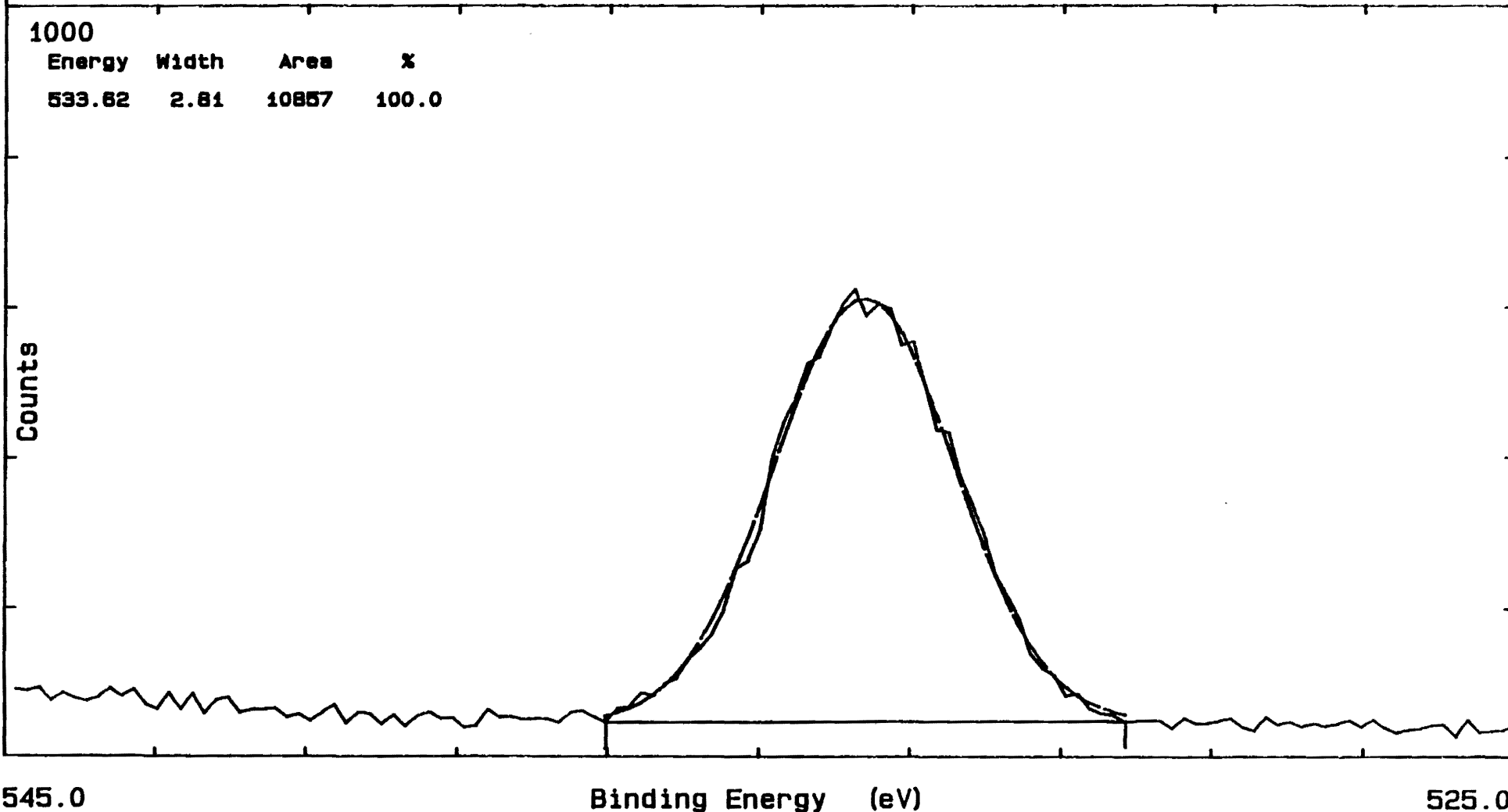


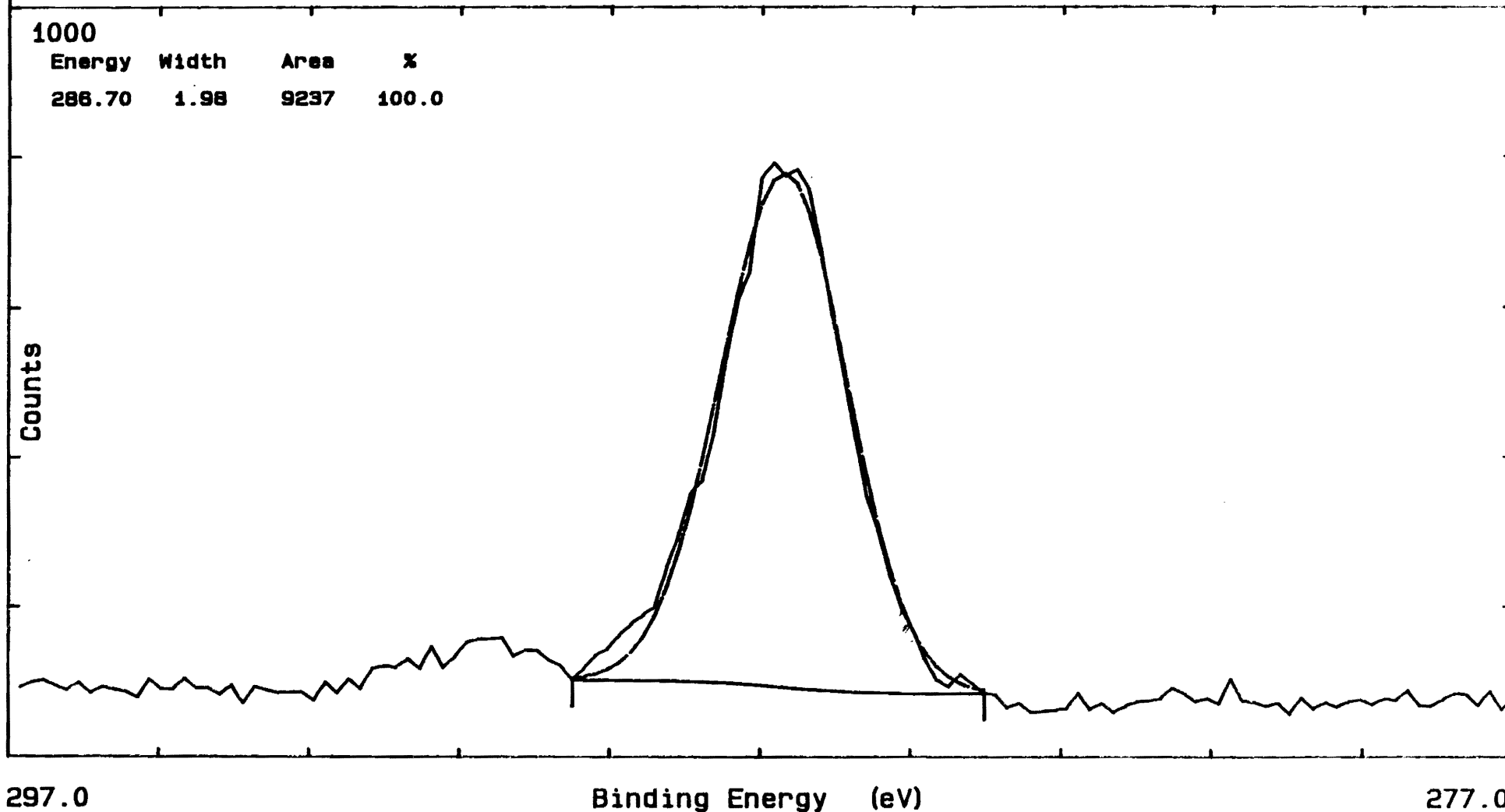
Figure 91

File: LDEF108	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT 0 1s SPECTRUM			Operator: TAP
SPOT 1 UNEXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF108	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT C 1s SPECTRUM			Operator: TAP
SPOT 1 UNEXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF109	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-80: Ag ALLOY + OVERCOAT			Operator: TAP
SPOT 2 UNEXPOSED			

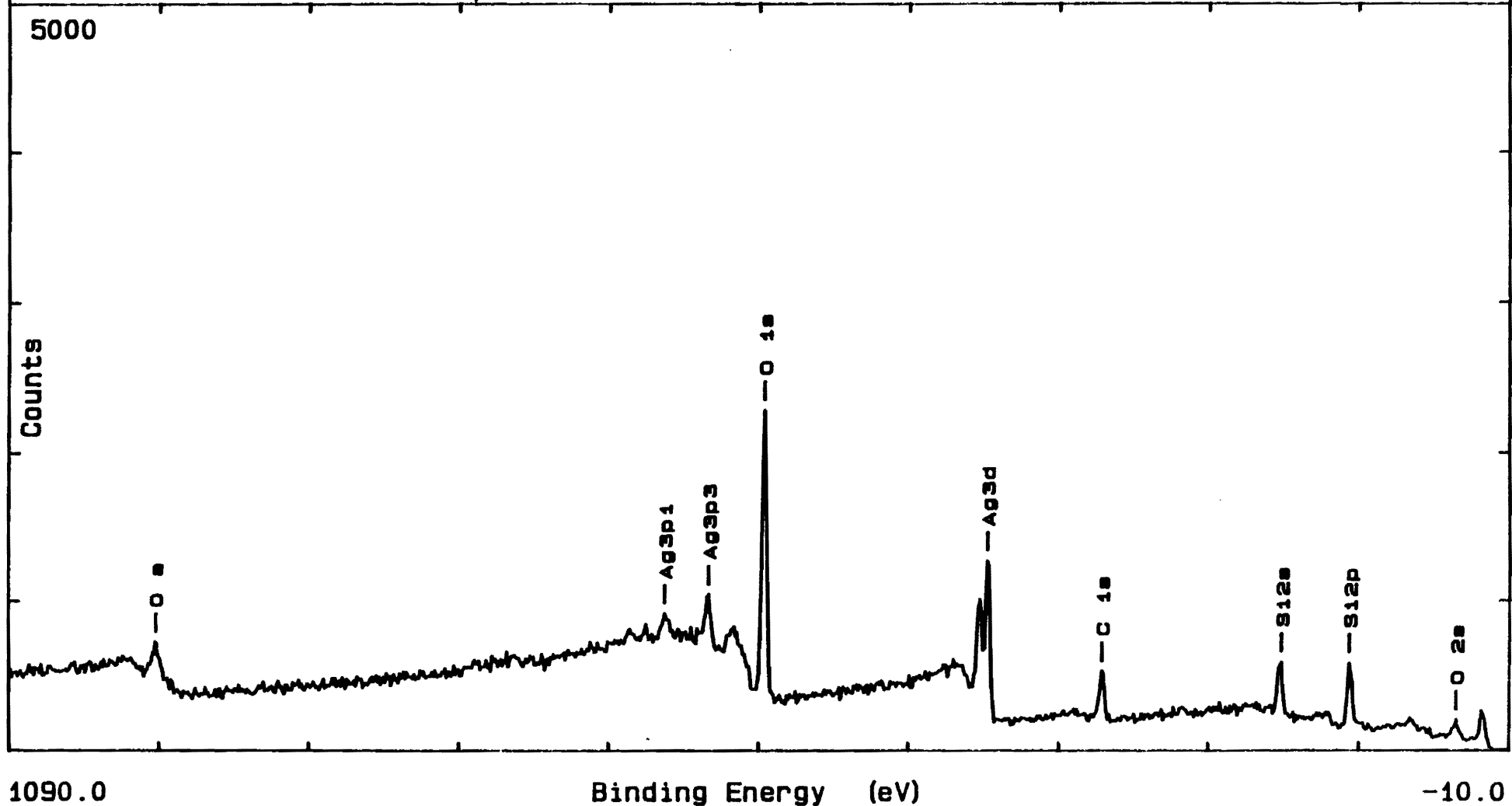
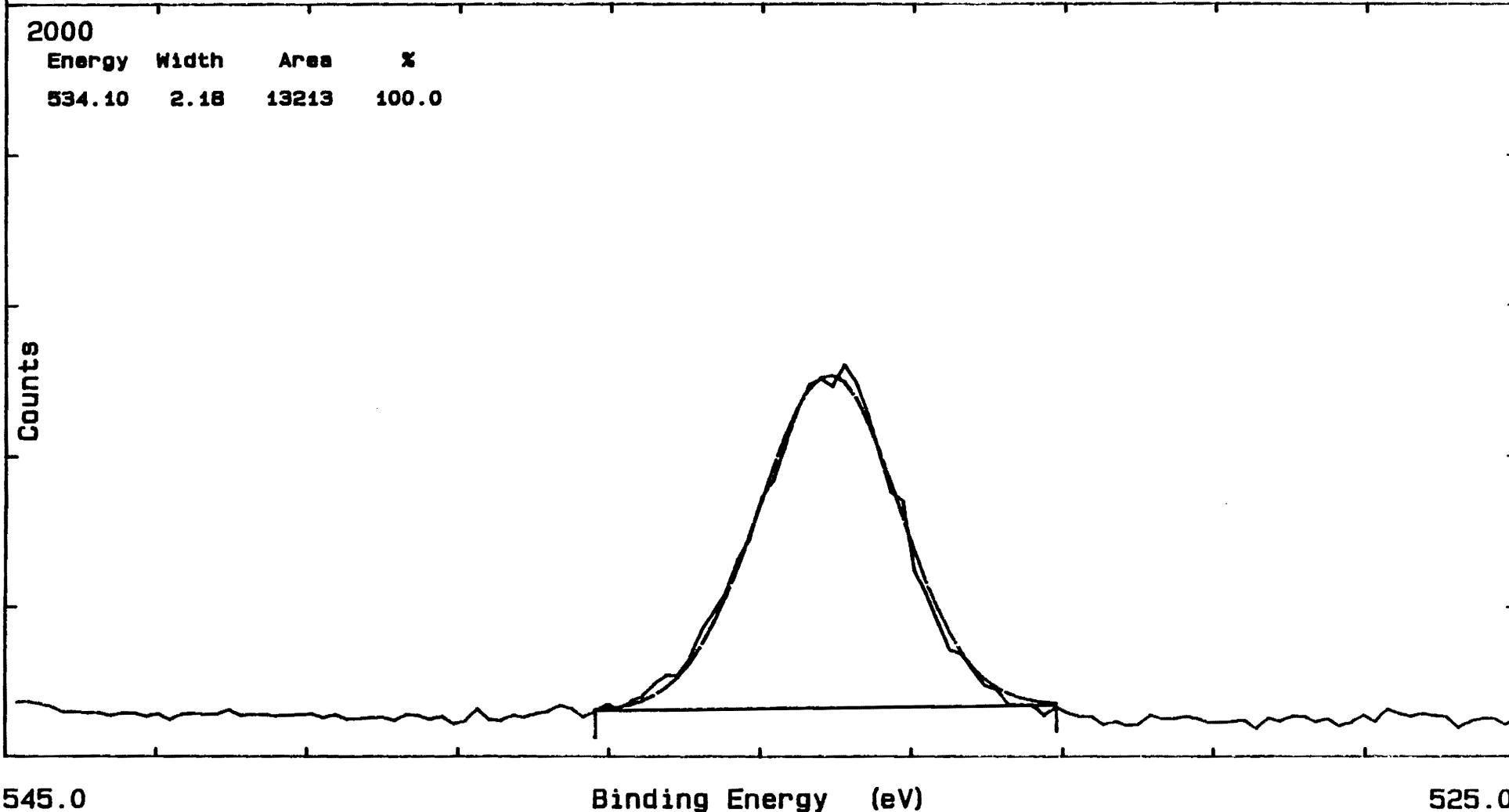


Figure 94

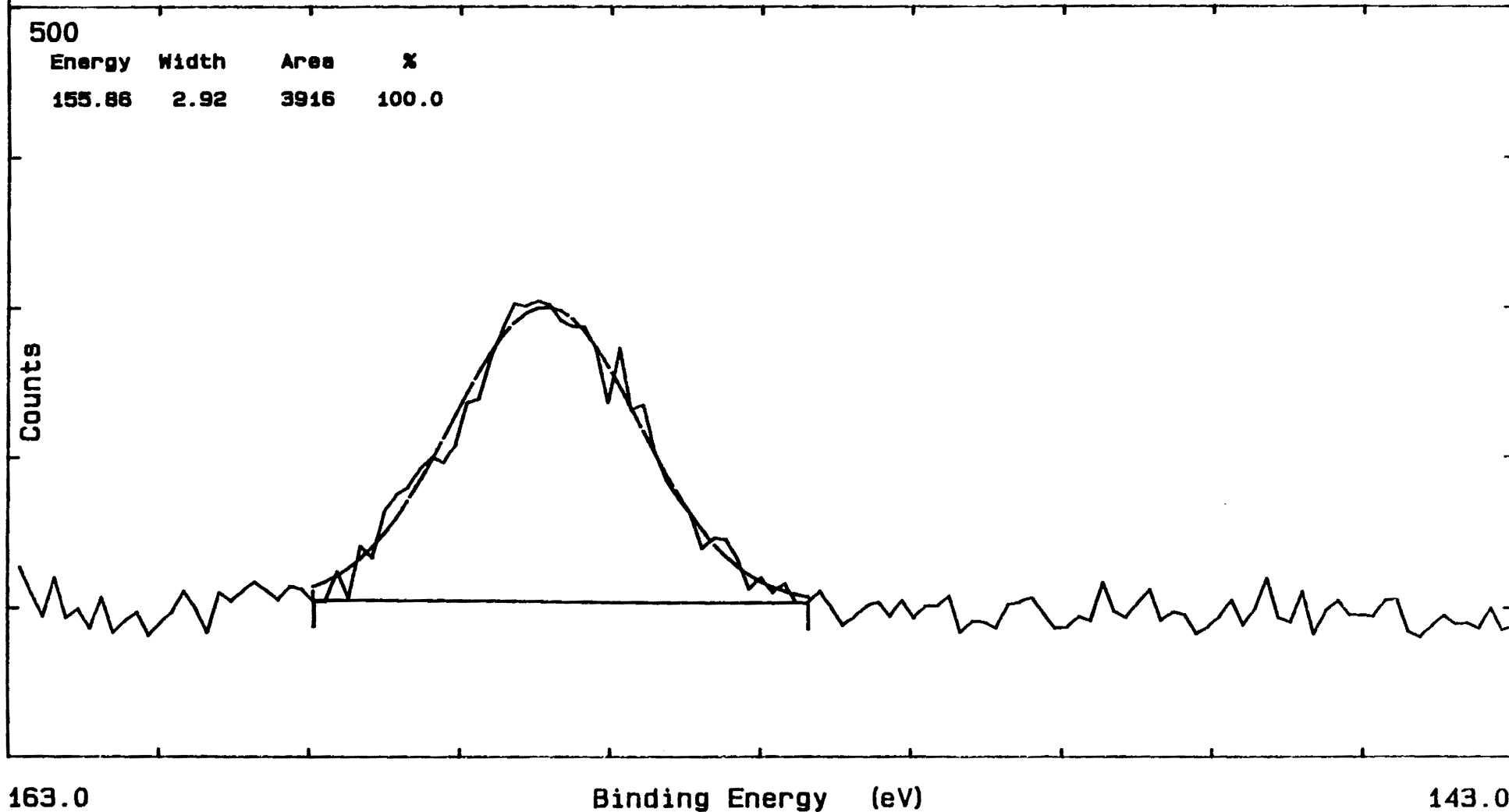
File: LDEF109	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT 0 1s SPECTRUM			Operator: TAP
SPOT 2 UNEXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF109	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-80: Ag ALLOY + OVERCOAT
Si 2s SPECTRUM
Operator: TAP
SPOT 2 UNEXPOSED



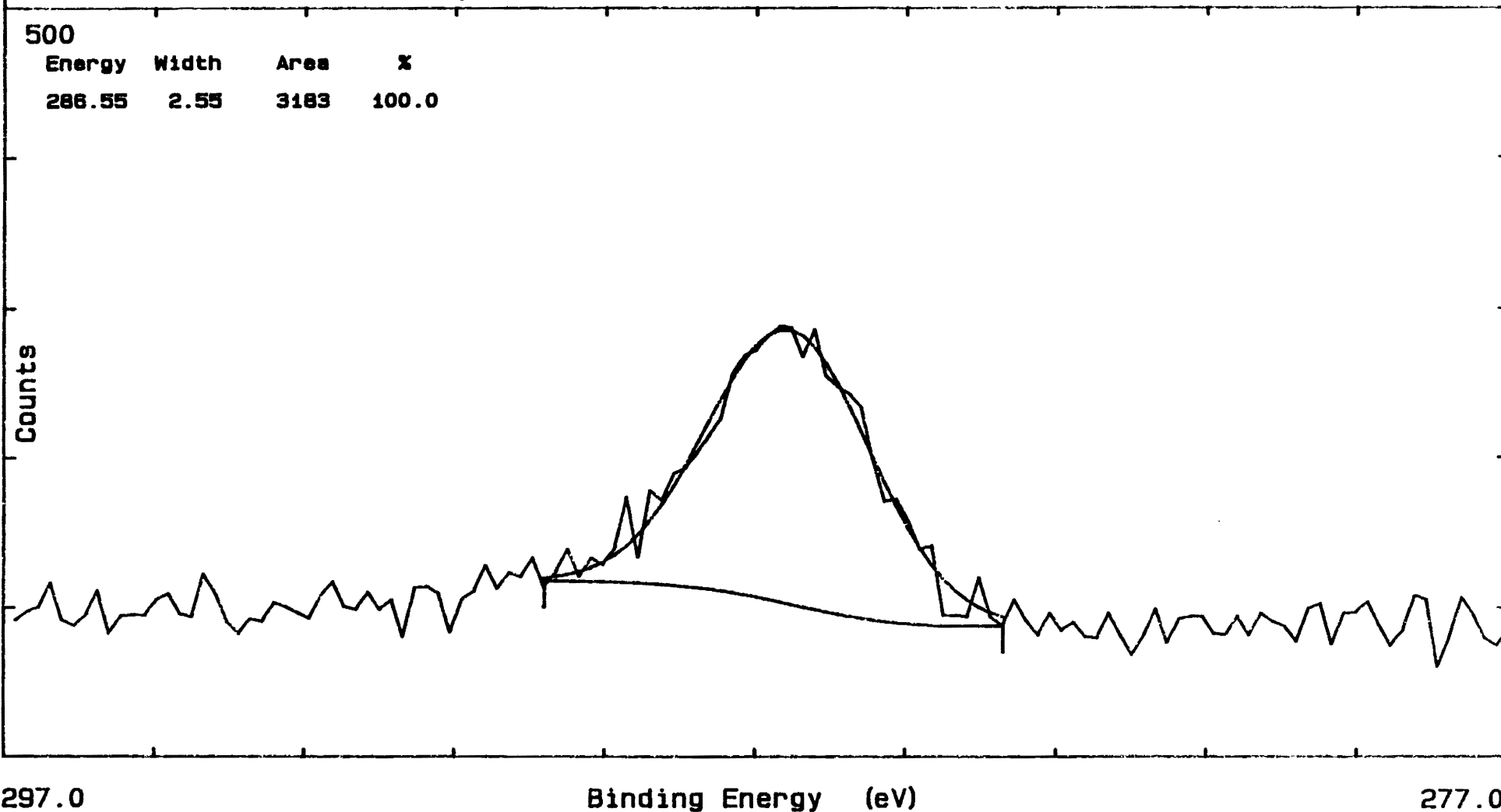
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF109	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2

Description: IV-80: Ag ALLOY + OVERCOAT
C 1s SPECTRUM

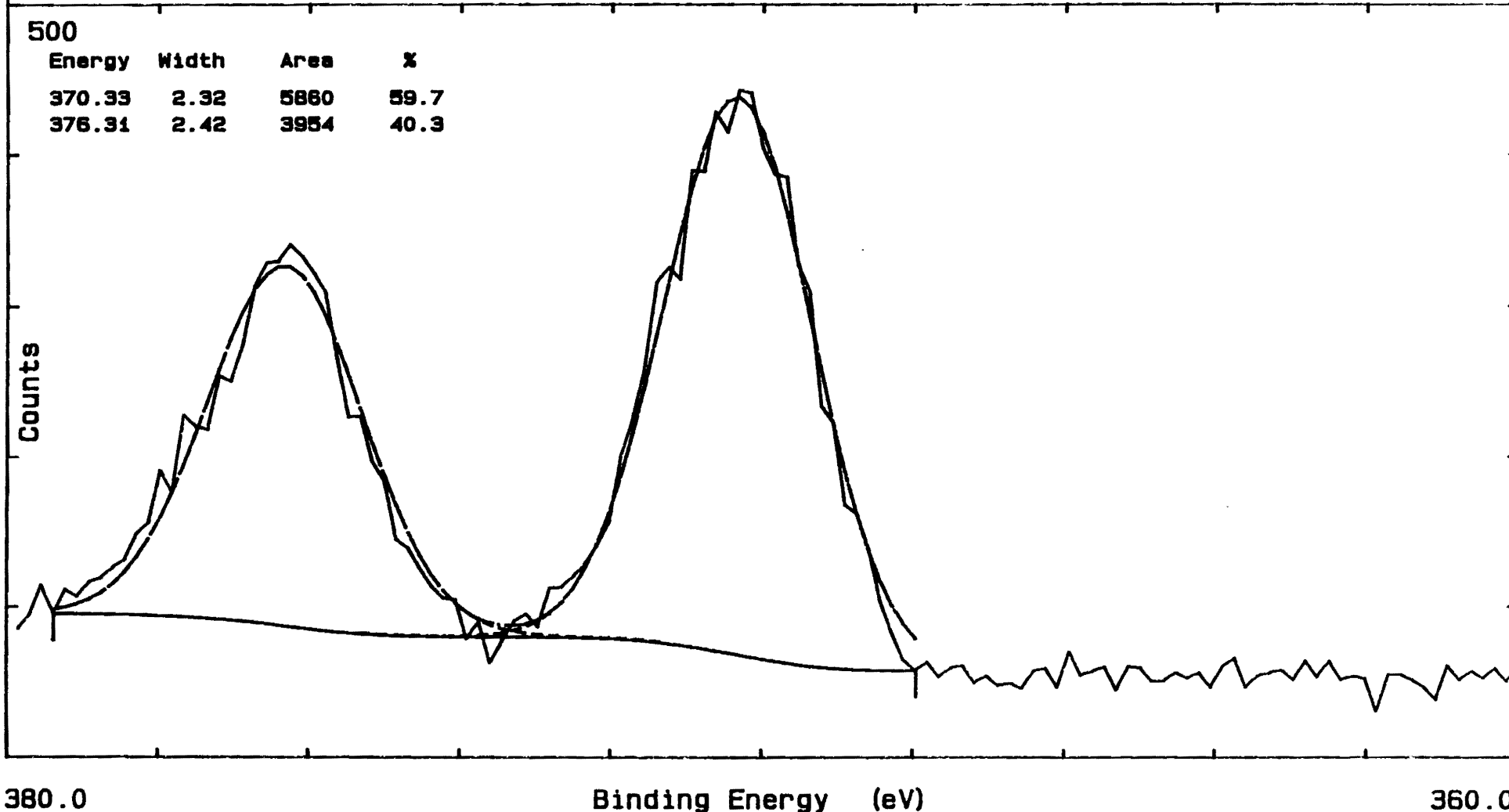
Operator: TAP

SPOT 2 UNEXPOSED



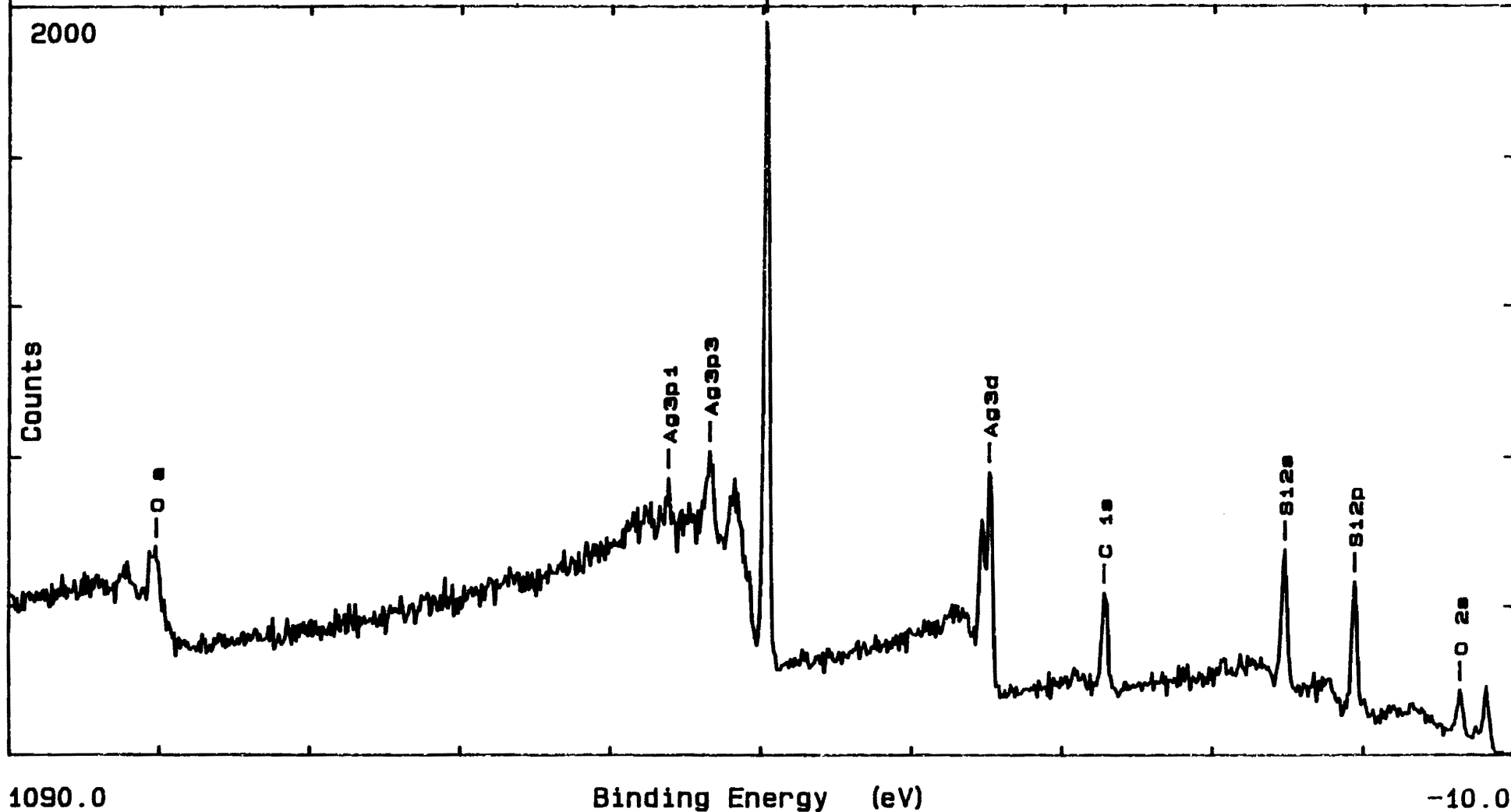
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF109	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT Ag 3d SPECTRUM			Operator: TAP
SPOT 2 UNEXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF106	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-80: Ag ALLOY + OVERCOAT		Operator: TAP	
		SPOT 3 EXPOSED	



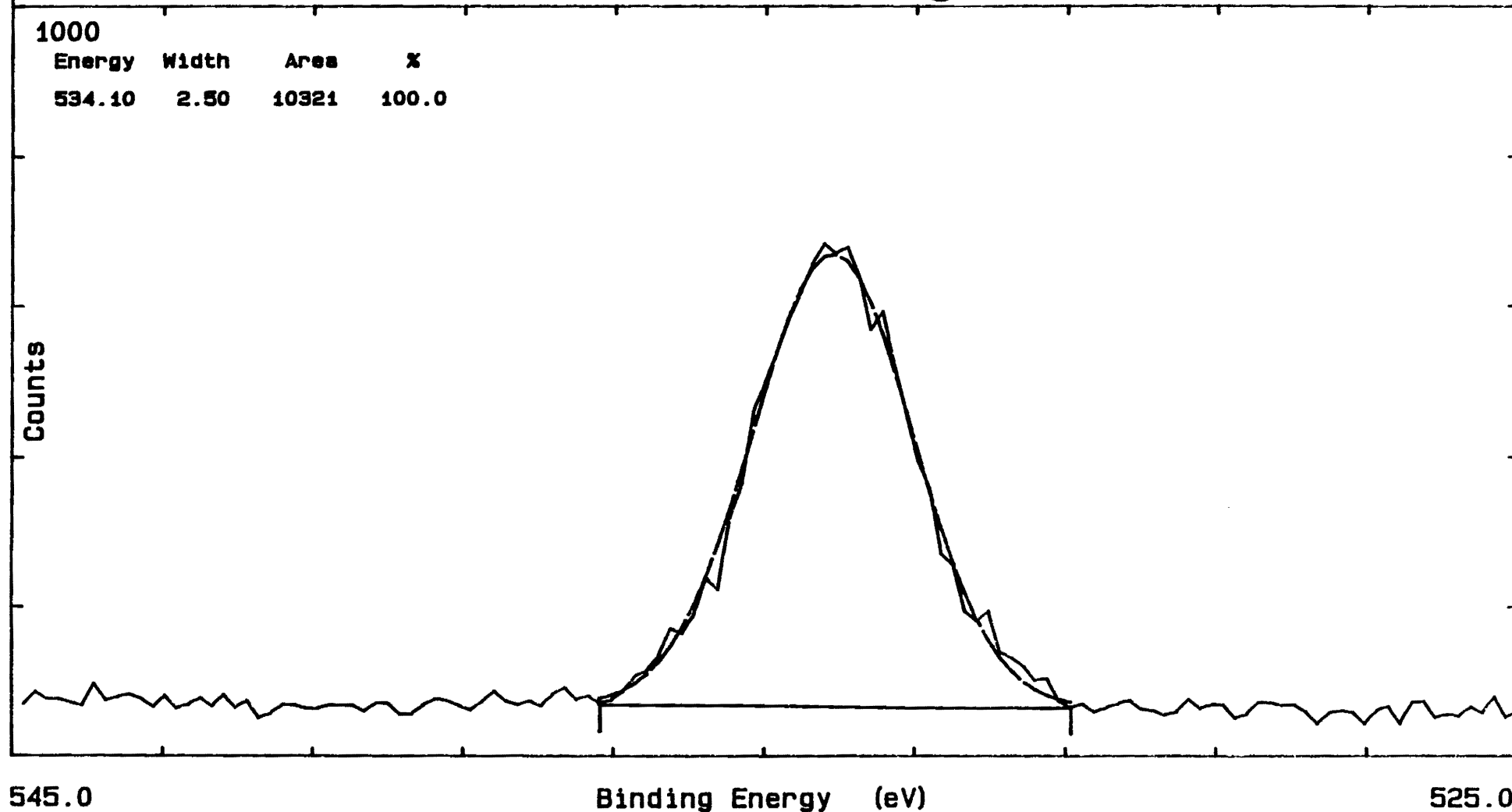
GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF106	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2

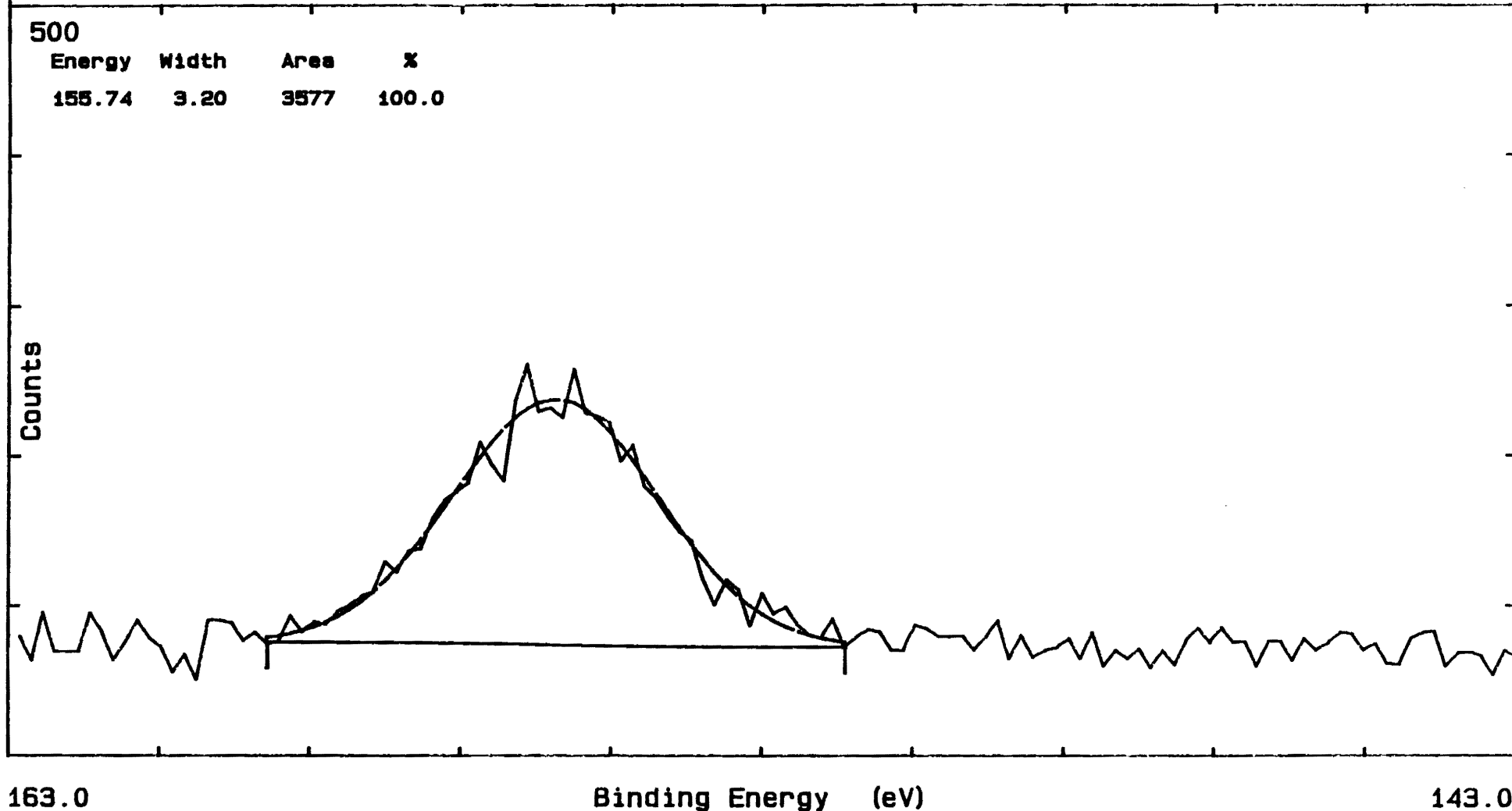
Description: IV-80: Ag ALLOY + OVERCOAT
O 1s SPECTRUM

Operator: TAP

SPOT 3 EXPOSED

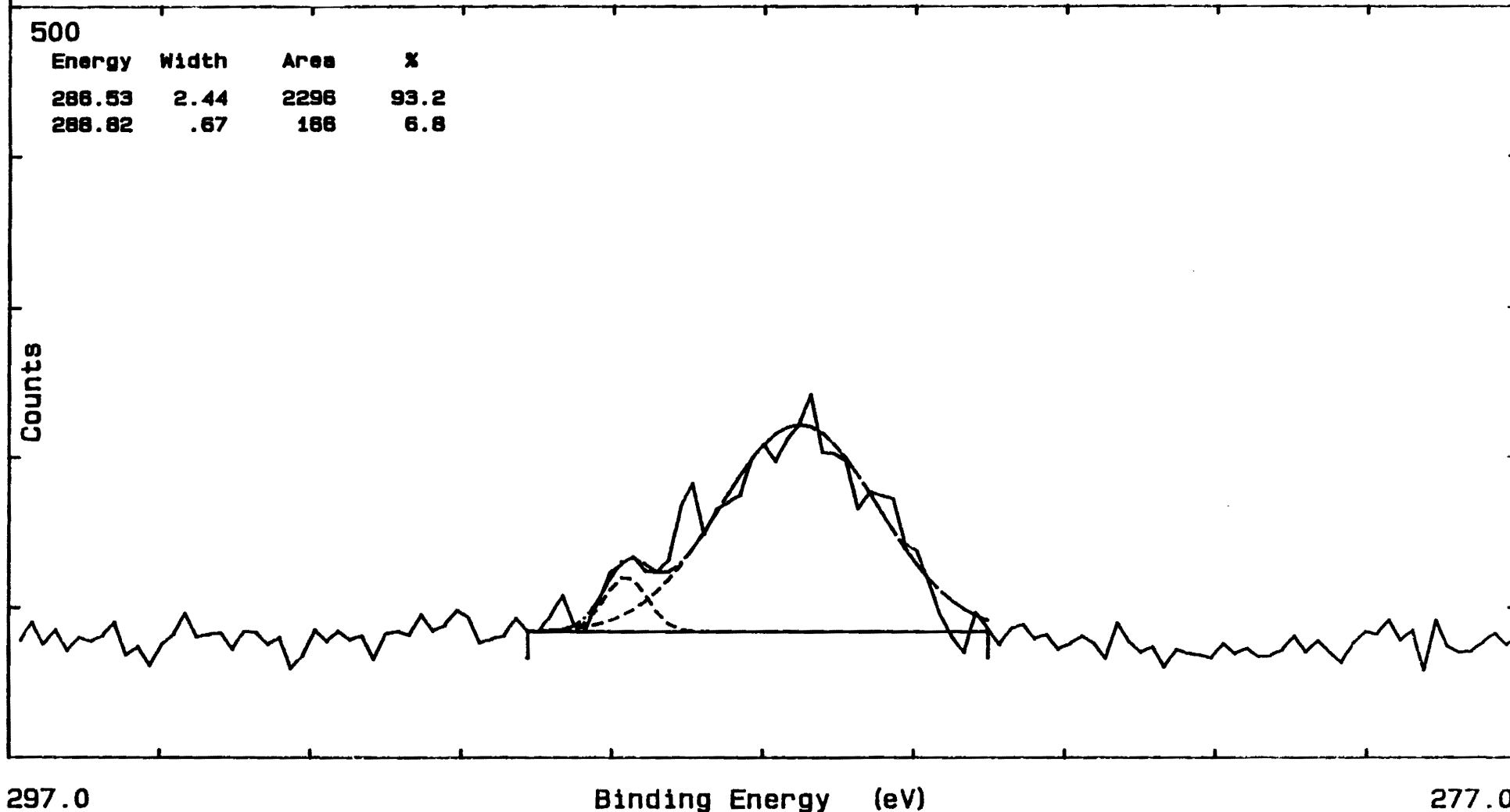


File: LDEF106	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT Si 2s SPECTRUM			Operator: TAP
SPOT 3 EXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

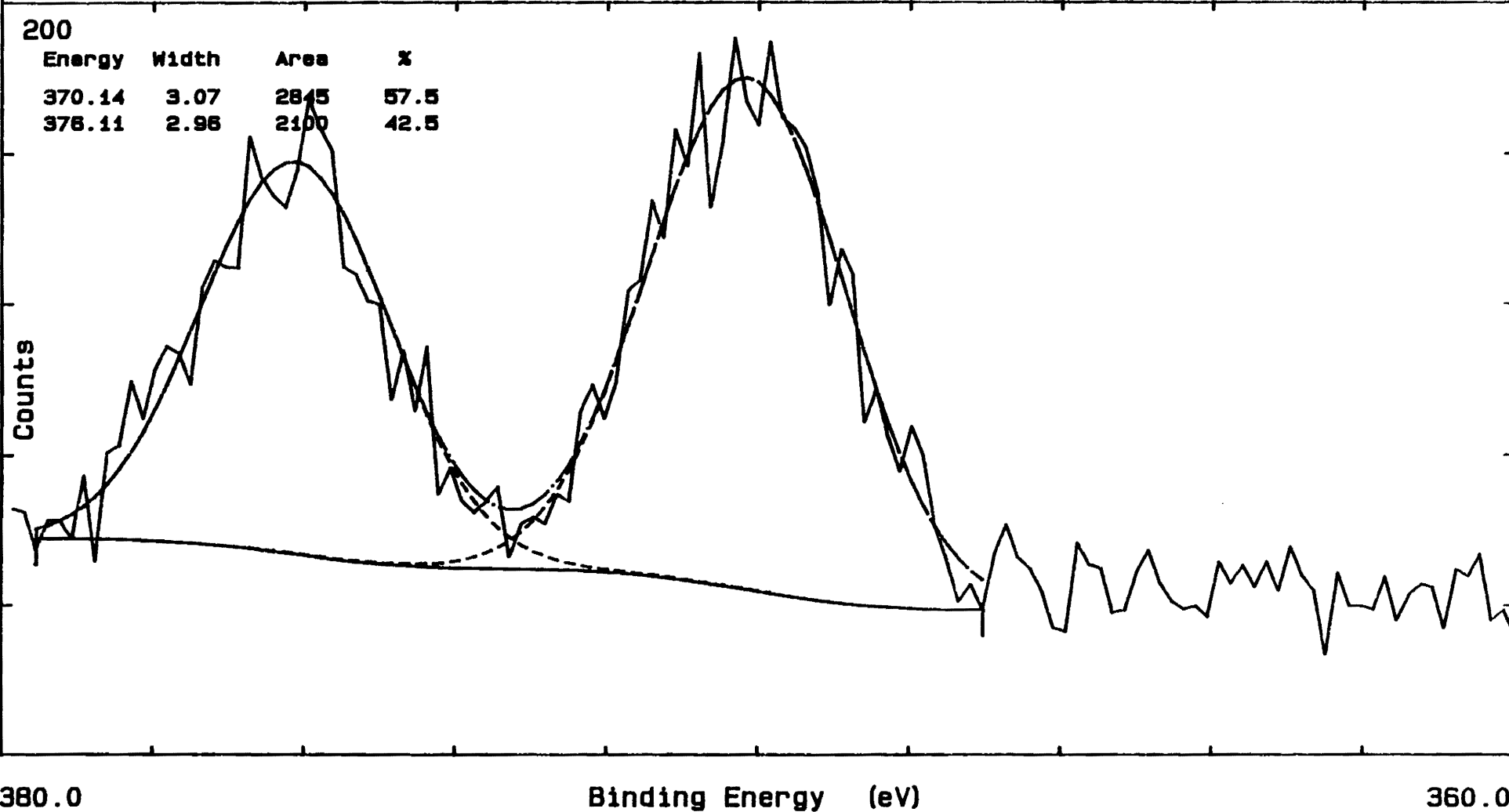
File: LDEF106	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT C 1s SPECTRUM			Operator: TAP
SPOT 3 EXPOSED			



GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF110	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
	Disc: LDEF-5	# of Scans: 3	Resolution: 2

Description: IV-80: Ag ALLOY + OVERCOAT
 Ag 3d SPECTRUM
 Operator: TAP
 SPOT 3 EXPOSED



File: LDEF107	Date: 9/23/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
Region 1	Disc: LDEF-5	# of Scans: 1	Resolution: 4
Description: IV-80: Ag ALLOY + OVERCOAT			Operator: TAP
SPOT 4 EXPOSED			

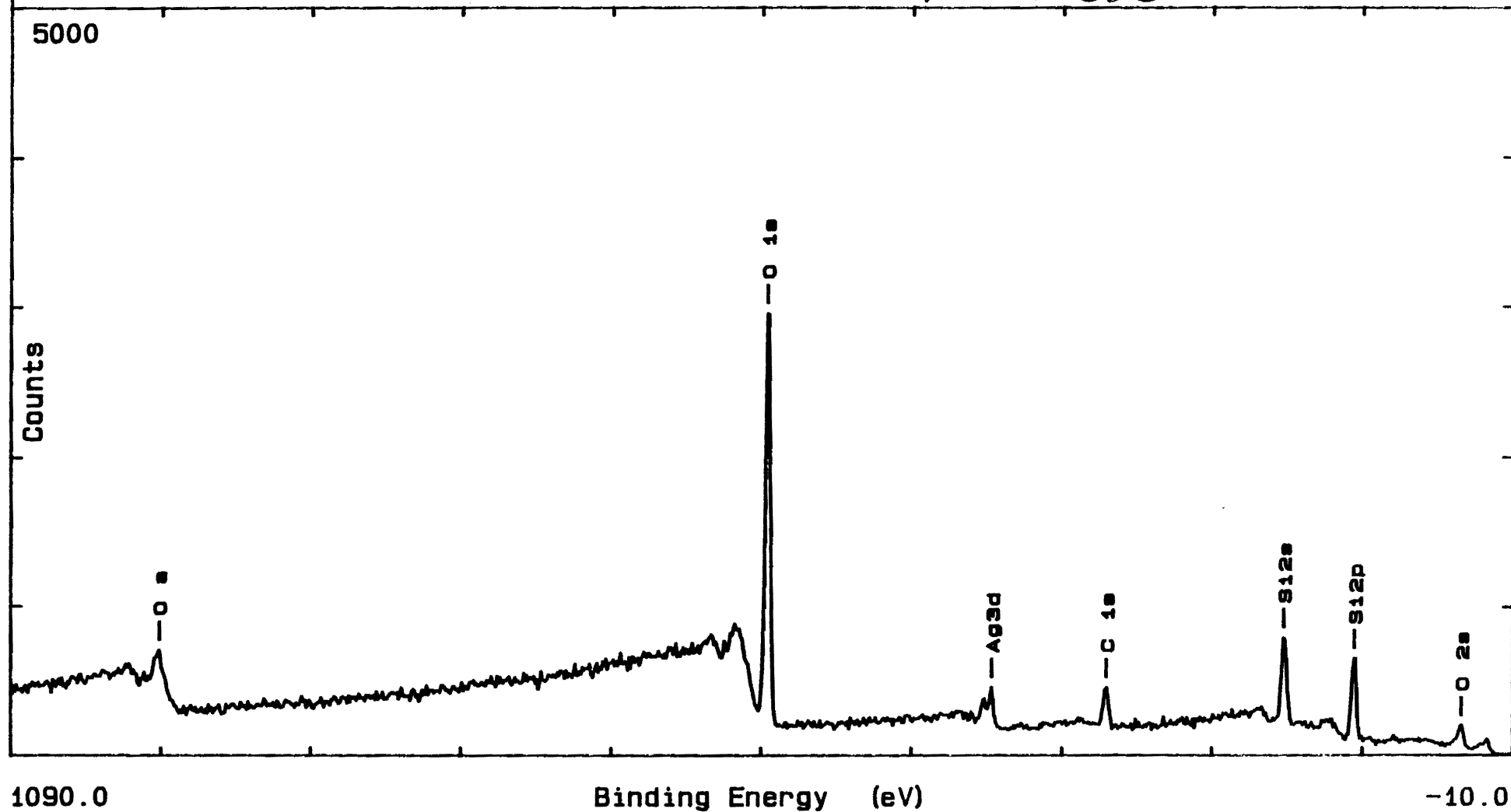
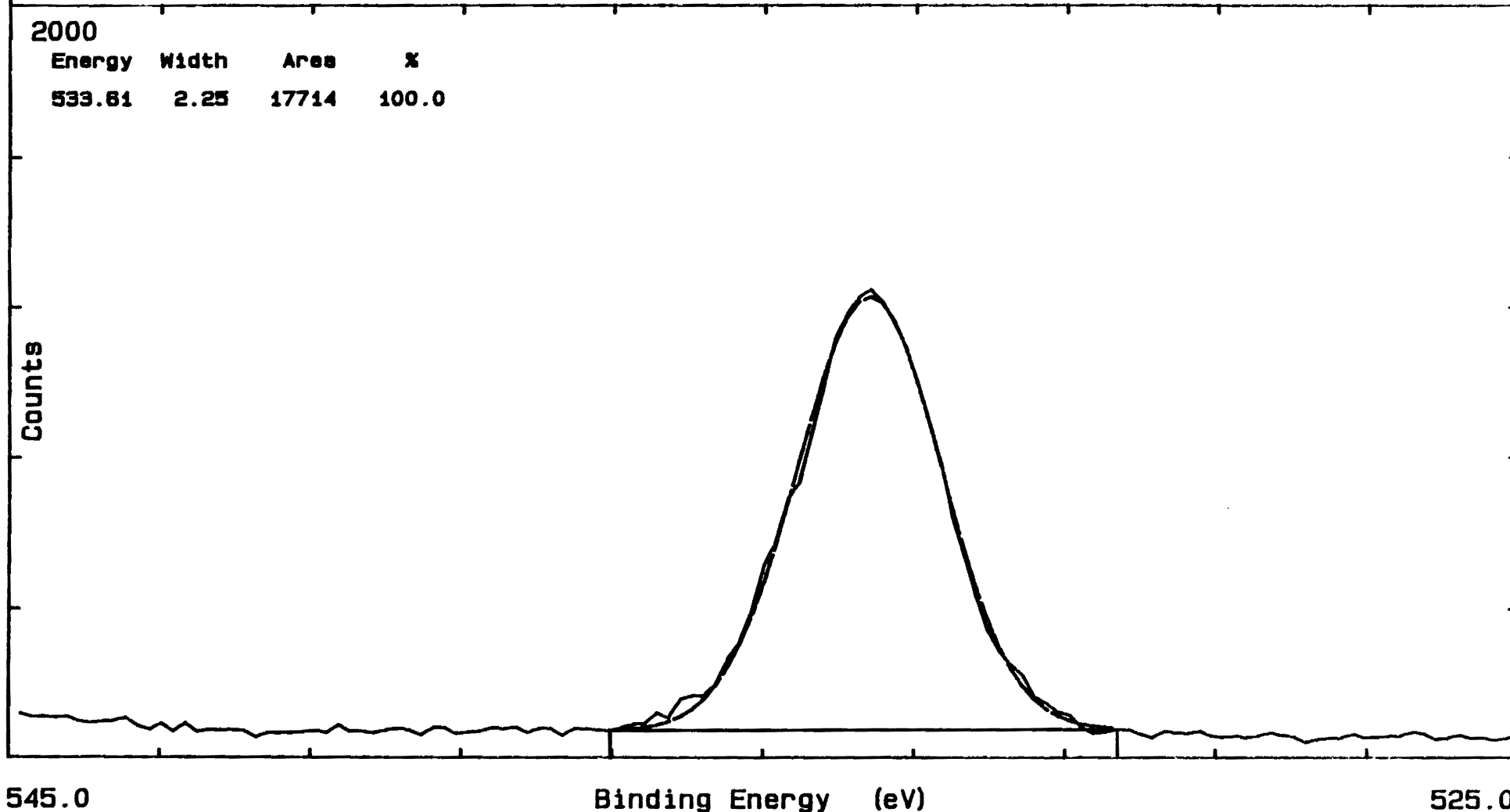


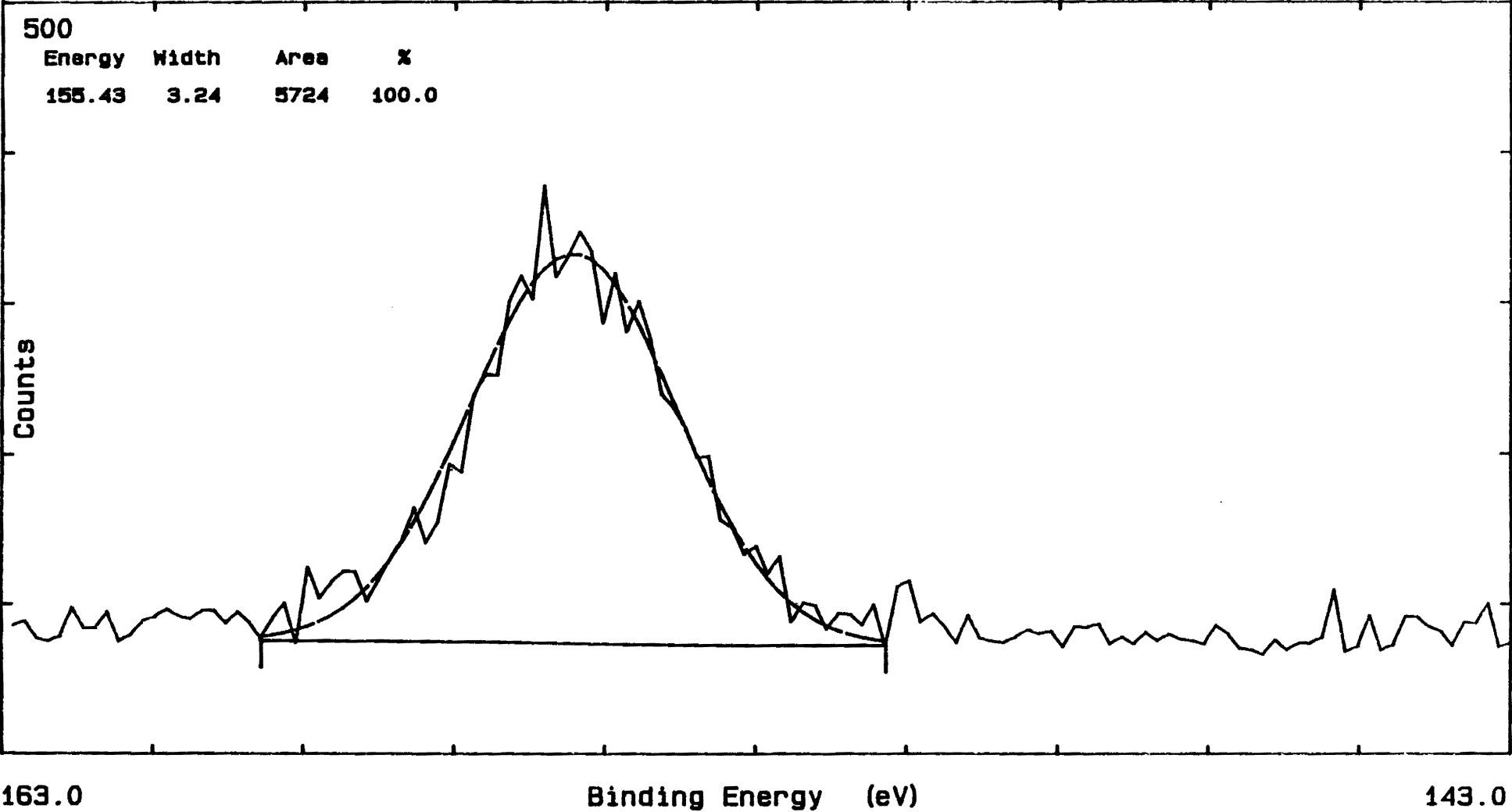
Figure 104

File: LDEF107	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 2	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT 0 1s SPECTRUM			Operator: TAP
SPOT 4 EXPOSED			

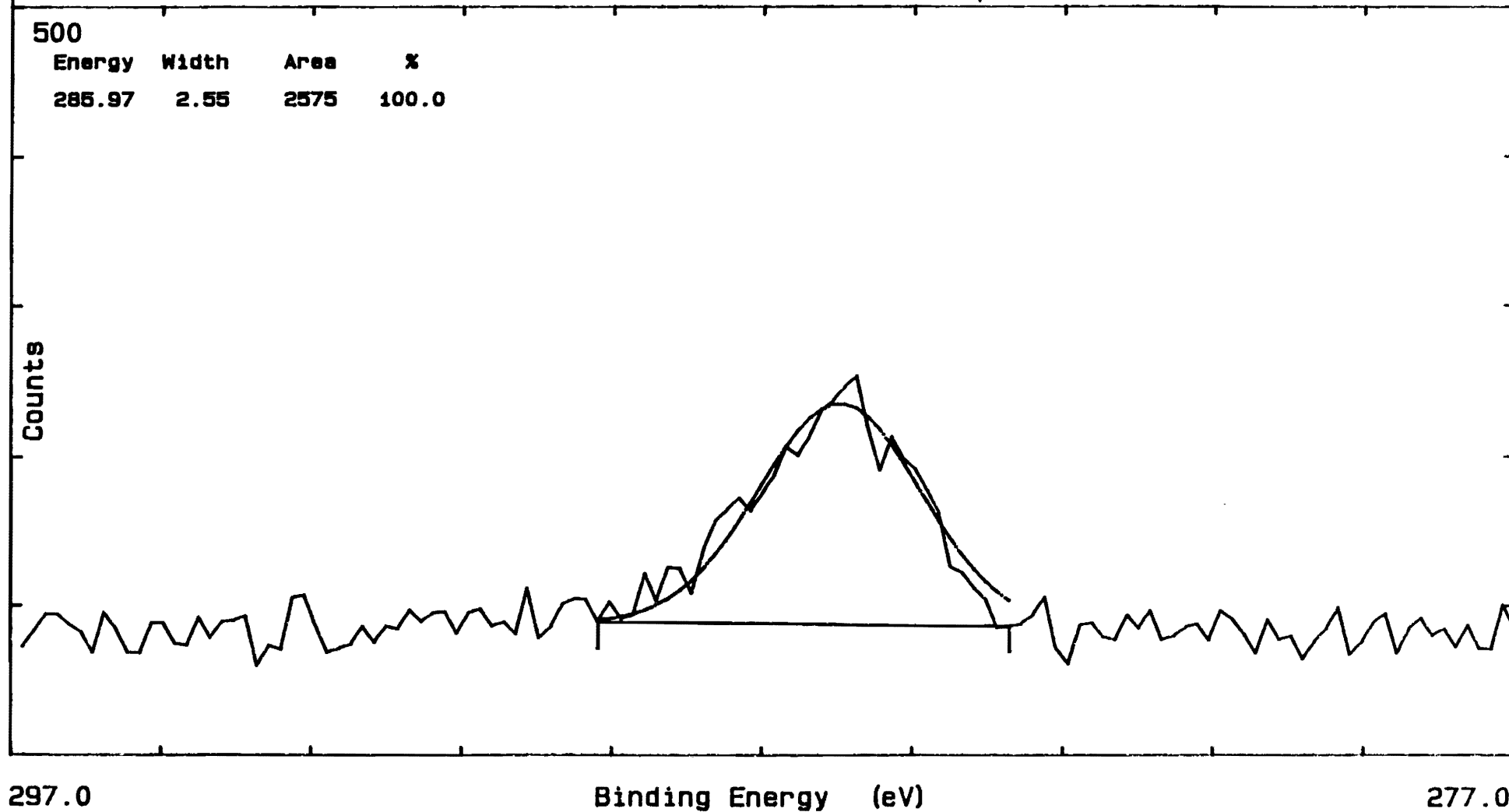


GEORGIA TECH MICROELECTRONICS RESEARCH CENTER

File: LDEF107	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 3	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT Si 2s SPECTRUM			Operator: TAP
SPOT 4 EXPOSED			

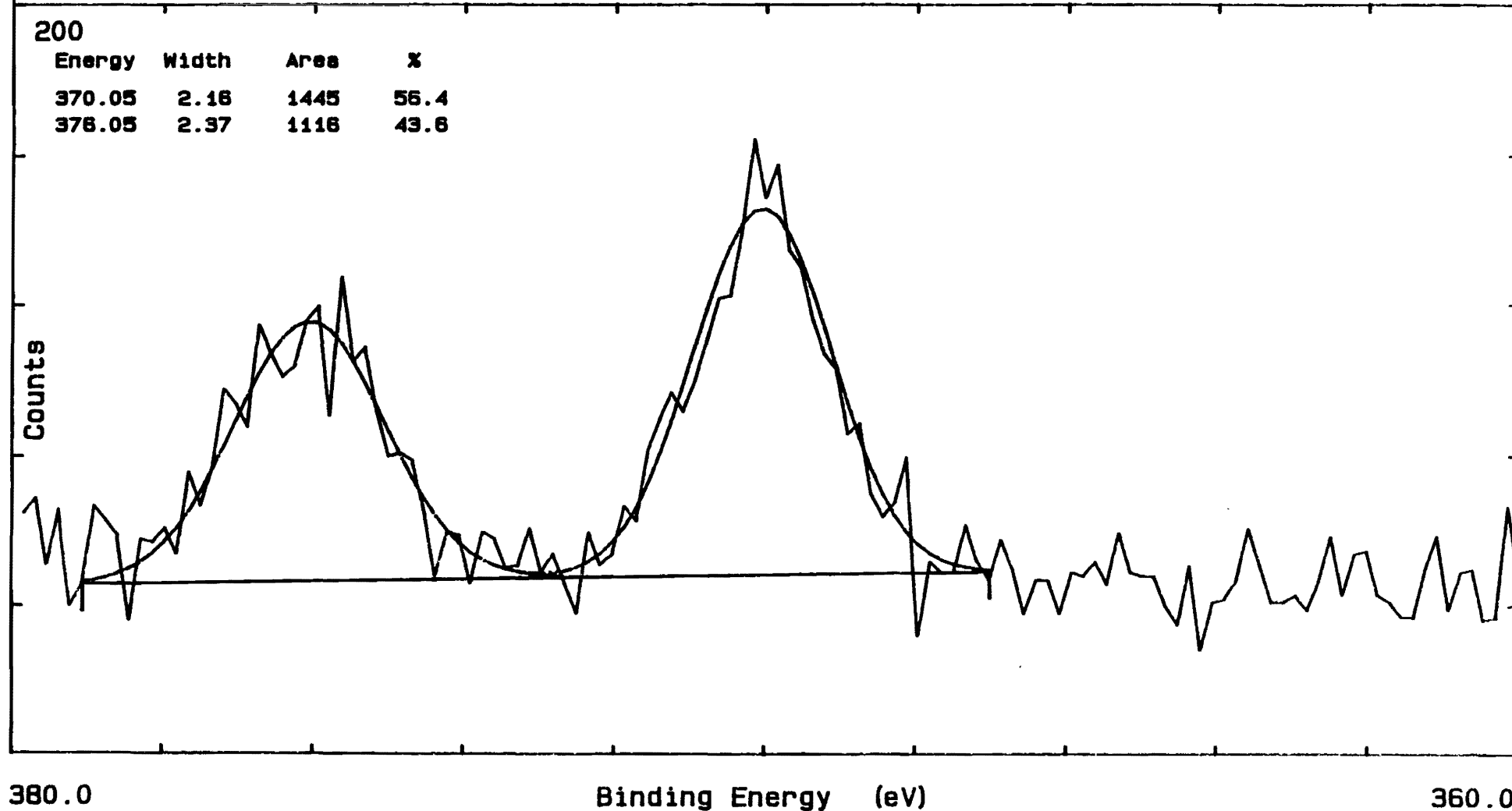


File: LDEF107	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 4	Disc: LDEF-5	# of Scans: 5	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT C 1s SPECTRUM			Operator: TAP
SPOT 4 EXPOSED			



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File: LDEF107	Date: 9/23/1992	Spot Size: 300 u	Flood Gun: 1.0 eV
Region 5	Disc: LDEF-5	# of Scans: 3	Resolution: 2
Description: IV-80: Ag ALLOY + OVERCOAT Ag 3d SPECTRUM			Operator: TAP
SPOT 4 EXPOSED			



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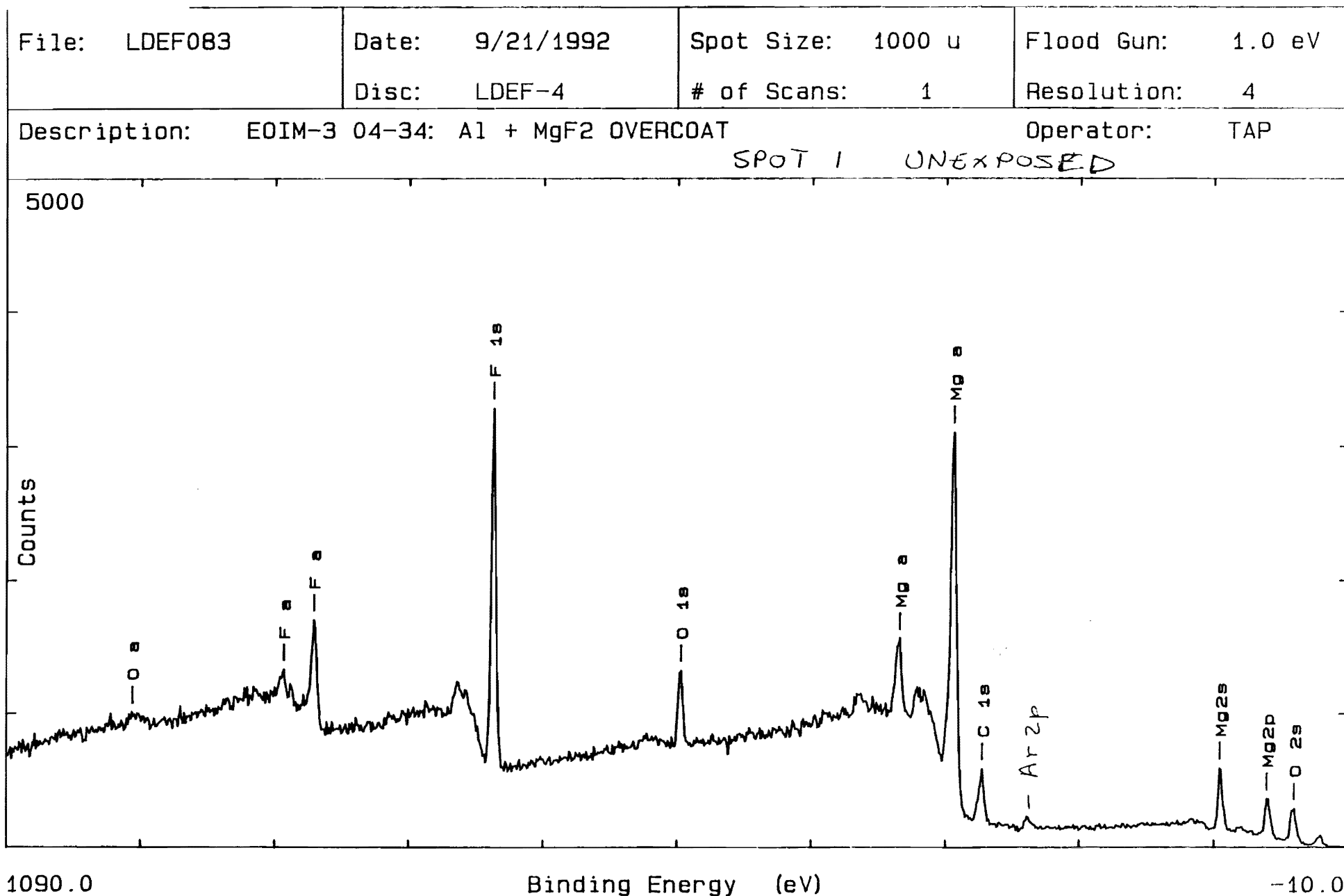


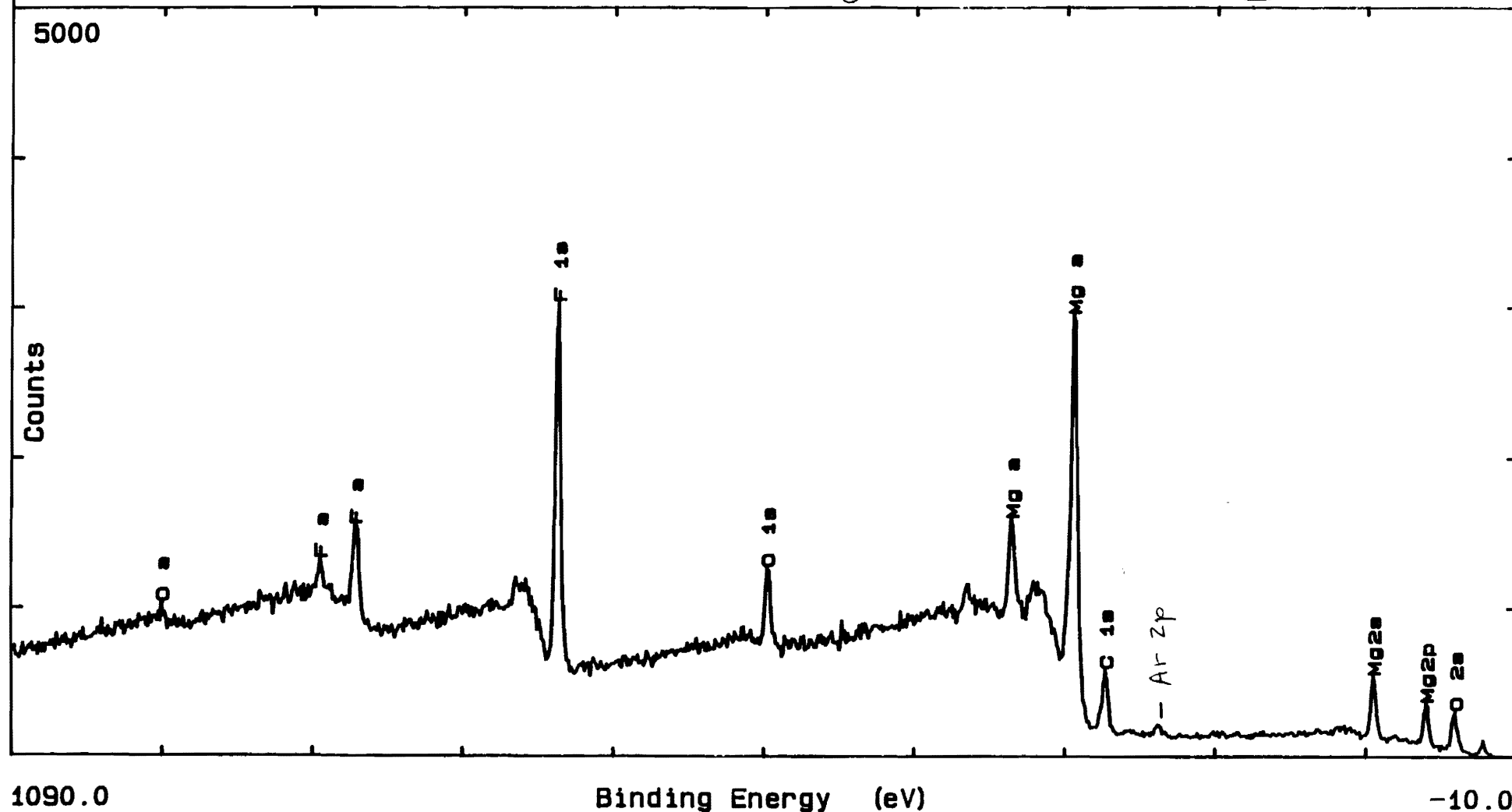
Figure 109

File: LDEF084	Date: 9/21/1992	Spot Size: 1000 u	Flood Gun: 1.0 eV
	Disc: LDEF-4	# of Scans: 1	Resolution: 4

Description: EOIM-3 04-34: Al + MgF2 OVERCOAT

Operator: TAP

SPOT 2 UNEXPOSED



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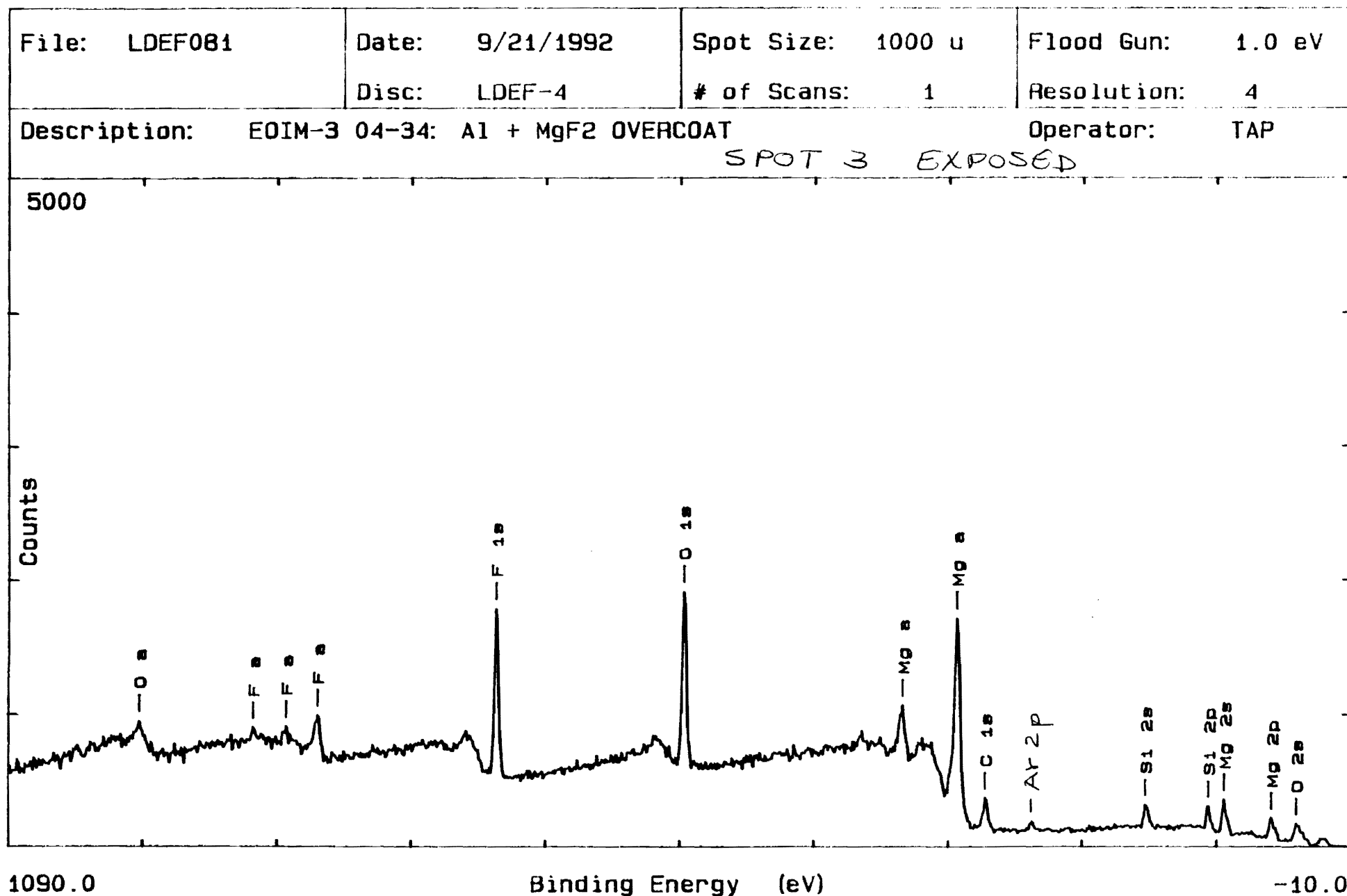


Figure 111

File: LDEF082

Date: 9/21/1992

Spot Size: 1000 u

Flood Gun: 1.0 eV

Disc: LDEF-4

of Scans: 1

Resolution: 4

Description: EOIM-3 04-34: Al + MgF₂ OVERCOAT

Operator: TAP

SPOT 4 EXPOSED

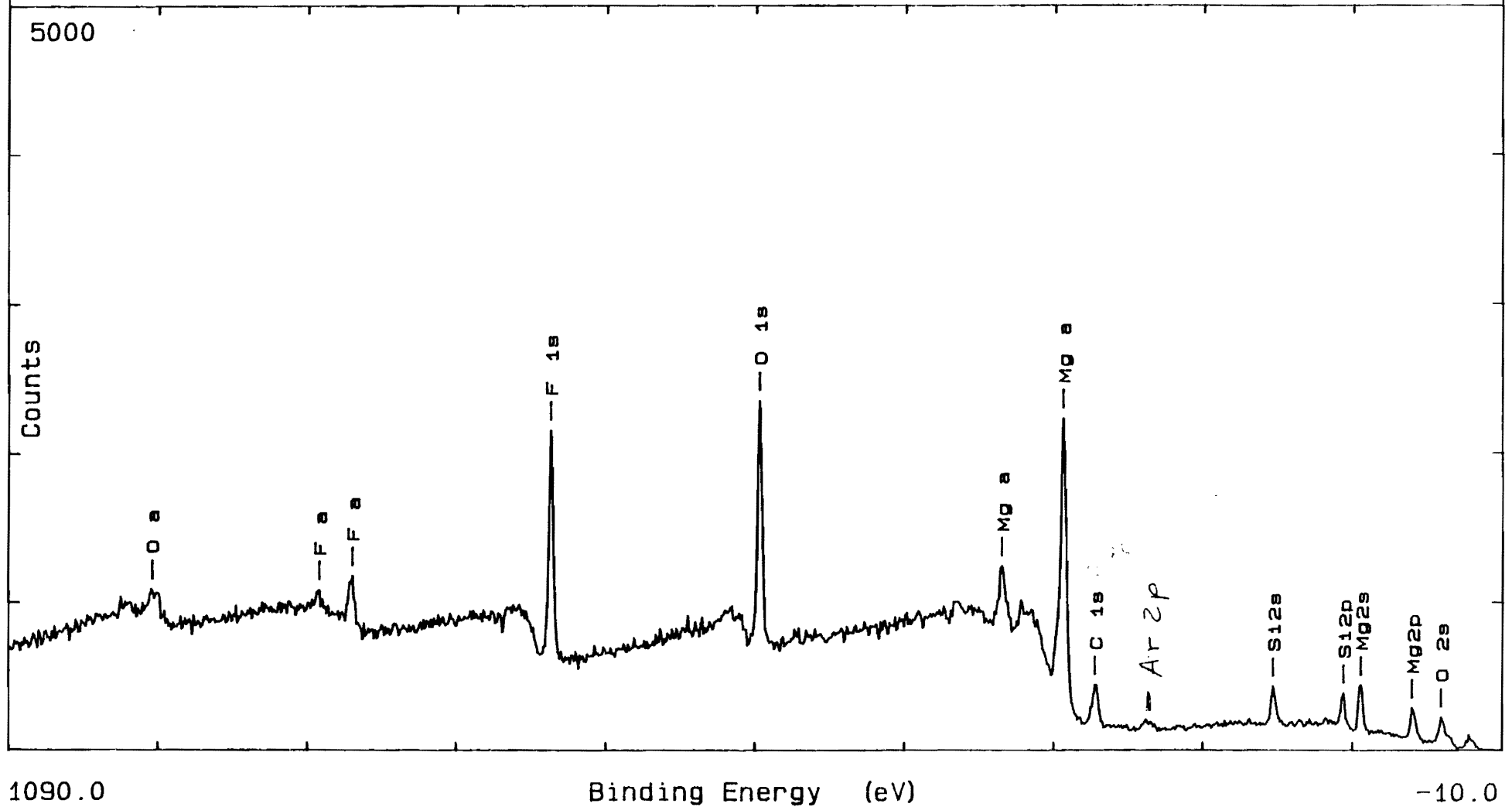


Figure 112